



MC9S08QE8 MC9S08QE4

Reference Manual



***HCS08
Microcontrollers***

MC9S08QE8RM
Rev. 7
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MC9S08QE8 Series Features

8-Bit HCS08 Central Processor Unit (CPU)

- Up to 20 MHz CPU at 3.6 V to 1.8 V across temperature range of -40°C to 85°C
- HC08 instruction set with added BGND instruction
- Support for up to 32 interrupt/reset sources

On-Chip Memory

- Flash read/program/erase over full operating voltage and temperature
- Random-Access memory (RAM)
- Security circuitry to prevent unauthorized access to RAM and flash contents

Power-Saving Modes

- Two low power stop modes
- Reduced power wait mode
- Low power run and wait modes allow peripherals to run while voltage regulator is in standby
- Peripheral clock gating register can disable clocks to unused modules, thereby reducing currents.
- Very low power external oscillator that can be used in stop2 and stop3 modes to provide accurate clock source to real time counter
- 6 μs typical wake up time from stop3 mode

Clock Source Options

- Oscillator (XOSC) — Loop-Control Pierce oscillator; crystal or ceramic resonator range of 31.25 kHz to 38.4 kHz or 1 MHz to 16 MHz
- Internal Clock Source (ICS) — Internal clock source module containing a frequency-locked-loop (FLL) controlled by internal or external reference; precision trimming of internal reference allows 0.2% resolution and 2% deviation over temperature and voltage; supporting bus frequencies from 1 MHz to 10 MHz.

System Protection

- Watchdog computer operating properly (COP) reset with option to run from dedicated 1 kHz internal clock source or bus clock
- Low-Voltage warning with interrupt
- Low-Voltage detection with reset or interrupt
- Illegal opcode detection with reset
- Illegal address detection with reset
- Flash block protection

Development Support

- Single-Wire background debug interface
- Breakpoint capability to allow single breakpoint setting during in-circuit debugging (plus two more breakpoints in on-chip debug module)
- On-Chip in-circuit emulator (ICE) debug module containing three comparators and nine trigger modes. Eight deep FIFO for storing change-of-flow addresses and event-only data. Debug module supports both tag and force breakpoints

Peripherals

- **ADC** — 10-channel, 12-bit resolution; 2.5 μs conversion time; automatic compare function; 1.7 mV/ $^{\circ}\text{C}$ temperature sensor; internal bandgap reference channel; operation in stop3; fully functional from 3.6 V to 1.8 V
- **ACMPx** — Two analog comparators with selectable interrupt on rising, falling, or either edge of comparator output; compare option to fixed internal bandgap reference voltage; outputs can be optionally routed to TPM module; operation in stop3
- **SCI** — Full-Duplex non-return to zero (NRZ); LIN master extended break generation; LIN slave extended break detection; wake-up on active edge
- **SPI** — Full-Duplex or single-wire bidirectional; double-buffered transmit and receive; master or slave mode; MSB-first or LSB-first shifting
- **IIC** — IIC with up to 100 kbps with maximum bus loading; multi-master operation; programmable slave address; interrupt driven byte-by-byte data transfer; supporting broadcast mode and 10-bit addressing
- **TPMx** — Two 3-channel TPMs (TPM1 and TPM2); selectable input capture, output compare, or buffered edge- or center-aligned PWM on each channel
- **RTC** — (Real-Time counter) 8-bit modulus counter with binary or decimal based prescaler; external clock source for precise time base, time-of-day, calendar or task scheduling functions; free running on-chip low power oscillator (1 kHz) for cyclic wake-up without external components; running in all MCU modes

Input/Output

- 26 GPIOs, one output-only pin and one input-only pin
- Eight KBI interrupts with selectable polarity
- Hysteresis and configurable pullup device on all input pins; configurable slew rate and drive strength on all output pins.

Package Options

- 32-pin LQFP, 32-pin QFN, 28-pin SOIC, 20-pin SOIC, 16-pin PDIP, 16-pin TSSOP



MC9S08QE8 Reference Manual

Covers MC9S08QE8
MC9S08QE4

Related Documentation:

- **MC9S08QE8 (Data Sheet)**
Contains pin assignments and diagrams, all electrical specifications, and mechanical drawing outlines.

MC9S08QE8RM
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Revision History

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The following revision history table summarizes changes contained in this document.

Revision Number	Revision Date	Description of Changes
2	Nov 2007	Initial preliminary release
3	Jan 2008	Initial public release
4	Jan 2009	Changed the ADC conversion time to 2.5 μ s in the feature page. Changed the unit in Equation 10-2 to μ s. Added a note to the Section 15.1, "Introduction." Fixed the cross reference in Section 12.7, "Initialization/Application Information." Added a paragraph before Table 4-4 and added a footnote of IFR at the same page. Updated "How to reach us" information.
5	May 19, 2009	Updated Section 13.1.5, "RTC Clock Gating." Updated Figure 4-2 and Figure 4-3 . In Chapter 11, "Internal Clock Source (S08ICSV3)," added a note in Section 11.1.3.7, "Stop (STOP);" updated Figure 11-2 to reflect ICSECLK is gated off when STOP is high or when ERCLKEN is low. In Chapter 10, "Analog-to-Digital Converter (S08ADC12V1)," Changed V_{DDAD} supply references to V_{DDA} ; fixed ADCRH:L description for compare operation, including an updates of Section 10.4.5, "Automatic Compare Function" description and ADCRH:L register descriptions (Section 10.3.3, "Data Result High Register (ADCRH)" and Section 10.3.4, "Data Result Low Register (ADCRL).") Reworded Chapter 16, "Timer/Pulse-Width Modulator (S08TPMV3)."
6	Sept 2, 2009	Added FLS bit description in the Table 5-15 . Updated Section 13.1.2, "RTC Clock Sources," to clarify the clock sources for the RTC.
7	April 12, 2011	Added 32-pin QFN package information.

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Chapter 1

Device Overview

The MC9S08QE8 and MC9S08QE4 are members of the low-cost, low-power, high-performance HCS08 family of 8-bit microcontroller units (MCUs). All MCUs in the family use the enhanced HCS08 core and are available with a variety of modules, memory sizes, memory types, and package types.

1.1 Devices in the MC9S08QE8 Series

Table 1-1 summarizes the feature set available in the MC9S08QE8 series of MCUs.

Table 1-1. MC9S08QE8 Series Features by MCU and Package

Feature	MC9S08QE8				MC9S08QE4			
Flash size (bytes)	8192				4096			
RAM size (bytes)	512				256			
Pin quantity	32	28	20	16	32	28	20	16
ACMP1	yes							
ACMP2	yes	yes	no	no	yes	yes	no	no
ADC channels	10	10	8	8	10	10	8	8
ADC Resolution	12	12	10	10	12	12	10	10
DBG	yes							
ICS	yes							
IIC	yes							
IRQ	yes							
KBI	8							
Port I/O ¹	26	22	16	12	26	22	16	12
RTC	yes							
SCI	yes							
SPI	yes							
TPM1 channels	3	3	3	2	3	3	3	2
TPM2 channels	3	3	3	2	3	3	3	2
XOSCVLP	yes							

¹ Port I/O count does not include the output-only PTA4 or the input-only PTA5 pins.

1.2 MCU Block Diagram

The block diagram in Figure 1-1 shows the structure of the MC9S08QE8 series MCU.

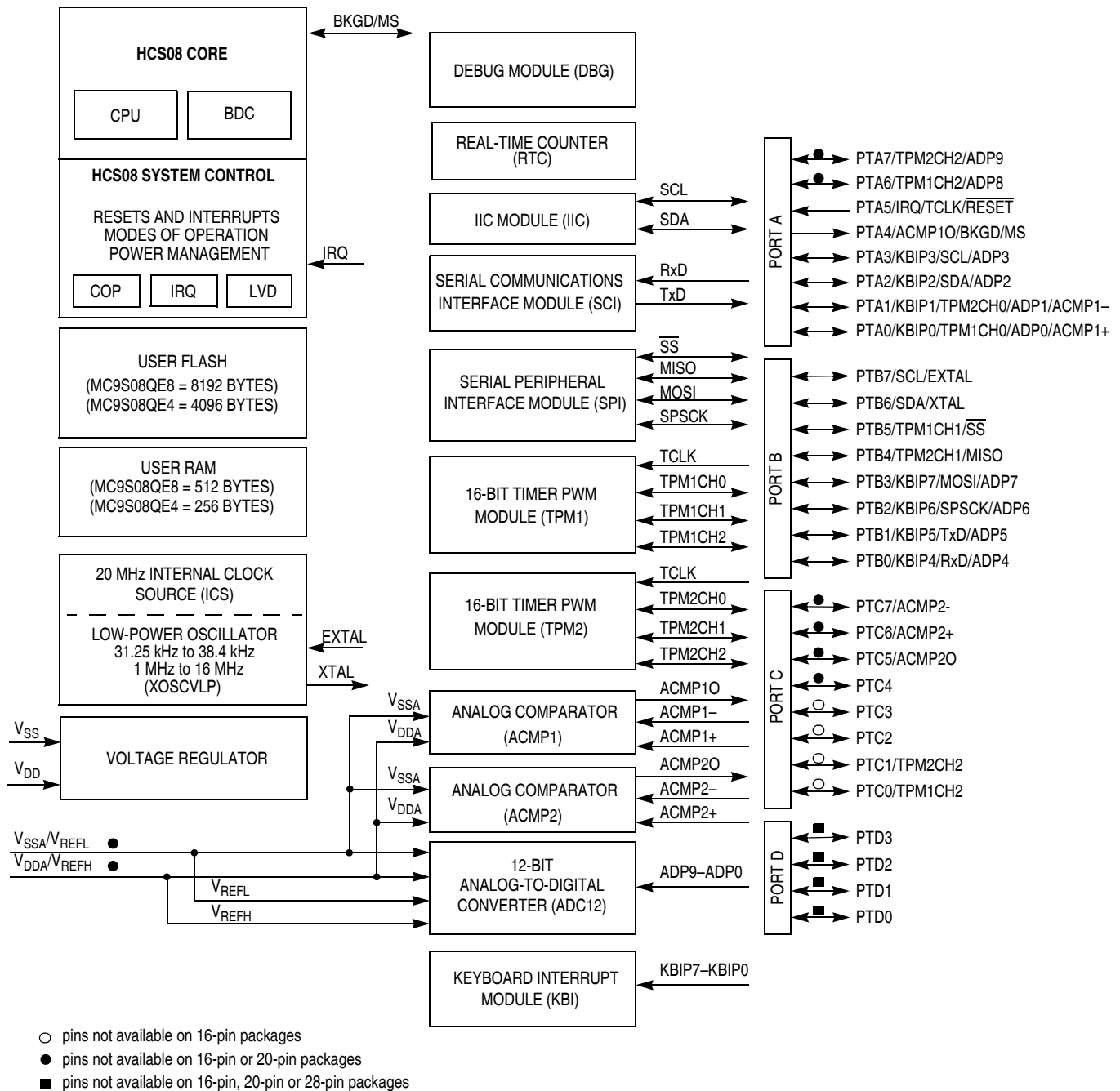


Figure 1-1. MC9S08QE8 Series Block Diagram

Table 1-2 provides the functional version of the on-chip modules

Table 1-2. Module Versions

Module	Version
Analog Comparator (ACMPVLP)	1
Analog-to-Digital Converter (ADC12)	1
Central Processor Unit (CPU)	4
Inter-Integrated Circuit (IIC)	2
Internal Clock Source (ICS)	3
Keyboard Interrupt (KBI)	2
Low Power Oscillator (XOSCVP)	1
On-Chip In-Circuit Debug/Emulator (DBG)	3
Real-Time Counter (RTC)	1
Serial Communications Interface (SCI)	4
Serial Peripheral Interface (SPI)	3
Timer Pulse Width Modulator (TPM)	3

1.3 System Clock Distribution

Figure 1-2 shows a simplified clock connection diagram. Some modules in the MCU have selectable clock inputs as shown. The clock inputs to the modules indicate the clock(s) that are used to drive the module function. All memory mapped registers associated with the modules are clocked with BUSCLK. The ICS supplies the clock sources:

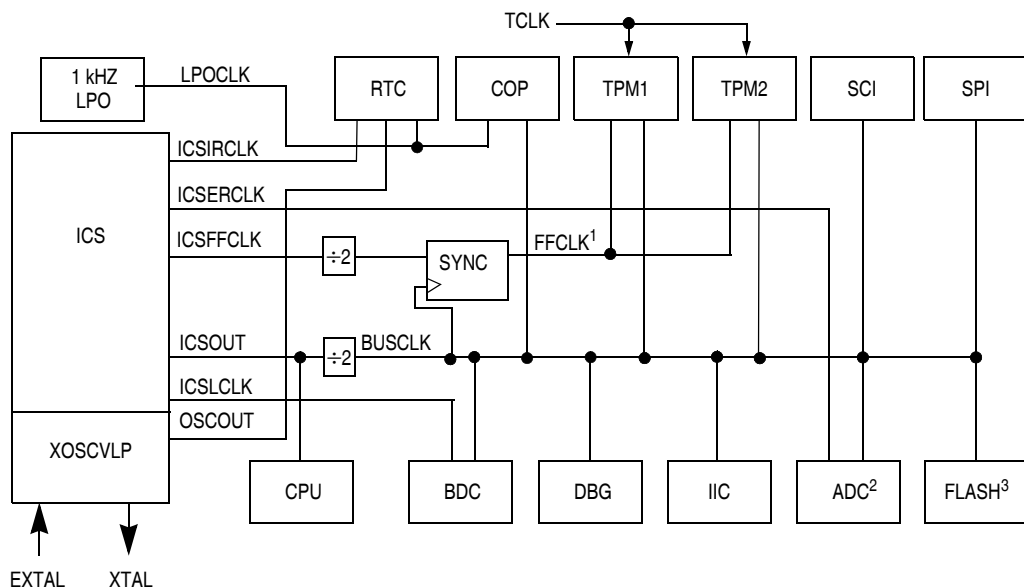
- ICSOUT — This clock source is used as the CPU clock and is divided by 2 to generate the peripheral bus clock, BUSCLK. Control bits in the ICS control registers determine which of three clock sources is connected:
 - Internal reference clock
 - External reference clock
 - Frequency-locked loop (FLL) output

See [Chapter 11, “Internal Clock Source \(S08ICSV3\)”](#) for details on configuring the ICSOUT clock.

- ICSLCLK — This clock source is derived from the digitally controlled oscillator, DCO, of the ICS when the ICS is configured to run off of the internal or external reference clock. Development tools can select this internal self-clocked source (~ 8 MHz) to speed up BDC communications in systems where the bus clock is slow.
- ICSECLK — This is the external reference clock and can be selected as the alternate clock for the ADC module. The “Optional External Reference Clock” section in [Chapter 11, “Internal Clock Source \(S08ICSV3\)”](#) explains the ICSECLK in more detail. See [Chapter 10, “Analog-to-Digital Converter \(S08ADC12V1\)”](#) for more information regarding the use of ICSECLK with these modules.
- ICSIRCLK — This is the internal reference clock and can be selected as the real-time counter clock source. [Chapter 11, “Internal Clock Source \(S08ICSV3\)”](#) explains the ICSIRCLK in more detail.

See [Chapter 13, “Real-Time Counter \(S08RTCV1\),”](#) for more information regarding the use of ICSIRCLK.

- **ICSFFCLK** — This generates the fixed frequency clock (FFCLK) after being synchronized to the bus clock. It can be selected as clock source for the TPM modules. The frequency of the ICSFFCLK is determined by the settings of the ICS. See the “Fixed Frequency Clock” section in [Chapter 11, “Internal Clock Source \(S08ICSV3\),”](#) for details.
- **LPOCLK** — This clock is generated from an internal low power oscillator that is completely independent of the ICS module. The LPOCLK can be selected as the clock source to the RTC or COP modules. See [Chapter 13, “Real-Time Counter \(S08RTCV1\),”](#) and [Section 5.4, “Computer Operating Properly \(COP\) Watchdog”](#) for details on using the LPOCLK with these modules.
- **OSCOULT** — This is the output of the XOSCVLP module and can be selected as the real-time counter clock source.
- **TCLK** — TCLK is the optional external clock source for the TPM modules. The TCLK must be limited to 1/4th the frequency of the bus clock for synchronization. See the “External TPM Clock Sources” section in [Chapter 16, “Timer/Pulse-Width Modulator \(S08TPMV3\),”](#) for more details.



¹ The fixed frequency clock (FFCLK) is internally synchronized to the bus clock and must not exceed one half of the bus clock frequency.

² ADC has min and max frequency requirements. See the [Chapter 10, “Analog-to-Digital Converter \(S08ADC12V1\)”](#) and *MC9S08QE8 Series Data Sheet* for details.

³ Flash has frequency requirements for program and erase operation. See *MC9S08QE8 Series Data Sheet* for details.

Figure 1-2. System Clock Distribution Diagram



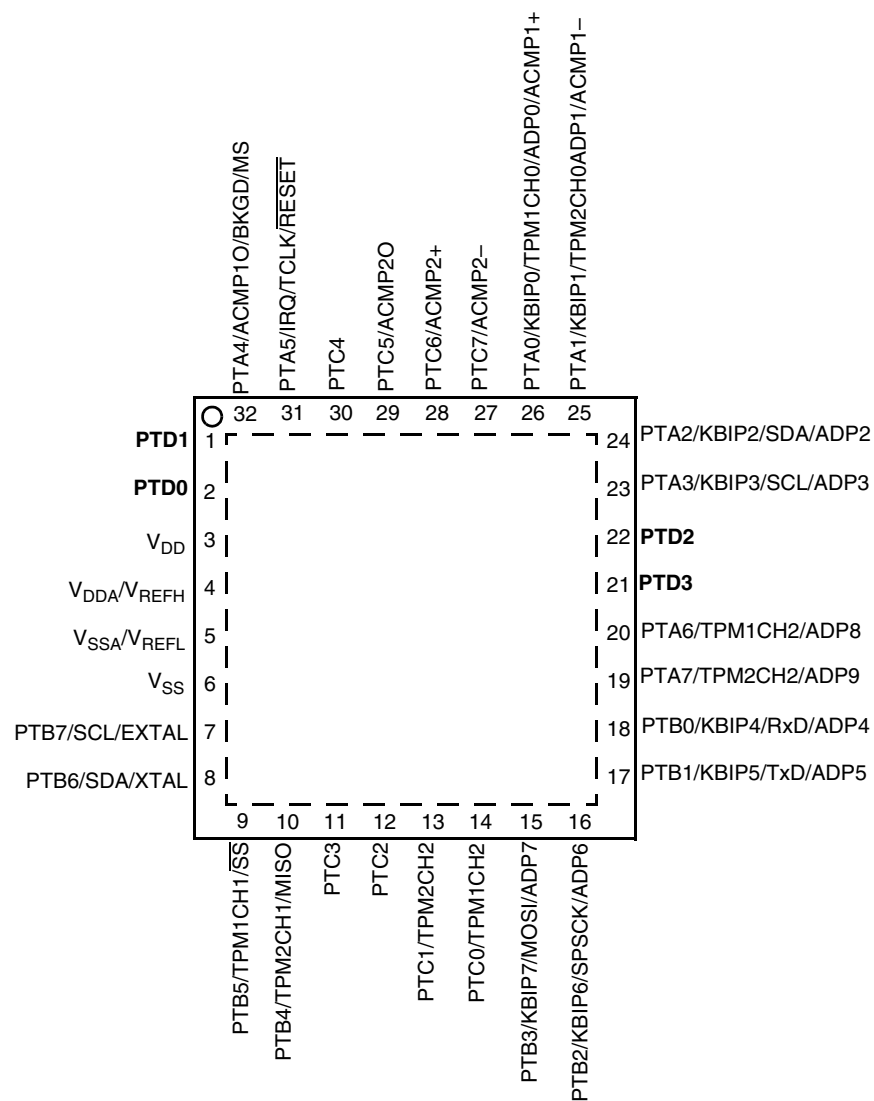
Chapter 2

Pins and Connections

This chapter describes signals that connect to package pins. It includes pinout diagrams, recommended system connections, and detailed discussions of signals.

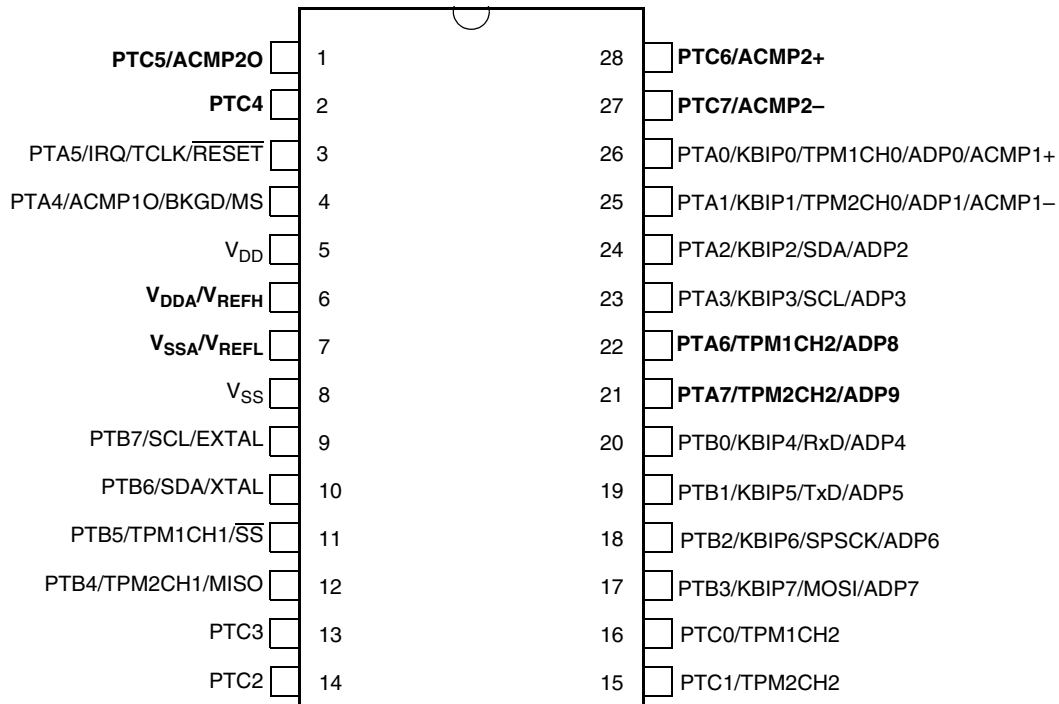
2.1 Device Pin Assignment

This section shows the pin assignments for MC9S08QE8 series devices.



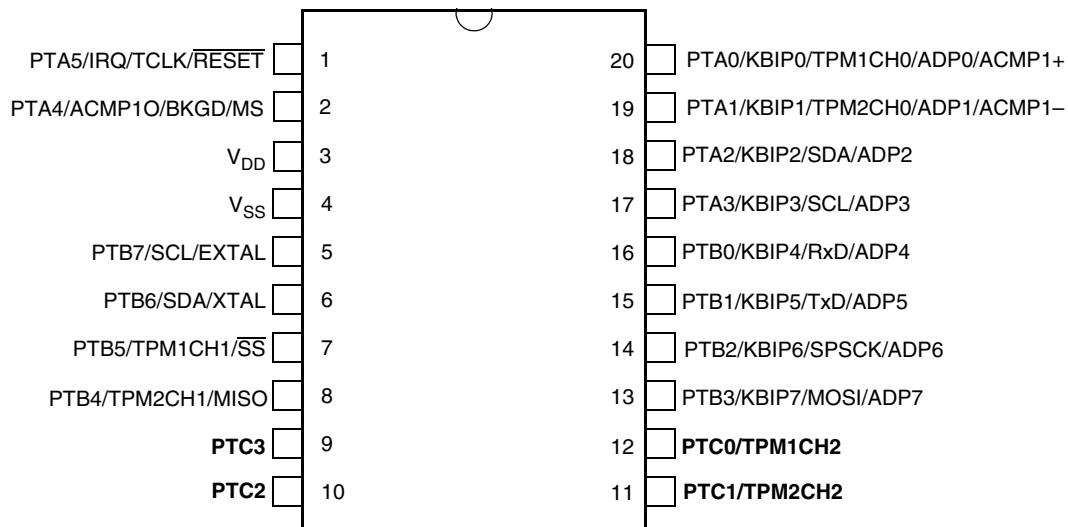
Pins shown in bold type are lost in the next lower pin count package.

Figure 2-1. MC9S08QE8 Series in 32-Pin LQFP/QFN



Pins shown in bold type are lost in the next lower pin count package.

Figure 2-2. MC9S08QE8 Series in 28-Pin SOIC Package



Pins shown in bold type are lost in the next lower pin count package.

Figure 2-3. MC9S08QE8 Series in 20-Pin SOIC Package

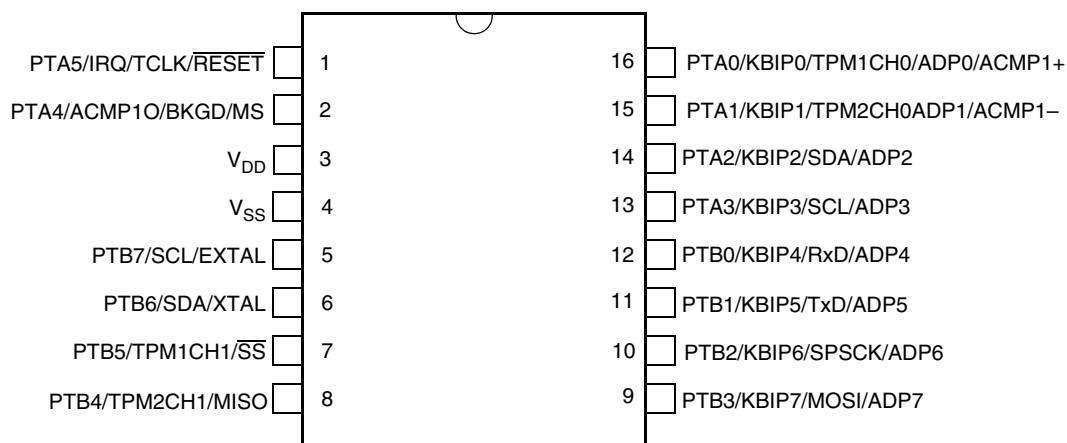
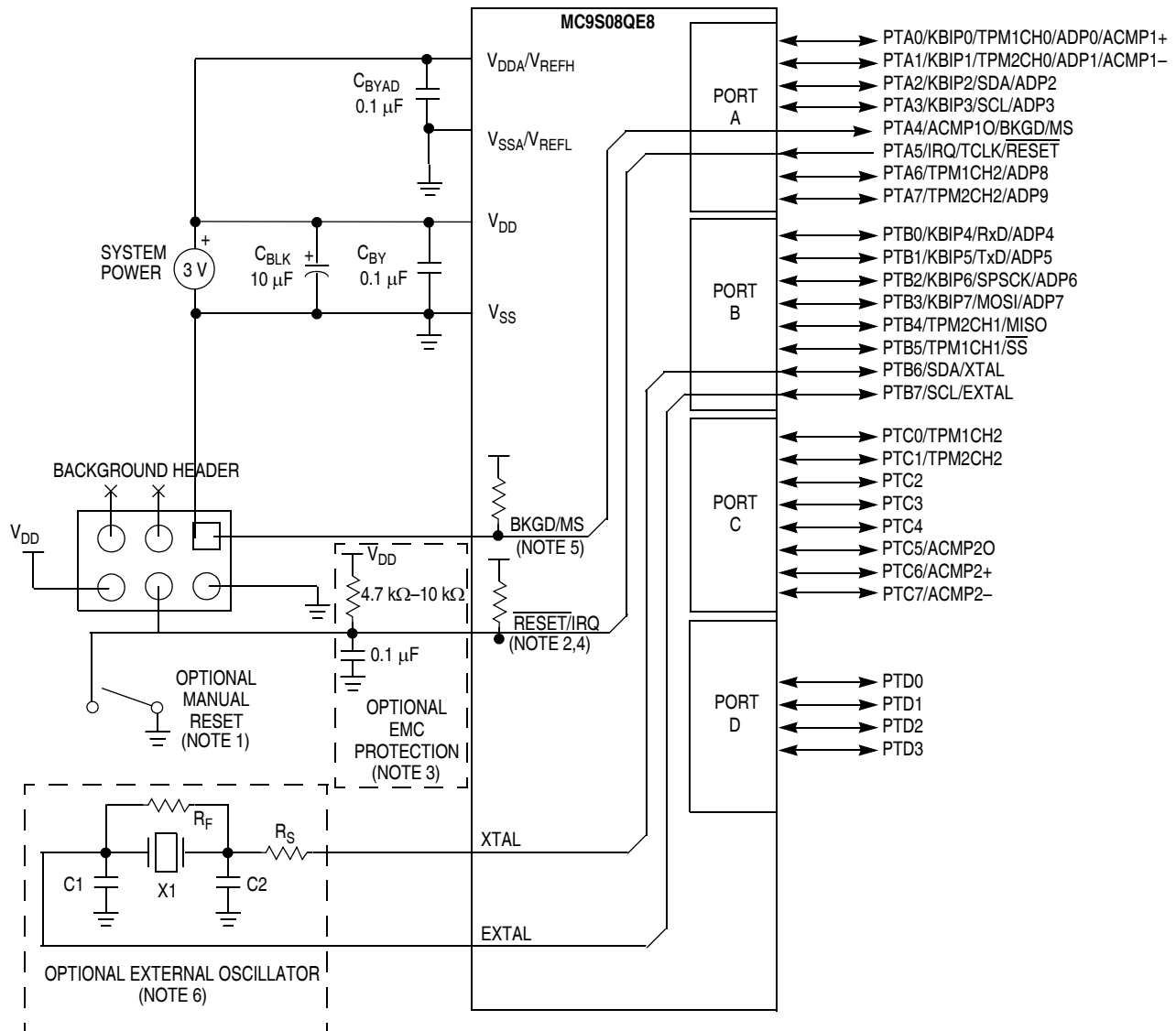


Figure 2-4. MC9S08QE8 Series in 16-Pin PDIP and TSSOP Packages

2.2 Recommended System Connections

Figure 2-5 shows pin connections that are common to MC9S08QE8 series application systems.



NOTES:

1. RESET pin can only be used to reset into user mode, you can not enter BDM using RESET pin. BDM can be entered by holding MS low during POR or writing a 1 to BDFR in SBDFFR with MS low after issuing BDM command.
2. RESET/IRQ features have optional internal pullup device.
3. RC filter on RESET/IRQ pin recommended for noisy environments.
4. When PTA5 is configured as RESET, pin becomes bi-directional with output being open-drain drive containing an internal pullup device.
5. When PTA4 is configured as BKGD, pin becomes bi-directional
6. When using the XOSCVLP module in low range and low power mode, the external components RF, RS, C1 and C2 are not required.

Figure 2-5. Basic System Connections

2.2.1 Power

V_{DD} and V_{SS} are the primary power supply pins for the MCU. This voltage source supplies power to all I/O buffer circuitry and to an internal voltage regulator. The internal voltage regulator provides a regulated lower-voltage source for the CPU and other internal circuitry of the MCU.

Typically, application systems have two separate capacitors across the power pins. In this case, there must be a bulk electrolytic capacitor, such as a 10- μ F tantalum capacitor, to provide bulk charge storage for the overall system and a 0.1- μ F ceramic bypass capacitor located as near to the MCU power pins as practical to suppress high-frequency noise.

V_{DDA} and V_{SSA} are the analog power supply pins for the MCU. This voltage source supplies power to the ADC and ACMP modules. A 0.1- μ F ceramic bypass capacitor must be located as near to the MCU power pins as practical to suppress high-frequency noise.

The V_{REFH} and V_{REFL} pins are the voltage reference high and voltage reference low inputs, respectively for the ADC module. For this MCU, V_{DDA} shares the V_{REFH} pin and these pins are available only in the 28-pin and 32-pin packages. In the 16-pin and 20-pin package they are double bonded to the V_{DD} pin. For this MCU, V_{SSA} shares the V_{REFL} pin. These pins are available only in the 28-pin and 32-pin packages. In the 16-pin and 20-pin package they are double bonded to the V_{SS} pin.

2.2.2 Oscillator

Immediately after reset, the MCU uses an internally generated clock provided by the internal clock source (ICS) module. The oscillator can be configured to run in stop2 or stop3 modes. For more information on the ICS, see [Chapter 11, “Internal Clock Source \(S08ICSV3\).”](#)

The oscillator (XOSCVLP) in this MCU is a Pierce oscillator that can accommodate a crystal or ceramic resonator. An external clock source can optionally be connected to the EXTAL input pin.

Refer to [Figure 2-5](#) for the following discussion. R_S (when used) and R_F must be low-inductance resistors such as carbon composition resistors. Wire-wound resistors and some metal film resistors have too much inductance. C1 and C2 normally must be high-quality ceramic capacitors that are specifically designed for high-frequency applications.

R_F provides a bias path to keep the EXTAL input in its linear range during crystal startup; its value is not generally critical. Typical systems use 1 M Ω to 10 M Ω . Higher values are sensitive to humidity and lower values reduce gain and (in extreme cases) could prevent startup.

C1 and C2 are typically in the 5-pF to 25-pF range and are chosen to match the requirements of a specific crystal or resonator. Be sure to consider printed circuit board (PCB) capacitance and MCU pin capacitance when selecting C1 and C2. The crystal manufacturer typically specifies a load capacitance which is the series combination of C1 and C2 (which are usually the same size). As a first-order approximation, use 10 pF as an estimate of combined pin and PCB capacitance for each oscillator pin (EXTAL and XTAL).

When using the oscillator in low range and low gain mode, the external components R_S , R_F , C1 and C2 are not required.

2.2.3 RESET Pin

After a power-on reset (POR), the PTA5/IRQ/TCLK/ $\overline{\text{RESET}}$ pin defaults to a general-purpose input port pin, PTA5. Setting RSTPE in SOPT1 configures the pin to be the $\overline{\text{RESET}}$ pin with an open-drain drive containing an internal pullup device. After configured as $\overline{\text{RESET}}$, the pin will remain in $\overline{\text{RESET}}$ until the next POR. When enabled, the $\overline{\text{RESET}}$ pin can be used to reset the MCU from an external source when the pin is driven low.

Internal power-on reset and low-voltage reset circuitry typically make external reset circuitry unnecessary. This pin is normally connected to the standard 6-pin background debug connector so a development system can directly reset the MCU system. A manual external reset can be added by supplying a simple switch to ground (pull reset pin low to force a reset).

Whenever any non-POR reset is initiated (whether from an external signal or from an internal system), the enabled $\overline{\text{RESET}}$ pin is driven low for about 34 bus cycles. The reset circuitry decodes the cause of reset and records it by setting a corresponding bit in the system reset status register (SRS).

NOTE

This pin does not contain a clamp diode to V_{DD} and must not be driven above V_{DD} .

NOTE

The voltage on the internally pulled up $\overline{\text{RESET}}$ pin when measured will be below V_{DD} . The internal gates connected to this pin are pulled to V_{DD} . If the $\overline{\text{RESET}}$ pin is required to drive to a V_{DD} level an external pullup must be used.

NOTE

In EMC-sensitive applications, an external RC filter is recommended on the $\overline{\text{RESET}}$ pin, if enabled. See [Figure 2-5](#) for an example.

2.2.4 Background / Mode Select (BKGD/MS)

During a power-on-reset (POR) or background debug force reset (see [Section 5.8.3, “System Background Debug Force Reset Register \(SBD FR\)”](#) for more information), the PTA4/ACMPO/BKGD/MS pin functions as a mode select pin. Immediately after any reset, the pin functions as the background pin and can be used for background debug communication. When enabled as the BKGD/MS pin ($\text{BKGDPE} = 1$), an internal pullup device is automatically enabled.

The background debug communication function is enabled when BKGDPE in SOPT1 is set. BKGDPE is set following any reset of the MCU and must be cleared to use the PTA4/ACMPO/BKGD/MS pin's alternative pin functions.

If nothing is connected to this pin, the MCU will enter normal operating mode at the rising edge of the internal reset after a POR, or force a background debug controller (BDC) reset. If a debug system is connected to the 6-pin standard background debug header, it can hold BKGD/MS low. It can do this during a POR or after issuing a background debug force reset. This will force the MCU to active background mode.

The BKGD/MS pin is used primarily with BDC communications, and features a custom protocol that uses 16 clock cycles of the target MCU's BDC clock per bit time. The target MCU's BDC clock can run as fast as the bus clock, so no significant capacitance must be connected to the BKGD/MS pin that could interfere with background serial communications.

Although the BKGD/MS pin is a pseudo open-drain pin, the background debug communication protocol provides brief, actively driven, high speedup pulses to ensure fast rise times. Small capacitances from

cables and the absolute value of the internal pullup device play a minimal role in determining rise and fall times on the BKGD/MS pin.

2.2.5 General-Purpose I/O (GPIO) and Peripheral Ports

The MC9S08QE8 series of MCUs support up to 26 general-purpose I/O pins, 1 input-only pin, and 1 output-only pin, which are shared with on-chip peripheral functions (timers, serial I/O, ADC, ACMP, etc.). The GPIO output-only (PTA4/ACMPO/BKGD/MS) and input-only (PTA5/IRQ/TCLK/RESET) pins are bi-directional when configured as BKGD and RESET, respectively.

When a port pin is configured as a general-purpose output or a peripheral uses the port pin as an output, software can select one of two drive strengths and enable or disable slew rate control. When a port pin is configured as a general-purpose input or a peripheral uses the port pin as an input, software can enable a pullup device.

PTA5 is a special case I/O pin. When the PTA5/IRQ/TCLK/RESET pin is configured as PTA5 input with the pullup enabled, the voltage observed on the pin will not be pulled to V_{DD} . However, the internal voltage on the PTA5 node will be at V_{DD} .

When an on-chip peripheral system is controlling a pin, data direction control bits still determine what is read from port data registers even though the peripheral module controls the pin direction by controlling the enable for the pin's output buffer. For information about controlling these pins as general-purpose I/O pins, see [Chapter 6, “Parallel Input/Output Control.”](#)

NOTE

To avoid extra current drain from floating input pins, the reset initialization routine in the application program must either enable on-chip pullup devices or change the direction of unused or non-bonded pins to outputs so they do not float.

When using the 28-pin device, the user must either enable on-chip pullup devices or change the direction of non-bonded PTD3-PTD0 pins to outputs so the pins do not float.

When using the 20-pin device, the user must either enable on-chip pullup devices or change the direction of non-bonded PTD3-PTD0, PTC7-PTC4 and PTA7-PTA6 pins to outputs so the pins do not float.

When using the 16-pin device, the user must either enable on-chip pullup devices or change the direction of non-bonded PTD3-PTD0, PTC7-PTC0 and PTA7-PTA6 pins to outputs so the pins do not float.

Table 2-1. Pin Availability by Package Pin-Count

Pin Number				<-- Lowest Priority --> Highest				
32	28	20	16	Port Pin	Alt 1	Alt 2	Alt 3	Alt 4
1	—	—	—	PTD1				
2	—	—	—	PTD0				
3	5	3	3					V_{DD}

Table 2-1. Pin Availability by Package Pin-Count (continued)

Pin Number				<-- Lowest Priority --> Highest				
32	28	20	16	Port Pin	Alt 1	Alt 2	Alt 3	Alt 4
4	6	—	—					V _{DDA} /V _{REFH}
5	7	—	—					V _{SSA} /V _{REFL}
6	8	4	4					V _{SS}
7	9	5	5	PTB7	SCL ¹			EXTAL
8	10	6	6	PTB6	SDA ¹			XTAL
9	11	7	7	PTB5	TPM1CH1	SS		
10	12	8	8	PTB4	TPM2CH1	MISO		
11	13	9	—	PTC3				
12	14	10	—	PTC2				
13	15	11	—	PTC1	TPM2CH2 ²			
14	16	12	—	PTC0	TPM1CH2 ³			
15	17	13	9	PTB3	KBIP7	MOSI	ADP7	
16	18	14	10	PTB2	KBIP6	SPSCK	ADP6	
17	19	15	11	PTB1	KBIP5	TxD	ADP5	
18	20	16	12	PTB0	KBIP4	RxD	ADP4	
19	21	—	—	PTA7	TPM2CH2 ²		ADP9	
20	22	—	—	PTA6	TPM1CH2 ³		ADP8	
21	—	—	—	PTD3				
22	—	—	—	PTD2				
23	23	17	13	PTA3	KBIP3	SCL ¹	ADP3	
24	24	18	14	PTA2	KBIP2	SDA ¹	ADP2	
25	25	19	15	PTA1	KBIP1	TPM2CH0	ADP1 ⁴	ACMP1– ⁴
26	26	20	16	PTA0	KBIP0	TPM1CH0	ADP0 ⁴	ACMP1+ ⁴
27	27	—	—	PTC7				ACMP2–
28	28	—	—	PTC6				ACMP2+
29	1	—	—	PTC5				ACMP2O
30	2	—	—	PTC4				
31	3	1	1	PTA5	IRQ	TCLK	RESET	
32	4	2	2	PTA4	ACMP1O	BKGD	MS	

¹ IIC pins, SCL and SDA can be repositioned using IICPS in SOPT2, default reset locations are PTA3 and PTA2.

² TPM2CH2 pin can be repositioned using TPM2CH2PS in SOPT2, default reset location is PTA7.

³ TPM1CH2 pin can be repositioned using TPM1CH2PS in SOPT2, default reset location is PTA6.

⁴ If ADC and ACMP1 are enabled, both modules will have access to the pin.

Chapter 3

Modes of Operation

3.1 Introduction

The operating modes of the MC9S08QE8 series are described in this chapter. Entry into each mode, exit from each mode, and functionality while in each of the modes are described.

3.2 Features

- Active background mode for code development
- Run mode — CPU clocks can be run at full speed and the internal supply is fully regulated
- LPRUN mode — CPU and peripheral clocks are restricted to 125 kHz maximum and the internal voltage regulator is in standby
- Wait mode — CPU shuts down to conserve power; system clocks are running and full regulation is maintained
- LPWAIT mode — CPU shuts down to conserve power; peripheral clocks are restricted to 125 kHz maximum and the internal voltage regulator is in standby
- Stop modes — System clocks are stopped and voltage regulator is in standby
 - Stop3 — All internal circuits are powered for fast recovery
 - Stop2 — Partial power down of internal circuits, RAM content is retained, I/O states held

3.3 Run Mode

This is the normal operating mode for the MC9S08QE8 series. In this mode, the CPU executes code from internal memory with execution beginning at the address fetched from memory at 0xFFFFE–0xFFFF after reset.

3.3.1 Low Power Run Mode (LPRun)

In the low power run mode, the on-chip voltage regulator is put into its standby state. This state uses the minimum power consumption necessary for CPU functionality. Power consumption is most reduced by disabling the clocks to all unused peripherals by clearing the corresponding bits in the SCGC1 and SCGC2 registers.

Before entering this mode, the following conditions must be met:

- FBELP is the selected clock mode for the ICS.
- The HGO bit in the ICSC2 register is clear.
- The bus frequency is less than 125 kHz.

- If enabled, the ADC must be configured to use the asynchronous clock source, ADACK, to meet the ADC minimum frequency requirements. The bandgap channel cannot be converted in low power run mode.
- The LVDE or LVDSE bit in SPMSC1 register must be clear. LVD and LVW will automatically be disabled.
- Flash programming/erasing is not allowed.
- ACMP option to compare to internal bandgap reference is not allowed in LPRUN and LPWAIT.

Once these conditions are met, low power run mode can be entered by setting the LPR bit in the SPMSC2 register.

To re-enter standard run mode, clear the LPR bit. The LPRS bit in the SPMSC2 register is a read-only status bit that can be used to determine if the regulator is in full regulation mode or not. When LPRS is '0', the regulator is in full regulation mode and the MCU can run at full speed in any clock mode.

3.3.1.1 Interrupts in Low Power Run Mode

Low power run mode provides the option to return to full regulation if any interrupt occurs. This is done by setting the LPWUI bit in the SPMSC2 register. The ICS can then be set for full speed immediately in the interrupt service routine.

If the LPWUI bit is clear, interrupts will be serviced in low power run mode.

If the LPWUI bit is set, LPR and LPRS bits will be cleared and interrupts will be serviced with the regulator in full regulation.

3.3.1.2 Resets in Low Power Run Mode

Any reset will exit low power run mode, clear the LPR and LPRS bits, and return the device to normal run mode.

3.3.1.3 BDM in Low Power Run Mode

Low power run mode cannot be entered when the MCU is in active background debug mode.

If a device is in low power run mode, a falling edge on an active BKGD/MS pin exits low power run mode, clears the LPR and LPRS bits and returns the device to normal run mode.

3.3.1.4 BDM in Low Power Wait Mode

If a device is in low power wait mode, a falling edge on an active BKGD/MS pin exits low power wait mode, clears the LPR and LPRS bits and returns the device to normal run mode.

3.4 Active Background Mode

The active background mode functions are managed through the BDC in the HCS08 core. The BDC and the on-chip debug module (DBG), provide the means for analyzing MCU operation during software development.

Active background mode is entered in any of six ways:

- When the BKGD/MS pin is low during POR
- When the BKGD/MS pin is low immediately after issuing a background debug force reset (see [Section 5.8.3, “System Background Debug Force Reset Register \(SBD FR\)”](#))
- When a BACKGROUND command is received through the BKGD/MS pin
- When a BGND instruction is executed
- When encountering a BDC breakpoint
- When encountering a DBG breakpoint

After entering active background mode, the CPU is held in a suspended state while it waits for serial background commands instead of executing instructions from the user application program.

Background commands are of two types:

- Non-intrusive commands, defined as commands that can be issued while the user program is running. Non-intrusive commands can be issued through the BKGD pin while the MCU is in run mode; non-intrusive commands can also be executed when the MCU is in the active background mode. Non-intrusive commands include:
 - Memory access commands
 - Memory-access-with-status commands
 - BDC register access commands
 - The BACKGROUND command
- Active background commands, which can only be executed while the MCU is in active background mode. Active background commands include commands to:
 - Read or write CPU registers
 - Trace one user program instruction at a time
 - Leave active background mode to return to the user application program (GO)

The active background mode is used to program a bootloader or user application program into the flash program memory before the MCU is operated in run mode for the first time. When the MC9S08QE8 series is shipped from the Freescale Semiconductor factory, the flash program memory is erased by default unless specifically noted. As a result, no program can be executed in run mode until the flash memory is initially programmed. The active background mode can also be used to erase and reprogram the flash memory after it has been previously programmed.

For additional information about the active background mode, refer to [Chapter 17, “Development Support.”](#)

3.5 Wait Mode

Wait mode is entered by executing a WAIT instruction. Upon execution of the WAIT instruction, the CPU enters a low-power state in which it is not clocked. The I bit in CCR is cleared when the CPU enters the wait mode, enabling interrupts. When an interrupt request occurs, the CPU exits the wait mode and resumes processing, beginning with the stacking operations that lead to the interrupt service routine.

While the MCU is in wait mode, background debug commands can be used on the following restrictions.

- Only the BACKGROUND command and memory-access-with-status commands are available when the MCU is in wait mode.
- The memory-access-with-status commands do not allow memory access, but they report an error indicating that the MCU is in either stop or wait mode.
- The BACKGROUND command can be used to wake the MCU from wait mode and enter active background mode.

3.5.1 Low Power Wait Mode (LPWait)

Low power wait mode is entered by executing a WAIT instruction while the MCU is in low power run mode. In the low power wait mode, the on-chip voltage regulator remains in its standby state (as in the low power run mode). This state uses the minimum power consumption necessary for most modules to maintain functionality. Power consumption is most reduced by disabling the clocks to all unused peripherals by clearing the corresponding bits in the SCGC register.

The same restrictions on the low power run mode apply to low power wait mode.

3.5.1.1 Interrupts in Low Power Wait Mode

If the LPWUI bit is set when the WAIT instruction is executed, then the voltage regulator will return to full regulation when wait mode is exited. The ICS can be set for full speed immediately in the interrupt service routine.

If the LPWUI bit is clear when the WAIT instruction is executed, an interrupt will return the device to low power run mode.

If the LPWUI bit is set when the WAIT instruction is executed, an interrupt will return the device to normal run mode with full regulation and the LPR and LPRS bits will be cleared.

3.5.1.2 Resets in Low Power Wait Mode

Any reset will exit low power wait mode, clear the LPR and LPRS bits, and return the device to normal run mode.

3.6 Stop Modes

One of two stop modes (stop2 or stop3) is entered upon execution of a STOP instruction when the STOPE bit in the system option 1 register (SOPT1) is set. In both stop modes, the bus and CPU clocks are halted. In stop3 the voltage regulator is in standby. In stop2 the voltage regulator is in partial powerdown. The ICS module can be configured to leave the reference clocks running. See [Chapter 11, “Internal Clock Source \(S08ICSV3\)”](#) for more information.

If the STOPE bit is not set when the CPU executes a STOP instruction, the MCU will not enter either stop mode and an illegal opcode reset is forced. The stop modes are selected by setting the appropriate bits in the system power management status and control 2 register (SPMSC2).

Table 3-1 shows all of the control bits that affect stop mode selection and the mode selected under various conditions. The selected mode is entered following the execution of a STOP instruction.

Table 3-1. Stop Mode Selection

Register	SOPT1	BDCSCR	SPMSC1		SPMSC2	Stop Mode
Bit name	STOPE	ENBDM ¹	LVDE	LVDSE	PPDC	
	0	x	x		x	Stop modes disabled; illegal opcode reset if STOP instruction executed
	1	1	x		x	Stop3 with BDM enabled ²
	1	0	Both bits must be 1		x	Stop3 with voltage regulator active
	1	0	Either bit a 0		0	Stop3
	1	0	Either bit a 0		1	Stop2

¹ ENBDM is located in the BDCSCR which is only accessible through BDC commands, see [Chapter 17, “Development Support.”](#)

² When in Stop3 mode with BDM enabled, The S_{IDD} will be near R_{IDD} levels because internal clocks are enabled.

3.6.1 Stop2 Mode

Stop2 mode is entered by executing a STOP instruction under the conditions as shown in [Table 3-1](#). Most of the internal circuitry of the MCU is powered off in stop2 with the exception of the RAM and optionally the RTC and low power oscillator. Upon entering stop2, all I/O pin control signals are latched so that the pins retain their states during stop2.

Exit from stop2 is performed by asserting the wake-up pin (PTA5/IRQ/TCLK/ $\overline{\text{RESET}}$) on the MCU.

NOTE

PTA5/IRQ/TCLK/ $\overline{\text{RESET}}$ is an active low wake-up and must be configured as an input prior to executing a STOP instruction to avoid an immediate exit from stop 2. PTA5/IRQ/TCLK/ $\overline{\text{RESET}}$ can be disabled as a wake-up if it is configured as a high driven output. For lowest power consumption in stop 2, this pin must not be left open if configured as input (enable the internal pullup or tie an external pullup device or set pin as output).

In addition, the real-time counter (RTC) can wake the MCU from stop2, if enabled.

Upon wake-up from stop2 mode, the MCU starts up as from a power-on reset (POR):

- All module control and status registers are reset, except for SPMSC1-SPMSC3, RTCSC, RTCCNT and RTCMOD.
- The LVD reset function is enabled and the MCU remains in the reset state if V_{DD} is below the LVD trip point
- The CPU takes the reset vector

In addition to the above, upon waking up from stop2, the PPDF bit in SPMSC2 is set. This flag is used to direct user code to go to a stop2 recovery routine. PPDF remains set and the I/O pin states remain latched until a 1 is written to PPDACK in SPMSC2.

If using the low power oscillator during stop2, the user must reconfigure the ICSC2 register which contains oscillator control bits before PPDACK is written.

To maintain I/O states for pins that were configured as GPIO before entering stop2, the user must restore the contents of the I/O port registers, which have been saved in RAM, to the port registers before writing to the PPDACK bit. If the port registers are not restored from RAM before writing to PPDACK, then the pins will switch to their reset states when PPDACK is written.

For pins that were configured as peripheral I/O, the user must reconfigure the peripheral module that interfaces to the pin before writing to the PPDACK bit. If the peripheral module is not enabled before writing to PPDACK, the pins will be controlled by their associated port control registers when the I/O latches are opened.

3.6.2 Stop3 Mode

Stop3 mode is entered by executing a STOP instruction under the conditions shown in [Table 3-1](#). The states of all of the internal registers and logic, RAM contents, and I/O pin states are maintained.

Stop3 can be exited by asserting $\overline{\text{RESET}}$, or by an interrupt from one of the following sources: the RTC, LVD, LVW, ADC, ACMPx, IRQ, SCI or the KBI.

If stop3 is exited by means of the $\overline{\text{RESET}}$ pin, then the MCU is reset and operation will resume after taking the reset vector. Exit by means of one of the internal interrupt sources results in the MCU taking the appropriate interrupt vector.

3.6.3 Active BDM Enabled in Stop Mode

Entry into the active background mode from run mode is enabled if the ENBDM bit in BDCSCR is set. This register is described in [Chapter 17, “Development Support.”](#) If ENBDM is set when the CPU executes a STOP instruction, the system clocks to the background debug logic remain active when the MCU enters stop mode. Because of this, background debug communication remains possible. In addition, the voltage regulator does not enter its low-power standby state but maintains full internal regulation. If the user attempts to enter stop2 with ENBDM set, the MCU will instead enter stop3.

Most background commands are not available in stop mode. The memory-access-with-status commands do not allow memory access, but they report an error indicating that the MCU is in stop or wait mode. The BACKGROUND command can be used to wake the MCU from stop and enter active background mode if the ENBDM bit is set. After entering background debug mode, all background commands are available.

3.6.4 LVD Enabled in Stop Mode

The LVD system is capable of generating an interrupt or a reset when the supply voltage drops below the LVD voltage. If the LVD is enabled in stop (LVDE and LVDSE bits in SPMSC1 both set) the voltage

regulator remains active during stop mode. If the user attempts to enter stop2 with the LVD enabled for stop, the MCU will instead enter stop3.

3.6.5 Stop Modes in Low Power Run Mode

Stop2 mode cannot be entered from low power run mode. If the PPDC bit is set, then the LPR bit cannot be set. Likewise, if the LPR bit is set, the PPDC bit cannot be set.

Stop3 mode can be entered from low power run mode by executing the STOP instruction while in low power run. Exiting stop3 with a reset will put the device back into normal run mode. If LPWUI is clear, interrupts will exit stop3 mode, return the device to low power run mode, and then service the interrupt. If LPWUI is set, interrupts will exit stop3 mode, put the device into normal run mode, clear LPR and LPRS bits, and then service the interrupt.

3.7 Mode Selection

Several control signals are used to determine the current operating mode of the device. [Table 3-2](#) shows the conditions for each of the device's operating modes.

Table 3-2. Power Mode Selections

Mode of Operation	BDCSCR BDM	SPMSC1 PMC		SPMSC2 PMC		CPU & Periph CLKs	Affects on Sub-System	
	ENBDM ¹	LVDE	LVDSE	LPR	PPDC		BDM Clock	Voltage Regulator
RUN mode	0	x	x	0	x	on. ICS in any mode.	off	on
		1	1	1				
	1	x	x	x			on	
LPRUN mode	0	0	x	1	0	low freq required. ICS in FBELP mode only.	off	standby
		1	0					
WAIT mode - (Assumes WAIT instruction executed.)	0	x	x	0	x	CPU clock is off; peripheral clocks on. ICS state same as RUN mode.	off	on
		1	1	1				
	1	x	x	x			on	
LPWAIT mode - (Assumes WAIT instruction executed.)	0	0	x	1	0	CPU clock is off; peripheral clocks at low speed. ICS in FBELP mode.	off	standby
		1	0					
STOP3 - (Assumes STOPE bit is set and STOP instruction executed.) Note that STOP3 is used in place of STOP2 if the BDM or LVD is enabled.	0	0	x	x	0	ICS in STOP. ICSECLK, ICSIRCLK, and OSCOUT optionally on ²	off	standby
	0	1	0	x	0		off	
	0	1	1	x	x		off	
	1	x	x	x	x	ICSLCLK still active.	on	on – stop currents will be increased
STOP2 - (Assumes STOPE bit is set and STOP instruction executed.) If BDM or LVD is enabled, STOP3 will be invoked rather than STOP2.	0	0	x	0	1	OSCOUT optionally on ^{2,3}	off	partial powerdown
		1	0					

¹ ENBDM is located in the BDC status and control register (BDCSCR) which is write accessible only through BDC commands.

² Configured within the ICS module based on the settings of IREFSTEN, EFRESTEN, IRCLKEN and ERCLKEN.

³ In stop2, CPU, flash, ICS and all peripheral modules are powered down except for the RTC.

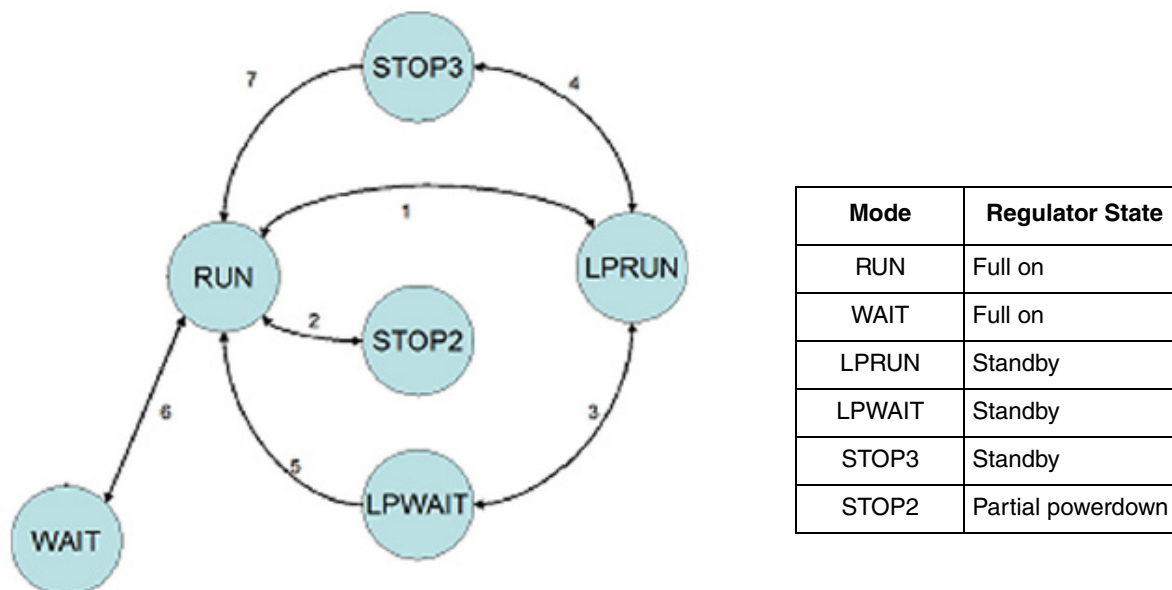


Figure 3-1. Allowable Power Mode Transitions for the MC9S08QE8 Series

Figure 3-1 illustrates mode state transitions allowed between the legal states shown in Table 3-1. $\overline{PTA5}/\overline{IRQ}/\overline{TCLK}/\overline{RESET}$ must be asserted low in order to exit STOP2. Interrupts suffice for the other STOP and WAIT modes.

Table 3-3 defines triggers for the various state transitions shown in Figure 3-1.

Table 3-3. Triggers for Transitions Shown in Figure 3-1.

Transition #	From	To	Trigger
1	RUN	LPRUN	Configure settings shown in Table 3-1, switch LPR=1 last
	LPRUN	RUN	Clear LPR Interrupt when LPWUI=1
2	RUN	STOP2	Pre-configure settings shown in Table 3-1, issue STOP instruction
	STOP2	RUN	assert zero on $\overline{PTA5}/\overline{IRQ}/\overline{TCLK}/\overline{RESET}$¹ , reload environment from RAM
3	LPRUN	LPWAIT	WAIT instruction
	LPWAIT	LPRUN	Interrupt when LPWUI=0
4	LPRUN	STOP3	STOP instruction
	STOP3	LPRUN	Interrupt when LPWUI=0
5	LPWAIT	RUN	Interrupt when LPWUI=1
	RUN	LPWAIT	NOT SUPPORTED
6	RUN	WAIT	WAIT instruction
	WAIT	RUN	Interrupt or reset

Table 3-3. Triggers for Transitions Shown in Figure 3-1. (continued)

Transition #	From	To	Trigger
7	STOP3	RUN	Interrupt (if LPR = 0, or LPR = 1 and LPWUI = 1) or reset
	RUN	STOP3	STOP instruction

¹ An analog connection from this pin to the on-chip regulator will wake up the regulator, which will then initiate a power-on-reset sequence.

3.7.1 On-Chip Peripheral Modules in Stop and Low Power Modes

When the MCU enters any stop mode, system clocks to the internal peripheral modules are stopped. Even in the exception case (ENBDM = 1), where clocks to the background debug logic continue to operate, clocks to the peripheral systems are halted to reduce power consumption. Refer to [Section 3.6.1, “Stop2 Mode,”](#) and [Section 3.6.2, “Stop3 Mode,”](#) for specific information on system behavior in stop modes.

When the MCU enters LPWait or LPRun modes, system clocks to the internal peripheral modules continue based on the settings of the clock gating control registers (SCGC1 and SCGC2).

Table 3-4. Stop and Low Power Mode Behavior

Peripheral	Mode			
	Stop2	Stop3	LPWait	LPRun
CPU	Off	Standby	Standby	On
RAM	Standby	Standby	Standby	On
Flash	Off	Standby	Standby	On
Port I/O Registers	Off	Standby	Standby	On
ADC	Off	Optionally On ¹	Optionally On ¹	Optionally On ¹
ACMPx	Off	Optionally On ²	Optionally On	Optionally On
BDM	Off ³	Optionally On	Off ⁴	Off ⁴
COP	Off	Off	Optionally On	Optionally On
ICS	Off	Optionally On ⁵	On ⁶	On ⁶
IIC	Off	Standby	Optionally On	Optionally On
IRQ	Wake Up	Optionally On	Optionally On	Optionally On
KBI	Off	Optionally On	Optionally On	Optionally On
LVD/LVW	Off ⁷	Optionally On	Off ⁸	Off ⁸
RTC	Optionally On	Optionally On	Optionally On	Optionally On
SCI	Off	Standby	Optionally On	Optionally On
SPI	Off	Standby	Optionally On	Optionally On
TPMx	Off	Standby	Optionally On	Optionally On
Voltage Regulator	Partial Powerdown	Optionally On ⁹	Standby	Standby
XOSCVLP	Optionally On ¹⁰	Optionally On ¹⁰	Optionally On	Optionally On
I/O Pins	States Held	Peripheral Control	Peripheral Control	On

¹ Requires the asynchronous ADC clock. For stop3, LVD must be enabled to run in stop if converting the bandgap channel.

² LVD must be enabled to run in stop if using the bandgap as a reference.

- ³ If ENBDM is set when entering stop2, the MCU will actually enter stop3.
- ⁴ If ENBDM is set when entering LPRun or LPWait, the MCU will actually stay in run mode or enter wait mode, respectively.
- ⁵ IRCLKEN and IREFSTEN set in ICSC1, else in standby.
- ⁶ ICS must be configured for FBELP, bus frequency limited to 125 kHz in LPRUN or LPWAIT.
- ⁷ If LVDSE is set when entering stop2, the MCU will actually enter stop3.
- ⁸ If LVDSE is set when entering LPRun or LPWait, the MCU will actually enter run or wait mode, respectively.
- ⁹ Requires the LVD to be enabled, else in standby. See [Section 3.6.4, “LVD Enabled in Stop Mode.”](#)
- ¹⁰ ERCLKEN and EREFSTEN set in ICSC2, else in standby.

Chapter 4

Memory

4.1 MC9S08QE8 Series Memory Map

As shown in [Figure 4-1](#), on-chip memory in the MC9S08QE8 series of MCUs consists of RAM, flash program memory for nonvolatile data storage, and I/O and control/status registers. The registers are divided into three groups:

- Direct-page registers (0x0000 through 0x005F)
- High-page registers (0x1800 through 0x184F)
- Nonvolatile registers (0xFFB0 through 0xFFBF)

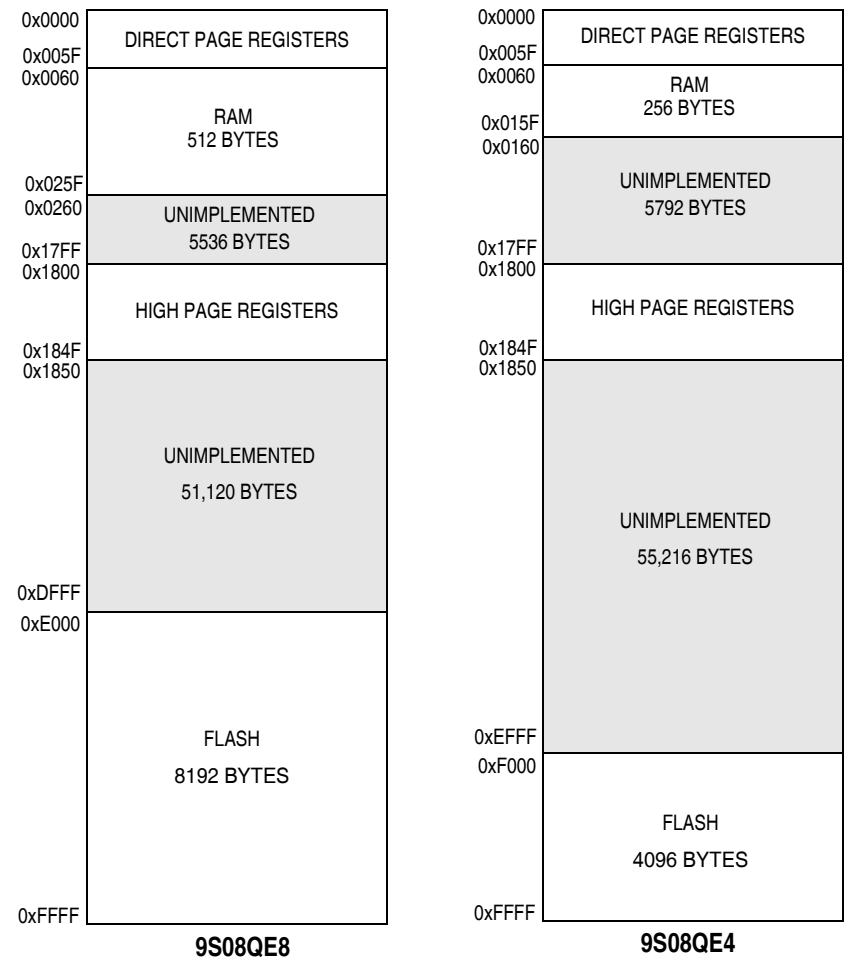


Figure 4-1. MC9S08QE8 Series Memory Maps

4.2 Reset and Interrupt Vector Assignments

Table 4-1 shows address assignments for reset and interrupt vectors. The vector names shown in this table are the labels used in the Freescale Semiconductor provided equate file for the MC9S08QE8 series.

Table 4-1. Reset and Interrupt Vectors

Address (High/Low)	Vector	Vector Name
0xFFC0:FFC1 ↕ 0xFFCC:FFCD	Unused Vector Space (available for user program)	
0xFFCE:0xFFCF	RTC	Vrtc
0xFFD0:0xFFD1	Reserved	—
0xFFD2:0xFFD3	Reserved	—
0xFFD4:0xFFD5	Reserved	—
0xFFD6:0xFFD7	ACMPx ¹	Vacmpx
0xFFD8:0xFFD9	ADC Conversion	Vadc
0xFFDA:0xFFDB	KBI Interrupt	Vkeyboard
0xFFDC:0xFFDD	IIC	Viic
0xFFDE:0xFFDF	SCI Transmit	Vscitx
0xFFE0:0xFFE1	SCI Receive	Vscirx
0xFFE2:0xFFE3	SCI Error	Vscierr
0xFFE4:0xFFE5	SPI	Vspi
0xFFE6:0xFFE7	Reserved	—
0xFFE8:0xFFE9	TPM2 Overflow	Vtpm2ovf
0xFFEA:0xFFEB	TPM2 Channel 2	Vtpm2ch2
0xFFEC:0xFFED	TPM2 Channel 1	Vtpm2ch1
0xFFEE:0xFFEF	TPM2 Channel 0	Vtpm2ch0
0xFFFF0:0xFFFF1	TPM1 Overflow	Vtpm1ovf
0xFFFF2:0xFFFF3	TPM1 Channel 2	Vtpm1ch2
0xFFFF4:0xFFFF5	TPM1 Channel 1	Vtpm1ch1
0xFFFF6:0xFFFF7	TPM1 Channel 0	Vtpm1ch0
0xFFFF8:0xFFFF9	Low Voltage Detect or Low Voltage Warning	Vlvd
0xFFFFA:0xFFFFB	IRQ	Virq
0xFFFFC:0xFFFFD	SWI	Vswi
0xFFFFE:0xFFFFF	Reset	Vreset

¹ ACMP1 and ACMP2 share this vector, if both modules are enabled user must poll each flag to determine pending interrupt.

4.3 Register Addresses and Bit Assignments

The registers in the MC9S08QE8 series are divided into these groups:

- Direct-page registers are the ones located in the first 256 locations in the memory map; these are accessible with efficient direct addressing mode instructions.
- High-page registers are used much less often, so they are located above 0x1800 in the memory map. This leaves more room in the direct page for more frequently used registers and RAM.
- The nonvolatile register area consists of a block of 16 locations in flash memory at 0xFFB0–0xFFBF. Nonvolatile register locations include:
 - NVPROT and NVOPT are loaded into working registers at reset
 - An 8-byte backdoor comparison key that optionally allows a user to gain controlled access to secure memory

Because the nonvolatile register locations are flash memory, they must be erased and programmed like other flash memory locations.

Direct-page registers can be accessed with efficient direct addressing mode instructions. Bit manipulation instructions can be used to access any bit in any direct-page register. [Table 4-2](#) is a summary of all user-accessible direct-page registers and control bits.

The direct page registers in [Table 4-2](#) can use the more efficient direct addressing mode, which requires only the lower byte of the address. Because of this, the lower byte of the address in column one is shown in bold text. In [Table 4-3](#) and [Table 4-4](#), the whole address in column one is shown in bold. In [Table 4-2](#), [Table 4-3](#), and [Table 4-4](#), the register names in column two are shown in bold to set them apart from the bit names to the right. Cells that are not associated with named bits are shaded. A shaded cell with a 0 indicates this unused bit always reads as a 0. Shaded cells with dashes indicate unused or reserved bit locations that could read as 1s or 0s. When writing to these bits, write a 0 unless otherwise specified.

Table 4-2. Direct-Page Register Summary (Sheet 1 of 3)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x0000	PTAD	PTAD7	PTAD6	PTAD5	PTAD4	PTAD3	PTAD2	PTAD1	PTAD0
0x0001	PTADD	PTADD7	PTADD6	PTADD5	PTADD4	PTADD3	PTADD2	PTADD1	PTADD0
0x0002	PTBD	PTBD7	PTBD6	PTBD5	PTBD4	PTBD3	PTBD2	PTBD1	PTBD0
0x0003	PTBDD	PTBDD7	PTBDD6	PTBDD5	PTBDD4	PTBDD3	PTBDD2	PTBDD1	PTBDD0
0x0004	PTCD	PTCD7	PTCD6	PTCD5	PTCD4	PTCD3	PTCD2	PTCD1	PTCD0
0x0005	PTCDD	PTCDD7	PTCDD6	PTCDD5	PTCDD4	PTCDD3	PTCDD2	PTCDD1	PTCDD0
0x0006	PTDD	0	0	0	0	PTDD3	PTDD2	PTDD1	PTDD0
0x0007	PTDDD	0	0	0	0	PTDDD3	PTDDD2	PTDDD1	PTDDD0
0x0008 – 0x000B	Reserved	—	—	—	—	—	—	—	—
0x000C	KBISC	0	0	0	0	KBF	KBACK	KBIE	KBIMOD
0x000D	KBIPE	KBIPE7	KBIPE6	KBIPE5	KBIPE4	KBIPE3	KBIPE2	KBIPE1	KBIPE0
0x000E	KBIES	KBEDG7	KBEDG6	KBEDG5	KBEDG4	KB1EDG3	KB1EDG2	KB1EDG1	KB1EDG0
0x000F	IRQSC	0	IRQPDD	IRQEDG	IRQPE	IRQF	IRQACK	IRQIE	IRQMOD
0x0010	ADCSC1	COCO	AIEN	ADCO	ADCH				
0x0011	ADCSC2	ADACT	ADTRG	ACFE	ACFGT	0	0	—	—
0x0012	ADCRH	0	0	0	0	ADR11	ADR10	ADR9	ADR8
0x0013	ADCRL	ADR7	ADR6	ADR5	ADR4	ADR3	ADR2	ADR1	ADR0
0x0014	ADCCVH	0	0	0	0	ADCV11	ADCV10	ADCV9	ADCV8
0x0015	ADCCVL	ADCV7	ADCV6	ADCV5	ADCV4	ADCV3	ADCV2	ADCV1	ADCV0
0x0016	ADCCFG	ADLPC	ADIV		ADLSMP	MODE		ADICLK	
0x0017	APCTL1	ADPC7	ADPC6	ADPC5	ADPC4	ADPC3	ADPC2	ADPC1	ADPC0
0x0018	APCTL2	—	—	—	—	—	—	ADPC9	ADPC8
0x0019	Reserved	—	—	—	—	—	—	—	—
0x001A	ACMP1SC	ACME	ACBGS	ACF	ACIE	ACO	ACOPE	ACMOD1	ACMOD0
0x001B	ACMP2SC	ACME	ACBGS	ACF	ACIE	ACO	ACOPE	ACMOD1	ACMOD0
0x001C – 0x001F	Reserved	—	—	—	—	—	—	—	—
0x0020	SCIBDH	LBKDIE	RXEDGIE	0	SBR12	SBR11	SBR10	SBR9	SBR8
0x0021	SCIBDL	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
0x0022	SCIC1	LOOPS	SCISWAI	RSRC	M	WAKE	ILT	PE	PT
0x0023	SCIC2	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
0x0024	SCIS1	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
0x0025	SCIS2	LBKDIF	RXEDGIF	0	RXINV	RWUID	BRK13	LBKDE	RAF
0x0026	SCIC3	R8	T8	TXDIR	TXINV	ORIE	NEIE	FEIE	PEIE
0x0027	SCID	Bit 7	6	5	4	3	2	1	Bit 0
0x0028	SPIC1	SPIE	SPE	SPTIE	MSTR	CPOL	CPHA	SSOE	LSBFE
0x0029	SPIC2	0	0	0	MODFEN	BIDIROE	0	SPISWAI	SPC0
0x002A	SPIBR	0	SPPR2	SPPR1	SPPR0	0	SPR2	SPR1	SPR0

Table 4-2. Direct-Page Register Summary (Sheet 2 of 3)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x002B	SPIS	SPRF	0	SPTEF	MODF	0	0	0	0
0x002C	Reserved	0	0	0	0	0	0	0	0
0x002D	SPID	Bit 7	6	5	4	3	2	1	Bit 0
0x002E – 0x002F	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x0030	IICA	AD7	AD6	AD5	AD4	AD3	AD2	AD1	0
0x0031	IICF	MULT		ICR					
0x0032	IICC1	IICEN	IICIE	MST	TX	TXAK	RSTA	0	0
0x0033	IICS	TCF	IAAS	BUSY	ARBL	0	SRW	IICIF	RXAK
0x0034	IICD	DATA							
0x0035	IICC2	GCAEN	ADEXT	0	0	0	AD10	AD9	AD8
0x0036 – 0x0037	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x0038	ICSC1	CLKS		RDIV			IREFS	IRCLKEN	IREFSTEN
0x0039	ICSC2	BDIV		RANGE	HGO	LP	EREFS	ERCLKEN	EREFSTEN
0x003A	ICSTRM	TRIM							
0x003B	ICSSC	DRST		DMX32	IREFST	CLKST		OSCINIT	FTRIM
0x003C – 0x003F	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x0040	TPM1SC	TOF	TOIE	CPWMS	CLKSB	CLKSA	PS2	PS1	PS0
0x0041	TPM1CNTH	Bit 15	14	13	12	11	10	9	Bit 8
0x0042	TPM1CNTL	Bit 7	6	5	4	3	2	1	Bit 0
0x0043	TPM1MODH	Bit 15	14	13	12	11	10	9	Bit 8
0x0044	TPM1MODL	Bit 7	6	5	4	3	2	1	Bit 0
0x0045	TPM1C0SC	CH0F	CH0IE	MS0B	MS0A	ELS0B	ELS0A	0	0
0x0046	TPM1C0VH	Bit 15	14	13	12	11	10	9	Bit 8
0x0047	TPM1C0VL	Bit 7	6	5	4	3	2	1	Bit 0
0x0048	TPM1C1SC	CH1F	CH1IE	MS1B	MS1A	ELS1B	ELS1A	0	0
0x0049	TPM1C1VH	Bit 15	14	13	12	11	10	9	Bit 8
0x004A	TPM1C1VL	Bit 7	6	5	4	3	2	1	Bit 0
0x004B	TPM1C2SC	CH2F	CH2IE	MS2B	MS2A	ELS2B	ELS2A	0	0
0x004C	TPM1C2VH	Bit 15	14	13	12	11	10	9	Bit 8
0x004D	TPM1C2VL	Bit 7	6	5	4	3	2	1	Bit 0
0x004E – 0x004F	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x0050	TPM2SC	TOF	TOIE	CPWMS	CLKSB	CLKSA	PS2	PS1	PS0
0x0051	TPM2CNTH	Bit 15	14	13	12	11	10	9	Bit 8
0x0052	TPM2CNTL	Bit 7	6	5	4	3	2	1	Bit 0
0x0053	TPM2MODH	Bit 15	14	13	12	11	10	9	Bit 8
0x0054	TPM2MODL	Bit 7	6	5	4	3	2	1	Bit 0

Table 4-2. Direct-Page Register Summary (Sheet 3 of 3)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x0055	TPM2C0SC	CH0F	CH0IE	MS0B	MS0A	ELS0B	ELS0A	0	0
0x0056	TPM2C0VH	Bit 15	14	13	12	11	10	9	Bit 8
0x0057	TPM2C0VL	Bit 7	6	5	4	3	2	1	Bit 0
0x0058	TPM2C1SC	CH1F	CH1IE	MS1B	MS1A	ELS1B	ELS1A	0	0
0x0059	TPM2C1VH	Bit 15	14	13	12	11	10	9	Bit 8
0x005A	TPM2C1VL	Bit 7	6	5	4	3	2	1	Bit 0
0x005B	TPM2C2SC	CH2F	CH2IE	MS2B	MS2A	ELS2B	ELS2A	0	0
0x005C	TPM2C2VH	Bit 15	14	13	12	11	10	9	Bit 8
0x005D	TPM2C2VL	Bit 7	6	5	4	3	2	1	Bit 0
0x005E – 0x005F	Reserved	—	—	—	—	—	—	—	—

High-page registers, shown in [Table 4-3](#), are accessed much less often than other I/O and control registers so they have been located outside the direct addressable memory space, starting at 0x1800.

Table 4-3. High-Page Register Summary (Sheet 1 of 2)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x1800	SRS	POR	PIN	COP	ILOP	ILAD	0	LVD	0
0x1801	SBD FR	0	0	0	0	0	0	0	BDFR
0x1802	SOPT1	COPE	COPT	STOPE	0	0	0	BKGDPE	RSTPE
0x1803	SOPT2	COPCLKS	0	TPM2CH2PS	TPM1CH2PS	0	ACIC2	IICPS	ACIC1
0x1804 – 0x1805	Reserved	—	—	—	—	—	—	—	—
0x1806	SDIDH	—	—	—	—	ID11	ID10	ID9	ID8
0x1807	SDIDL	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
0x1808	SPMSC1	LVDF	LVDACK	LVDIE	LVDRE	LVDSE	LVDE	0	BGBE
0x1809	SPMSC2	LPR	LPRS	LPWUI	0	PPDF	PPDACK	PPDE	PPDC
0x180A	Reserved	—	—	—	—	—	—	—	—
0x180B	SPMSC3	LVWF	LVWACK	—	—	LVWIE	0	0	0
0x180C	Reserved	—	—	—	—	—	—	—	—
0x180D	Reserved	—	—	—	—	—	—	—	—
0x180E	SCGC1	1	TPM2	TPM1	ADC	1	IIC	1	SCI
0x180F	SCGC2	DBG	FLS	IRQ	KBI	ACMP	RTC	1	SPI
0x1810	DBGCAH	Bit 15	14	13	12	11	10	9	Bit 8
0x1811	DBGCAL	Bit 7	6	5	4	3	2	1	Bit 0
0x1812	DBGCBH	Bit 15	14	13	12	11	10	9	Bit 8
0x1813	DBGCBL	Bit 7	6	5	4	3	2	1	Bit 0
0x1814	DBGCCH	Bit 15	14	13	12	11	10	9	Bit 8
0x1815	DBGCCL	Bit 7	6	5	4	3	2	1	Bit 0
0x1816	DBGFH	Bit 15	14	13	12	11	10	9	Bit 8

Table 4-3. High-Page Register Summary (Sheet 2 of 2)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x1817	DBGFL	Bit 7	6	5	4	3	2	1	Bit 0
0x1818	DBGCAx	RWAEN	RWA	0	0	0	0	0	0
0x1819	DBGCBx	RWBEN	RWB	0	0	0	0	0	0
0x181A	DBGCCx	RWCEN	RWC	0	0	0	0	0	0
0x181B	Reserved	—	—	—	—	—	—	—	—
0x181C	DBGc	DBGEN	ARM	TAG	BRKEN	0	0	0	LOOP1
0x181D	DBGt	TRGSEL	BEGIN	0	0	TRG			
0x181E	DBGs	AF	BF	CF	0	0	0	0	ARMF
0x181F	DBGcNT	0	0	0	0	CNT			
0x1820	FCDIV	DIVLD	PRDIV8	DIV					
0x1821	FOPT	KEYEN	FNORED	0	0	0	0	SEC01	SEC00
0x1822	Reserved	—	—	—	—	—	—	—	—
0x1823	FCNFG	0	0	KEYACC	0	0	0	0	0
0x1824	FPROT	FPS							FPDIS
0x1825	FSTAT	FCBEF	FCCF	FPVIOL	FACCERR	0	FBLANK	0	0
0x1826	FCMD	FCMD							
0x1827 – 0x182F	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x1830	RTCSC	RTIF	RTCLKS		RTIE	RTCPS			
0x1831	RTCCNT	RTCCNT							
0x1832	RTCMOD	RTCMOD							
0x1833 – 0x183F	Reserved	— —	— —	— —	— —	— —	— —	— —	— —
0x1840	PTAPE	PTAPE7	PTAPE6	PTAPE5	PTAPE4	PTAPE3	PTAPE2	PTAPE1	PTAPE0
0x1841	PTASE	PTASE7	PTASE6	PTASE5	PTASE4	PTASE3	PTASE2	PTASE1	PTASE0
0x1842	PTADS	PTADS7	PTADS6	PTADS5	PTADS4	PTADS3	PTADS2	PTADS1	PTADS0
0x1843	Reserved	—	—	—	—	—	—	—	—
0x1844	PTBPE	PTBPE7	PTBPE6	PTBPE5	PTBPE4	PTBPE3	PTBPE2	PTBPE1	PTBPE0
0x1845	PTBSE	PTBSE7	PTBSE6	PTBSE5	PTBSE4	PTBSE3	PTBSE2	PTBSE1	PTBSE0
0x1846	PTBDS	PTBDS7	PTBDS6	PTBDS5	PTBDS4	PTBDS3	PTBDS2	PTBDS1	PTBDS0
0x1847	Reserved	—	—	—	—	—	—	—	—
0x1848	PTCPE	PTCPE7	PTCPE6	PTCPE5	PTCPE4	PTCPE3	PTCPE2	PTCPE1	PTCPE0
0x1849	PTCSE	PTCSE7	PTCSE6	PTCSE5	PTCSE4	PTCSE3	PTCSE2	PTCSE1	PTCSE0
0x184A	PTCDS	PTCDS7	PTCDS6	PTCDS5	PTCDS4	PTCDS3	PTCDS2	PTCDS1	PTCDS0
0x184B	Reserved	—	—	—	—	—	—	—	—
0x184C	PTDPE	0	0	0	0	PTDPE3	PTDPE2	PTDPE1	PTDPE0
0x184D	PTDSE	0	0	0	0	PTDSE3	PTDSE2	PTDSE1	PTDSE0
0x184E	PTDDS	0	0	0	0	PTDDS3	PTDDS2	PTDDS1	PTDDS0
0x184F	Reserved	—	—	—	—	—	—	—	—

Several reserved flash memory locations, shown in Table 4-4, are used for storing values used by several registers. These registers include an 8-byte backdoor key, NVBACKKEY, which can be used to gain access to secure memory resources. During reset events, the contents of NVPROT and NVOPT in the reserved flash memory are transferred into corresponding FPROT and FOPT registers in the high-page registers area to control security and block protection options.

The factory ICS trim value is stored in the flash information row (IFR¹) and will be loaded into the ICSTRM and ICSSC registers after any reset. The internal reference trim values stored in flash, TRIM and FTRIM, can be programmed by third party programmers and must be copied into the corresponding ICS registers by user code to override the factory trim.

Table 4-4. Reserved Flash Memory Addresses

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0xFFAE	Reserved for Storage of FTRIM	0	0	0	0	0	0	0	FTRIM
0xFFAF	Reserved for Storage of ICSTRM	TRIM							
0xFFB0 – 0xFFB7	NVBACKKEY	8-Byte Comparison Key							
0xFFB8 – 0xFFBC	Reserved	—	—	—	—	—	—	—	—
0xFFBD	NVPROT	FPS							FPDIS
0xFFBE	Reserved	—	—	—	—	—	—	—	—
0xFFBF	NVOPT	KEYEN	FNORED	0	0	0	0	SEC	

Provided the key enable (KEYEN) bit is 1, the 8-byte comparison key can be used to temporarily disengage memory security. This key mechanism can be accessed only through user code running in secure memory. (A security key cannot be entered directly through background debug commands.) This security key can be disabled completely by programming the KEYEN bit to 0. If the security key is disabled, the only way to disengage security is by mass erasing the flash if needed (normally through the background debug interface) and verifying that flash is blank. To avoid returning to secure mode after the next reset, program the security bits (SEC) to the unsecured state (1:0).

1. IFR — Nonvolatile information memory that can be accessed only during production test. During production test, system initialization, configuration and test information are stored in the IFR. This information cannot be read or modified in normal user or background debug modes.

4.4 RAM

The MC9S08QE8 series includes static RAM. The locations in RAM below 0x0100 can be accessed using the more efficient direct addressing mode, and any single bit in this area can be accessed with the bit manipulation instructions (BCLR, BSET, BRCLR, and BRSET). Locating the most frequently accessed program variables in this area of RAM is preferred.

At power-on, the contents of RAM are uninitialized. RAM data is unaffected by any reset provided that the supply voltage does not drop below the minimum value for RAM retention (V_{RAM}).

For compatibility with M68HC05 MCUs, the HCS08 resets the stack pointer to 0x00FF. In the MC9S08QE8 series, it is usually best to reinitialize the stack pointer to the top of the RAM so the direct page RAM can be used for frequently accessed RAM variables and bit-addressable program variables. Include the following 2-instruction sequence in your reset initialization routine (where RamLast is equated to the highest address of the RAM in the Freescale Semiconductor-provided equate file).

```
LDHX    #RamLast+1    ;point one past RAM
TXS                      ;SP<= (H:X-1)
```

When security is enabled, the RAM is considered a secure memory resource and is not accessible through background debug mode (BDM) or through code executing from non-secure memory. See [Section 4.6, “Security,”](#) for a detailed description of the security feature.

4.5 Flash

The flash memory is used primarily for program storage. In-circuit programming allows the operating program to be loaded into the flash memory after final assembly of the application product. It is possible to program the entire array through the single-wire background debug interface. Because no special voltages are needed for flash erase and programming operations, in-application programming is also possible through other software-controlled communication paths. For a more detailed discussion of in-circuit and in-application programming, refer to the *HCS08 Family Reference Manual, Volume I*, Freescale Semiconductor document order number HCS08RMv1.

4.5.1 Features

Features of the flash memory include:

- Flash size
 - MC9S08QE8: 8,192 bytes (16 pages of 512 bytes each)
 - MC9S08QE4: 4,096 bytes (8 pages of 512 bytes each)
- Single power supply program and erase
- Command interface for fast program and erase operation
- Up to 100,000 program/erase cycles at typical voltage and temperature
- Flexible block protection
- Security feature for flash and RAM
- Auto power-down for low-frequency read accesses

4.5.2 Program and Erase Times

Before any program or erase command can be accepted, the flash clock divider register (FCDIV) must be written to set the internal clock for the flash module to a frequency (f_{FCLK}) between 150 kHz and 200 kHz (see [Section 4.7.1, “Flash Clock Divider Register \(FCDIV\)”](#)). This register can be written only once, so normally this write is done during reset initialization. FCDIV cannot be written if the access error flag, FACCERR in FSTAT, is set. The user must ensure that FACCERR is not set before writing to the FCDIV register. One period of the resulting clock ($1/f_{FCLK}$) is used by the command processor to time program and erase pulses. An integer number of these timing pulses is used by the command processor to complete a program or erase command.

[Table 4-5](#) shows program and erase times. The bus clock frequency and FCDIV determine the frequency of FCLK (f_{FCLK}). The time for one cycle of FCLK is $t_{FCLK} = 1/f_{FCLK}$. The times are shown as a number of cycles of FCLK and as an absolute time for the case where $t_{FCLK} = 5 \mu s$. Program and erase times shown include overhead for the command state machine and enabling and disabling of program and erase voltages.

Table 4-5. Program and Erase Times

Parameter	Cycles of FCLK	Time if FCLK = 200 kHz
Byte program	9	45 μs
Byte program (burst)	4	20 μs ¹
Page erase	4000	20 ms
Mass erase	20,000	100 ms

¹ Excluding start/end overhead

4.5.3 Program and Erase Command Execution

The steps for executing any of the commands are listed below. The FCDIV register must be initialized and any error flags cleared before beginning command execution. The command execution steps are:

1. Write a data value to an address in the flash array. The address and data information from this write is latched into the flash interface. This write is a required first step in any command sequence. For erase and blank check commands, the value of the data is not important. For page erase commands, the address may be any address in the 512-byte page of flash to be erased. For mass erase and blank check commands, the address can be any address in the flash memory. Whole pages of 512 bytes are the smallest block of flash that may be erased.

NOTE

Do not program any byte in the flash more than once after a successful erase operation. Reprogramming bits to a byte that is already programmed is not allowed without first erasing the page in which the byte resides or mass erasing the entire flash memory. Programming without first erasing may disturb data stored in the flash.

2. Write the command code for the desired command to FCMD. The five valid commands are blank check (0x05), byte program (0x20), burst program (0x25), page erase (0x40), and mass erase (0x41). The command code is latched into the command buffer.
3. Write a 1 to the FCBEF bit in FSTAT to clear FCBEF and launch the command (including its address and data information).

A partial command sequence can be aborted manually by writing a 0 to FCBEF any time after the write to the memory array and before writing the 1 that clears FCBEF and launches the complete command. Aborting a command in this way sets the FACCERR access error flag, which must be cleared before starting a new command.

A strictly monitored procedure must be obeyed or the command will not be accepted. This minimizes the possibility of any unintended changes to the flash memory contents. The command complete flag (FCCF) indicates when a command is complete. The command sequence must be completed by clearing FCBEF to launch the command. [Figure 4-2](#) is a flowchart for executing all of the commands except for burst programming. The FCDIV register must be initialized before using any flash commands. This must be done only once following a reset.

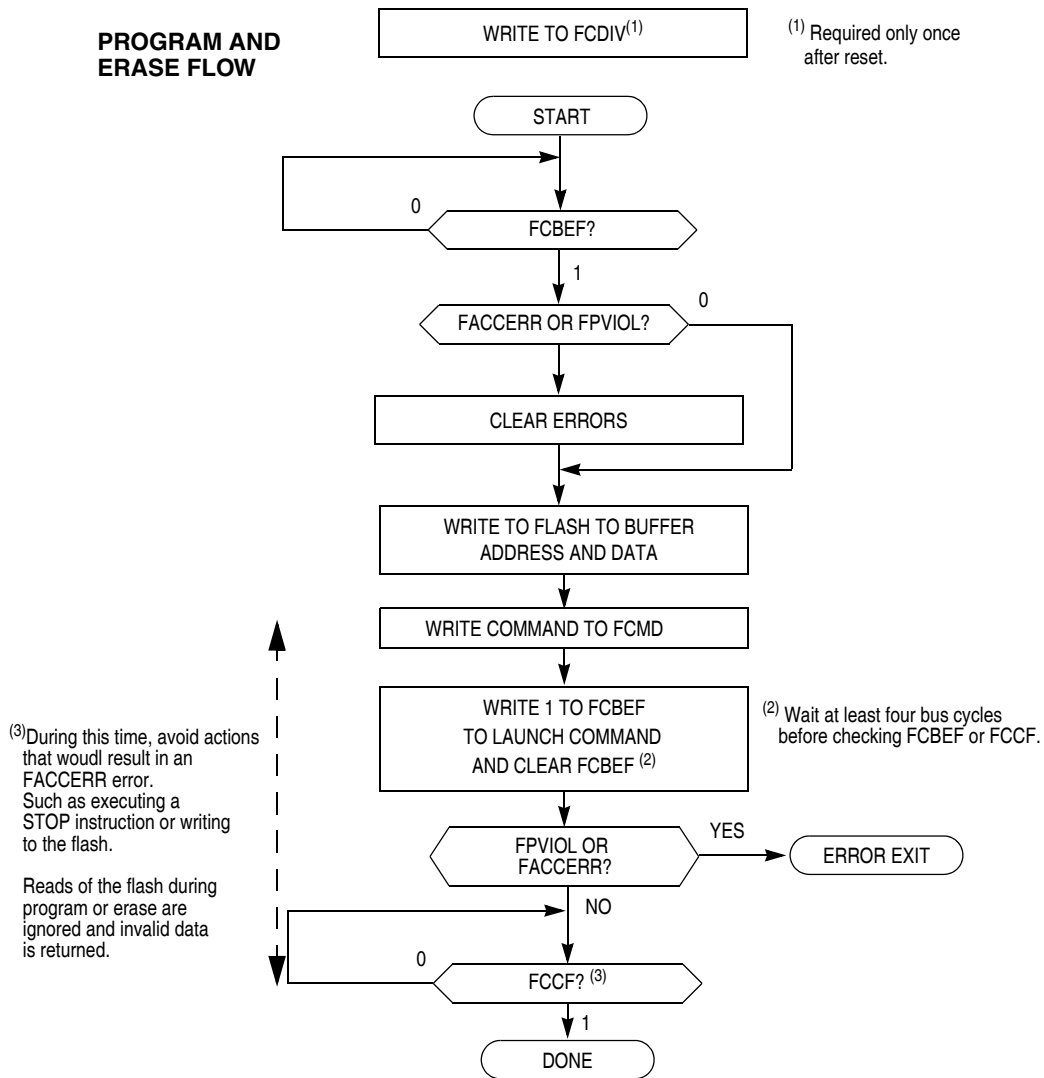


Figure 4-2. Flash Program and Erase Flowchart

4.5.4 Burst Program Execution

The burst program command is used to program sequential bytes of data in less time than would be required using the standard program command. This is possible because the high voltage to the Flash array does not need to be disabled between program operations. Ordinarily, when a program or erase command is issued, an internal charge pump associated with the Flash memory must be enabled to supply high voltage to the array. Upon completion of the command, the charge pump is turned off. When a burst program command is issued, the charge pump is enabled and then remains enabled after completion of the burst program operation if these two conditions are met:

- The next burst program command has been queued before the current program operation has completed.

- The next sequential address selects a byte on the same physical row as the current byte being programmed. A row of flash memory consists of 64 bytes. A byte within a row is selected by addresses A5 through A0. A new row begins when addresses A5 through A0 are all zero.

The first byte of a series of sequential bytes being programmed in burst mode will take the same amount of time to program as a byte programmed in standard mode. Subsequent bytes will program in the burst program time provided that the conditions above are met. In the case the next sequential address is the beginning of a new row, the program time for that byte will be the standard time instead of the burst time. This is because the high voltage to the array must be disabled and then enabled again. If a new burst command has not been queued before the current command completes, then the charge pump will be disabled and high voltage removed from the array.

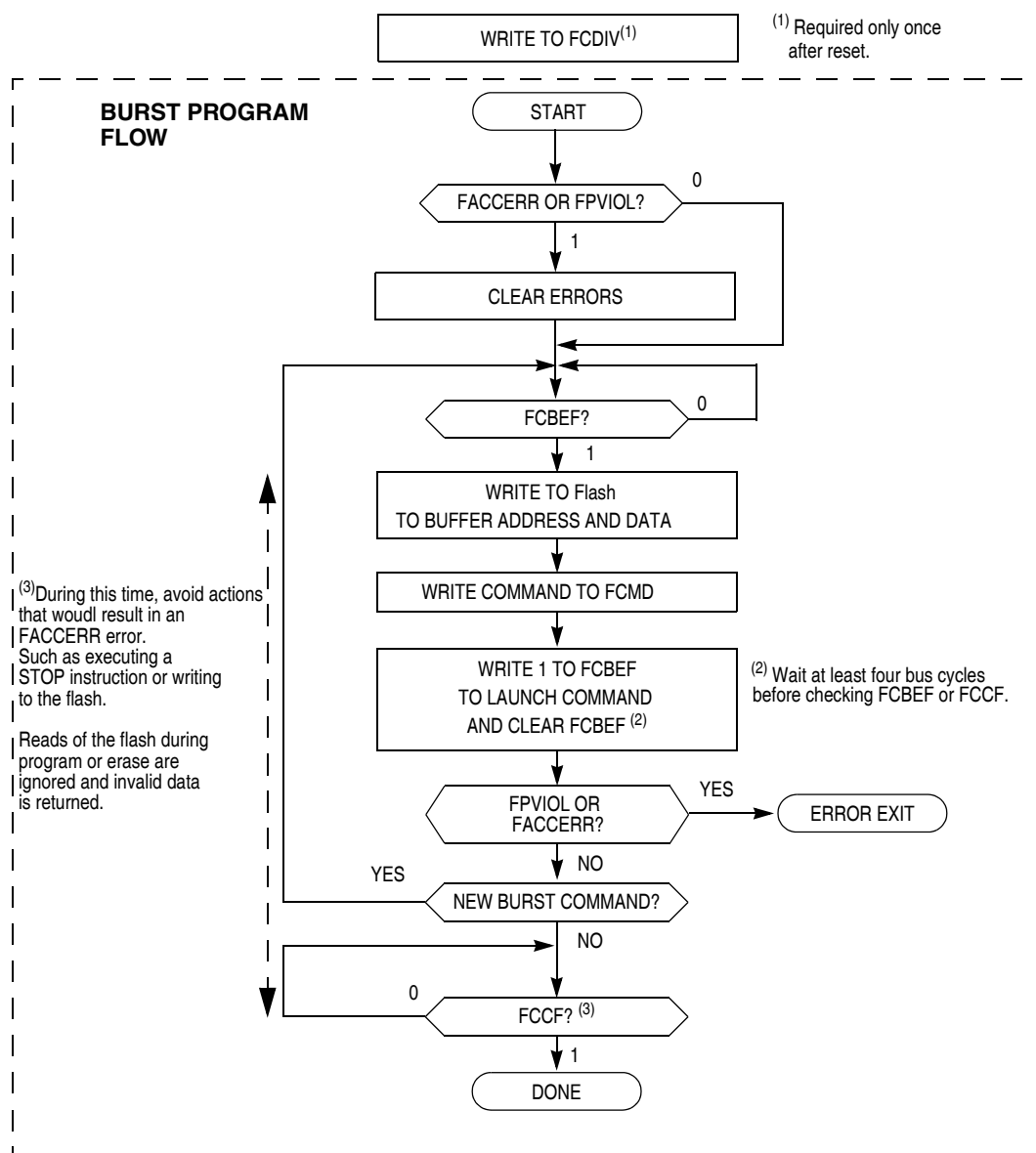


Figure 4-3. Flash Burst Program Flowchart

4.5.5 Access Errors

An access error occurs whenever the command execution protocol is violated.

Any of the following actions will cause the access error flag (FACCERR) in FSTAT to be set. FACCERR must be cleared by writing a 1 to FACCERR in FSTAT before any command can be processed.

- Writing to a flash address before the internal flash clock frequency has been set by writing to the FCDIV register
- Writing to a flash address while FCBEF is not set (a new command cannot start until the command buffer is empty)
- Writing a second time to a flash address before launching the previous command (there is only one write to flash for every command)
- Writing a second time to FCMD before launching the previous command (there is only one write to FCMD for every command)
- Writing to any flash control register other than FCMD after writing to a flash address
- Writing any command code to FCMD other than the five allowed codes (0x05, 0x20, 0x25, 0x40, or 0x41)
- Writing any flash control register other than the write to FSTAT (to clear FCBEF and launch the command) after writing the command to FCMD
- The MCU enters stop mode while a program or erase command is in progress (the command is aborted)
- Writing the byte program, burst program, or page erase command code (0x20, 0x25, or 0x40) with a background debug command while the MCU is secured (the background debug controller can only do blank check and mass erase commands when the MCU is secure)
- Writing 0 to FCBEF to cancel a partial command

4.5.6 Flash Block Protection

The block protection feature prevents the protected region of flash from program or erase changes. Block protection is controlled through the flash protection register (FPROT). When enabled, block protection begins at any 512 byte boundary below the last address of flash, 0xFFFF. (See [Section 4.7.4, “Flash Protection Register \(FPROT and NVPROT\)”](#).)

After exit from reset, FPROT is loaded with the contents of the NVPROT location, which is in the nonvolatile register block of the flash memory. FPROT cannot be changed directly from application software to prevent runaway programs from altering the block protection settings. Because NVPROT is within the last 512 bytes of flash, if any amount of memory is protected, NVPROT is itself protected and cannot be altered (intentionally or unintentionally) by the application software. FPROT can be written through background debug commands, which allows a protected flash memory to be erased and reprogrammed.

The block protection mechanism is illustrated in [Figure 4-4](#). The FPS bits are used as the upper bits of the last address of unprotected memory. This address is formed by concatenating FPS7:FPS1 with logic 1 bits as shown. For example, to protect the last 1536 bytes of memory (addresses 0xFA00 through 0xFFFF), the FPS bits must be set to 1111 100, which results in the value 0xF9FF as the last address of unprotected

memory. In addition to programming the FPS bits to the appropriate value, FPDIS (bit 0 of NVPROT) must be programmed to logic 0 to enable block protection. Therefore the value 0xF8 must be programmed into NVPROT to protect addresses 0xFA00 through 0xFFFF.

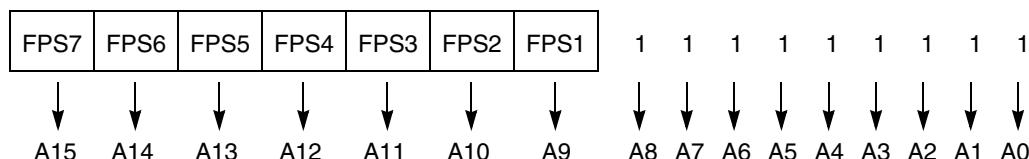


Figure 4-4. Block Protection Mechanism

One use of block protection is to block protect an area of flash memory for a bootloader program. This bootloader program then can be used to erase the rest of the flash memory and reprogram it. Because the bootloader is protected, it remains intact even if MCU power is lost in the middle of an erase and reprogram operation.

4.5.7 Vector Redirection

Whenever any block protection is enabled, the reset and interrupt vectors will be protected. Vector redirection allows users to modify interrupt vector information without unprotecting bootloader and reset vector space. Vector redirection is enabled by programming the FNORED bit in the NVOPT register located at address 0xFFBF to zero. For redirection to occur, at least some portion but not all of the flash memory must be block protected by programming the NVPROT register located at address 0xFFBD. All of the interrupt vectors (memory locations 0xFFC0–0xFFFD) are redirected, though the reset vector (0xFFFE:FFFF) is not.

For example, if 512 bytes of flash are protected, the protected address region is from 0xFE00 through 0xFFFF. The interrupt vectors (0xFFC0–0xFFFD) are redirected to the locations 0xFDC0–0xFDFD. For instance, if an SPI interrupt is taken, the values in the locations 0xFDE0:FDE1 are used for the vector instead of the values in the locations 0xFFE0:FFE1. This allows the user to reprogram the unprotected portion of the flash with new program code including new interrupt vector values while leaving the protected area, which includes the default vector locations, unchanged.

4.6 Security

The MC9S08QE8 series includes circuitry to prevent unauthorized access to the contents of flash and RAM memory. When security is engaged, flash and RAM are considered secure resources. Direct-page registers, high-page registers, and the background debug controller are considered unsecured resources. Programs executing within secure memory have normal access to any MCU memory locations and resources. Attempts to access a secure memory location with a program executing from an unsecured memory space or through the background debug interface are blocked (writes are ignored and reads return all 0s).

Security is engaged or disengaged based on the state of two nonvolatile register bits (SEC01:SEC00) in the FOPT register. During reset, the contents of the nonvolatile location NVOPT are copied from flash into the working FOPT register in high-page register space. A user engages security by programming the NVOPT location which can be done at the same time the flash memory is programmed. The 1:0 state

disengages security and the other three combinations engage security. Notice the erased state (1:1) makes the MCU secure. During development, whenever the flash is erased, user code must immediately program the SEC00 bit to 0 in NVOPT so SEC01:SEC00 = 1:0. This would allow the MCU to remain unsecured after a subsequent reset.

The on-chip debug module cannot be enabled while the MCU is secure. The separate background debug controller can still be used for background memory access commands of unsecured resources.

A user can choose to allow or disallow a security unlocking mechanism through an 8-byte backdoor security key. If the nonvolatile KEYEN bit in NVOPT/FOPT is 0, the backdoor key is disabled and there is no way to disengage security without completely erasing all flash locations. If KEYEN is 1, a secure user program can temporarily disengage security by:

1. Writing 1 to KEYACC in the FCNFG register. This makes the flash module interpret writes to the backdoor comparison key locations (NVBACKKEY through NVBACKKEY+7) as values to be compared against the key rather than as the first step in a flash program or erase command.
2. Writing the user-entered key values to the NVBACKKEY through NVBACKKEY+7 locations. These writes must be done in order starting with the value for NVBACKKEY and ending with NVBACKKEY+7. STHX must not be used for these writes because these writes cannot be done on adjacent bus cycles. User software normally would get the key codes from outside the MCU system through a communication interface such as a serial I/O.
3. Writing 0 to KEYACC in the FCNFG register. If the 8-byte key that was just written matches the key stored in the flash locations, SEC01:SEC00 are automatically changed to 1:0 and security will be disengaged until the next reset.

The security key can be written only from secure memory (either RAM or flash), so it cannot be entered through background commands without the cooperation of a secure user program.

The backdoor comparison key (NVBACKKEY through NVBACKKEY+7) is located in flash memory locations in the nonvolatile register space so users can program these locations exactly as they would program any other flash memory location. The nonvolatile registers are in the same 512-byte block of flash as the reset and interrupt vectors, so block protecting that space also block protects the backdoor comparison key. Block protects cannot be changed from user application programs, so if the vector space is block protected, the backdoor security key mechanism cannot permanently change the block protect, security settings, or the backdoor key.

Security can always be disengaged through the background debug interface by taking these steps:

1. Disable any block protections by writing FPROT. FPROT can be written only with background debug commands, not from application software.
2. Mass erase flash if necessary.
3. Blank check flash. Provided flash is completely erased, security is disengaged until the next reset. To avoid returning to secure mode after the next reset, program NVOPT so SEC01:SEC00 = 1:0.

4.7 Flash Registers and Control Bits

The flash module has nine 8-bit registers in the high-page register space. Two locations (NVOPT, NVPROT) in the nonvolatile register space in flash memory are copied into corresponding high-page

control registers (FOPT, FPROT) at reset. There is also an 8-byte comparison key in flash memory. Refer to [Table 4-3](#) and [Table 4-4](#) for the absolute address assignments for all flash registers. This section refers to registers and control bits only by their names. A Freescale Semiconductor-provided equate or header file is normally used to translate these names into the appropriate absolute addresses.

4.7.1 Flash Clock Divider Register (FCDIV)

Bit 7 of this register is a read-only flag. Bits 6:0 may be read at any time but can be written only one time. Before any erase or programming operations are possible, write to this register to set the frequency of the clock for the nonvolatile memory system within acceptable limits.

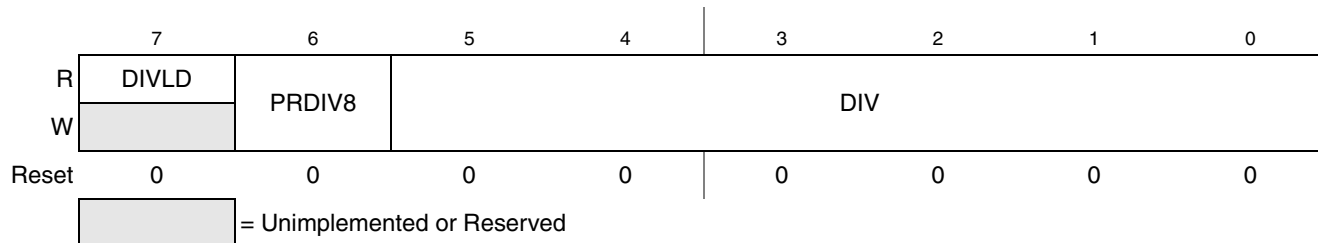


Figure 4-5. Flash Clock Divider Register (FCDIV)

Table 4-6. FCDIV Register Field Descriptions

Field	Description
7 DIVLD	Divisor Loaded Status Flag — When set, this read-only status flag indicates that the FCDIV register has been written since reset. Reset clears this bit and the first write to this register causes this bit to become set regardless of the data written. 0 FCDIV has not been written since reset; erase and program operations disabled for flash. 1 FCDIV has been written since reset; erase and program operations enabled for flash.
6 PRDIV8	Prescale (Divide) Flash Clock by 8 0 Clock input to the flash clock divider is the bus rate clock. 1 Clock input to the flash clock divider is the bus rate clock divided by 8.
5:0 DIV	Divisor for Flash Clock Divider — The flash clock divider divides the bus rate clock (or the bus rate clock divided by 8 if PRDIV8 = 1) by the value in the 6-bit DIV field plus one. The resulting frequency of the internal flash clock must fall within the range of 200 kHz to 150 kHz for proper flash operations. Program/Erase timing pulses are one cycle of this internal flash clock which corresponds to a range of 5 μ s to 6.7 μ s. The automated programming logic uses an integer number of these pulses to complete an erase or program operation. See Equation 4-1 and Equation 4-2 .

$$\text{if PRDIV8} = 0 \text{ — } f_{\text{FCLK}} = f_{\text{Bus}} \div (\text{DIV} + 1) \quad \text{Eqn. 4-1}$$

$$\text{if PRDIV8} = 1 \text{ — } f_{\text{FCLK}} = f_{\text{Bus}} \div (8 \times (\text{DIV} + 1)) \quad \text{Eqn. 4-2}$$

[Table 4-7](#) shows the appropriate values for PRDIV8 and DIV for selected bus frequencies.

Table 4-7. Flash Clock Divider Settings

f_{Bus}	PRDIV8 (Binary)	DIV (Decimal)	f_{CLK}	Program/Erase Timing Pulse (5 μs Min, 6.7 μs Max)
20 MHz	1	12	192.3 kHz	5.2 μs
10 MHz	0	49	200 kHz	5 μs
8 MHz	0	39	200 kHz	5 μs
4 MHz	0	19	200 kHz	5 μs
2 MHz	0	9	200 kHz	5 μs
1 MHz	0	4	200 kHz	5 μs
200 kHz	0	0	200 kHz	5 μs
150 kHz	0	0	150 kHz	6.7 μs

4.7.2 Flash Options Register (FOPT and NVOPT)

During reset, the contents of the nonvolatile location NVOPT are copied from flash into FOPT. To change the value in this register, erase and reprogram the NVOPT location in flash memory as usual and then issue a new MCU reset.

	7	6	5	4	3	2	1	0
R	KEYEN	FNORED	0	0	0	0	SEC01	SEC00
W								

Reset This register is loaded from nonvolatile location NVOPT during reset.


 = Unimplemented or Reserved

Figure 4-6. Flash Options Register (FOPT)

Table 4-8. FOPT Register Field Descriptions

Field	Description
7 KEYEN	Backdoor Key Mechanism Enable — When this bit is 0, the backdoor key mechanism cannot be used to disengage security. The backdoor key mechanism is accessible only from user (secured) firmware. BDM commands cannot be used to write key comparison values that would unlock the backdoor key. For more detailed information about the backdoor key mechanism, refer to Section 4.6, “Security.” 0 No backdoor key access allowed. 1 If user firmware writes an 8-byte value that matches the nonvolatile backdoor key (NVBACKKEY through NVBACKKEY+7 in that order), security is temporarily disengaged until the next MCU reset.
6 FNORED	Vector Redirection Disable — When this bit is 1, then vector redirection is disabled. 0 Vector redirection enabled. 1 Vector redirection disabled.
1:0 SEC0[1:0]	Security State Code — This 2-bit field determines the security state of the MCU as shown in Table 4-9 . When the MCU is secure, the contents of RAM and flash memory cannot be accessed by instructions from any unsecured source including the background debug interface. SEC01:SEC00 changes to 1:0 after successful backdoor key entry or a successful blank check of flash. For more detailed information about security, refer to Section 4.6, “Security.”

Table 4-9. Security States¹

SEC01:SEC00	Description
0:0	secure
0:1	secure
1:0	unsecured
1:1	secure

¹ SEC01:SEC00 changes to 1:0 after successful backdoor key entry or a successful blank check of flash.

4.7.3 Flash Configuration Register (FCNFG)

	7	6	5	4	3	2	1	0
R	0	0	KEYACC	0	0	0	0	0
W								
Reset	0	0	0	0	0	0	0	0


 = Unimplemented or Reserved

Figure 4-7. Flash Configuration Register (FCNFG)

Table 4-10. FCNFG Register Field Descriptions

Field	Description
5 KEYACC	Enable Writing of Access Key — This bit enables writing of the backdoor comparison key. For more detailed information about the backdoor key mechanism, refer to Section 4.6, “Security.” 0 Writes to 0xFFB0–0xFFB7 are interpreted as the start of a flash programming or erase command. 1 Writes to NVBACKKEY (0xFFB0–0xFFB7) are interpreted as comparison key writes.

4.7.4 Flash Protection Register (FPROT and NVPROT)

During reset, the contents of the nonvolatile location NVPROT is copied from flash into FPROT. FPROT can be read at any time. With FPDIS set, all bits are writable, but with FPDIS clear, the FPS bits are writable as long as the size of the protected region is being increased. Any FPROT write that attempts to decrease the size of the protected region will be ignored.

	7	6	5	4	3	2	1	0
R	FPS ⁽¹⁾							FPDIS ⁽¹⁾
W								
Reset	This register is loaded from nonvolatile location NVPROT during reset.							

¹ Background commands can be used to change the contents of these bits in FPROT.

Figure 4-8. Flash Protection Register (FPROT)

Table 4-11. FPROT Register Field Descriptions

Field	Description
7:1 FPS	Flash Protect Select Bits — When FPDIS = 0, this 7-bit field determines the ending address of unprotected flash locations at the high address end of the flash. Protected flash locations cannot be erased or programmed.
0 FPDIS	Flash Protection Disable 0 Flash block specified by FPS7:FPS1 is block protected (program and erase not allowed). 1 No flash block is protected.

4.7.5 Flash Status Register (FSTAT)

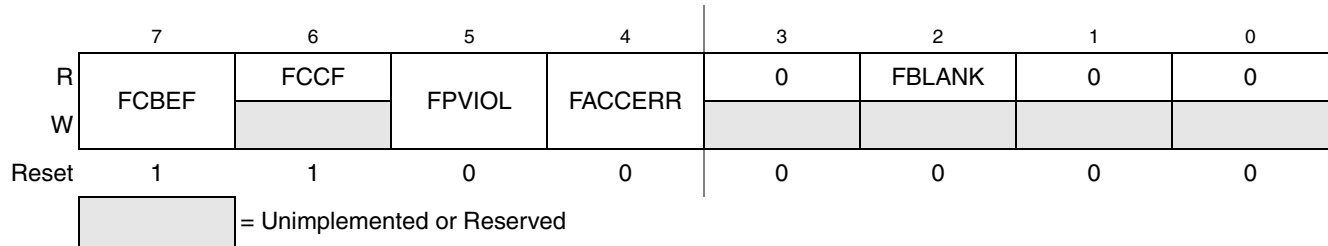


Figure 4-9. Flash Status Register (FSTAT)

Table 4-12. FSTAT Register Field Descriptions

Field	Description
7 FCBEF	Flash Command Buffer Empty Flag — The FCBEF bit is used to launch commands. It also indicates that the command buffer is empty so that a new command sequence can be executed when performing burst programming. The FCBEF bit is cleared by writing a 1 to it or when a burst program command is transferred to the array for programming. Only burst program commands can be buffered. 0 Command buffer is full (not ready for additional commands). 1 A new burst program command can be written to the command buffer.
6 FCCF	Flash Command Complete Flag — FCCF is set automatically when the command buffer is empty and no command is being processed. FCCF is cleared automatically when a new command is started (by writing 1 to FCBEF to register a command). Writing to FCCF has no meaning or effect. 0 Command in progress 1 All commands complete
5 FPVIOL	Protection Violation Flag — FPVIOL is set automatically when a command is written that attempts to erase or program a location in a protected block (the erroneous command is ignored). FPVIOL is cleared by writing a 1 to FPVIOL. 0 No protection violation. 1 An attempt was made to erase or program a protected location.

Table 4-12. FSTAT Register Field Descriptions (continued)

Field	Description
4 FACCERR	Access Error Flag — FACCERR is set automatically when the proper command sequence is not obeyed exactly (the erroneous command is ignored), if a program or erase operation is attempted before the FCDIV register has been initialized, or if the MCU enters stop while a command was in progress. For a more detailed discussion of the exact actions that are considered access errors, see Section 4.5.5, “Access Errors.” FACCERR is cleared by writing a 1 to FACCERR. Writing a 0 to FACCERR has no meaning or effect. 0 No access error. 1 An access error has occurred.
2 FBLANK	Flash Verified as All Blank (erased) Flag — FBLANK is set automatically at the conclusion of a blank check command if the entire flash array was verified to be erased. FBLANK is cleared by clearing FCBF to write a new valid command. Writing to FBLANK has no meaning or effect. 0 After a blank check command is completed and FCCF = 1, FBLANK = 0 indicates the flash array is not completely erased. 1 After a blank check command is completed and FCCF = 1, FBLANK = 1 indicates the flash array is completely erased (all 0xFF).

4.7.6 Flash Command Register (FCMD)

Only five command codes are recognized in normal user modes as shown in [Table 4-13](#). Refer to [Section 4.5.3, “Program and Erase Command Execution,”](#) for a detailed discussion of flash programming and erase operations.

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
W	FCMD							
Reset	0	0	0	0	0	0	0	0

Figure 4-10. Flash Command Register (FCMD)

Table 4-13. Flash Commands

Command	FCMD	Equate File Label
Blank check	0x05	mBlank
Byte program	0x20	mByteProg
Byte program — burst mode	0x25	mBurstProg
Page erase (512 bytes/page)	0x40	mPageErase
Mass erase (all flash)	0x41	mMassErase

All other command codes are illegal and generate an access error.

It is not necessary to perform a blank check command after a mass erase operation. Only blank check is required as part of the security unlocking mechanism.

Chapter 5

Resets, Interrupts, and General System Control

5.1 Introduction

This chapter discusses basic reset and interrupt mechanisms and the various sources of reset and interrupt in the MC9S08QE8 series. Some interrupt sources from peripheral modules are discussed in greater detail in other chapters of this document. This chapter gathers basic information about all reset and interrupt sources in one place for easy reference. A few reset and interrupt sources, including the computer operating properly (COP) watchdog are not part of on-chip peripheral systems and have their own chapters.

5.2 Features

Reset and interrupt features include:

- Multiple sources of reset for flexible system configuration and reliable operation
- Reset status register (SRS) to indicate source of most recent reset
- Separate interrupt vector for most modules (reduces polling overhead) (see [Table 5-2](#))

5.3 MCU Reset

Resetting the MCU provides a way to start processing from a known set of initial conditions. During reset, most control and status registers are forced to initial values and the program counter is loaded from the reset vector (0xFFFF:0xFFFF). On-chip peripheral modules are disabled and I/O pins are initially configured as general-purpose high-impedance inputs with pullup devices disabled. The I bit in the condition code register (CCR) is set to block maskable interrupts, so the user program has a chance to initialize the stack pointer (SP) and system control settings. SP is forced to 0x00FF at reset.

The MC9S08QE8 series has the following sources for reset:

- Power-on reset (POR)
- External pin reset (PIN)
- Computer operating properly (COP) timer
- Illegal opcode detect (IOP)
- Illegal address detect (ILAD)
- Low-voltage detect (LVD)
- Background debug forced reset

Each of these sources, with the exception of the background debug forced reset, has an associated bit in the system reset status register (SRS).

5.4 Computer Operating Properly (COP) Watchdog

The COP watchdog is used to force a system reset when the application software fails to execute as expected. To prevent a system reset from the COP timer (when it is enabled), application software must reset the COP counter periodically. If the application program gets lost and fails to reset the COP counter before it times out, a system reset is generated to force the system back to a known starting point.

After any reset, the COPE becomes set in SOPT1 enabling the COP watchdog (see [Section 5.8.4, “System Options Register 1 \(SOPT1\)”](#) for additional information). If the COP watchdog is not used in an application, it can be disabled by clearing COPE. The COP counter is reset by writing any value to the address of SRS. This write does not affect the data in the read-only SRS. Instead, the act of writing to this address is decoded and sends a reset signal to the COP counter.

The COPCLKS bit in SOPT2 (see [Section 5.8.5, “System Options Register 2 \(SOPT2\)”](#) for additional information) selects the clock source used for the COP timer. The clock source options are either the bus clock or an internal 1 kHz clock source. With each clock source, there is an associated short and long timeout controlled by COPT in SOPT1. [Table 5-1](#) summarizes the control functions of the COPCLKS and COPT bits. The COP watchdog defaults to operation from the 1 kHz clock source and the associated long timeout (2^8 cycles).

Table 5-1. COP Configuration Options

Control Bits		Clock Source	COP Overflow Count
COPCLKS	COPT		
0	0	~1 kHz	2^5 cycles (32 ms) ¹
0	1	~1 kHz	2^8 cycles (256 ms) ¹
1	0	Bus	2^{13} cycles
1	1	Bus	2^{18} cycles

¹ Values are shown in this column based on $t_{LPO} = 1$ ms. See t_{LPO} in the data sheet for the tolerance of this value.

Even if the application will use the reset default settings of COPE, COPCLKS, and COPT, the user must write to the write-once SOPT1 and SOPT2 registers during reset initialization to lock in the settings. In that way, they cannot be changed accidentally if the application program gets lost. The initial writes to SOPT1 and SOPT2 will reset the COP counter.

The write to SRS that services (clears) the COP counter must not be placed in an interrupt service routine (ISR) because the ISR could continue to be executed periodically even if the main application program fails.

In background debug mode, the COP counter will not increment.

When the bus clock source is selected, the COP counter does not increment while the system is in stop mode. The COP counter resumes as soon as the MCU exits stop mode.

When the 1 kHz clock source is selected, the COP counter is re-initialized to zero upon entry to stop mode. The COP counter begins from zero after the MCU exits stop mode.

5.5 Interrupts

Interrupts provide a way to save the current CPU status and registers, execute an interrupt service routine (ISR), and then restore the CPU status so processing can resume where it left off before the interrupt. Other than the software interrupt (SWI), which is a program instruction, interrupts are caused by hardware events such as an edge on the IRQ pin or a timer-overflow event. The debug module can also generate an SWI under certain circumstances.

If an event occurs in an enabled interrupt source, an associated read-only status flag will become set. The CPU will not respond unless the local interrupt enable is a 1 (enabled) and the I bit in the CCR is 0 to allow interrupts. The global interrupt mask (I bit) in the CCR is initially set after reset which prevents all maskable interrupt sources. The user program initializes the stack pointer and performs other system setup before clearing the I bit to allow the CPU to respond to interrupts.

When the CPU receives a qualified interrupt request, it completes the current instruction before responding to the interrupt. The interrupt sequence obeys the same cycle-by-cycle sequence as the SWI instruction and consists of:

- Saving the CPU registers on the stack
- Setting the I bit in the CCR to mask further interrupts
- Fetching the interrupt vector for the highest-priority interrupt that is currently pending
- Filling the instruction queue with the first three bytes of program information starting from the address fetched from the interrupt vector locations

While the CPU is responding to the interrupt, the I bit is automatically set to avoid the possibility of another interrupt interrupting the ISR itself (this is called nesting of interrupts). Normally, the I bit is restored to 0 when the CCR is restored from the value stacked on entry to the ISR. In rare cases, the I bit can be cleared inside an ISR (after clearing the status flag that generated the interrupt) so that other interrupts can be serviced without waiting for the first service routine to finish. This practice is not recommended for anyone other than the most experienced programmers because it can lead to subtle program errors that are difficult to debug.

The interrupt service routine ends with a return-from-interrupt (RTI) instruction which restores the CCR, A, X, and PC registers to their pre-interrupt values by reading the previously saved information from the stack.

NOTE

For compatibility with M68HC08 devices, the H register is not automatically saved and restored. Push H onto the stack at the start of the interrupt service routine (ISR) and restore it immediately before the RTI that is used to return from the ISR.

If more than one interrupt is pending when the I bit is cleared, the highest priority source is serviced first (see [Table 5-2](#)).

5.5.1 Interrupt Stack Frame

Figure 5-1 shows the contents and organization of a stack frame. Before the interrupt, the stack pointer (SP) points at the next available byte location on the stack. The current values of CPU registers are stored on the stack starting with the low-order byte of the program counter (PCL) and ending with the CCR. After stacking, the SP points at the next available location on the stack. This address is one less than the address where the CCR was saved. The PC value that is stacked is the address of the instruction in the main program that would have executed next if the interrupt had not occurred.

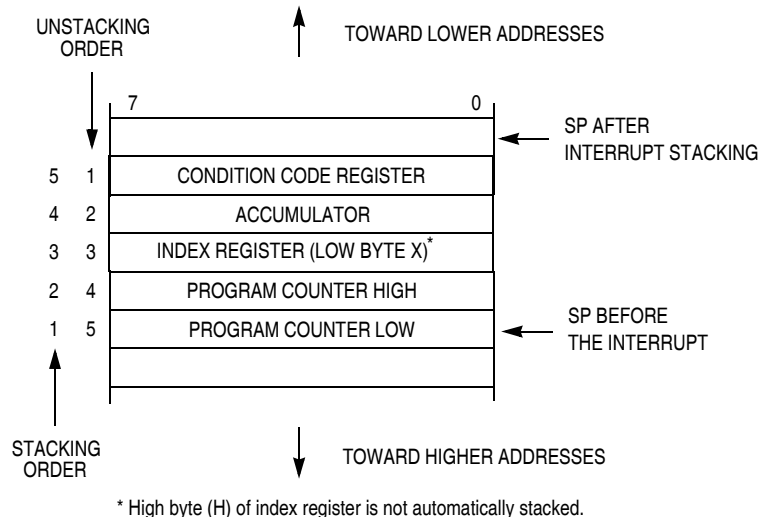


Figure 5-1. Interrupt Stack Frame

When an RTI instruction is executed, these values are recovered from the stack in reverse order. As part of the RTI sequence, the CPU fills the instruction pipeline by reading three bytes of program information, starting from the PC address recovered from the stack.

The status flag corresponding to the interrupt source must be acknowledged (cleared) before returning from the ISR. Typically, the flag is cleared at the beginning of the ISR so that if another interrupt is generated by this same source, it will be registered so it can be serviced after completion of the current ISR.

5.5.2 External Interrupt Request (IRQ) Pin

External interrupts are managed by the IRQ status and control register (IRQSC). When the IRQ function is enabled, synchronous logic monitors the pin for edge-only or edge-and-level events. When the MCU is in stop mode and system clocks are shut down, a separate asynchronous path is used so the IRQ pin (if enabled) can wake the MCU.

5.5.2.1 Pin Configuration Options

The IRQ pin enable (IRQPE) control bit in IRQSC must be 1 in order for the IRQ pin to act as the interrupt request (IRQ) input. As an IRQ input, the user can choose the polarity of edges or levels detected (IRQEDG), whether the pin detects edges-only or edges and levels (IRQMOD) and whether an event causes an interrupt or only sets the IRQF flag which can be polled by software (IRQIE).

The IRQ pin, when enabled, defaults to use an internal pull device ($\text{IRQPDD} = 0$), configured as a pullup or pulldown depending on the polarity chosen. If the user desires to use an external pullup or pulldown, the IRQPDD can be written to a 1 to turn off the internal device.

BIH and BIL instructions may be used to detect the level on the IRQ pin when the pin is configured to act as the IRQ input.

NOTE

This pin does not contain a clamp diode to V_{DD} and must not be driven above V_{DD} .

NOTE

The voltage measured on the internally pulled up $\overline{\text{RESET}}$ pin will not be pulled to V_{DD} . The internal gates connected to this pin are pulled to V_{DD} . The $\overline{\text{RESET}}$ pullup must not be used to pullup components external to the MCU.

5.5.2.2 Edge and Level Sensitivity

The IRQMOD control bit reconfigures the detection logic to detect edge events and pin levels. In the edge and level detection mode, the IRQF status flag becomes set when an edge is detected (when the IRQ pin changes from the deasserted to the asserted level), but the flag is continuously set (and cannot be cleared) as long as the IRQ pin remains at the asserted level.

5.5.3 Interrupt Vectors, Sources, and Local Masks

Table 5-2 provides a summary of all interrupt sources. Higher-priority sources are located toward the bottom of the table. The high-order byte of the address for the interrupt service routine is located at the first address in the vector address column, and the low-order byte of the address for the interrupt service routine is located at the next higher address.

When an interrupt condition occurs, an associated flag bit becomes set. If the associated local interrupt enable is 1, an interrupt request is sent to the CPU. Within the CPU, if the global interrupt mask (I bit in the CCR) is 0, the CPU will finish the current instruction; stack the PCL, PCH, X, A, and CCR CPU registers; set the I bit; and then fetch the interrupt vector for the highest priority pending interrupt. Processing then continues in the interrupt service routine.

Table 5-2. Vector Summary

Vector Priority	Vector Number	Address (High/Low)	Vector Name	Module	Source	Enable	Description
<div>Lowest</div> <div>↑</div> <div>↓</div> <div>Highest</div>	31 through 25	0xFFC0:FFC1 through 0xFFCC:FFCD	Unused Vector Space (available for user program)				
	24	0xFFCE/0xFFCF	Vrtc	RTC	RTIF	RTIE	Real-time interrupt
	23	0xFFD0/0xFFD1	—	—	—	—	—
	22	0xFFD2/0xFFD3	—	—	—	—	—
	21	0xFFD4/0xFFD5	—	—	—	—	—
	20	0xFFD6/0xFFD7	Vacmpx	ACMPx ¹	ACF	ACIE	Analog comparator x
	19	0xFFD8/0xFFD9	Vadc	ADC	COCO	AIEN	ADC
	18	0xFFDA/0xFFDB	Vkeyboard	KBI	KBF	KBIE	Keyboard pins
	17	0xFFDC/0xFFDD	Viic	IIC	IICIS	IICIE	IIC control
	16	0xFFDE/0xFFDF	Vscitx	SCI	TDRE, TC	TIE, TCIE	SCI transmit
	15	0xFFE0/0xFFE1	Vscirx	SCI	IDLE, RDRF, LBKDIF, RXEDGIF	ILIE, RIE, LBKDIE, RXEDGIE	SCI receive
	14	0xFFE2/0xFFE3	Vscierr	SCI	OR, NF, FE, PF	ORIE, NFIE, FEIE, PFIE	SCI error
	13	0xFFE4/0xFFE5	Vspi	SPI	SPIF, MODF, SPTEF	SPIE, SPIE, SPTIE	SPI
	12	0xFFE6/0xFFE7	—	—	—	—	—
	11	0xFFE8/0xFFE9	Vtpm2ovf	TPM2	TOF	TOIE	TPM2 overflow
	10	0xFFEA/0xFFEB	Vtpm2ch2	TPM2	CH2F	CH2IE	TPM2 channel 2
	9	0xFFEC/0xFFED	Vtpm2ch1	TPM2	CH1F	CH1IE	TPM2 channel 1
	8	0xFFEE/0xFFEF	Vtpm2ch0	TPM2	CH0F	CH0IE	TPM2 channel 0
	7	0xFFFF0/0xFFFF1	Vtpm1ovf	TPM1	TOF	TOIE	TPM1 overflow
	6	0xFFFF2/0xFFFF3	Vtpm1ch2	TPM1	CH2F	CH2IE	TPM1 channel 2
	5	0xFFFF4/0xFFFF5	Vtpm1ch1	TPM1	CH1F	CH1IE	TPM1 channel 1
	4	0xFFFF6/0xFFFF7	Vtpm1ch0	TPM1	CH0F	CH0IE	TPM1 channel 0
	3	0xFFFF8/0xFFFF9	Vlvd	System control	LVDF, LVWF	LVDIE, LVWIE	Low-voltage detect, Low-voltage warning
	2	0xFFFFA/0xFFFFB	Virq	IRQ	IRQF	IRQIE	IRQ pin
	1	0xFFFFC/0xFFFFD	Vswi	Core	SWI Instruction	—	Software interrupt
	0	0xFFFFE/0xFFFFF	Vreset	System control	COP LVD RESET pin Illegal opcode Illegal address POR	COPE LVDRE RSTPE — —	Watchdog timer Low-voltage detect External pin Illegal opcode Illegal address

¹ ACMP1 and ACMP2 share this vector, if both modules are enabled user must poll each flag to determine pending interrupt.

5.6 Low-Voltage Detect (LVD) System

The MC9S08QE8 series includes a system to protect against low voltage conditions to protect memory contents and control MCU system states during supply voltage variations. The system is comprised of a power-on reset (POR) circuit and a LVD circuit. The LVD circuit is enabled when LVDE in SPMSC1. The LVD is disabled upon entering either of the stop modes unless LVDSE is set in SPMSC1. If LVDSE and LVDE are both set, then the MCU will enter stop3 instead of stop2, and the current consumption in stop3 with the LVD enabled will be greater.

5.6.1 Power-On Reset Operation

When power is initially applied to the MCU, or when the supply voltage drops below the power-on reset rearm voltage level, V_{POR} , the POR circuit will cause a reset condition. As the supply voltage rises, the LVD circuit will hold the MCU in reset until the supply has risen above the low voltage detection low threshold, V_{LVDL} . Both the POR bit and the LVD bit in SRS are set following a POR.

5.6.2 Low-Voltage Detection (LVD) Reset Operation

The LVD can be configured to generate a reset upon detection of a low voltage condition by setting LVDRE to 1. After an LVD reset has occurred, the LVD system will hold the MCU in reset until the supply voltage has risen above the low voltage detection threshold. The LVD bit in the SRS register is set following an LVD reset or POR.

5.6.3 Low-Voltage Detection (LVD) Interrupt Operation

When a low voltage condition is detected and the LVD circuit is configured using SPMSC1 for interrupt operation (LVDE set, LVDIE set, and LVDRE clear), then LVDF in SPMSC1 will be set and an LVD interrupt request will occur. The LVDF bit is cleared by writing a 1 to the LVDACK bit in SPMSC1.

5.6.4 Low-Voltage Warning (LVW) Interrupt Operation

The LVD system has a low voltage warning flag (LVWF) to indicate to the user that the supply voltage is approaching, but remains above, the LVD voltage. The LVW also has an interrupt associated with it, enabled by setting the LVWIE bit in the SPMSC3 register. If enabled, an LVW interrupt request will occur when the LVWF is set. LVWF is cleared by writing a 1 to the LVWACK bit in SPMSC3.

5.7 Peripheral Clock Gating

The MC9S08QE8 series includes a clock gating system to manage the bus clock sources to the individual peripherals. Using this system, the user can enable or disable the bus clock to each of the peripherals at the clock source, eliminating unnecessary clocks to peripherals which are not in use and thereby reducing the overall run and wait mode currents.

Out of reset, all peripheral clocks will be enabled. For lowest possible run or wait currents, user software must disable the clock source to any peripheral not in use. The actual clock will be enabled or disabled immediately following the write to the clock gating control registers (SCGC1 and SCGC2). Any

peripheral with a gated clock cannot be used unless its clock is enabled. Writing to the registers of a peripheral with a disabled clock has no effect.

NOTE

User software must disable the peripheral before disabling the clocks to the peripheral. When clocks are re-enabled to a peripheral, the peripheral registers need to be re-initialized by user software.

In stop modes, the bus clock is disabled for all gated peripherals, regardless of the settings in SCGC1 and SCGC2.

5.8 Reset, Interrupt, and System Control Registers and Control Bits

One 8-bit register in the direct page register space and eight 8-bit registers in the high-page register space are related to reset and interrupt systems.

Refer to [Table 4-2](#) and [Table 4-3](#) in [Chapter 4, “Memory,”](#) of this reference manual for the absolute address assignments for all registers. This section refers to registers and control bits only by their names. A Freescale-provided equate or header file is used to translate these names into the appropriate absolute addresses.

Some control bits in the SOPT1 and SPMSC2 registers are related to modes of operation. Although brief descriptions of these bits are provided here, the related functions are discussed in greater detail in [Chapter 3, “Modes of Operation.”](#)

5.8.1 Interrupt Pin Request Status and Control Register (IRQSC)

This direct page register includes status and control bits which are used to configure the IRQ function, report status, and acknowledge IRQ events.

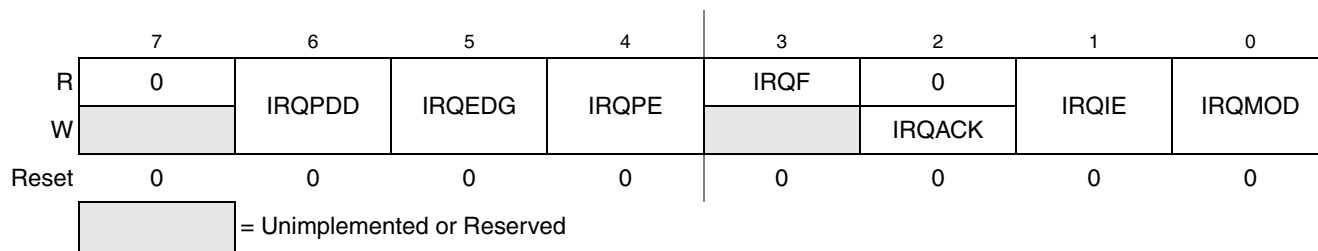


Figure 5-2. Interrupt Request Status and Control Register (IRQSC)

Table 5-3. IRQSC Register Field Descriptions

Field	Description
6 IRQPDD	Interrupt Request (IRQ) Pull Device Disable — This read/write control bit is used to disable the internal pullup pulldown device when the IRQ pin is enabled (IRQPE = 1) allowing for an external device to be used. 0 IRQ pull device enabled if IRQPE = 1. 1 IRQ pull device disabled if IRQPE = 1.
5 IRQEDG	Interrupt Request (IRQ) Edge Select — This read/write control bit is used to select the polarity of edges or levels on the IRQ pin that cause IRQF to be set. The IRQMOD control bit determines whether the IRQ pin is sensitive to both edges and levels or only edges. When IRQEDG = 1 and the internal pull device is enabled, the pullup device is reconfigured as an optional pulldown device. 0 IRQ is falling edge or falling edge/low-level sensitive. 1 IRQ is rising edge or rising edge/high-level sensitive.
4 IRQPE	IRQ Pin Enable — This read/write control bit enables the IRQ pin function. When this bit is set, the IRQ pin can be used as an interrupt request. 0 IRQ pin function is disabled. 1 IRQ pin function is enabled.
3 IRQF	IRQ Flag — This read-only status bit indicates when an interrupt request event has occurred. 0 No IRQ request. 1 IRQ event detected.
2 IRQACK	IRQ Acknowledge — This write-only bit is used to acknowledge interrupt request events (write 1 to clear IRQF). Writing 0 has no meaning or effect. Reads always return 0. If edge-and-level detection is selected (IRQMOD = 1), IRQF cannot be cleared while the IRQ pin remains at its asserted level.
1 IRQIE	IRQ Interrupt Enable — This read/write control bit determines whether IRQ events generate an interrupt request. 0 Interrupt request when IRQF set is disabled (use polling). 1 Interrupt requested whenever IRQF = 1.
0 IRQMOD	IRQ Detection Mode — This read/write control bit selects either edge-only detection or edge-and-level detection. The IRQEDG control bit determines the polarity of edges and levels that are detected as interrupt request events. See Section 5.5.2.2, “Edge and Level Sensitivity” for more details. 0 IRQ event on falling edges or rising edges only. 1 IRQ event on falling edges and low levels or on rising edges and high levels.

5.8.2 System Reset Status Register (SRS)

This high page register includes read-only status flags to indicate the source of the most recent reset. When a debug host forces reset by writing 1 to BDFR in the SBDFR register, none of the status bits in SRS will be set. Writing any value to this register address clears the COP watchdog timer without affecting the contents of this register. The reset state of these bits depends on what caused the MCU to reset.

	7	6	5	4	3	2	1	0
R	POR	PIN	COP	ILOP	ILAD	0	LVD	0
W	Writing any value to SRS address clears COP watchdog timer.							
POR:	1	0	0	0	0	0	1	0
LVD:	u ⁽¹⁾	0	0	0	0	0	1	0
Any other reset:	0	Note ⁽²⁾	Note ⁽²⁾	Note ⁽²⁾	Note ⁽²⁾	0	0	0

¹ u = unaffected

² Any of these reset sources that are active at the time of reset entry will cause the corresponding bit(s) to be set; bits corresponding to sources that are not active at the time of reset entry will be cleared.

Figure 5-3. System Reset Status (SRS)

Table 5-4. SRS Register Field Descriptions

Field	Description
7 POR	Power-On Reset — Reset was caused by the power-on detection logic. Because the internal supply voltage was ramping up at the time, the low-voltage reset (LVD) status bit is also set to indicate that the reset occurred while the internal supply was below the LVD threshold. 0 Reset not caused by POR. 1 POR caused reset.
6 PIN	External Reset Pin — Reset was caused by an active-low level on the external reset pin. 0 Reset not caused by external reset pin. 1 Reset came from external reset pin.
5 COP	Computer Operating Properly (COP) Watchdog — Reset was caused by the COP watchdog timer timing out. This reset source can be blocked by COPE = 0. 0 Reset not caused by COP timeout. 1 Reset caused by COP timeout.
4 ILOP	Illegal Opcode — Reset was caused by an attempt to execute an unimplemented or illegal opcode. The STOP instruction is considered illegal if stop is disabled by STOPE = 0 in the SOPT register. The BGND instruction is considered illegal if active background mode is disabled by ENBDM = 0 in the BDCSC register. 0 Reset not caused by an illegal opcode. 1 Reset caused by an illegal opcode.


Table 5-4. SRS Register Field Descriptions

Field	Description
3 ILAD	Illegal Address — Reset was caused by an attempt to access data or an instruction at an unimplemented memory address. 0 Reset not caused by an illegal address. 1 Reset caused by an illegal address.
1 LVD	Low Voltage Detect — If the LVDRE bit is set and the supply drops below the LVD trip voltage, an LVD reset will occur. This bit is also set by POR. 0 Reset not caused by LVD trip or POR. 1 Reset caused by LVD trip or POR.

5.8.3 System Background Debug Force Reset Register (SBDFR)

This high page register contains a single write-only control bit. A serial background command such as WRITE_BYTE must be used to write to SBDFR. Attempts to write this register from a user program are ignored. Reads always return 0x00.

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
W								BDFR ¹
Reset:	0	0	0	0	0	0	0	0

 = Unimplemented or Reserved

¹ BDFR is writable only through serial background debug commands, not from user programs.

Figure 5-4. System Background Debug Force Reset Register (SBDFR)

Table 5-5. SBDFR Register Field Descriptions

Field	Description
0 BDFR	Background Debug Force Reset — A serial background command such as WRITE_BYTE can be used to allow an external debug host to force a target system reset. Writing 1 to this bit forces an MCU reset. This bit cannot be written from a user program. To enter user mode, PTA4/ACMPO/BKGD/MS must be high immediately after issuing WRITE_BYTE command. To enter BDM, PTA4/ACMPO/BKGD/MS must be low immediately after issuing WRITE_BYTE command.

5.8.4 System Options Register 1 (SOPT1)

This high page register is a write-once register, so only the first write after reset is honored. It can be read at any time. Any subsequent attempt to write to SOPT1 (intentionally or unintentionally) is ignored to avoid accidental changes to these sensitive settings. SOPT1 must be written during the user's reset initialization program to set the desired controls even if the desired settings are the same as the reset settings.

	7	6	5	4	3	2	1	0
R	COPE	COPT	STOPE	0	0	0	BKGDPE	RSTPE
W								
Reset:	1	1	0	0	0	0	1	u ⁽¹⁾
POR:	1	1	0	0	0	0	1	0
LVR:	1	1	0	0	0	0	1	0


 = Unimplemented or Reserved

Figure 5-5. System Options Register 1 (SOPT1)

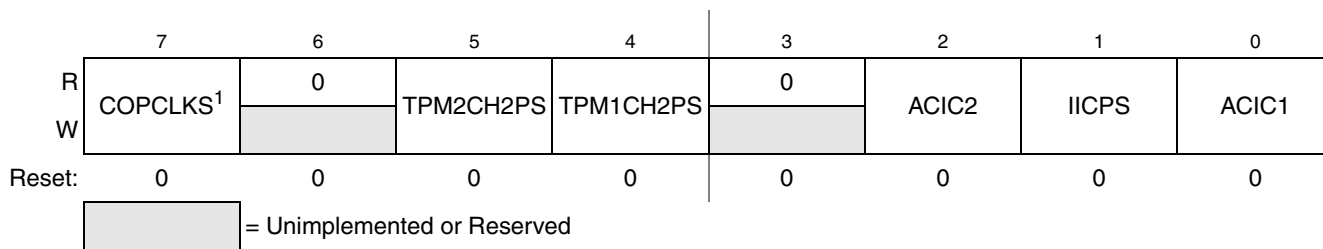
¹ u = unaffected

Table 5-6. SOPT1 Register Field Descriptions

Field	Description
7 COPE	COP Watchdog Enable — This write-once bit selects whether the COP watchdog is enabled. 0 COP watchdog timer disabled. 1 COP watchdog timer enabled (force reset on timeout).
6 COPT	COP Watchdog Timeout — This write-once bit selects the timeout period of the COP. COPT along with COPCLKS in SOPT2 defines the COP timeout period. 0 Short timeout period selected. 1 Long timeout period selected.
5 STOPE	Stop Mode Enable — This write-once bit is used to enable stop mode. If stop mode is disabled and a user program attempts to execute a STOP instruction, an illegal opcode reset is forced. 0 Stop mode disabled. 1 Stop mode enabled.
1 BKGDPE	Background Debug Mode Pin Enable — This write-once bit when set enables the PTA4/ACMPO/BKGD/MS pin to function as BKGD/MS. When clear, the pin functions as one of its output only alternative functions. This pin defaults to the BKGD/MS function following any MCU reset. 0 PTA4/ACMPO/BKGD/MS pin functions as PTA4 or ACMPO. 1 PTA4/ACMPO/BKGD/MS pin functions as BKGD/MS.
0 RSTPE	RESET Pin Enable — This write-once bit when set enables the PTA5/IRQ/TCLK/RESET pin to function as RESET. When clear, the pin functions as one of its input only alternative functions. This pin defaults to its PTA5 function following an MCU POR. When RSTPE is set, an internal pullup device is enabled on RESET. 0 PTA5/IRQ/TCLK/RESET pin functions as PTA5, IRQ or TCLK. 1 PTA5/IRQ/TCLK/RESET pin functions as RESET.

5.8.5 System Options Register 2 (SOPT2)

This high page register contains bits to configure MCU specific features on the MC9S08QE8 series devices.



¹ This bit can be written only one time after reset. Additional writes are ignored.

Figure 5-6. System Options Register 2 (SOPT2)

Table 5-7. SOPT2 Register Field Descriptions

Field	Description
7 COPCLKS	COP Watchdog Clock Select — This write-once bit selects the clock source of the COP watchdog. 0 Internal 1 kHz clock is source to COP. 1 Bus clock is source to COP.
5 TPM2CH2PS	TPM2CH2 Pin Select — This bit selects the location of the TPM2CH2 pins of the TPM2 module. 0 TPM2CH2 on PTA7. 1 TPM2CH2 on PTC1.
4 TPM1CH2PS	TPM1CH2 Pin Select — This bit selects the location of the TPM1CH2 pins of the TPM1 module. 0 TPM1CH2 on PTA6. 1 TPM1CH2 on PTC0.
2 ACIC2	Analog Comparator 2 to Input Capture Enable — This bit connects the output of ACMP2 to TPM2 input channel 0. See Chapter 9, “Analog Comparator (S08ACMPVLPV1)” , and Chapter 16, “Timer/Pulse-Width Modulator (S08TPMV3)” , for more details on this feature. 0 ACMP2 output not connected to TPM2 input channel 0. 1 ACMP2 output connected to TPM2 input channel 0.
1 IICPS	IIC Pin Select — This bit selects the location of the SDA and SCL pins of the IIC module. 0 SDA on PTA2, SCL on PTA3. 1 SDA on PTB6, SCL on PTB7.
0 ACIC1	Analog Comparator 1 to Input Capture Enable — This bit connects the output of ACMP1 to TPM1 input channel 0. See Chapter 9, “Analog Comparator (S08ACMPVLPV1)” , and Chapter 16, “Timer/Pulse-Width Modulator (S08TPMV3)” , for more details on this feature. 0 ACMP output not connected to TPM1 input channel 0. 1 ACMP output connected to TPM1 input channel 0.

5.8.6 System Device Identification Register (SDIDH, SDIDL)

These high page read-only registers are included so host development systems can identify the HCS08 derivative. This allows the development software to recognize where specific memory blocks, registers, and control bits are located in a target MCU.

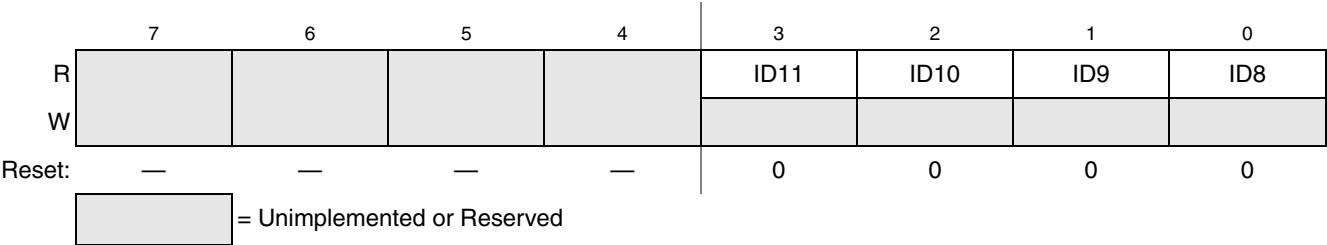


Figure 5-7. System Device Identification Register — High (SDIDH)

Table 5-8. SDIDH Register Field Descriptions

Field	Description
7:4 Reserved	Bits 7:4 are reserved. Reading these bits will result in an indeterminate value; writes have no effect.
3:0 ID[11:8]	Part Identification Number — Each derivative in the HCS08 family has a unique identification number. The MC9S08QE8 is hard coded to the value 0x01C. See also ID bits in Table 5-9 .

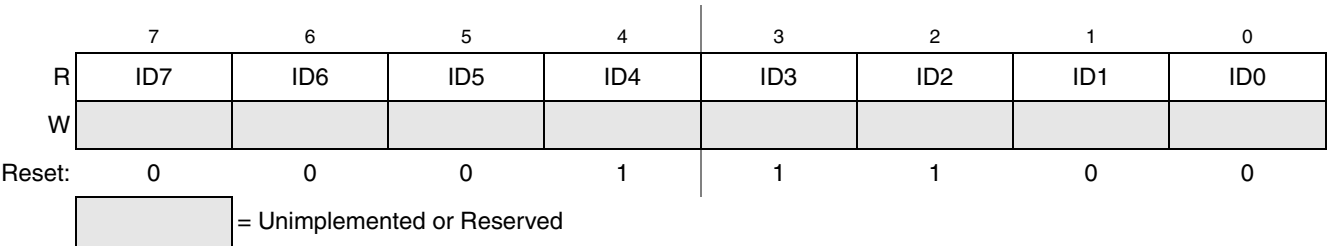


Figure 5-8. System Device Identification Register — Low (SDIDL)

Table 5-9. SDIDL Register Field Descriptions

Field	Description
7:0 ID[7:0]	Part Identification Number — Each derivative in the HCS08 family has a unique identification number. The MC9S08QE8 is hard coded to the value 0x01C. See also ID bits in Table 5-8 .

5.8.7 System Power Management Status and Control 1 Register (SPMSC1)

This high page register contains status and control bits to support the low voltage detect function, and to enable the bandgap voltage reference for use by the ADC or ACMP modules. To configure the low voltage detect trip voltage, see [Table 5-12](#) for the LVDV bit description in SPMSC3.

	7	6	5	4	3	2	1	0
R	LVDF	0	LVDIE	LVDRE ²	LVDSE	LVDE ²	0	BGBE
W		LVDACK						
Reset:	0	0	0	1	1	1	0	0
Stop2 wakeup:	u	0	u	u	u	u	0	u

= Unimplemented or Reserved u = Unaffected by reset

¹ Bit 1 is a reserved bit that must always be written to 0.

² This bit can be written only one time after reset. Additional writes are ignored.

Figure 5-9. System Power Management Status and Control 1 Register (SPMSC1)

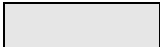
Table 5-10. SPMSC1 Register Field Descriptions

Field	Description
7 LVDF	Low-Voltage Detect Flag — Provided LVDE = 1, this read-only status bit indicates a low-voltage detect event.
6 LVDACK	Low-Voltage Detect Acknowledge — This write-only bit is used to acknowledge low voltage detection errors (write 1 to clear LVDF). Reads always return 0.
5 LVDIE	Low-Voltage Detect Interrupt Enable — This bit enables hardware interrupt requests for LVDF. 0 Hardware interrupt disabled (use polling). 1 Request a hardware interrupt when LVDF = 1.
4 LVDRE	Low-Voltage Detect Reset Enable — This write-once bit enables LVDF events to generate a hardware reset (provided LVDE = 1). 0 LVDF does not generate hardware resets. 1 Force an MCU reset when LVDF = 1.
3 LVDSE	Low-Voltage Detect Stop Enable — Provided LVDE = 1, this read/write bit determines whether the low-voltage detect function operates when the MCU is in stop mode. 0 Low-voltage detect disabled during stop mode. 1 Low-voltage detect enabled during stop mode.
2 LVDE	Low-Voltage Detect Enable — This write-once bit enables low-voltage detect logic and qualifies the operation of other bits in this register. 0 LVD logic disabled. 1 LVD logic enabled.
0 BGBE	Bandgap Buffer Enable — This bit enables an internal buffer for the bandgap voltage reference for use by the ADC module on one of its internal channels or as a voltage reference for ACMP module. For proper operation of the bandgap voltage reference in stop3, the MCU's voltage regulator must remain active during stop3 mode. 0 Bandgap buffer disabled. 1 Bandgap buffer enabled.

5.8.8 System Power Management Status and Control 2 Register (SPMSC2)

This high page register contains status and control bits to configure the low power run and wait modes as well as configure the stop mode behavior of the MCU. See [Section 3.3.1, “Low Power Run Mode \(LPRun\),”](#) [Section 3.5.1, “Low Power Wait Mode \(LPWait\),”](#) and [Section 3.6, “Stop Modes,”](#) for more information.

	7	6	5	4	3	2	1	0
R	LPR	LPRS	LPWUI	0	PPDF	0	PPDE ¹	PPDC
W						PPDACK		
Reset:	0	0	0	0	0	0	1	0
Stop2 wakeup:	0	0	u	0	1	0	1	1

 = Unimplemented or Reserved u = Unaffected by reset

¹ This bit can be written only one time after reset. Additional writes are ignored.

Figure 5-10. System Power Management Status and Control 2 Register (SPMSC2)

Table 5-11. SPMSC2 Register Field Descriptions

Field	Description
7 LPR	Low Power Regulator Control — The LPR bit controls entry into the low power run and wait modes in which the voltage regulator is put into standby. This bit cannot be set if PPDC=1. If PPDC and LPR are set in a single write instruction, only PPDC will actually be set. Automatically cleared when LPWUI is set and an interrupt occurs. 0 Low power run and wait modes are disabled. 1 Low power run and wait modes are enabled.
6 LPRS	Low Power Regulator Status — This read-only status bit indicates that the voltage regulator has entered standby for the low power run or wait mode. 0 The voltage regulator is not currently in standby. 1 The voltage regulator is currently in standby.
5 LPWUI	Low Power Wake Up on Interrupt — This bit controls whether or not the voltage regulator exits standby when any active MCU interrupt occurs. 0 The voltage regulator will remain in standby on an interrupt. 1 The voltage regulator will exit standby on an interrupt.
3 PPDF	Partial Power Down Flag — This read-only status bit indicates that the MCU has recovered from stop2 mode. 0 MCU has not recovered from stop2 mode. 1 MCU recovered from stop2 mode.
2 PPDACK	Partial Power Down Acknowledge — Writing a 1 to PPDACK clears the PPDF bit.
1 PPDE	Partial Power Down Enable — The write-once PPDE bit can be used to “lockout” the partial power down mode. 0 Partial power down is not enabled. 1 Partial power down is enabled and controlled via the PPDC bit.
0 PPDC	Partial Power Down Control — The PPDC bit controls which power down mode is selected. This bit cannot be set if LPR=1. If PPDC and LPR are set in a single write instruction, only PPDC will actually be set. 0 Stop3 low power mode enabled. 1 Stop2 partial power down mode enabled.

5.8.9 System Power Management Status and Control 3 Register (SPMSC3)

This high page register is used to report the status of the low voltage warning function and to select the low voltage detect trip voltage.

	7	6	5	4	3	2	1	0
R	LVWF	0	—	—	LVWIE	0	0	0
W		LVWACK						
Reset:	0 ¹	0	0	0	0	0	0	0
Stop2 wakeUp:	u	0	u	u	u	0	0	0

= Unimplemented or Reserved
 u = Unaffected by reset

¹ LVWF will be set if V_{Supply} transitions below the trip point or after reset and V_{Supply} is already below V_{LVW} .

Figure 5-11. System Power Management Status and Control 3 Register (SPMSC3)

Table 5-12. SPMSC3 Register Field Descriptions

Field	Description
7 LVWF	Low-Voltage Warning Flag — The LVWF bit indicates the low voltage warning status. 0 Low voltage warning not present. 1 Low voltage warning is present or was present.
6 LVWACK	Low-Voltage Warning Acknowledge — The LVWF bit indicates the low voltage warning status. Writing a 1 to LVWACK clears LVWF to a 0 if a low voltage warning is not present.
3 LVWIE	Low-Voltage Warning Interrupt Enable — This bit enables hardware interrupt requests for LVWF. 0 Hardware interrupt disabled (use polling). 1 Request a hardware interrupt when LVWF = 1.

Table 5-13. LVD and LVW trip point typical values¹

LVW Trip Point	LVD Trip Point
$V_{LVW} = 2.14\text{ V}$	$V_{LVD} = 1.84\text{ V}$

¹ See *MC9S08QE8 Series Data Sheet* for minimum and maximum values.

5.8.10 System Clock Gating Control 1 Register (SCGC1)

This high page register contains control bits to enable or disable the bus clock to the TPMx, ADC, IIC, and SCI modules. Gating off the clocks to unused peripherals is used to reduce the MCU's run and wait currents. See [Section 5.7, “Peripheral Clock Gating,”](#) for more information.

NOTE

User software must disable the peripheral before disabling the clocks to the peripheral. When clocks are re-enabled to a peripheral, the peripheral registers need to be re-initialized by user software.

	7	6	5	4	3	2	1	0
R	1	TPM2	TPM1	ADC	1	IIC	1	SCI
W	—				—		—	
Reset:	1	1	1	1	1	1	1	1

Figure 5-12. System Clock Gating Control 1 Register (SCGC1)

Table 5-14. SCGC1 Register Field Descriptions

Field	Description
6 TPM2	TPM2 Clock Gate Control — This bit controls the clock gate to the TPM2 module. 0 Bus clock to the TPM2 module is disabled. 1 Bus clock to the TPM2 module is enabled.
5 TPM1	TPM1 Clock Gate Control — This bit controls the clock gate to the TPM1 module. 0 Bus clock to the TPM1 module is disabled. 1 Bus clock to the TPM1 module is enabled.
4 ADC	ADC Clock Gate Control — This bit controls the clock gate to the ADC module. 0 Bus clock to the ADC module is disabled. 1 Bus clock to the ADC module is enabled.
2 IIC	IIC Clock Gate Control — This bit controls the clock gate to the IIC module. 0 Bus clock to the IIC module is disabled. 1 Bus clock to the IIC module is enabled.
0 SCI	SCI Clock Gate Control — This bit controls the clock gate to the SCI module. 0 Bus clock to the SCI module is disabled. 1 Bus clock to the SCI module is enabled.

5.8.11 System Clock Gating Control 2 Register (SCGC2)

This high page register contains control bits to enable or disable the bus clock to the RTC and SPIx modules. Gating off the clocks to unused peripherals is used to reduce the MCU's run and wait currents. See [Section 5.7, “Peripheral Clock Gating,”](#) for more information.

NOTE

User software must disable the peripheral before disabling the clocks to the peripheral. When clocks are re-enabled to a peripheral, the peripheral registers need to be re-initialized by user software.

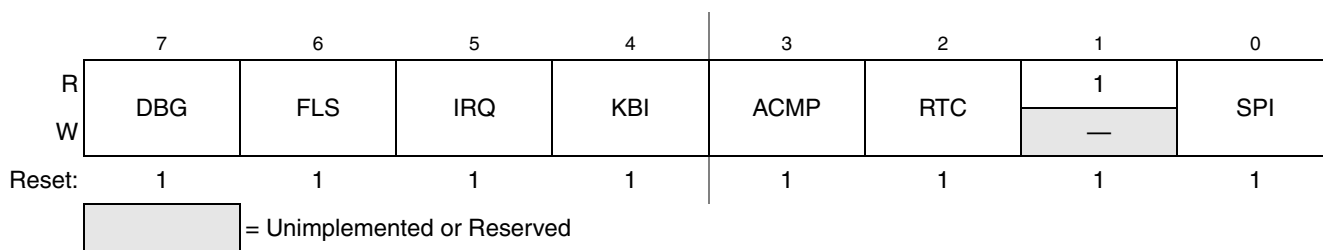


Figure 5-13. System Clock Gating Control 2 Register (SCGC2)

Table 5-15. SCGC2 Register Field Descriptions

Field	Description
7 DBG	DBG Register Clock Gate Control — This bit controls the bus clock gate to the DBG module. 0 Bus clock to the DBG module is disabled. 1 Bus clock to the DBG module is enabled.
6 FLS	Flash Register Clock Gate Control — This bit controls the bus clock gate to the flash registers. This bit does not affect normal program execution from within the flash array. Only the clock to the flash control registers is affected. 0 Bus clock to the flash registers is disabled. 1 Bus clock to the flash registers is enabled.
5 IRQ	IRQ Clock Gate Control — This bit controls the bus clock gate to the IRQ module. 0 Bus clock to the IRQ module is disabled. 1 Bus clock to the IRQ module is enabled.
4 KBI	KBI Clock Gate Control — This bit controls the clock gate to the KBI module. 0 Bus clock to the KBI module is disabled. 1 Bus clock to the KBI module is enabled.
3 ACMP	ACMP Clock Gate Control — This bit controls the clock gate to both of the ACMP modules. 0 Bus clock to the ACMP modules is disabled. 1 Bus clock to the ACMP modules is enabled.
2 RTC	RTC Clock Gate Control — This bit controls the bus clock gate to the RTC module. Only the bus clock is gated, the IC SERCLK and LPOCLK are still available to the RTC. 0 Bus clock to the RTC module is disabled. 1 Bus clock to the RTC module is enabled.
0 SPI	SPI Clock Gate Control — This bit controls the clock gate to the SPI module. 0 Bus clock to the SPI module is disabled. 1 Bus clock to the SPI module is enabled.

Chapter 6

Parallel Input/Output Control

This chapter explains software controls related to parallel input/output (I/O) and pin control. The MC9S08QE8 has four parallel I/O ports which include a total of 26 I/O pins, one output-only pin and one input-only pin. See [Chapter 2, “Pins and Connections,”](#) for more information about pin assignments and external hardware considerations of these pins.

Many of these pins are shared with on-chip peripherals such as timer systems, communication systems, or keyboard interrupts, as shown in [Table 2-1](#). The peripheral modules have priority over the general-purpose I/O functions so that when a peripheral is enabled, the I/O functions associated with the shared pins may be disabled.

After reset, the shared peripheral functions are disabled and the pins are configured as inputs ($PTxDDn = 0$). The pin control functions for each pin are configured as follows: slew rate control enabled ($PTxSEn = 1$), low drive strength selected ($PTxDSn = 0$), and internal pullups disabled ($PTxPEn = 0$).

NOTE

Not all general-purpose I/O pins are available on all packages. To avoid extra current drain from floating input pins, the user's reset initialization routine in the application program must either enable on-chip pullup devices or change the direction of unconnected pins to outputs so the pins do not float.

6.1 Port Data and Data Direction

Reading and writing of parallel I/Os are performed through the port data registers. The direction, either input or output, is controlled through the port data direction registers. The parallel I/O port function for an individual pin is illustrated in the block diagram shown in [Figure 6-1](#).

The data direction control bit ($PTxDDn$) determines whether the output buffer for the associated pin is enabled, and also controls the source for port data register reads. The input buffer for the associated pin is always enabled unless the pin is enabled as an analog function or is an output-only pin.

When a shared digital function is enabled for a pin, the output buffer is controlled by the shared function. However, the data direction register bit will continue to control the source for reads of the port data register.

When a shared analog function is enabled for a pin, both the input and output buffers are disabled. A value of 0 is read for any port data bit where the bit is an input ($PTxDDn = 0$) and the input buffer is disabled. In general, whenever a pin is shared with both an alternate digital function and an analog function, the analog function has priority such that if both the digital and analog functions are enabled, the analog function controls the pin.

Write to the port data register before changing the direction of a port pin so it becomes an output. This ensures that the pin will not be driven momentarily with an old data value that happened to be in the port data register.

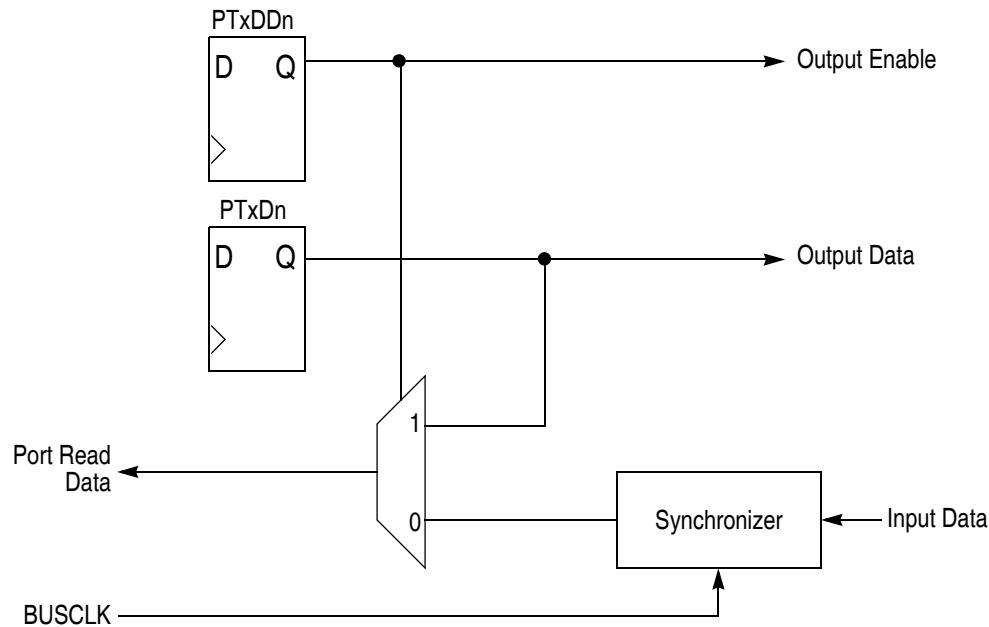


Figure 6-1. Parallel I/O Block Diagram

6.2 Pullup, Slew Rate, and Drive Strength

Associated with the parallel I/O ports is a set of registers located in the high page register space that operate independently of the parallel I/O registers. These registers are used to control pullups, slew rate, and drive strength for the pins and may be used in conjunction with the peripheral functions on these pins.

6.2.1 Port Internal Pullup Enable

An internal pullup device can be enabled for each port pin by setting the corresponding bit in the pullup enable register (PTxPEn). The pullup device is disabled if the pin is configured as an output by the parallel I/O control logic or any shared peripheral function regardless of the state of the corresponding pullup enable register bit. The pullup device is also disabled if the pin is controlled by an analog function.

6.2.2 Port Slew Rate Enable

Slew rate control can be enabled for each port pin by setting the corresponding bit in the slew rate control register (PTxSEn). When enabled, slew control limits the rate at which an output can transition in order to reduce EMC emissions. Slew rate control has no effect on pins that are configured as inputs.

6.2.3 Port Drive Strength Select

An output pin can be configured for high output drive strength by setting the corresponding bit in the drive strength select register (PTxDSn). When high drive is selected, a pin is capable of sourcing and sinking

greater current. Even though every I/O pin can be selected as high drive, the user must ensure that the total current source and sink limits for the MCU are not exceeded. Drive strength selection affects the DC behavior of I/O pins. However, the AC behavior is also affected. High drive allows a pin to drive a greater load with the same switching speed as a low drive enabled pin into a smaller load. Because of this, the EMC emissions may be affected by enabling pins as high drive.

6.3 Pin Behavior in Stop Modes

Pin behavior following execution of a STOP instruction depends on the stop mode that is entered. An explanation of pin behavior for the various stop modes follows:

- Stop2 mode is a partial power-down mode, whereby I/O latches are maintained in their pre-STOP instruction state. CPU register status and the state of I/O registers must be saved in RAM before the STOP instruction is executed to place the MCU in stop2 mode. Upon recovery from stop2 mode, before accessing any I/O, the user must examine the state of the PPDF bit in the SPMSC2 register. If the PPDF bit is 0, I/O must be initialized as if a power-on reset had occurred. If the PPDF bit is 1, I/O register states must be restored from the values saved in RAM before the STOP instruction was executed. Peripherals may require initialization or restoration to their pre-stop condition. The user must then write a 1 to the PPDACK bit in the SPMSC2 register. Access to I/O is again permitted in the user application program.
- In stop3 mode, all I/O is maintained because internal logic circuitry stays powered up. Upon recovery, normal I/O function is available to the user.

6.4 Parallel I/O and Pin Control Registers

This section provides information about the registers associated with the parallel I/O ports. The data and data direction registers are located in page zero of the memory map. The pull up, slew rate, drive strength, and interrupt control registers are located in the high page section of the memory map.

Refer to tables in [Chapter 4, “Memory,”](#) for the absolute address assignments for all parallel I/O and their pin control registers. This section refers to registers and control bits only by their names. A Freescale Semiconductor-provided equate or header file is normally to translate these names into the appropriate absolute addresses.

6.4.1 Port A Registers

Port A is controlled by the registers listed below.

The pins PTA4 and PTA5 are unique. PTA4 is an output only, so the control bits for the input functions will not have any effect on this pin. PTA5 is an input only, so the control bits for the output functions will not have any effect on this pin.

6.4.1.1 Port A Data Register (PTAD)

	7	6	5	4	3	2	1	0
R	PTAD7	PTAD6	PTAD5 ¹	PTAD4 ²	PTAD3	PTAD2	PTAD1	PTAD0
W								
Reset:	0	0	0	0	0	0	0	0

¹ Reads of bit PTAD5 always return the pin value of PTA5, regardless of the value stored in bit PTADD5.

² Reads of bit PTAD4 always return the contents of PTAD4, regardless of the value stored in bit PTADD4.

Figure 6-2. Port A Data Register (PTAD)

Table 6-1. PTAD Register Field Descriptions

Field	Description
7:0 PTAD[7:0]	Port A Data Register Bits — For port A pins that are inputs, reads return the logic level on the pin. For port A pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port A pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTAD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups/pulldowns disabled.

6.4.1.2 Port A Data Direction Register (PTADD)

	7	6	5	4	3	2	1	0
R	PTADD7	PTADD6	PTADD5 ¹	PTADD4 ²	PTADD3	PTADD2	PTADD1	PTADD0
W								
Reset:	0	0	0	0	0	0	0	0

¹ Writing to PTADD5 has no effect on the input-only PTA5 pin.

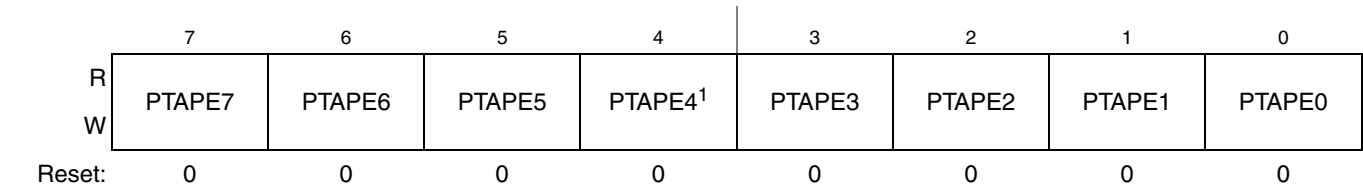
² Writing to PTADD4 has no effect on the output-only PTA4 pin.

Figure 6-3. Port A Data Direction Register (PTADD)

Table 6-2. PTADD Register Field Descriptions

Field	Description
7:0 PTADD[7:0]	Data Direction for Port A Bits — These read/write bits control the direction of port A pins and what is read for PTAD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port A bit n and PTAD reads return the contents of PTADn.

6.4.1.3 Port A Pull Enable Register (PTAPE)



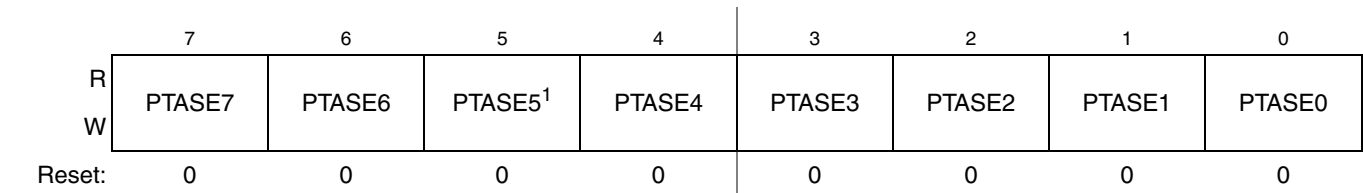
¹ PTAPE4 has no effect on the output only PTA4 pin.

Figure 6-4. Internal Pull Enable for Port A Register (PTAPE)

Table 6-3. PTAPE Register Field Descriptions

Field	Description
7:0 PTAPE[7:0]	Internal Pull Enable for Port A Bits — Each of these control bits determines if the internal pullup or pulldown device is enabled for the associated PTA pin. For port A pins that are configured as outputs, these bits have no effect and the internal pull devices are disabled. 0 Internal pullup/pulldown device disabled for port A bit n. 1 Internal pullup/pulldown device enabled for port A bit n.

6.4.1.4 Port A Slew Rate Enable Register (PTASE)



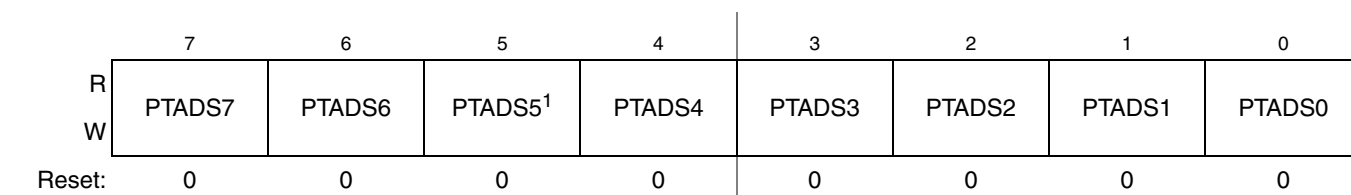
¹ PTASE5 will have no effect on the input only PTA5 pin.

Figure 6-5. Slew Rate Enable for Port A Register (PTASE)

Table 6-4. PTASE Register Field Descriptions

Field	Description
7:0 PTASE[7:0]	Output Slew Rate Enable for Port A Bits — Each of these control bits determines if the output slew rate control is enabled for the associated PTA pin. For port A pins that are configured as inputs, these bits have no effect. 0 Output slew rate control disabled for port A bit n. 1 Output slew rate control enabled for port A bit n.

6.4.1.5 Port A Drive Strength Selection Register (PTADS)



¹ PTADS5 will have no effect on the input only PTA5 pin.

Figure 6-6. Drive Strength Selection for Port A Register (PTADS)

Table 6-5. PTADS Register Field Descriptions

Field	Description
7:0 PTADS[7:0]	Output Drive Strength Selection for Port A Bits — Each of these control bits selects between low and high output drive for the associated PTA pin. For port A pins that are configured as inputs, these bits have no effect. 0 Low output drive strength selected for port A bit n. 1 High output drive strength selected for port A bit n.

6.4.2 Port B Registers

Port B is controlled by the registers listed below.

6.4.2.1 Port B Data Register (PTBD)

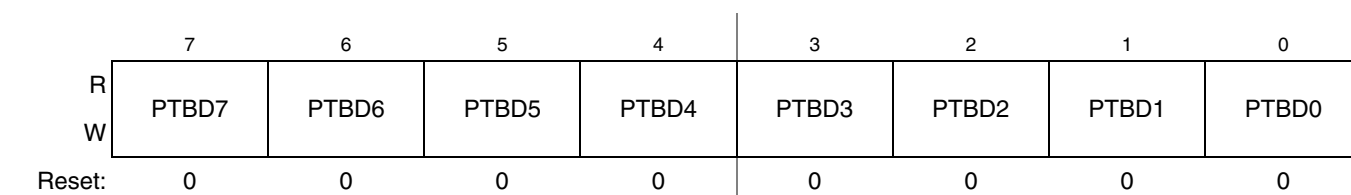


Figure 6-7. Port B Data Register (PTBD)

Table 6-6. PTBD Register Field Descriptions

Field	Description
7:0 PTBD[7:0]	Port B Data Register Bits — For port B pins that are inputs, reads return the logic level on the pin. For port B pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port B pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTBD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups/pulldowns disabled.

6.4.2.2 Port B Data Direction Register (PTBDD)

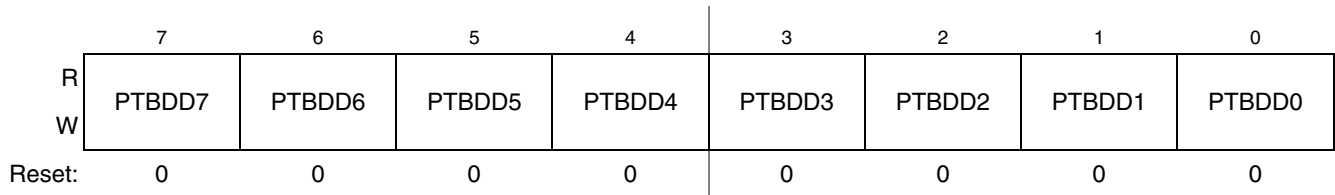


Figure 6-8. Port B Data Direction Register (PTBDD)

Table 6-7. PTBDD Register Field Descriptions

Field	Description
7:0 PTBDD[7:0]	Data Direction for Port B Bits — These read/write bits control the direction of port B pins and what is read for PTBD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port B bit n and PTBD reads return the contents of PTBDn.

6.4.2.3 Port B Pull Enable Register (PTBPE)

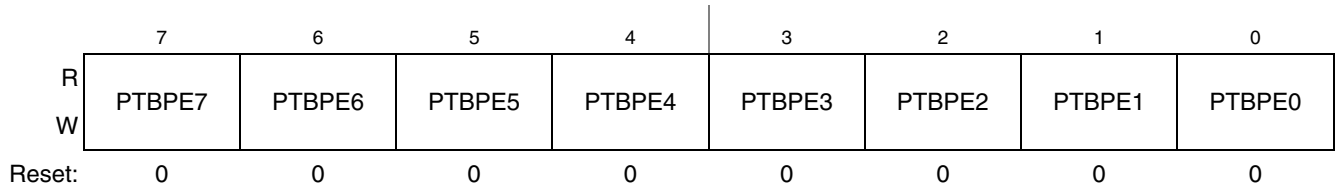


Figure 6-9. Internal Pull Enable for Port B Register (PTBPE)

Table 6-8. PTBPE Register Field Descriptions

Field	Description
7:0 PTBPE[7:0]	Internal Pull Enable for Port B Bits — Each of these control bits determines if the internal pullup or pulldown device is enabled for the associated PTB pin. For port B pins that are configured as outputs, these bits have no effect and the internal pull devices are disabled. 0 Internal pullup/pulldown device disabled for port B bit n. 1 Internal pullup/pulldown device enabled for port B bit n.

6.4.2.4 Port B Slew Rate Enable Register (PTBSE)

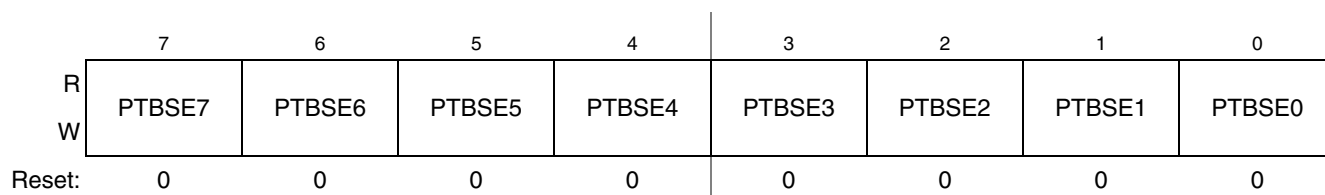


Figure 6-10. Slew Rate Enable for Port B Register (PTBSE)

Table 6-9. PTBSE Register Field Descriptions

Field	Description
7:0 PTBSE[7:0]	Output Slew Rate Enable for Port B Bits — Each of these control bits determines if the output slew rate control is enabled for the associated PTB pin. For port B pins that are configured as inputs, these bits have no effect. 0 Output slew rate control disabled for port B bit n. 1 Output slew rate control enabled for port B bit n.

6.4.2.5 Port B Drive Strength Selection Register (PTBDS)

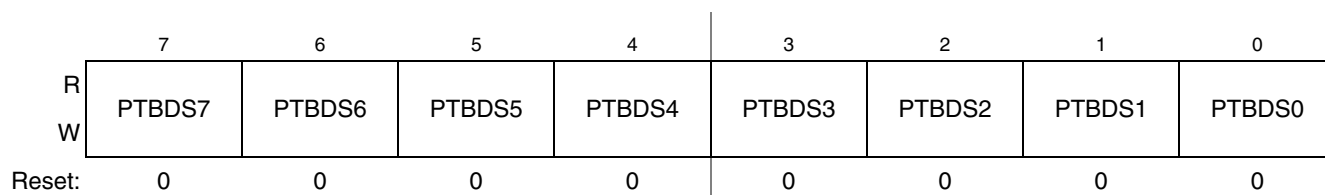


Figure 6-11. Drive Strength Selection for Port B Register (PTBDS)

Table 6-10. PTBDS Register Field Descriptions

Field	Description
7:0 PTBDS[7:0]	Output Drive Strength Selection for Port B Bits — Each of these control bits selects between low and high output drive for the associated PTB pin. For port B pins that are configured as inputs, these bits have no effect. 0 Low output drive strength selected for port B bit n. 1 High output drive strength selected for port B bit n.

6.4.3 Port C Registers

Port C is controlled by the registers listed below.

6.4.3.1 Port C Data Register (PTCD)

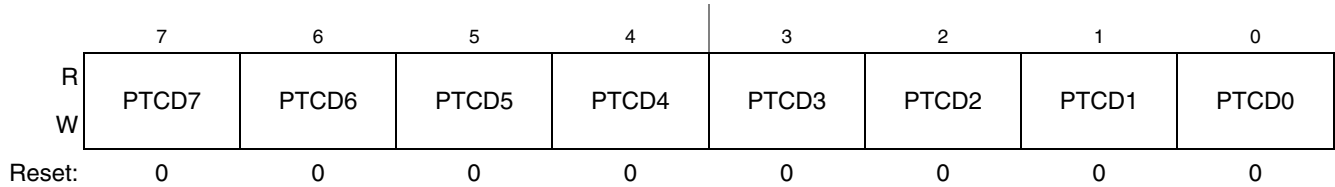


Figure 6-12. Port C Data Register (PTCD)

Table 6-11. PTCD Register Field Descriptions

Field	Description
7:0 PTCD[7:0]	Port C Data Register Bits — For port C pins that are inputs, reads return the logic level on the pin. For port C pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port C pins that are configured as outputs, the logic level is driven out of the corresponding MCU pin. Reset forces PTCD to all 0s, but these 0s are not driven out of the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups disabled.

6.4.3.2 Port C Data Direction Register (PTCDD)

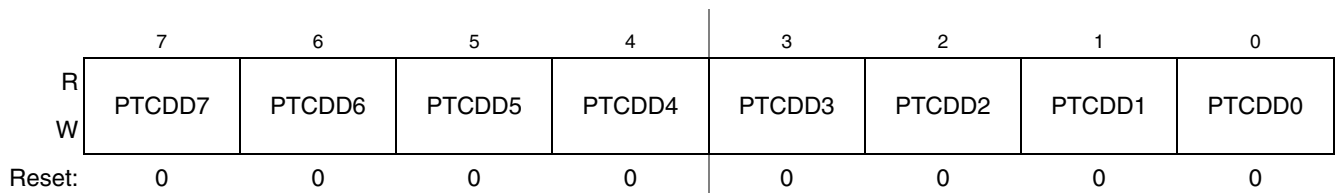


Figure 6-13. Port C Data Direction Register (PTCDD)

Table 6-12. PTCDD Register Field Descriptions

Field	Description
7:0 PTCDD[7:0]	Data Direction for Port C Bits — These read/write bits control the direction of port C pins and what is read for PTCD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port C bit n and PTCD reads return the contents of PTCDn.

6.4.3.3 Port C Pull Enable Register (PTCPE)

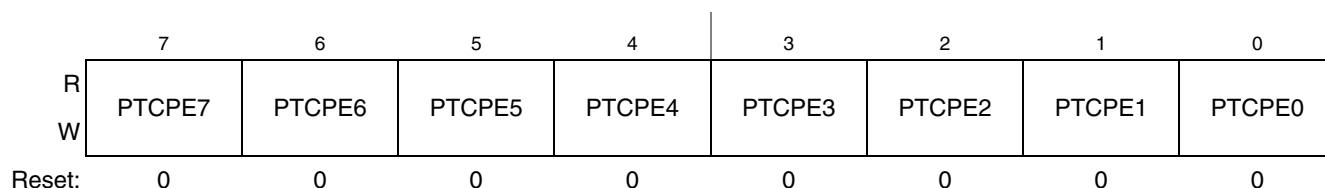


Figure 6-14. Internal Pull Enable for Port C Register (PTCPE)

Table 6-13. PTCPE Register Field Descriptions

Field	Description
7:0 PTCPE[7:0]	Internal Pull Enable for Port C Bits — Each of these control bits determines if the internal pullup device is enabled for the associated PTC pin. For port C pins that are configured as outputs, these bits have no effect and the internal pull devices are disabled. 0 Internal pullup device disabled for port C bit n. 1 Internal pullup device enabled for port C bit n.

6.4.3.4 Port C Slew Rate Enable Register (PTCSE)

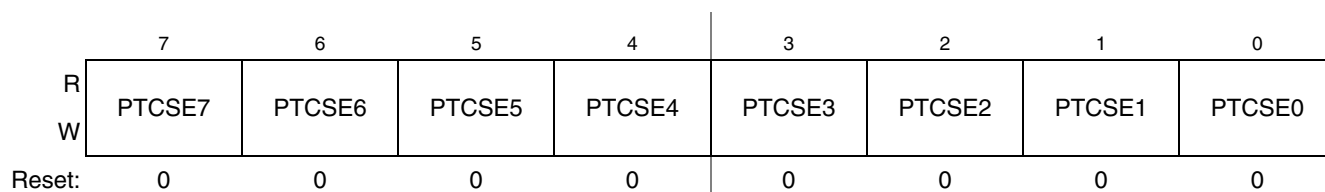


Figure 6-15. Slew Rate Enable for Port C Register (PTCSE)

Table 6-14. PTCSE Register Field Descriptions

Field	Description
7:0 PTCSE[7:0]	Output Slew Rate Enable for Port C Bits — Each of these control bits determines if the output slew rate control is enabled for the associated PTC pin. For port C pins that are configured as inputs, these bits have no effect. 0 Output slew rate control disabled for port C bit n. 1 Output slew rate control enabled for port C bit n.

6.4.3.5 Port C Drive Strength Selection Register (PTCDS)

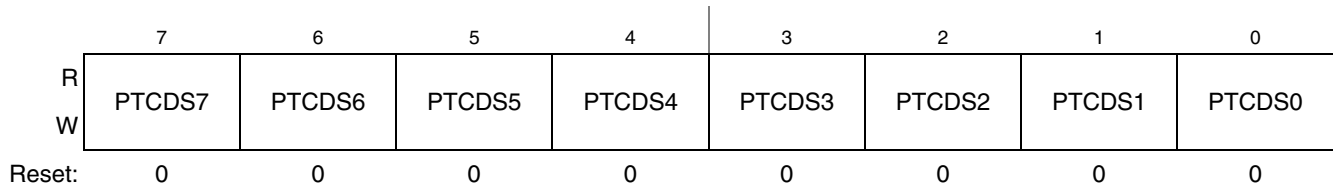


Figure 6-16. Drive Strength Selection for Port C Register (PTCDS)

Table 6-15. PTCDS Register Field Descriptions

Field	Description
7:0 PTCDS[7:0]	Output Drive Strength Selection for Port C Bits — Each of these control bits selects between low and high output drive for the associated PTC pin. For port C pins that are configured as inputs, these bits have no effect. 0 Low output drive strength selected for port C bit n. 1 High output drive strength selected for port C bit n.

6.4.4 Port D Registers

Port D is controlled by the registers listed below.

6.4.4.1 Port D Data Register (PTDD)

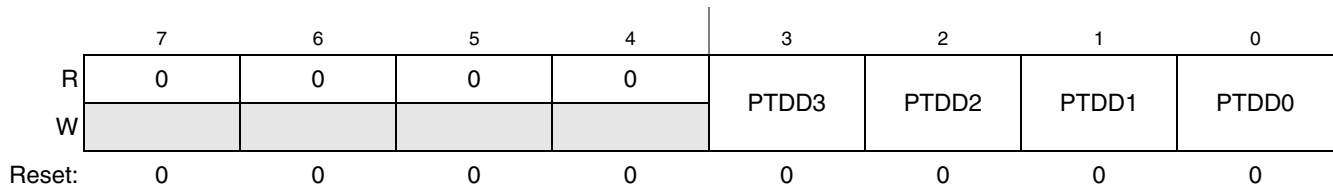


Figure 6-17. Port D Data Register (PTDD)

Table 6-16. PTDD Register Field Descriptions

Field	Description
3:0 PTDD[3:0]	Port D Data Register Bits — For port D pins that are inputs, reads return the logic level on the pin. For port D pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port D pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTDD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups/pulldowns disabled.

6.4.4.2 Port D Data Direction Register (PTDDD)

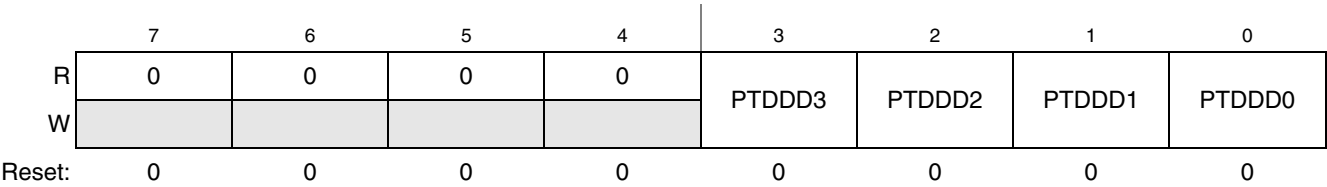


Figure 6-18. Port D Data Direction Register (PTDDD)

Table 6-17. PTDDD Register Field Descriptions

Field	Description
3:0 PTDDD[3:0]	Data Direction for Port D Bits — These read/write bits control the direction of port D pins and what is read for PTDD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port D bit n and PTDD reads return the contents of PTDDn.

6.4.4.3 Port D Pull Enable Register (PTDPE)

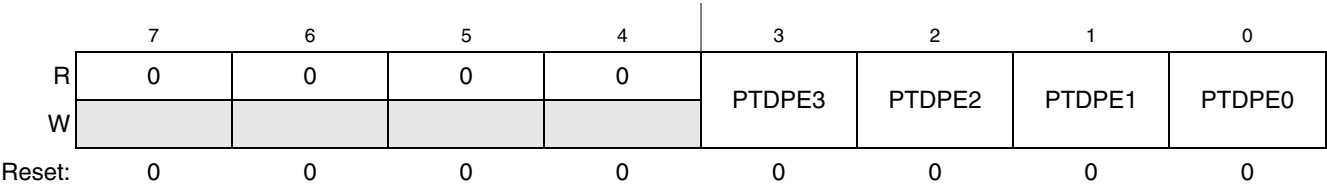


Figure 6-19. Internal Pull Enable for Port D Register (PTDPE)

Table 6-18. PTDPE Register Field Descriptions

Field	Description
3:0 PTDPE[3:0]	Internal Pull Enable for Port D Bits — Each of these control bits determines if the internal pullup or pulldown device is enabled for the associated PTD pin. For port D pins that are configured as outputs, these bits have no effect and the internal pull devices are disabled. 0 Internal pullup/pulldown device disabled for port D bit n. 1 Internal pullup/pulldown device enabled for port D bit n.

6.4.4.4 Port D Slew Rate Enable Register (PTDSE)

	7	6	5	4	3	2	1	0
R	0	0	0	0	PTDSE3	PTDSE2	PTDSE1	PTDSE0
W								
Reset:	0	0	0	0	0	0	0	0

Figure 6-20. Slew Rate Enable for Port D Register (PTDSE)

Table 6-19. PTDSE Register Field Descriptions

Field	Description
3:0 PTDSE[3:0]	Output Slew Rate Enable for Port D Bits — Each of these control bits determines if the output slew rate control is enabled for the associated PTD pin. For port D pins that are configured as inputs, these bits have no effect. 0 Output slew rate control disabled for port D bit n. 1 Output slew rate control enabled for port D bit n.

6.4.4.5 Port D Drive Strength Selection Register (PTDDS)

	7	6	5	4	3	2	1	0
R	0	0	0	0	PTDDS3	PTDDS2	PTDDS1	PTDDS0
W								
Reset:	0	0	0	0	0	0	0	0

Figure 6-21. Drive Strength Selection for Port D Register (PTDDS)

Table 6-20. PTDDS Register Field Descriptions

Field	Description
3:0 PTDDS[3:0]	Output Drive Strength Selection for Port D Bits — Each of these control bits selects between low and high output drive for the associated PTD pin. For port D pins that are configured as inputs, these bits have no effect. 0 Low output drive strength selected for port D bit n. 1 High output drive strength selected for port D bit n.

Chapter 7

Keyboard Interrupt (S08KBIV2)

7.1 Introduction

The keyboard interrupt (KBI) module provides up to eight independently enabled external interrupt sources.

[Figure 7-1](#) shows the device-level block diagram with the KBI module highlighted

7.1.1 KBI Clock Gating

The bus clock to the KBI can be gated on and off using the KBI bit in SCGC2. This bit is set after any reset, which enables the bus clock to this module. To conserve power, this bit can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

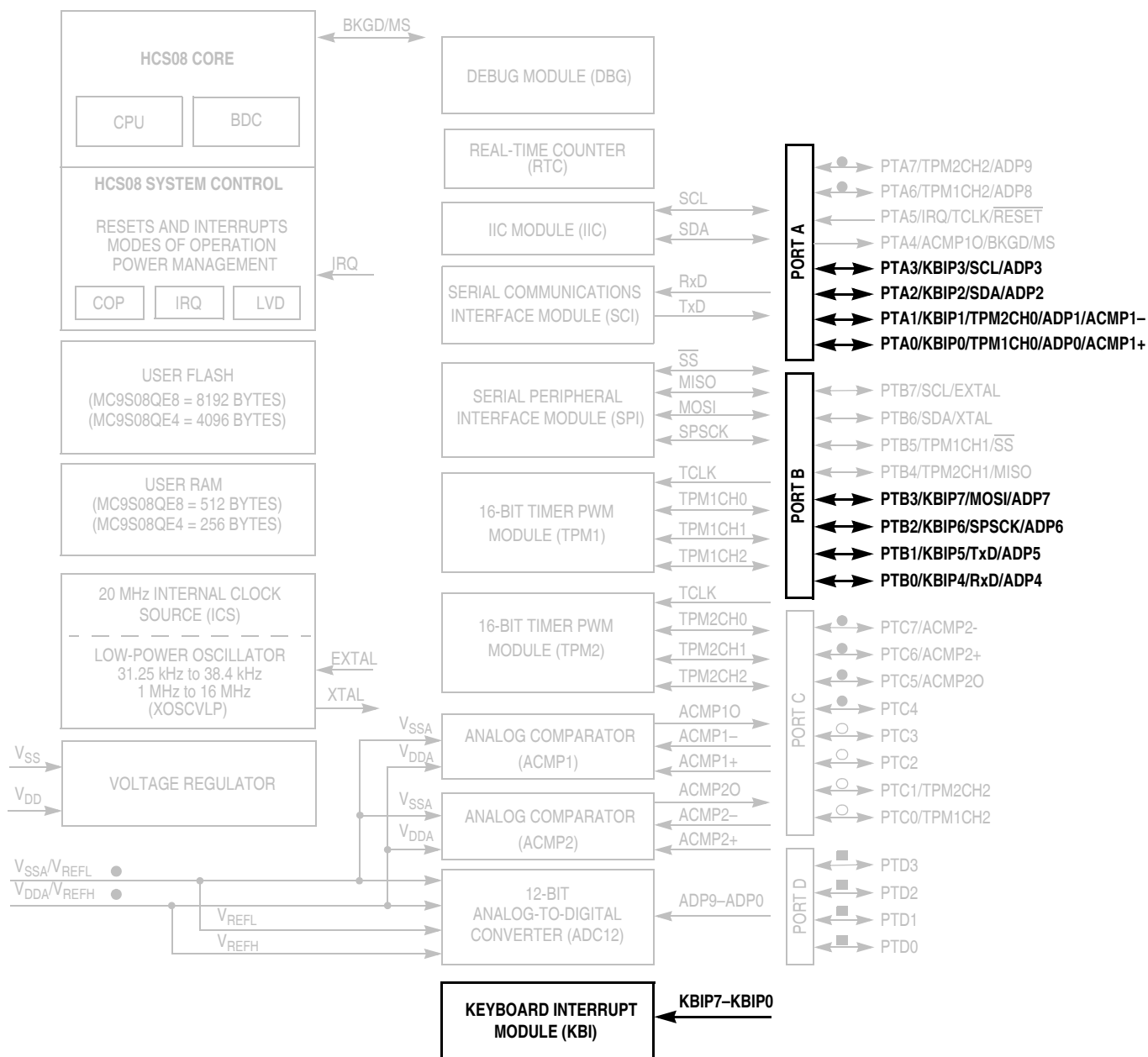


Figure 7-1. MC9S08QE8 Series Block Diagram Highlighting KBI Block and Pins

7.1.2 Features

The KBI features include:

- Up to eight keyboard interrupt pins with individual pin enable bits.
- Each keyboard interrupt pin is programmable as falling edge (or rising edge) only, or both falling edge and low level (or both rising edge and high level) interrupt sensitivity.
- One software enabled keyboard interrupt.
- Exit from low-power modes.

7.1.3 Modes of Operation

This section defines the KBI operation in wait, stop, and background debug modes.

7.1.3.1 KBI in Wait Mode

The KBI continues to operate in wait mode if enabled before executing the WAIT instruction. Therefore, an enabled KBI pin ($KBPEX = 1$) can be used to bring the MCU out of wait mode if the KBI interrupt is enabled ($KBIE = 1$).

7.1.3.2 KBI in Stop Modes

The KBI operates asynchronously in stop3 mode if enabled before executing the STOP instruction. Therefore, an enabled KBI pin ($KBPEX = 1$) can be used to bring the MCU out of stop3 mode if the KBI interrupt is enabled ($KBIE = 1$).

During stop2 mode, the KBI is disabled. Upon wake-up from stop2 mode, the KBI module will be in the reset state.

7.1.3.3 KBI in Active Background Mode

When the microcontroller is in active background mode, the KBI will continue to operate normally.

7.1.4 Block Diagram

The block diagram for the keyboard interrupt module is shown as [Figure 7-2](#).

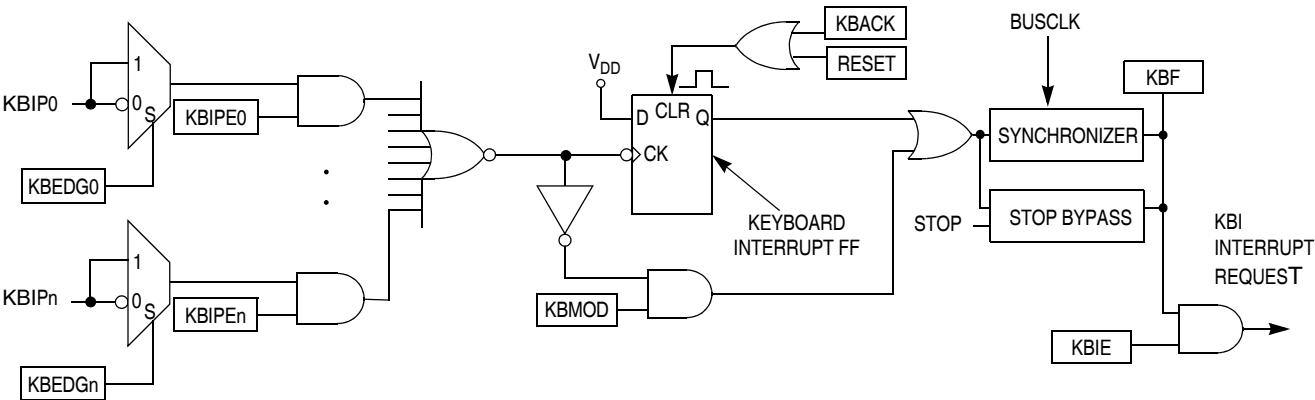


Figure 7-2. Keyboard Interrupt (KBI) Block Diagram

7.2 External Signal Description

The KBI input pins can be used to detect either falling edges, or both falling edge and low level interrupt requests. The KBI input pins can also be used to detect either rising edges, or both rising edge and high level interrupt requests.

Table 7-1. KBI Pin Mapping

Port pin	PTB3	PTB2	PTB1	PTB0	PTA3	PTA2	PTA1	PTA0
KBI pin	KBIP7	KBIP6	KBIP5	KBIP4	KBIP3	KBIP2	KBIP1	KBIP0

7.3 Register Definition

The KBI includes three registers:

- An 8-bit pin status and control register.
- An 8-bit pin enable register.
- An 8-bit edge select register.

Refer to the direct-page register summary in [Chapter 4, “Memory,”](#) for the absolute address assignments for all KBI registers. This section refers to registers and control bits only by their names and relative address offsets.

7.3.1 KBI Interrupt Status and Control Register (KBISC)

	7	6	5	4	3	2	1	0
R	0	0	0	0	KBF	0	KBIE	KBIMOD
W						KBACK		
Reset:	0	0	0	0	0	0	0	0

Figure 7-3. KBI Interrupt Status and Control Register (KBISC)

Table 7-2. KBISC Register Field Descriptions

Field	Description
3 KBF	KBI Interrupt Flag — KBF indicates when a KBI interrupt is detected. Writes have no effect on KBF. 0 No KBI interrupt detected. 1 KBI interrupt detected.
2 KBACK	KBI Interrupt Acknowledge — Writing a 1 to KBACK is part of the flag clearing mechanism. KBACK always reads as 0.
1 KBIE	KBI Interrupt Enable — KBIE determines whether a KBI interrupt is requested. 0 KBI interrupt request not enabled. 1 KBI interrupt request enabled.
0 KBIMOD	KBI Detection Mode — KBIMOD (along with the KBIES bits) controls the detection mode of the KBI interrupt pins. 0 KBI pins detect edges only. 1 KBI pins detect both edges and levels.

7.3.2 KBI Interrupt Pin Select Register (KBIPE)

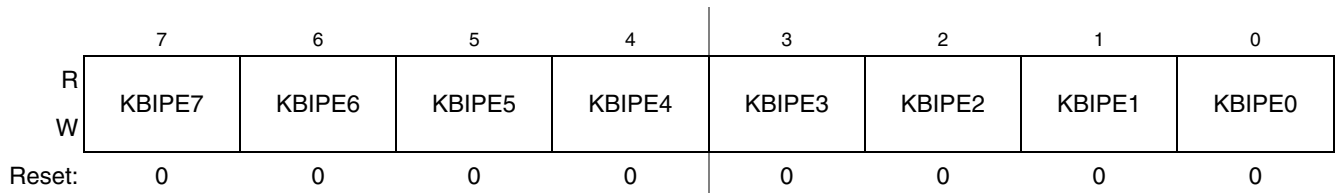


Figure 7-4. KBI Interrupt Pin Select Register (KBIPE)

Table 7-3. KBIXPE Register Field Descriptions

Field	Description
7:0 KBIPE[7:0]	KBI Interrupt Pin Selects — Each of the KBIPE _n bits enable the corresponding KBI interrupt pin. 0 Pin not enabled as interrupt. 1 Pin enabled as interrupt.

7.3.3 KBI Interrupt Edge Select Register (KBIES)

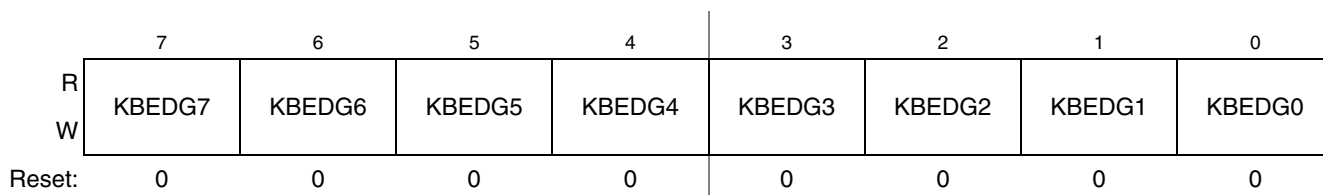


Figure 7-5. KBI Edge Select Register (KBIES)

Table 7-4. KBIES Register Field Descriptions

Field	Description
7:0 KBEDG[7:0]	KBI Edge Selects — Each of the KBEDGn bits serves a dual purpose by selecting the polarity of the active interrupt edge as well as selecting a pullup or pulldown device if enabled. 0 A pullup device is connected to the associated pin and detects falling edge/low level for interrupt generation. 1 A pulldown device is connected to the associated pin and detects rising edge/high level for interrupt generation.

7.4 Functional Description

This on-chip peripheral module is called a keyboard interrupt (KBI) module because originally it was used to simplify the connection and use of row-column matrices of keyboard switches. However, these inputs are also useful as extra external interrupt inputs and as an external means of waking the MCU from stop or wait low-power modes. The KBI module allows up to eight pins to act as additional interrupt sources.

Writing to the KBIPEn bits in the keyboard interrupt pin enable register (KBIPE) independently enables or disables each port pin. Each port can be configured as edge sensitive or edge and level sensitive based on the KBIMOD bit in the keyboard interrupt status and control register (KBISC). Edge sensitivity can be software programmed to be either falling or rising; the level can be either low or high. The polarity of the edge or edge and level sensitivity is selected using the KBEDGn bits in the keyboard interrupt edge select register (KBIES).

7.4.1 Edge Only Sensitivity

A valid edge on an enabled port pin will set KBF in KBISC. If KBIE in KBISC is set, an interrupt request will be presented to the CPU. Clearing of KBF is accomplished by writing a 1 to KBACK in KBISC.

Synchronous logic is used to detect edges. A falling edge is detected when an enabled keyboard interrupt (KBIPEn=1) input signal is seen as a logic 1 (the deasserted level) during one bus cycle and then a logic 0 (the asserted level) during the next cycle. A rising edge is detected when the input signal is seen as a logic 0 (the deasserted level) during one bus cycle and then a logic 1 (the asserted level) during the next cycle.

Before the first edge is detected, all enabled keyboard interrupt input signals must be at the deasserted logic levels. After any edge is detected, all enabled keyboard interrupt input signals must return to the deasserted level before any new edge can be detected.

7.4.2 Edge and Level Sensitivity

A valid edge or level on an enabled port pin will set KBF in KBISC. If KBIE in KBISC is set, an interrupt request will be presented to the CPU. Clearing of KBF is accomplished by writing a 1 to KBACK in KBISC provided all enabled port inputs are at their deasserted levels. KBF will remain set if any enabled port pin is asserted while attempting to clear by writing a 1 to KBACK.

7.4.3 Pullup/Pulldown Resistors

The keyboard interrupt pins can be configured to use an internal pullup/pulldown resistor using the associated I/O port pullup enable register. If an internal resistor is enabled, the KBIES register is used to select whether the resistor is a pullup (KBEDGn = 0) or a pulldown (KBEDGn = 1).

7.4.4 Keyboard Interrupt Initialization

When an interrupt pin is first enabled, it is possible to get a false interrupt flag. To prevent a false interrupt request during pin interrupt initialization, the user must do the following:

1. Mask interrupts by clearing KBIE in KBISC.
2. Select the pin polarity by setting the appropriate KBEDGn bits in KBIES.
3. If using internal pullup/pulldown device, configure the associated pull enable bits in KBIPE.
4. Enable the interrupt pins by setting the appropriate KBIPEn bits in KBIPE.
5. Write to KBACK in KBIxC to clear any false interrupts.
6. Set KBIE in KBISC to enable interrupts.

Chapter 8

Central Processor Unit (S08CPUV4)

8.1 Introduction

This section provides summary information about the registers, addressing modes, and instruction set of the CPU of the HCS08 Family. For a more detailed discussion, refer to the *HCS08 Family Reference Manual, volume 1*, Freescale Semiconductor document order number HCS08RMV1/D.

The HCS08 CPU is fully source- and object-code-compatible with the M68HC08 CPU. Several instructions and enhanced addressing modes were added to improve C compiler efficiency and to support a new background debug system which replaces the monitor mode of earlier M68HC08 microcontrollers (MCU).

8.1.1 Features

Features of the HCS08 CPU include:

- Object code fully upward-compatible with M68HC05 and M68HC08 Families
- All registers and memory are mapped to a single 64-Kbyte address space
- 16-bit stack pointer (any size stack anywhere in 64-KB CPU address space)
- 16-bit index register (H:X) with powerful indexed addressing modes
- 8-bit accumulator (A)
- Many instructions treat X as a second general-purpose 8-bit register
- Seven addressing modes:
 - Inherent — Operands in internal registers
 - Relative — 8-bit signed offset to branch destination
 - Immediate — Operand in next object code byte(s)
 - Direct — Operand in memory at 0x0000–0x00FF
 - Extended — Operand anywhere in 64-Kbyte address space
 - Indexed relative to H:X — Five submodes including auto increment
 - Indexed relative to SP — Improves C efficiency dramatically
- Memory-to-memory data move instructions with four address mode combinations
- Overflow, half-carry, negative, zero, and carry condition codes support conditional branching on the results of signed, unsigned, and binary-coded decimal (BCD) operations
- Efficient bit manipulation instructions
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- STOP and WAIT instructions to invoke low-power operating modes

8.2 Programmer's Model and CPU Registers

Figure 8-1 shows the five CPU registers. CPU registers are not part of the memory map.

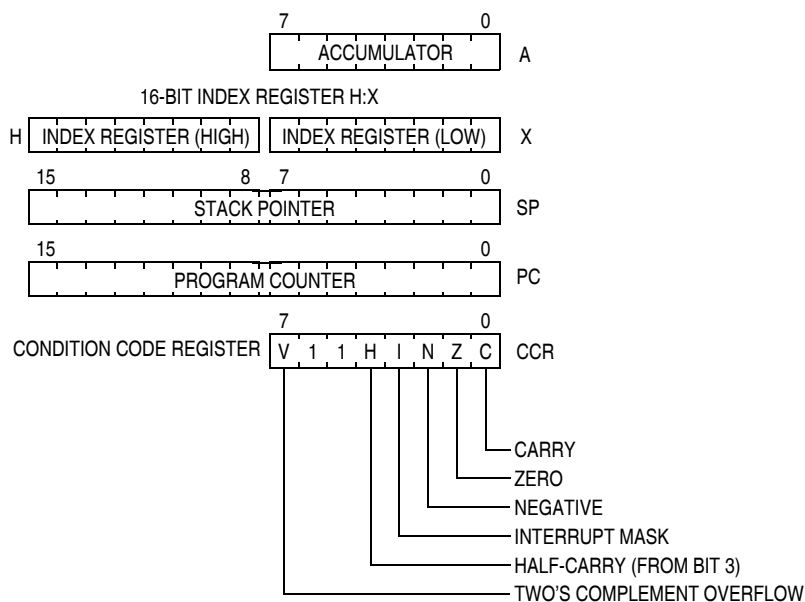


Figure 8-1. CPU Registers

8.2.1 Accumulator (A)

The A accumulator is a general-purpose 8-bit register. One operand input to the arithmetic logic unit (ALU) is connected to the accumulator and the ALU results are often stored into the A accumulator after arithmetic and logical operations. The accumulator can be loaded from memory using various addressing modes to specify the address where the loaded data comes from, or the contents of A can be stored to memory using various addressing modes to specify the address where data from A will be stored.

Reset has no effect on the contents of the A accumulator.

8.2.2 Index Register (H:X)

This 16-bit register is actually two separate 8-bit registers (H and X), which often work together as a 16-bit address pointer where H holds the upper byte of an address and X holds the lower byte of the address. All indexed addressing mode instructions use the full 16-bit value in H:X as an index reference pointer; however, for compatibility with the earlier M68HC05 Family, some instructions operate only on the low-order 8-bit half (X).

Many instructions treat X as a second general-purpose 8-bit register that can be used to hold 8-bit data values. X can be cleared, incremented, decremented, complemented, negated, shifted, or rotated. Transfer instructions allow data to be transferred from A or transferred to A where arithmetic and logical operations can then be performed.

For compatibility with the earlier M68HC05 Family, H is forced to 0x00 during reset. Reset has no effect on the contents of X.

8.2.3 Stack Pointer (SP)

This 16-bit address pointer register points at the next available location on the automatic last-in-first-out (LIFO) stack. The stack may be located anywhere in the 64-Kbyte address space that has RAM and can be any size up to the amount of available RAM. The stack is used to automatically save the return address for subroutine calls, the return address and CPU registers during interrupts, and for local variables. The AIS (add immediate to stack pointer) instruction adds an 8-bit signed immediate value to SP. This is most often used to allocate or deallocate space for local variables on the stack.

SP is forced to 0x00FF at reset for compatibility with the earlier M68HC05 Family. HCS08 programs normally change the value in SP to the address of the last location (highest address) in on-chip RAM during reset initialization to free up direct page RAM (from the end of the on-chip registers to 0x00FF).

The RSP (reset stack pointer) instruction was included for compatibility with the M68HC05 Family and is seldom used in new HCS08 programs because it only affects the low-order half of the stack pointer.

8.2.4 Program Counter (PC)

The program counter is a 16-bit register that contains the address of the next instruction or operand to be fetched.

During normal program execution, the program counter automatically increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, interrupt, and return operations load the program counter with an address other than that of the next sequential location. This is called a change-of-flow.

During reset, the program counter is loaded with the reset vector that is located at 0xFFFFE and 0xFFFF. The vector stored there is the address of the first instruction that will be executed after exiting the reset state.

8.2.5 Condition Code Register (CCR)

The 8-bit condition code register contains the interrupt mask (I) and five flags that indicate the results of the instruction just executed. Bits 6 and 5 are set permanently to 1. The following paragraphs describe the functions of the condition code bits in general terms. For a more detailed explanation of how each instruction sets the CCR bits, refer to the *HCS08 Family Reference Manual, volume 1*, Freescale Semiconductor document order number HCS08RMv1.

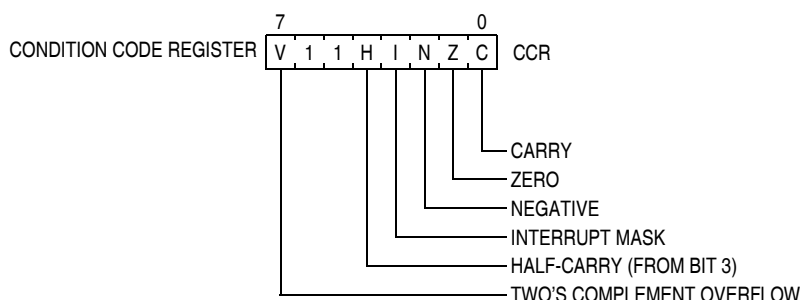


Figure 8-2. Condition Code Register

Table 8-1. CCR Register Field Descriptions

Field	Description
7 V	Two's Complement Overflow Flag — The CPU sets the overflow flag when a two's complement overflow occurs. The signed branch instructions BGT, BGE, BLE, and BLT use the overflow flag. 0 No overflow 1 Overflow
4 H	Half-Carry Flag — The CPU sets the half-carry flag when a carry occurs between accumulator bits 3 and 4 during an add-without-carry (ADD) or add-with-carry (ADC) operation. The half-carry flag is required for binary-coded decimal (BCD) arithmetic operations. The DAA instruction uses the states of the H and C condition code bits to automatically add a correction value to the result from a previous ADD or ADC on BCD operands to correct the result to a valid BCD value. 0 No carry between bits 3 and 4 1 Carry between bits 3 and 4
3 I	Interrupt Mask Bit — When the interrupt mask is set, all maskable CPU interrupts are disabled. CPU interrupts are enabled when the interrupt mask is cleared. When a CPU interrupt occurs, the interrupt mask is set automatically after the CPU registers are saved on the stack, but before the first instruction of the interrupt service routine is executed. Interrupts are not recognized at the instruction boundary after any instruction that clears I (CLI or TAP). This ensures that the next instruction after a CLI or TAP will always be executed without the possibility of an intervening interrupt, provided I was set. 0 Interrupts enabled 1 Interrupts disabled
2 N	Negative Flag — The CPU sets the negative flag when an arithmetic operation, logic operation, or data manipulation produces a negative result, setting bit 7 of the result. Simply loading or storing an 8-bit or 16-bit value causes N to be set if the most significant bit of the loaded or stored value was 1. 0 Non-negative result 1 Negative result
1 Z	Zero Flag — The CPU sets the zero flag when an arithmetic operation, logic operation, or data manipulation produces a result of 0x00 or 0x0000. Simply loading or storing an 8-bit or 16-bit value causes Z to be set if the loaded or stored value was all 0s. 0 Non-zero result 1 Zero result
0 C	Carry/Borrow Flag — The CPU sets the carry/borrow flag when an addition operation produces a carry out of bit 7 of the accumulator or when a subtraction operation requires a borrow. Some instructions — such as bit test and branch, shift, and rotate — also clear or set the carry/borrow flag. 0 No carry out of bit 7 1 Carry out of bit 7

8.3 Addressing Modes

Addressing modes define the way the CPU accesses operands and data. In the HCS08, memory, status and control registers, and input/output (I/O) ports share a single 64-Kbyte CPU address space. This arrangement means that the same instructions that access variables in RAM can also be used to access I/O and control registers or nonvolatile program space.

Some instructions use more than one addressing mode. For instance, move instructions use one addressing mode to specify the source operand and a second addressing mode to specify the destination address. Instructions such as BRCLR, BRSET, CBEQ, and DBNZ use one addressing mode to specify the location of an operand for a test and then use relative addressing mode to specify the branch destination address when the tested condition is true. For BRCLR, BRSET, CBEQ, and DBNZ, the addressing mode listed in the instruction set tables is the addressing mode needed to access the operand to be tested, and relative addressing mode is implied for the branch destination.

8.3.1 Inherent Addressing Mode (INH)

In this addressing mode, operands needed to complete the instruction (if any) are located within CPU registers so the CPU does not need to access memory to get any operands.

8.3.2 Relative Addressing Mode (REL)

Relative addressing mode is used to specify the destination location for branch instructions. A signed 8-bit offset value is located in the memory location immediately following the opcode. During execution, if the branch condition is true, the signed offset is sign-extended to a 16-bit value and is added to the current contents of the program counter, which causes program execution to continue at the branch destination address.

8.3.3 Immediate Addressing Mode (IMM)

In immediate addressing mode, the operand needed to complete the instruction is included in the object code immediately following the instruction opcode in memory. In the case of a 16-bit immediate operand, the high-order byte is located in the next memory location after the opcode, and the low-order byte is located in the next memory location after that.

8.3.4 Direct Addressing Mode (DIR)

In direct addressing mode, the instruction includes the low-order eight bits of an address in the direct page (0x0000–0x00FF). During execution a 16-bit address is formed by concatenating an implied 0x00 for the high-order half of the address and the direct address from the instruction to get the 16-bit address where the desired operand is located. This is faster and more memory efficient than specifying a complete 16-bit address for the operand.

8.3.5 Extended Addressing Mode (EXT)

In extended addressing mode, the full 16-bit address of the operand is located in the next two bytes of program memory after the opcode (high byte first).

8.3.6 Indexed Addressing Mode

Indexed addressing mode has seven variations including five that use the 16-bit H:X index register pair and two that use the stack pointer as the base reference.

8.3.6.1 Indexed, No Offset (IX)

This variation of indexed addressing uses the 16-bit value in the H:X index register pair as the address of the operand needed to complete the instruction.

8.3.6.2 Indexed, No Offset with Post Increment (IX+)

This variation of indexed addressing uses the 16-bit value in the H:X index register pair as the address of the operand needed to complete the instruction. The index register pair is then incremented ($H:X = H:X + 0x0001$) after the operand has been fetched. This addressing mode is only used for MOV and CBEQ instructions.

8.3.6.3 Indexed, 8-Bit Offset (IX1)

This variation of indexed addressing uses the 16-bit value in the H:X index register pair plus an unsigned 8-bit offset included in the instruction as the address of the operand needed to complete the instruction.

8.3.6.4 Indexed, 8-Bit Offset with Post Increment (IX1+)

This variation of indexed addressing uses the 16-bit value in the H:X index register pair plus an unsigned 8-bit offset included in the instruction as the address of the operand needed to complete the instruction. The index register pair is then incremented ($H:X = H:X + 0x0001$) after the operand has been fetched. This addressing mode is used only for the CBEQ instruction.

8.3.6.5 Indexed, 16-Bit Offset (IX2)

This variation of indexed addressing uses the 16-bit value in the H:X index register pair plus a 16-bit offset included in the instruction as the address of the operand needed to complete the instruction.

8.3.6.6 SP-Relative, 8-Bit Offset (SP1)

This variation of indexed addressing uses the 16-bit value in the stack pointer (SP) plus an unsigned 8-bit offset included in the instruction as the address of the operand needed to complete the instruction.

8.3.6.7 SP-Relative, 16-Bit Offset (SP2)

This variation of indexed addressing uses the 16-bit value in the stack pointer (SP) plus a 16-bit offset included in the instruction as the address of the operand needed to complete the instruction.

8.4 Special Operations

The CPU performs a few special operations that are similar to instructions but do not have opcodes like other CPU instructions. In addition, a few instructions such as STOP and WAIT directly affect other MCU circuitry. This section provides additional information about these operations.

8.4.1 Reset Sequence

Reset can be caused by a power-on-reset (POR) event, internal conditions such as the COP (computer operating properly) watchdog, or by assertion of an external active-low reset pin. When a reset event occurs, the CPU immediately stops whatever it is doing (the MCU does not wait for an instruction boundary before responding to a reset event). For a more detailed discussion about how the MCU recognizes resets and determines the source, refer to the [Resets, Interrupts, and System Configuration](#) chapter.

The reset event is considered concluded when the sequence to determine whether the reset came from an internal source is done and when the reset pin is no longer asserted. At the conclusion of a reset event, the CPU performs a 6-cycle sequence to fetch the reset vector from 0xFFFFE and 0xFFFF and to fill the instruction queue in preparation for execution of the first program instruction.

8.4.2 Interrupt Sequence

When an interrupt is requested, the CPU completes the current instruction before responding to the interrupt. At this point, the program counter is pointing at the start of the next instruction, which is where the CPU should return after servicing the interrupt. The CPU responds to an interrupt by performing the same sequence of operations as for a software interrupt (SWI) instruction, except the address used for the vector fetch is determined by the highest priority interrupt that is pending when the interrupt sequence started.

The CPU sequence for an interrupt is:

1. Store the contents of PCL, PCH, X, A, and CCR on the stack, in that order.
2. Set the I bit in the CCR.
3. Fetch the high-order half of the interrupt vector.
4. Fetch the low-order half of the interrupt vector.
5. Delay for one free bus cycle.
6. Fetch three bytes of program information starting at the address indicated by the interrupt vector to fill the instruction queue in preparation for execution of the first instruction in the interrupt service routine.

After the CCR contents are pushed onto the stack, the I bit in the CCR is set to prevent other interrupts while in the interrupt service routine. Although it is possible to clear the I bit with an instruction in the

interrupt service routine, this would allow nesting of interrupts (which is not recommended because it leads to programs that are difficult to debug and maintain).

For compatibility with the earlier M68HC05 MCUs, the high-order half of the H:X index register pair (H) is not saved on the stack as part of the interrupt sequence. The user must use a PSHH instruction at the beginning of the service routine to save H and then use a PULH instruction just before the RTI that ends the interrupt service routine. It is not necessary to save H if you are certain that the interrupt service routine does not use any instructions or auto-increment addressing modes that might change the value of H.

The software interrupt (SWI) instruction is like a hardware interrupt except that it is not masked by the global I bit in the CCR and it is associated with an instruction opcode within the program so it is not asynchronous to program execution.

8.4.3 Wait Mode Operation

The WAIT instruction enables interrupts by clearing the I bit in the CCR. It then halts the clocks to the CPU to reduce overall power consumption while the CPU is waiting for the interrupt or reset event that will wake the CPU from wait mode. When an interrupt or reset event occurs, the CPU clocks will resume and the interrupt or reset event will be processed normally.

If a serial BACKGROUND command is issued to the MCU through the background debug interface while the CPU is in wait mode, CPU clocks will resume and the CPU will enter active background mode where other serial background commands can be processed. This ensures that a host development system can still gain access to a target MCU even if it is in wait mode.

8.4.4 Stop Mode Operation

Usually, all system clocks, including the crystal oscillator (when used), are halted during stop mode to minimize power consumption. In such systems, external circuitry is needed to control the time spent in stop mode and to issue a signal to wake up the target MCU when it is time to resume processing. Unlike the earlier M68HC05 and M68HC08 MCUs, the HCS08 can be configured to keep a minimum set of clocks running in stop mode. This optionally allows an internal periodic signal to wake the target MCU from stop mode.

When a host debug system is connected to the background debug pin (BKGD) and the ENBDM control bit has been set by a serial command through the background interface (or because the MCU was reset into active background mode), the oscillator is forced to remain active when the MCU enters stop mode. In this case, if a serial BACKGROUND command is issued to the MCU through the background debug interface while the CPU is in stop mode, CPU clocks will resume and the CPU will enter active background mode where other serial background commands can be processed. This ensures that a host development system can still gain access to a target MCU even if it is in stop mode.

Recovery from stop mode depends on the particular HCS08 and whether the oscillator was stopped in stop mode. Refer to the [Modes of Operation](#) chapter for more details.

8.4.5 BGND Instruction

The BGND instruction is new to the HCS08 compared to the M68HC08. BGND would not be used in normal user programs because it forces the CPU to stop processing user instructions and enter the active background mode. The only way to resume execution of the user program is through reset or by a host debug system issuing a GO, TRACE1, or TAGGO serial command through the background debug interface.

Software-based breakpoints can be set by replacing an opcode at the desired breakpoint address with the BGND opcode. When the program reaches this breakpoint address, the CPU is forced to active background mode rather than continuing the user program.

8.5 HCS08 Instruction Set Summary

Table 8-2 provides a summary of the HCS08 instruction set in all possible addressing modes. The table shows operand construction, execution time in internal bus clock cycles, and cycle-by-cycle details for each addressing mode variation of each instruction.

Table 8-2. Instruction Set Summary (Sheet 1 of 9)

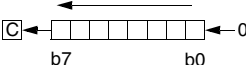
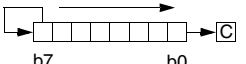
Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
ADC #opr8i ADC opr8a ADC opr16a ADC oprx16,X ADC oprx8,X ADC ,X ADC oprx16,SP ADC oprx8,SP	Add with Carry $A \leftarrow (A) + (M) + (C)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	A9 ii B9 dd C9 hh ll D9 ee ff E9 ff F9 9E D9 ee ff 9E E9 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$\uparrow 1 1 \uparrow$	$- \uparrow \uparrow \uparrow$
ADD #opr8i ADD opr8a ADD opr16a ADD oprx16,X ADD oprx8,X ADD ,X ADD oprx16,SP ADD oprx8,SP	Add without Carry $A \leftarrow (A) + (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	AB ii BB dd CB hh ll DB ee ff EB ff FB 9E DB ee ff 9E EB ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$\uparrow 1 1 \uparrow$	$- \uparrow \uparrow \uparrow$
AIS #opr8i	Add Immediate Value (Signed) to Stack Pointer $SP \leftarrow (SP) + (M)$	IMM	A7 ii	2	pp	$- 1 1 -$	$- - - -$
AIX #opr8i	Add Immediate Value (Signed) to Index Register (H:X) $H:X \leftarrow (H:X) + (M)$	IMM	AF ii	2	pp	$- 1 1 -$	$- - - -$
AND #opr8i AND opr8a AND opr16a AND oprx16,X AND oprx8,X AND ,X AND oprx16,SP AND oprx8,SP	Logical AND $A \leftarrow (A) \& (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	A4 ii B4 dd C4 hh ll D4 ee ff E4 ff F4 9E D4 ee ff 9E E4 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$0 1 1 -$	$- \uparrow \uparrow -$
ASL opr8a ASLA ASLX ASL oprx8,X ASL ,X ASL oprx8,SP	Arithmetic Shift Left  (Same as LSL)	DIR INH INH IX1 IX SP1	38 dd 48 58 68 ff 78 9E 68 ff	5 1 1 5 4 6	rfwpp p p rfwpp rfwp prfwpp	$\uparrow 1 1 -$	$- \uparrow \uparrow \uparrow$
ASR opr8a ASRA ASRX ASR oprx8,X ASR ,X ASR oprx8,SP	Arithmetic Shift Right 	DIR INH INH IX1 IX SP1	37 dd 47 57 67 ff 77 9E 67 ff	5 1 1 5 4 6	rfwpp p p rfwpp rfwp prfwpp	$\uparrow 1 1 -$	$- \uparrow \uparrow \uparrow$

Table 8-2. Instruction Set Summary (Sheet 2 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
BCC <i>rel</i>	Branch if Carry Bit Clear (if C = 0)	REL	24 rr	3	ppp	- 1 1 -	- - - -
BCLR <i>n,opr8a</i>	Clear Bit n in Memory (Mn ← 0)	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7)	11 dd 13 dd 15 dd 17 dd 19 dd 1B dd 1D dd 1F dd	5 5 5 5 5 5 5 5	r fwpp r fwpp r fwpp r fwpp r fwpp r fwpp r fwpp r fwpp	- 1 1 -	- - - -
BCS <i>rel</i>	Branch if Carry Bit Set (if C = 1) (Same as BLO)	REL	25 rr	3	ppp	- 1 1 -	- - - -
BEQ <i>rel</i>	Branch if Equal (if Z = 1)	REL	27 rr	3	ppp	- 1 1 -	- - - -
BGE <i>rel</i>	Branch if Greater Than or Equal To (if N ⊕ V = 0) (Signed)	REL	90 rr	3	ppp	- 1 1 -	- - - -
BGND	Enter active background if ENBDM=1 Waits for and processes BDM commands until GO, TRACE1, or TAGGO	INH	82	5+	fp...ppp	- 1 1 -	- - - -
BGT <i>rel</i>	Branch if Greater Than (if Z (N ⊕ V) = 0) (Signed)	REL	92 rr	3	ppp	- 1 1 -	- - - -
BHCC <i>rel</i>	Branch if Half Carry Bit Clear (if H = 0)	REL	28 rr	3	ppp	- 1 1 -	- - - -
BHCS <i>rel</i>	Branch if Half Carry Bit Set (if H = 1)	REL	29 rr	3	ppp	- 1 1 -	- - - -
BHI <i>rel</i>	Branch if Higher (if C Z = 0)	REL	22 rr	3	ppp	- 1 1 -	- - - -
BHS <i>rel</i>	Branch if Higher or Same (if C = 0) (Same as BCC)	REL	24 rr	3	ppp	- 1 1 -	- - - -
BIH <i>rel</i>	Branch if IRQ Pin High (if IRQ pin = 1)	REL	2F rr	3	ppp	- 1 1 -	- - - -
BIL <i>rel</i>	Branch if IRQ Pin Low (if IRQ pin = 0)	REL	2E rr	3	ppp	- 1 1 -	- - - -
BIT # <i>opr8i</i> BIT <i>opr8a</i> BIT <i>opr16a</i> BIT <i>opr16,X</i> BIT <i>opr8,X</i> BIT <i>,X</i> BIT <i>opr16,SP</i> BIT <i>opr8,SP</i>	Bit Test (A) & (M) (CCR Updated but Operands Not Changed)	IMM DIR EXT IX2 IX1 IX SP2 SP1	A5 ii B5 dd C5 hh ll D5 ee ff E5 ff F5 9E D5 ee ff 9E E5 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	0 1 1 -	- ↑ ↓ -
BLE <i>rel</i>	Branch if Less Than or Equal To (if Z (N ⊕ V) = 1) (Signed)	REL	93 rr	3	ppp	- 1 1 -	- - - -
BLO <i>rel</i>	Branch if Lower (if C = 1) (Same as BCS)	REL	25 rr	3	ppp	- 1 1 -	- - - -
BLS <i>rel</i>	Branch if Lower or Same (if C Z = 1)	REL	23 rr	3	ppp	- 1 1 -	- - - -
BLT <i>rel</i>	Branch if Less Than (if N ⊕ V = 1) (Signed)	REL	91 rr	3	ppp	- 1 1 -	- - - -
BMC <i>rel</i>	Branch if Interrupt Mask Clear (if I = 0)	REL	2C rr	3	ppp	- 1 1 -	- - - -
BMI <i>rel</i>	Branch if Minus (if N = 1)	REL	2B rr	3	ppp	- 1 1 -	- - - -
BMS <i>rel</i>	Branch if Interrupt Mask Set (if I = 1)	REL	2D rr	3	ppp	- 1 1 -	- - - -
BNE <i>rel</i>	Branch if Not Equal (if Z = 0)	REL	26 rr	3	ppp	- 1 1 -	- - - -

Table 8-2. Instruction Set Summary (Sheet 3 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
BPL <i>rel</i>	Branch if Plus (if N = 0)	REL	2A rr	3	ppp	- 1 1 -	- - - -
BRA <i>rel</i>	Branch Always (if I = 1)	REL	20 rr	3	ppp	- 1 1 -	- - - -
BRCLR <i>n,opr8a,rel</i>	Branch if Bit <i>n</i> in Memory Clear (if (Mn) = 0)	DIR (b0)	01 dd rr	5	rpppp	- 1 1 -	- - - ↑
		DIR (b1)	03 dd rr	5	rpppp		
		DIR (b2)	05 dd rr	5	rpppp		
		DIR (b3)	07 dd rr	5	rpppp		
		DIR (b4)	09 dd rr	5	rpppp		
		DIR (b5)	0B dd rr	5	rpppp		
		DIR (b6)	0D dd rr	5	rpppp		
		DIR (b7)	0F dd rr	5	rpppp		
BRN <i>rel</i>	Branch Never (if I = 0)	REL	21 rr	3	ppp	- 1 1 -	- - - -
BRSET <i>n,opr8a,rel</i>	Branch if Bit <i>n</i> in Memory Set (if (Mn) = 1)	DIR (b0)	00 dd rr	5	rpppp	- 1 1 -	- - - ↑
		DIR (b1)	02 dd rr	5	rpppp		
		DIR (b2)	04 dd rr	5	rpppp		
		DIR (b3)	06 dd rr	5	rpppp		
		DIR (b4)	08 dd rr	5	rpppp		
		DIR (b5)	0A dd rr	5	rpppp		
		DIR (b6)	0C dd rr	5	rpppp		
		DIR (b7)	0E dd rr	5	rpppp		
BSET <i>n,opr8a</i>	Set Bit <i>n</i> in Memory (Mn ← 1)	DIR (b0)	10 dd	5	rfwpp	- 1 1 -	- - - -
		DIR (b1)	12 dd	5	rfwpp		
		DIR (b2)	14 dd	5	rfwpp		
		DIR (b3)	16 dd	5	rfwpp		
		DIR (b4)	18 dd	5	rfwpp		
		DIR (b5)	1A dd	5	rfwpp		
		DIR (b6)	1C dd	5	rfwpp		
		DIR (b7)	1E dd	5	rfwpp		
BSR <i>rel</i>	Branch to Subroutine PC ← (PC) + \$0002 push (PCL); SP ← (SP) - \$0001 push (PCH); SP ← (SP) - \$0001 PC ← (PC) + <i>rel</i>	REL	AD rr	5	ssppp	- 1 1 -	- - - -
CBEQ <i>opr8a,rel</i>	Compare and... Branch if (A) = (M)	DIR	31 dd rr	5	rpppp	- 1 1 -	- - - -
CBEQA # <i>opr8i,rel</i>		IMM	41 ii rr	4	pppp		
CBEQX # <i>opr8i,rel</i>		IMM	51 ii rr	4	pppp		
CBEQ <i>opr8,X+,rel</i>		IX1+	61 ff rr	5	rpppp		
CBEQ <i>,X+,rel</i>		IX+	71 rr	5	rpppp		
CBEQ <i>opr8,SP,rel</i>		SP1	9E 61 ff rr	6	prpppp		
CLC	Clear Carry Bit (C ← 0)	INH	98	1	p	- 1 1 -	- - - 0
CLI	Clear Interrupt Mask Bit (I ← 0)	INH	9A	1	p	- 1 1 -	0 - - -
CLR <i>opr8a</i>	Clear M ← \$00	DIR	3F dd	5	rfwpp	0 1 1 -	- 0 1 -
CLRA		INH	4F	1	p		
CLR X		INH	5F	1	p		
CLR H		INH	8C	1	p		
CLR <i>opr8,X</i>		IX1	6F ff	5	rffwpp		
CLR <i>,X</i>		IX	7F	4	rffw		
CLR <i>opr8,SP</i>		SP1	9E 6F ff	6	prffwpp		

Table 8-2. Instruction Set Summary (Sheet 4 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
CMP #opr8i CMP opr8a CMP opr16a CMP oprx16,X CMP oprx8,X CMP ,X CMP oprx16,SP CMP oprx8,SP	Compare Accumulator with Memory $A - M$ (CCR Updated But Operands Not Changed)	IMM DIR EXT IX2 IX1 IX SP2 SP1	A1 ii B1 dd C1 hh ll D1 ee ff E1 ff F1 9E D1 ee ff 9E E1 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	↑ 1 1 -	- ↓ ↓ ↓
COM opr8a COMA COMX COM oprx8,X COM ,X COM oprx8,SP	Complement $M \leftarrow (\overline{M}) = \$FF - (M)$ (One's Complement) $A \leftarrow (\overline{A}) = \$FF - (A)$ $X \leftarrow (\overline{X}) = \$FF - (X)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$	DIR INH INH IX1 IX SP1	33 dd 43 53 63 ff 73 9E 63 ff	5 1 1 5 4 6	rffwpp p p rffwpp rffw prffwpp	0 1 1 -	- ↓ ↓ 1
CPHX opr16a CPHX #opr16i CPHX opr8a CPHX oprx8,SP	Compare Index Register (H:X) with Memory (H:X) - (M:M + \$0001) (CCR Updated But Operands Not Changed)	EXT IMM DIR SP1	3E hh ll 65 jj kk 75 dd 9E F3 ff	6 3 5 6	prrrfpp ppp rrfpp prrrfpp	↑ 1 1 -	- ↓ ↓ ↓
CPX #opr8i CPX opr8a CPX opr16a CPX oprx16,X CPX oprx8,X CPX ,X CPX oprx16,SP CPX oprx8,SP	Compare X (Index Register Low) with Memory $X - M$ (CCR Updated But Operands Not Changed)	IMM DIR EXT IX2 IX1 IX SP2 SP1	A3 ii B3 dd C3 hh ll D3 ee ff E3 ff F3 9E D3 ee ff 9E E3 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	↑ 1 1 -	- ↓ ↓ ↓
DAA	Decimal Adjust Accumulator After ADD or ADC of BCD Values	INH	72	1	p	U 1 1 -	- ↓ ↓ ↓
DBNZ opr8a,rel DBNZA rel DBNZX rel DBNZ oprx8,X,rel DBNZ ,X,rel DBNZ oprx8,SP,rel	Decrement A, X, or M and Branch if Not Zero (if (result) ≠ 0) DBNZX Affects X Not H	DIR INH INH IX1 IX SP1	3B dd rr 4B rr 5B rr 6B ff rr 7B rr 9E 6B ff rr	7 4 4 7 6 8	rffwpppp fppp fppp rffwpppp rffwppp prffwpppp	- 1 1 -	- - - -
DEC opr8a DECA DECX DEC oprx8,X DEC ,X DEC oprx8,SP	Decrement $M \leftarrow (M) - \$01$ $A \leftarrow (A) - \$01$ $X \leftarrow (X) - \$01$ $M \leftarrow (M) - \$01$ $M \leftarrow (M) - \$01$ $M \leftarrow (M) - \$01$	DIR INH INH IX1 IX SP1	3A dd 4A 5A 6A ff 7A 9E 6A ff	5 1 1 5 4 6	rffwpp p p rffwpp rffw prffwpp	↑ 1 1 -	- ↓ ↓ -
DIV	Divide $A \leftarrow (H:A) \div (X)$; H ← Remainder	INH	52	6	fffffp	- 1 1 -	- - ↓ ↑
EOR #opr8i EOR opr8a EOR opr16a EOR oprx16,X EOR oprx8,X EOR ,X EOR oprx16,SP EOR oprx8,SP	Exclusive OR Memory with Accumulator $A \leftarrow (A \oplus M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	A8 ii B8 dd C8 hh ll D8 ee ff E8 ff F8 9E D8 ee ff 9E E8 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	0 1 1 -	- ↓ ↓ -

Table 8-2. Instruction Set Summary (Sheet 5 of 9)

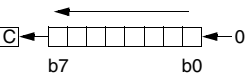
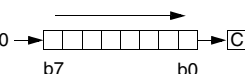
Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V I 1 H	I N Z C
INC <i>opr8a</i> INCA INCX INC <i>opr8,X</i> INC ,X INC <i>opr8,SP</i>	Increment $M \leftarrow (M) + \$01$ $A \leftarrow (A) + \$01$ $X \leftarrow (X) + \$01$ $M \leftarrow (M) + \$01$ $M \leftarrow (M) + \$01$ $M \leftarrow (M) + \$01$	DIR INH INH IX1 IX SP1	3C dd 4C 5C 6C ff 7C 9E 6C ff	5 1 1 5 4 6	r fwpp p p r fwpp r fwp p rfwpp	$\uparrow 1 1 -$	$- \uparrow \uparrow -$
JMP <i>opr8a</i> JMP <i>opr16a</i> JMP <i>opr16,X</i> JMP <i>opr8,X</i> JMP ,X	Jump $PC \leftarrow \text{Jump Address}$	DIR EXT IX2 IX1 IX	BC dd CC hh ll DC ee ff EC ff FC	3 4 4 3 3	ppp pppp pppp ppp ppp	$- 1 1 -$	$- - - -$
JSR <i>opr8a</i> JSR <i>opr16a</i> JSR <i>opr16,X</i> JSR <i>opr8,X</i> JSR ,X	Jump to Subroutine $PC \leftarrow (PC) + n$ ($n = 1, 2, \text{ or } 3$) Push (PCL); $SP \leftarrow (SP) - \$0001$ Push (PCH); $SP \leftarrow (SP) - \$0001$ $PC \leftarrow \text{Unconditional Address}$	DIR EXT IX2 IX1 IX	BD dd CD hh ll DD ee ff ED ff FD	5 6 6 5 5	ssppp pssppp pssppp ssppp ssppp	$- 1 1 -$	$- - - -$
LDA # <i>opr8i</i> LDA <i>opr8a</i> LDA <i>opr16a</i> LDA <i>opr16,X</i> LDA <i>opr8,X</i> LDA ,X LDA <i>opr16,SP</i> LDA <i>opr8,SP</i>	Load Accumulator from Memory $A \leftarrow (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	A6 ii B6 dd C6 hh ll D6 ee ff E6 ff F6 9E D6 ee ff 9E E6 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$0 1 1 -$	$- \uparrow \uparrow -$
LDHX # <i>opr16i</i> LDHX <i>opr8a</i> LDHX <i>opr16a</i> LDHX ,X LDHX <i>opr16,X</i> LDHX <i>opr8,X</i> LDHX <i>opr8,SP</i>	Load Index Register (H:X) $H:X \leftarrow (M:M + \$0001)$	IMM DIR EXT IX IX2 IX1 SP1	45 jj kk 55 dd 32 hh ll 9E AE 9E BE ee ff 9E CE ff 9E FE ff	3 4 5 5 6 5 5	ppp rrpp prrrp prrrp pprrpp prrrp prrrp	$0 1 1 -$	$- \uparrow \uparrow -$
LDX # <i>opr8i</i> LDX <i>opr8a</i> LDX <i>opr16a</i> LDX <i>opr16,X</i> LDX <i>opr8,X</i> LDX ,X LDX <i>opr16,SP</i> LDX <i>opr8,SP</i>	Load X (Index Register Low) from Memory $X \leftarrow (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	AE ii BE dd CE hh ll DE ee ff EE ff FE 9E DE ee ff 9E EE ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$0 1 1 -$	$- \uparrow \uparrow -$
LSL <i>opr8a</i> LSLA LSLX LSL <i>opr8,X</i> LSL ,X LSL <i>opr8,SP</i>	Logical Shift Left  (Same as ASL)	DIR INH INH IX1 IX SP1	38 dd 48 58 68 ff 78 9E 68 ff	5 1 1 5 4 6	r fwpp p p r fwpp r fwp p rfwpp	$\uparrow 1 1 -$	$- \uparrow \uparrow \uparrow$
LSR <i>opr8a</i> LSRA LSRX LSR <i>opr8,X</i> LSR ,X LSR <i>opr8,SP</i>	Logical Shift Right 	DIR INH INH IX1 IX SP1	34 dd 44 54 64 ff 74 9E 64 ff	5 1 1 5 4 6	r fwpp p p r fwpp r fwp p rfwpp	$\uparrow 1 1 -$	$- 0 \uparrow \uparrow$

Table 8-2. Instruction Set Summary (Sheet 6 of 9)

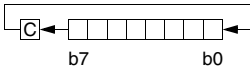
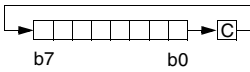
Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
MOV <i>opr8a,opr8a</i> MOV <i>opr8a,X+</i> MOV <i>#opr8i,opr8a</i> MOV <i>,X+,opr8a</i>	Move $(M)_{\text{destination}} \leftarrow (M)_{\text{source}}$ In IX+/DIR and DIR/IX+ Modes, $H:X \leftarrow (H:X) + \$0001$	DIR/DIR DIR/IX+ IMM/DIR IX+/DIR	4E dd dd 5E dd 6E ii dd 7E dd	5 5 4 5	rwpp rfwpp pwpp rfwpp	0 1 1 -	- $\uparrow\downarrow$ -
MUL	Unsigned multiply $X:A \leftarrow (X) \times (A)$	INH	42	5	ffffp	- 1 1 0	- - - 0
NEG <i>opr8a</i> NEGA NEGX NEG <i>opr8,X</i> NEG <i>,X</i> NEG <i>opr8,SP</i>	Negate $M \leftarrow -(M) = \$00 - (M)$ (Two's Complement) $A \leftarrow -(A) = \$00 - (A)$ $X \leftarrow -(X) = \$00 - (X)$ $M \leftarrow -(M) = \$00 - (M)$ $M \leftarrow -(M) = \$00 - (M)$ $M \leftarrow -(M) = \$00 - (M)$	DIR INH INH IX1 IX SP1	30 dd 40 50 60 ff 70 9E 60 ff	5 1 1 5 4 6	rfwpp p p rfwpp rfwp prfwpp	\uparrow 1 1 -	- $\uparrow\downarrow\downarrow$
NOP	No Operation — Uses 1 Bus Cycle	INH	9D	1	p	- 1 1 -	- - - -
NSA	Nibble Swap Accumulator $A \leftarrow (A[3:0]:A[7:4])$	INH	62	1	p	- 1 1 -	- - - -
ORA <i>#opr8i</i> ORA <i>opr8a</i> ORA <i>opr16a</i> ORA <i>opr16,X</i> ORA <i>opr8,X</i> ORA <i>,X</i> ORA <i>opr16,SP</i> ORA <i>opr8,SP</i>	Inclusive OR Accumulator and Memory $A \leftarrow (A) \mid (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	AA ii BA dd CA hh ll DA ee ff EA ff FA 9E DA ee ff 9E EA ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	0 1 1 -	- $\uparrow\downarrow$ -
PSHA	Push Accumulator onto Stack $\text{Push } (A); SP \leftarrow (SP) - \0001	INH	87	2	sp	- 1 1 -	- - - -
PSHH	Push H (Index Register High) onto Stack $\text{Push } (H); SP \leftarrow (SP) - \0001	INH	8B	2	sp	- 1 1 -	- - - -
PSHX	Push X (Index Register Low) onto Stack $\text{Push } (X); SP \leftarrow (SP) - \0001	INH	89	2	sp	- 1 1 -	- - - -
PULA	Pull Accumulator from Stack $SP \leftarrow (SP + \$0001); \text{Pull } (A)$	INH	86	3	ufp	- 1 1 -	- - - -
PULH	Pull H (Index Register High) from Stack $SP \leftarrow (SP + \$0001); \text{Pull } (H)$	INH	8A	3	ufp	- 1 1 -	- - - -
PULX	Pull X (Index Register Low) from Stack $SP \leftarrow (SP + \$0001); \text{Pull } (X)$	INH	88	3	ufp	- 1 1 -	- - - -
ROL <i>opr8a</i> ROLA ROLX ROL <i>opr8,X</i> ROL <i>,X</i> ROL <i>opr8,SP</i>	Rotate Left through Carry 	DIR INH INH IX1 IX SP1	39 dd 49 59 69 ff 79 9E 69 ff	5 1 1 5 4 6	rfwpp p p rfwpp rfwp prfwpp	\uparrow 1 1 -	- $\uparrow\downarrow\downarrow$
ROR <i>opr8a</i> RORA RORX ROR <i>opr8,X</i> ROR <i>,X</i> ROR <i>opr8,SP</i>	Rotate Right through Carry 	DIR INH INH IX1 IX SP1	36 dd 46 56 66 ff 76 9E 66 ff	5 1 1 5 4 6	rfwpp p p rfwpp rfwp prfwpp	\uparrow 1 1 -	- $\uparrow\downarrow\downarrow$

Table 8-2. Instruction Set Summary (Sheet 7 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
RSP	Reset Stack Pointer (Low Byte) SPL ← \$FF (High Byte Not Affected)	INH	9C	1	p	- 1 1 -	- - - -
RTI	Return from Interrupt SP ← (SP) + \$0001; Pull (CCR) SP ← (SP) + \$0001; Pull (A) SP ← (SP) + \$0001; Pull (X) SP ← (SP) + \$0001; Pull (PCH) SP ← (SP) + \$0001; Pull (PCL)	INH	80	9	uuuuufppp	↑ 1 1 ↑	↑ ↑ ↑ ↑
RTS	Return from Subroutine SP ← SP + \$0001; Pull (PCH) SP ← SP + \$0001; Pull (PCL)	INH	81	5	ufppp	- 1 1 -	- - - -
SBC #opr8i SBC opr8a SBC opr16a SBC oprx16,X SBC oprx8,X SBC ,X SBC oprx16,SP SBC oprx8,SP	Subtract with Carry A ← (A) - (M) - (C)	IMM DIR EXT IX2 IX1 IX SP2 SP1	A2 ii B2 dd C2 hh ll D2 ee ff E2 ff F2 9E D2 ee ff 9E E2 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	↑ 1 1 -	- ↑ ↑ ↑
SEC	Set Carry Bit (C ← 1)	INH	99	1	p	- 1 1 -	- - - 1
SEI	Set Interrupt Mask Bit (I ← 1)	INH	9B	1	p	- 1 1 -	1 - - -
STA opr8a STA opr16a STA oprx16,X STA oprx8,X STA ,X STA oprx16,SP STA oprx8,SP	Store Accumulator in Memory M ← (A)	DIR EXT IX2 IX1 IX SP2 SP1	B7 dd C7 hh ll D7 ee ff E7 ff F7 9E D7 ee ff 9E E7 ff	3 4 4 3 2 5 4	wpp pwpp pwpp wpp wp ppwpp pwpp	0 1 1 -	- ↑ ↓ -
STHX opr8a STHX opr16a STHX oprx8,SP	Store H:X (Index Reg.) (M:M + \$0001) ← (H:X)	DIR EXT SP1	35 dd 96 hh ll 9E FF ff	4 5 5	wwpp pwwpp pwwpp	0 1 1 -	- ↑ ↓ -
STOP	Enable Interrupts: Stop Processing Refer to MCU Documentation I bit ← 0; Stop Processing	INH	8E	2	fp...	- 1 1 -	0 - - -
STX opr8a STX opr16a STX oprx16,X STX oprx8,X STX ,X STX oprx16,SP STX oprx8,SP	Store X (Low 8 Bits of Index Register) in Memory M ← (X)	DIR EXT IX2 IX1 IX SP2 SP1	BF dd CF hh ll DF ee ff EF ff FF 9E DF ee ff 9E EF ff	3 4 4 3 2 5 4	wpp pwpp pwpp wpp wp ppwpp pwpp	0 1 1 -	- ↑ ↓ -

Table 8-2. Instruction Set Summary (Sheet 8 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V I 1 H	I N Z C
SUB #opr8i SUB opr8a SUB opr16a SUB oprx16,X SUB oprx8,X SUB ,X SUB oprx16,SP SUB oprx8,SP	Subtract $A \leftarrow (A) - (M)$	IMM DIR EXT IX2 IX1 IX SP2 SP1	A0 ii B0 dd C0 hh ll D0 ee ff E0 ff F0 9E D0 ee ff 9E E0 ff	2 3 4 4 3 3 5 4	pp rpp prpp prpp rpp rfp pprpp prpp	$\uparrow 1 1 -$	$- \uparrow \uparrow \uparrow$
SWI	Software Interrupt $PC \leftarrow (PC) + \$0001$ Push (PCL); $SP \leftarrow (SP) - \$0001$ Push (PCH); $SP \leftarrow (SP) - \$0001$ Push (X); $SP \leftarrow (SP) - \$0001$ Push (A); $SP \leftarrow (SP) - \$0001$ Push (CCR); $SP \leftarrow (SP) - \$0001$ $I \leftarrow 1$; PCH \leftarrow Interrupt Vector High Byte PCL \leftarrow Interrupt Vector Low Byte	INH	83	11	sssssvvfppp	$- 1 1 -$	$1 - - -$
TAP	Transfer Accumulator to CCR $CCR \leftarrow (A)$	INH	84	1	p	$\uparrow 1 1 \uparrow$	$\uparrow \uparrow \uparrow \uparrow$
TAX	Transfer Accumulator to X (Index Register Low) $X \leftarrow (A)$	INH	97	1	p	$- 1 1 -$	$- - - -$
TPA	Transfer CCR to Accumulator $A \leftarrow (CCR)$	INH	85	1	p	$- 1 1 -$	$- - - -$
TST opr8a TSTA TSTX TST oprx8,X TST ,X TST oprx8,SP	Test for Negative or Zero (M) – \$00 (A) – \$00 (X) – \$00 (M) – \$00 (M) – \$00 (M) – \$00	DIR INH INH IX1 IX SP1	3D dd 4D 5D 6D ff 7D 9E 6D ff	4 1 1 4 3 5	rfpp p p rfpp rfp prfpp	$0 1 1 -$	$- \uparrow \uparrow -$
TSX	Transfer SP to Index Reg. $H:X \leftarrow (SP) + \$0001$	INH	95	2	fp	$- 1 1 -$	$- - - -$
TXA	Transfer X (Index Reg. Low) to Accumulator $A \leftarrow (X)$	INH	9F	1	p	$- 1 1 -$	$- - - -$

Table 8-2. Instruction Set Summary (Sheet 9 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V I 1 H	I N Z C
TXS	Transfer Index Reg. to SP $SP \leftarrow (H:X) - \$0001$	INH	94	2	f _p	- 1 1 -	- - - -
WAIT	Enable Interrupts; Wait for Interrupt I bit \leftarrow 0; Halt CPU	INH	8F	2+	f _p ...	- 1 1 -	0 - - -

Source Form: Everything in the source forms columns, *except expressions in italic characters*, is literal information which must appear in the assembly source file exactly as shown. The initial 3- to 5-letter mnemonic and the characters (#, (,) and +) are always a literal characters.

- n* Any label or expression that evaluates to a single integer in the range 0-7.
- opr8i* Any label or expression that evaluates to an 8-bit immediate value.
- opr16i* Any label or expression that evaluates to a 16-bit immediate value.
- opr8a* Any label or expression that evaluates to an 8-bit direct-page address (\$00xx).
- opr16a* Any label or expression that evaluates to a 16-bit address.
- opr8* Any label or expression that evaluates to an unsigned 8-bit value, used for indexed addressing.
- opr16* Any label or expression that evaluates to a 16-bit value, used for indexed addressing.
- rel* Any label or expression that refers to an address that is within -128 to +127 locations from the start of the next instruction.

Operation Symbols:

- A Accumulator
- CCR Condition code register
- H Index register high byte
- M Memory location
- n* Any bit
- opr* Operand (one or two bytes)
- PC Program counter
- PCH Program counter high byte
- PCL Program counter low byte
- rel* Relative program counter offset byte
- SP Stack pointer
- SPL Stack pointer low byte
- X Index register low byte
- & Logical AND
- | Logical OR
- ⊕ Logical EXCLUSIVE OR
- () Contents of
- + Add
- Subtract, Negation (two's complement)
- × Multiply
- ÷ Divide
- # Immediate value
- ← Loaded with
- :

CCR Bits:

- V Overflow bit
- H Half-carry bit
- I Interrupt mask
- N Negative bit
- Z Zero bit
- C Carry/borrow bit

Addressing Modes:

- DIR Direct addressing mode
- EXT Extended addressing mode
- IMM Immediate addressing mode
- INH Inherent addressing mode
- IX Indexed, no offset addressing mode
- IX1 Indexed, 8-bit offset addressing mode
- IX2 Indexed, 16-bit offset addressing mode
- IX+ Indexed, no offset, post increment addressing mode
- IX1+ Indexed, 8-bit offset, post increment addressing mode
- REL Relative addressing mode
- SP1 Stack pointer, 8-bit offset addressing mode
- SP2 Stack pointer 16-bit offset addressing mode

Cycle-by-Cycle Codes:

- f Free cycle. This indicates a cycle where the CPU does not require use of the system buses. An f cycle is always one cycle of the system bus clock and is always a read cycle.
- p Program fetch; read from next consecutive location in program memory
- r Read 8-bit operand
- s Push (write) one byte onto stack
- u Pop (read) one byte from stack
- v Read vector from \$FFxx (high byte first)
- w Write 8-bit operand

CCR Effects:

- ↑ Set or cleared
- Not affected
- U Undefined

Table 8-3. Opcode Map (Sheet 1 of 2)

Bit-Manipulation			Branch		Read-Modify-Write								Control				Register/Memory														
00	5	10	5	20	3	30	5	40	1	50	5	60	5	70	4	80	9	90	3	A0	2	B0	3	C0	4	D0	4	E0	3	F0	3
BRSET0	DIR	BSET0	DIR	BRA	REL	NEG	DIR	NEGA	INH	NEGX	INH	NEG	IX1	NEG	IX	RTI	INH	BGE	REL	SUB	IMM	SUB	DIR	SUB	EXT	SUB	IX2	SUB	IX1	SUB	IX
01	5	11	5	21	3	31	5	41	4	51	4	61	5	71	5	81	6	91	3	A1	2	B1	3	C1	4	D1	4	E1	3	F1	3
BRCLR0	DIR	BCLR0	DIR	BRN	REL	CBEQ	DIR	CBEQA	IMM	CBEQX	IMM	CBEQ	IX1+	CBEQ	IX+	RTS	INH	BLT	REL	CMP	IMM	CMP	DIR	CMP	EXT	CMP	IX2	CMP	IX1	CMP	IX
02	5	12	5	22	3	32	5	42	5	52	6	62	1	72	1	82	5+	92	3	A2	2	B2	3	C2	4	D2	4	E2	3	F2	3
BRSET1	DIR	BSET1	DIR	BHI	REL	LDHX	EXT	MUL	INH	DIV	INH	NSA	INH	DAA	INH	BGND	INH	BGT	REL	SBC	IMM	SBC	DIR	SBC	EXT	SBC	IX2	SBC	IX1	SBC	IX
03	5	13	5	23	3	33	5	43	1	53	1	63	5	73	4	83	11	93	3	A3	2	B3	3	C3	4	D3	4	E3	3	F3	3
BRCLR1	DIR	BCLR1	DIR	BLS	REL	COM	DIR	COMA	INH	COMX	INH	COM	IX1	COM	IX	SWI	INH	BLE	REL	CPX	IMM	CPX	DIR	CPX	EXT	CPX	IX2	CPX	IX1	CPX	IX
04	5	14	5	24	3	34	5	44	1	54	1	64	5	74	4	84	1	94	2	A4	2	B4	3	C4	4	D4	4	E4	3	F4	3
BRSET2	DIR	BSET2	DIR	BCC	REL	LSR	DIR	LSRA	INH	LSRX	INH	LSR	IX1	LSR	IX	TAP	INH	TXS	INH	AND	IMM	AND	DIR	AND	EXT	AND	IX2	AND	IX1	AND	IX
05	5	15	5	25	3	35	4	45	3	55	4	65	3	75	5	85	1	95	2	A5	2	B5	3	C5	4	D5	4	E5	3	F5	3
BRCLR2	DIR	BCLR2	DIR	BCS	REL	STHX	DIR	LDHX	IMM	LDHX	DIR	CPHX	IMM	CPHX	DIR	TPA	INH	TSX	INH	BIT	IMM	BIT	DIR	BIT	EXT	BIT	IX2	BIT	IX1	BIT	IX
06	5	16	5	26	3	36	5	46	1	56	1	66	5	76	4	86	3	96	5	A6	2	B6	3	C6	4	D6	4	E6	3	F6	3
BRSET3	DIR	BSET3	DIR	BNE	REL	ROR	DIR	RORA	INH	RORX	INH	ROR	IX1	ROR	IX	PULA	INH	STHX	EXT	LDA	IMM	LDA	DIR	LDA	EXT	LDA	IX2	LDA	IX1	LDA	IX
07	5	17	5	27	3	37	5	47	1	57	1	67	5	77	4	87	2	97	1	A7	2	B7	3	C7	4	D7	4	E7	3	F7	2
BRCLR3	DIR	BCLR3	DIR	BEQ	REL	ASR	DIR	ASRA	INH	ASRX	INH	ASR	IX1	ASR	IX	PSHA	INH	TAX	INH	AIS	IMM	STA	DIR	STA	EXT	STA	IX2	STA	IX1	STA	IX
08	5	18	5	28	3	38	5	48	1	58	1	68	5	78	4	88	3	98	1	A8	2	B8	3	C8	4	D8	4	E8	3	F8	3
BRSET4	DIR	BSET4	DIR	BHCC	REL	LSL	DIR	LSLA	INH	LSLX	INH	LSL	IX1	LSL	IX	PULX	INH	CLC	INH	EOR	IMM	EOR	DIR	EOR	EXT	EOR	IX2	EOR	IX1	EOR	IX
09	5	19	5	29	3	39	5	49	1	59	1	69	5	79	4	89	2	99	1	A9	2	B9	3	C9	4	D9	4	E9	3	F9	3
BRCLR4	DIR	BCLR4	DIR	BHCS	REL	ROL	DIR	ROLA	INH	ROLX	INH	ROL	IX1	ROL	IX	PSHX	INH	SEC	INH	ADC	IMM	ADC	DIR	ADC	EXT	ADC	IX2	ADC	IX1	ADC	IX
0A	5	1A	5	2A	3	3A	5	4A	1	5A	1	6A	5	7A	4	8A	3	9A	1	AA	2	BA	3	CA	4	DA	4	EA	3	FA	3
BRSET5	DIR	BSET5	DIR	BPL	REL	DEC	DIR	DECA	INH	DECX	INH	DEC	IX1	DEC	IX	PULH	INH	CLI	INH	ORA	IMM	ORA	DIR	ORA	EXT	ORA	IX2	ORA	IX1	ORA	IX
0B	5	1B	5	2B	3	3B	7	4B	4	5B	4	6B	7	7B	6	8B	2	9B	1	AB	2	BB	3	CB	4	DB	4	EB	3	FB	3
BRCLR5	DIR	BCLR5	DIR	BMI	REL	DBNZ	DIR	DBNZA	INH	DBNZX	INH	DBNZ	IX1	DBNZ	IX	PSHH	INH	SEI	INH	ADD	IMM	ADD	DIR	ADD	EXT	ADD	IX2	ADD	IX1	ADD	IX
0C	5	1C	5	2C	3	3C	5	4C	1	5C	1	6C	5	7C	4	8C	1	9C	1			BC	3	CC	4	DC	4	EC	3	FC	3
BRSET6	DIR	BSET6	DIR	BMC	REL	INC	DIR	INCA	INH	INCX	INH	INC	IX1	INC	IX	CLRH	INH	RSP	INH			JMP	DIR	JMP	EXT	JMP	IX2	JMP	IX1	JMP	IX
0D	5	1D	5	2D	3	3D	4	4D	1	5D	1	6D	4	7D	3			9D	1	AD	5	BD	5	CD	6	DD	6	ED	5	FD	5
BRCLR6	DIR	BCLR6	DIR	BMS	REL	TST	DIR	TSTA	INH	TSTX	INH	TST	IX1	TST	IX			NOP	INH	BSR	REL	JSR	DIR	JSR	EXT	JSR	IX2	JSR	IX1	JSR	IX
0E	5	1E	5	2E	3	3E	6	4E	5	5E	5	6E	4	7E	5	8E	2+	9E	Page 2	AE	2	BE	3	CE	4	DE	4	EE	3	FE	3
BRSET7	DIR	BSET7	DIR	BIL	REL	CPHX	EXT	MOV	DD	MOV	DIX+	MOV	IMD	MOV	IX+D	STOP	INH			LDX	IMM	LDX	DIR	LDX	EXT	LDX	IX2	LDX	IX1	LDX	IX
0F	5	1F	5	2F	3	3F	5	4F	1	5F	1	6F	5	7F	4	8F	2+	9F	1	AF	2	BF	3	CF	4	DF	4	EF	3	FF	2
BRCLR7	DIR	BCLR7	DIR	BIH	REL	CLR	DIR	CLRA	INH	CLR	INH	CLR	IX1	CLR	IX	WAIT	INH	TXA	INH	AIX	IMM	STX	DIR	STX	EXT	STX	IX2	STX	IX1	STX	IX

INH Inherent
 IMM Immediate
 DIR Direct
 EXT Extended
 DD DIR to DIR
 IX+D IX+ to DIR
 REL Relative
 IX Indexed, No Offset
 IX1 Indexed, 8-Bit Offset
 IX2 Indexed, 16-Bit Offset
 IMM to DIR
 DIR to IX+
 SP1 Stack Pointer, 8-Bit Offset
 SP2 Stack Pointer, 16-Bit Offset
 IX+ Indexed, No Offset with Post Increment
 IX1+ Indexed, 1-Byte Offset with Post Increment

Opcode in
 Hexadecimal F0 SUB 3
 Number of Bytes 1 IX
 HCS08 Cycles
 Instruction Mnemonic
 Addressing Mode

Table 8-3. Opcode Map (Sheet 2 of 2)

Bit-Manipulation	Branch	Read-Modify-Write				Control				Register/Memory							
					9E60 6 3 SP1 NEG						9ED0 5 4 SP2 SUB	9EE0 4 3 SP1 SUB					
					9E61 6 4 SP1 CBEQ						9ED1 5 4 SP2 CMP	9EE1 4 3 SP1 CMP					
											9ED2 5 4 SP2 SBC	9EE2 4 3 SP1 SBC					
					9E63 6 3 SP1 COM						9ED3 5 4 SP2 CPX	9EE3 4 3 SP1 CPX	9EF3 6 3 SP1 CPHX				
					9E64 6 3 SP1 LSR						9ED4 5 4 SP2 AND	9EE4 4 3 SP1 AND					
											9ED5 5 4 SP2 BIT	9EE5 4 3 SP1 BIT					
					9E66 6 3 SP1 ROR						9ED6 5 4 SP2 LDA	9EE6 4 3 SP1 LDA					
					9E67 6 3 SP1 ASR						9ED7 5 4 SP2 STA	9EE7 4 3 SP1 STA					
					9E68 6 3 SP1 LSL						9ED8 5 4 SP2 EOR	9EE8 4 3 SP1 EOR					
					9E69 6 3 SP1 ROL						9ED9 5 4 SP2 ADC	9EE9 4 3 SP1 ADC					
					9E6A 6 3 SP1 DEC						9EDA 5 4 SP2 ORA	9EEA 4 3 SP1 ORA					
					9E6B 8 4 SP1 DBNZ						9EDB 5 4 SP2 ADD	9EEB 4 3 SP1 ADD					
					9E6C 6 3 SP1 INC												
					9E6D 5 3 SP1 TST												
										9EAE 5 2 IX LDHX	9EBE 6 4 IX2 LDHX	9ECE 5 3 IX1 LDHX	9EDE 5 4 SP2 LDX	9EEE 4 3 SP1 LDX	9EFE 5 3 SP1 LDHX		
					9E6F 6 3 SP1 CLR						9EDF 5 4 SP2 STX	9EEF 4 3 SP1 STX	9EFF 5 3 SP1 STHX				

INH Inherent REL Relative SP1 Stack Pointer, 8-Bit Offset
 IMM Immediate IX Indexed, No Offset SP2 Stack Pointer, 16-Bit Offset
 DIR Direct IX1 Indexed, 8-Bit Offset IX+ Indexed, No Offset with
 EXT Extended IX2 Indexed, 16-Bit Offset Post Increment
 DD DIR to DIR IMD IMM to DIR IX1+ Indexed, 1-Byte Offset with
 IX+D IX+ to DIR DIX+ DIR to IX+ Post Increment

Note: All Sheet 2 Opcodes are Preceded by the Page 2 Prebyte (9E)

Prebyte (9E) and Opcode in
 Hexadecimal

9E60 6
3 SP1 NEG

 HCS08 Cycles
 Number of Bytes

3

 Instruction Mnemonic
 Addressing Mode

Chapter 9

Analog Comparator (S08ACMPVLPV1)

9.1 Introduction

MC9S08QE8 series MCUs have two independent analog comparators (ACMPs), named ACMP1 and ACMP2.

The analog comparator module (ACMP) provides a circuit for comparing two analog input voltages or for comparing one analog input voltage to an internal reference voltage. The comparator circuit is designed to operate across the full range of the supply voltage (rail-to-rail operation).

ACMP option to compare to internal bandgap reference is not allowed in LPRUN and LPWAIT.

[Figure 9-1](#) shows the MC9S08QE8 series block diagram with the ACMP highlighted.

9.1.1 ACMP Configuration Information

When using the bandgap reference voltage for input to ACMP1+ and/or ACMP2+, the user must enable the bandgap buffer by setting BGBE = 1 in SPMSC1 see [Section 5.8.7, “System Power Management Status and Control 1 Register \(SPMSC1\)”](#). For value of bandgap voltage reference see the data sheet.

9.1.2 ACMP/TPM Configuration Information

The ACMP modules can be configured to connect the output of the analog comparator to a TPM input capture channel 0 by setting the corresponding ACICx bit in SOPT2. With ACICx set, the TPMxCH0 pin is not available externally regardless of the configuration of the TPMx module.

The ACMP1 output can be connected to TPM1CH0; The ACMP2 output can be connected to TPM2CH0.

9.1.3 ACMP Clock Gating

The bus clock to the ACMP can be gated on and off using the ACMP bit in SCGC2. This bit is set after any reset, which enables the bus clock to this module. To conserve power, the ACMP bit can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

9.1.4 Interrupt Vectors

ACMP1 and ACMP2 share a single interrupt vector, located at address 0xFFD6:0xFFD7. When interrupts are enabled for both ACMPs, the ACF bit must be polled in the ACMP1SC and ACMP2SC registers to determine which ACMP caused the interrupt.

9.1.5 Stop1 Not Available

This device is not intended for low power applications. Therefore stop1 is not available.

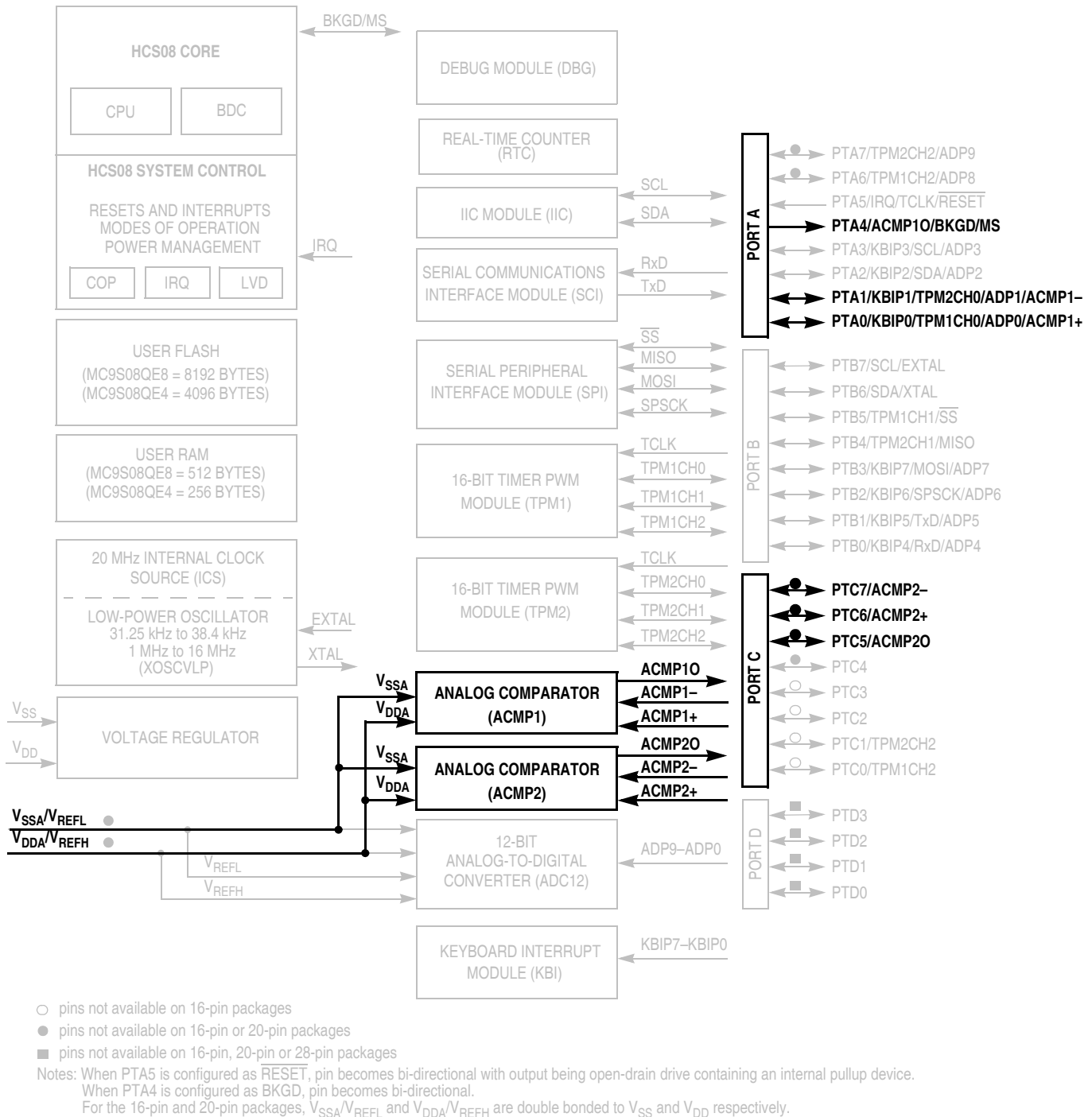


Figure 9-1. MC9S08QE8 Series Block Diagram Highlighting ACMP Blocks and Pins

9.1.6 Features

The ACMP has the following features:

- Full rail-to-rail supply operation
- Low input offset and hysteresis
- Selectable interrupt on rising edge, falling edge, or rising and falling edges of comparator output
- Option to compare to fixed internal bandgap reference voltage

9.1.7 Modes of Operation

9.1.7.1 Wait Mode Operation

During wait mode the ACMP, if enabled, continues to operate normally. Also, if enabled, the interrupt can wake the MCU.

9.1.7.2 Stop3 Mode Operation

If enabled, the ACMP continues to operate in stop3 mode and compare operation remains active. If ACOPE is enabled, comparator output operates in the normal operating mode and comparator output is placed onto the external pin. The MCU is brought out of stop when a compare event occurs and ACIE is enabled; ACF flag sets accordingly.

If stop is exited with a reset, the ACMP will be put into its reset state.

9.1.7.3 Stop2 Mode Operation

During stop2 mode, the ACMP module is fully powered down. Upon wakeup from stop2 mode, the ACMP module is in the reset state.

9.1.7.4 Active Background Mode Operation

When the microcontroller is in active background mode, the ACMP continues to operate normally. When ACMPO is shared with the BKGD pin and the BKGD pin is enabled, the ACMPO function is not available.

9.1.8 Block Diagram

The block diagram for the ACMP module follows.

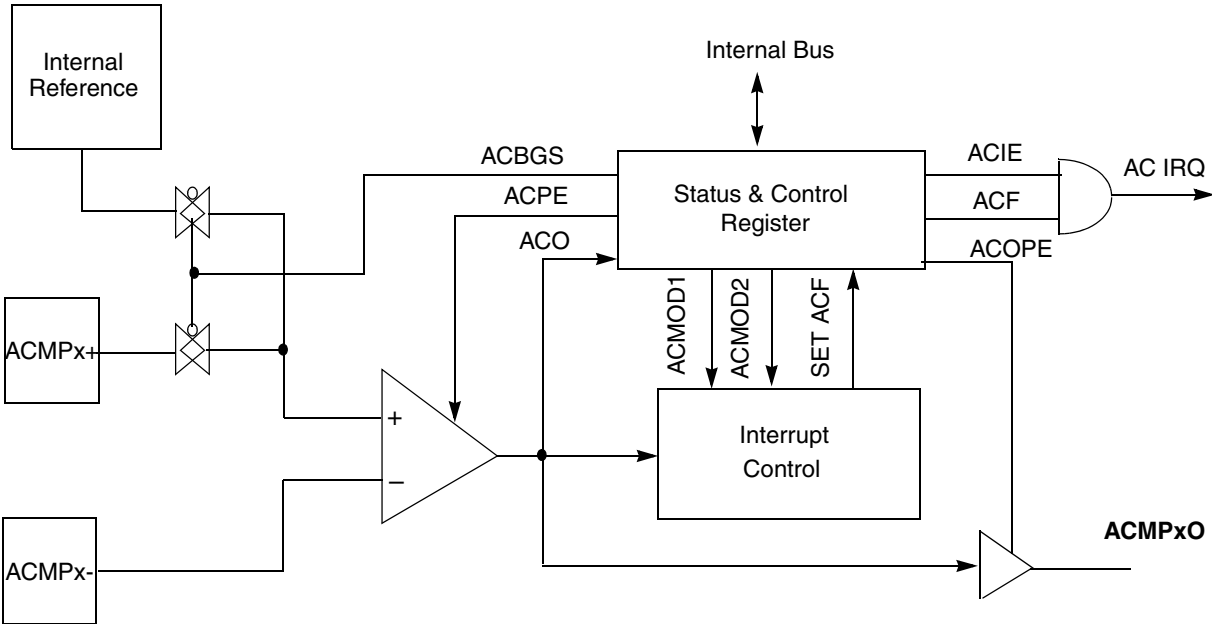


Figure 9-2. Analog Comparator Module Block Diagram

9.2 External Signal Description

The ACMP has two analog input pins: ACMP- and ACMP+. Each of these pins can accept an input voltage that varies across the full operating voltage range of the MCU. If the module is not enabled, each of these pins can be used as digital inputs or outputs. Consult the specific MCU documentation to determine what functions are shared with these analog inputs. As shown in the block diagram, the ACMP+ pin is connected to the comparator non-inverting input if ACBGS is equal to logic zero, and the ACMP- pin is connected to the inverting input of the comparator.

9.3 Register Definition

9.3.1 Status and Control Register (ACMPxSC)

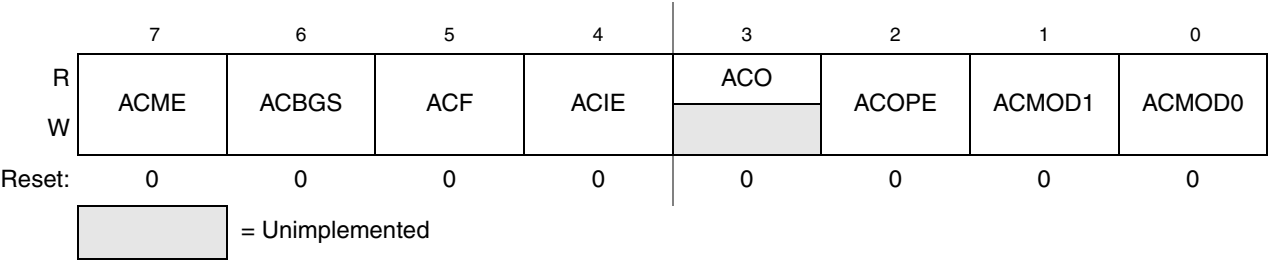


Figure 9-3. ACMP Status and Control Register (ACMPxSC)

Table 9-1. ACMPxSC Field Descriptions

Field	Description
7 ACME	Analog Comparator Module Enable — The ACME bit enables the ACMP module. When the module is not enabled, it remains in a low power state. 0 Analog Comparator disabled. 1 Analog Comparator enabled.
6 ACBGS	Analog Comparator Bandgap Select — The ACBGS bit selects the internal bandgap as the comparator reference. 0 External pin ACMP+ selected as comparator non-inverting input. 1 Internal bandgap reference selected as comparator non-inverting input.
5 ACF	Analog Comparator Flag — The ACF bit is set when a compare event occurs. Compare events are defined by the ACMOD0 and ACMOD1 bits. The ACF bit is cleared by writing a logic one to the bit. 0 Compare event has not occurred. 1 Compare event has occurred.
4 ACIE	Analog Comparator Interrupt Enable — The ACIE bit enables the interrupt from the ACM. When this bit is set, an interrupt is asserted when the ACF bit is set. 0 Interrupt disabled. 1 Interrupt enabled.
3 ACO	Analog Comparator Output — Reading the ACO bit returns the current value of the analog comparator output. The register bit is reset to zero and reads as logic zero when the ACMP module is disabled (ACME = 0).
2 ACOPE	Analog Comparator Output Pin Enable — ACOPE enables the comparator output to be placed onto the external pin, ACMPxO. 0 Analog comparator output not available on ACMPxO. 1 Analog comparator output is driven out on ACMPxO.
1:0 ACMOD	Analog Comparator Modes — The ACMOD1 and ACMOD0 bits select the flag setting mode that controls the type of compare event that sets the ACF bit. 00 Comparator output falling edge. 01 Comparator output rising edge. 10 Comparator output falling edge. 11 Comparator output rising and falling edge.

9.4 Functional Description

The ACMP module can be used to compare:

- Two analog input voltages applied to ACMP- and ACMP+ or
- An analog input voltage applied to ACMP- with an internal bandgap reference voltage

The ACBGS bit selects the mode of operation. The comparator output is high when the non-inverting input is greater than the inverting input, and low when the non-inverting input is less than the inverting input. The ACMOD0 and ACMOD1 bits select the condition that causes the ACF bit to be set. The ACF bit can be set on a rising edge of the comparator output, a falling edge of the comparator output, or a rising and a falling edge (toggle). The comparator output can be read directly through the ACO bit.

9.5 Interrupts

The ACMP module is capable of generating an interrupt on a compare event. The interrupt request is asserted when both the ACIE bit and the ACF bit are set. The interrupt is deasserted by clearing either the

ACIE bit or the ACF bit. The ACIE bit is cleared by writing a logic zero and the ACF bit is cleared by writing a logic one.

Chapter 10

Analog-to-Digital Converter (S08ADC12V1)

10.1 Introduction

The 12-bit analog-to-digital converter (ADC) is a successive approximation ADC designed for operation within an integrated microcontroller system-on-chip.

[Figure 10-1](#) shows the MC9S08QE8 series with the ADC module and pins highlighted.

10.1.1 ADC Clock Gating

The bus clock to the ADC can be gated on and off using the ADC bit in SCGC1. This bit is set after any reset, which enables the bus clock to this module. To conserve power, the ADC bit can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

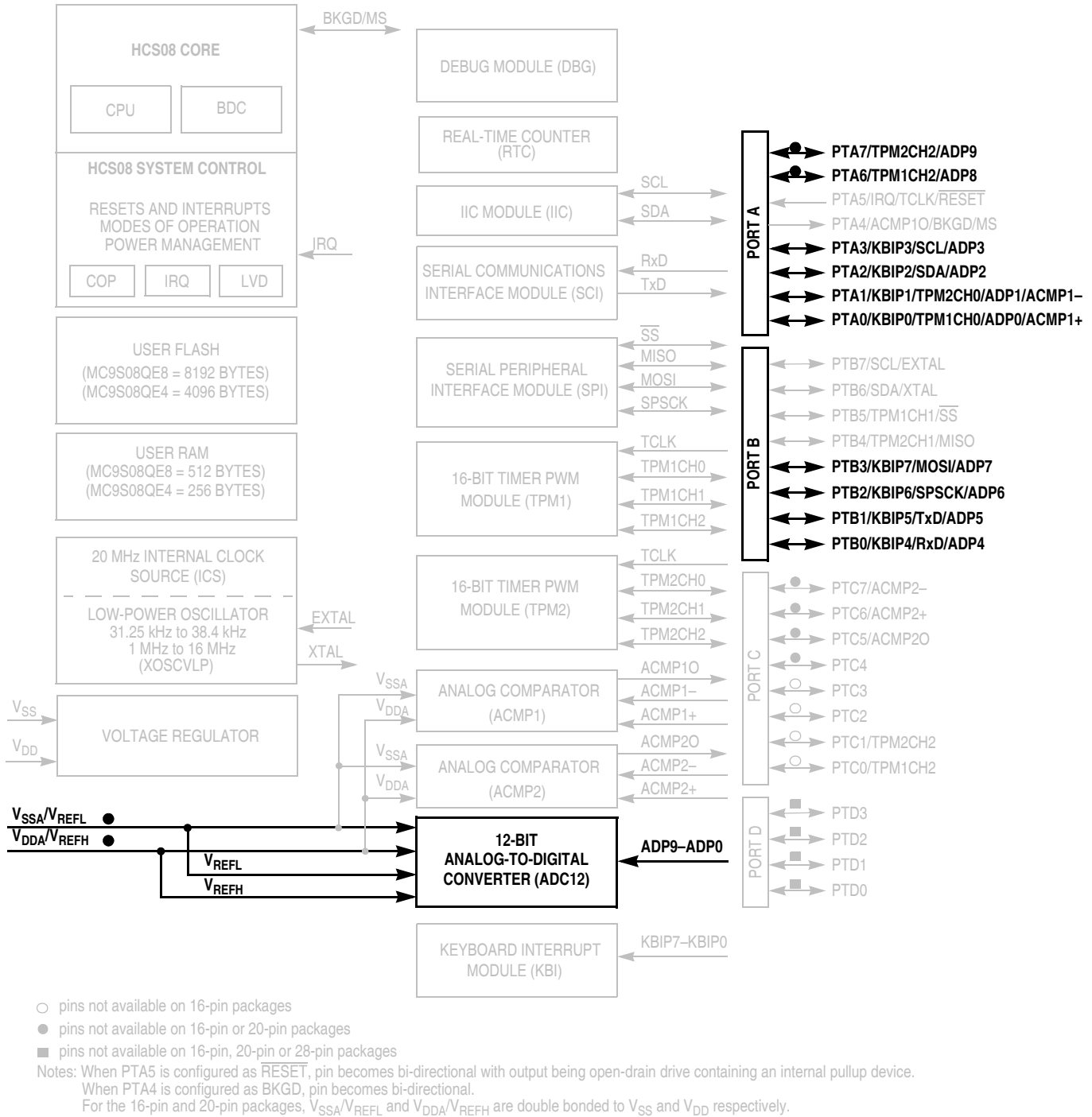


Figure 10-1. MC9S08QE8 Series Block Diagram Highlighting ADC Block and Pins

10.1.2 Module Configurations

This section provides device-specific information for configuring the ADC on MC9S08QE8 series.

10.1.2.1 Analog Supply and Voltage Reference Connections

The MC9S08QE8 series contain separate V_{DDA}/V_{REFH} and V_{SSA}/V_{REFL} pins on 28-pin and 32-pin devices. These pins are double bonded to V_{DD} and V_{SS} , respectively, in the 16-pin and 20-pin packages.

10.1.2.2 Configurations for Stop Modes

The ADC, if enabled, must be configured to use the asynchronous clock source, ADACK, to meet the ADC minimum frequency requirements. The bandgap channel cannot be converted in low power run mode.

10.1.2.3 Channel Assignments

The ADC channel assignments for the MC9S08QE8 series devices are shown in Table 10-1. Reserved channels convert to an unknown value.

Table 10-1. ADC Channel Assignment

ADCH	Channel	Input	Pin Control	ADCH	Channel	Input	Pin Control
00000	AD0	PTA0/ADP0	ADPC0	10000	AD16	V_{REFL}	N/A
00001	AD1	PTA1/ADP1	ADPC1	10001	AD17	V_{REFL}	N/A
00010	AD2	PTA2/ADP2	ADPC2	10010	AD18	V_{REFL}	N/A
00011	AD3	PTA3/ADP3	ADPC3	10011	AD19	V_{REFL}	N/A
00100	AD4	PTB0/ADP4	ADPC4	10100	AD20	V_{REFL}	N/A
00101	AD5	PTB1/ADP5	ADPC5	10101	AD21	V_{REFL}	N/A
00110	AD6	PTB2/ADP6	ADPC6	10110	AD22	V_{REFL}	N/A
00111	AD7	PTB3/ADP7	ADPC7	10111	AD23	Reserved	N/A
01000	AD8	PTA6/ADP8	ADPC8	11000	AD24	Reserved	N/A
01001	AD9	PTA7/ADP9	ADPC9	11001	AD25	Reserved	N/A
01010	AD10	V_{REFL}	N/A	11010	AD26	Temperature Sensor ¹	N/A
01011	AD11	V_{REFL}	N/A	11011	AD27	Internal Bandgap	N/A
01100	AD12	V_{REFL}	N/A	11100	—	Reserved	N/A
01101	AD13	V_{REFL}	N/A	11101	V_{REFH} ²	V_{REFH}	N/A
01110	AD14	V_{REFL}	N/A	11110	V_{REFL} ³	V_{SS}	N/A
01111	AD15	V_{REFL}	N/A	11111	Module Disabled	None	N/A

¹ For information, see Section 10.1.2.6, “Temperature Sensor.”

² V_{REFH} is tied to V_{DDA} in 28-pin package, and both V_{REFH} and V_{DDA} are tied to V_{DD} in 20-pin and 16-pin packages.

³ V_{REFL} is tied to V_{SSA} in 28-pin package, and both V_{REFL} and V_{SSA} are tied to V_{SS} in 20-pin and 16-pin packages.

NOTE

Selecting the internal bandgap channel requires BGBE = 1 in SPMSC1 see [Section 5.8.7, “System Power Management Status and Control 1 Register \(SPMSC1\)”](#). For value of bandgap voltage reference see the data sheet.

10.1.2.4 Alternate Clock

The ADC is capable of performing conversions using the MCU bus clock, the bus clock divided by two, the local asynchronous clock (ADACK) within the module, or the alternate clock (ALTCLK). The ALTCLK on the MC9S08QE8 series is the ICSERCLK. See [Chapter 11, “Internal Clock Source \(S08ICSV3\)”](#), for more information.

10.1.2.5 Hardware Trigger

This RTC can be enabled as a hardware trigger for the ADC module by setting the ADTRG bit in the ADCSC2 register. When enabled, the ADC will be triggered every time RTCINT matches RTCMOD. The RTC interrupt does not have to be enabled to trigger the ADC.

The RTC can be clocked by either ICSIRCLK, OSCOUT or LPO. The period of the RTC is determined by the input clock frequency and the RTC configuration bits. When the ADC hardware trigger is enabled, a conversion is initiated upon a RTC overflow.

The RTC can be configured to cause a hardware trigger in MCU run, wait, low power run, low power wait, and stop3.

10.1.2.6 Temperature Sensor

The ADC module includes a temperature sensor whose output is connected to one of the ADC analog channel inputs. [Equation 10-1](#) provides an approximate transfer function of the temperature sensor.

$$\text{Temp} = 25 - ((V_{\text{TEMP}} - V_{\text{TEMP25}}) \div m) \quad \text{Eqn. 10-1}$$

where:

- V_{TEMP} is the voltage of the temperature sensor channel at the ambient temperature.
- V_{TEMP25} is the voltage of the temperature sensor channel at 25°C.
- m is the hot or cold voltage versus temperature slope in V/°C.

For temperature calculations, use the V_{TEMP25} and m values in the data sheet.

In application code, the user reads the temperature sensor channel, calculates V_{TEMP} , and compares it to V_{TEMP25} . If V_{TEMP} is greater than V_{TEMP25} the cold slope value is applied in [Equation 10-1](#). If V_{TEMP} is less than V_{TEMP25} the hot slope value is applied in [Equation 10-1](#).

10.1.3 Features

Features of the ADC module include:

- Linear successive approximation algorithm with 12-bit resolution
- Up to 28 analog inputs
- Output formatted in 12-, 10-, or 8-bit right-justified unsigned format
- Single or continuous conversion (automatic return to idle after single conversion)
- Configurable sample time and conversion speed/power
- Conversion complete flag and interrupt
- Input clock selectable from up to four sources
- Operation in wait or stop3 modes for lower noise operation
- Asynchronous clock source for lower noise operation
- Selectable asynchronous hardware conversion trigger
- Automatic compare with interrupt for less-than, or greater-than or equal-to, programmable value
- Temperature sensor

10.1.4 ADC Module Block Diagram

Figure 10-2 provides a block diagram of the ADC module.

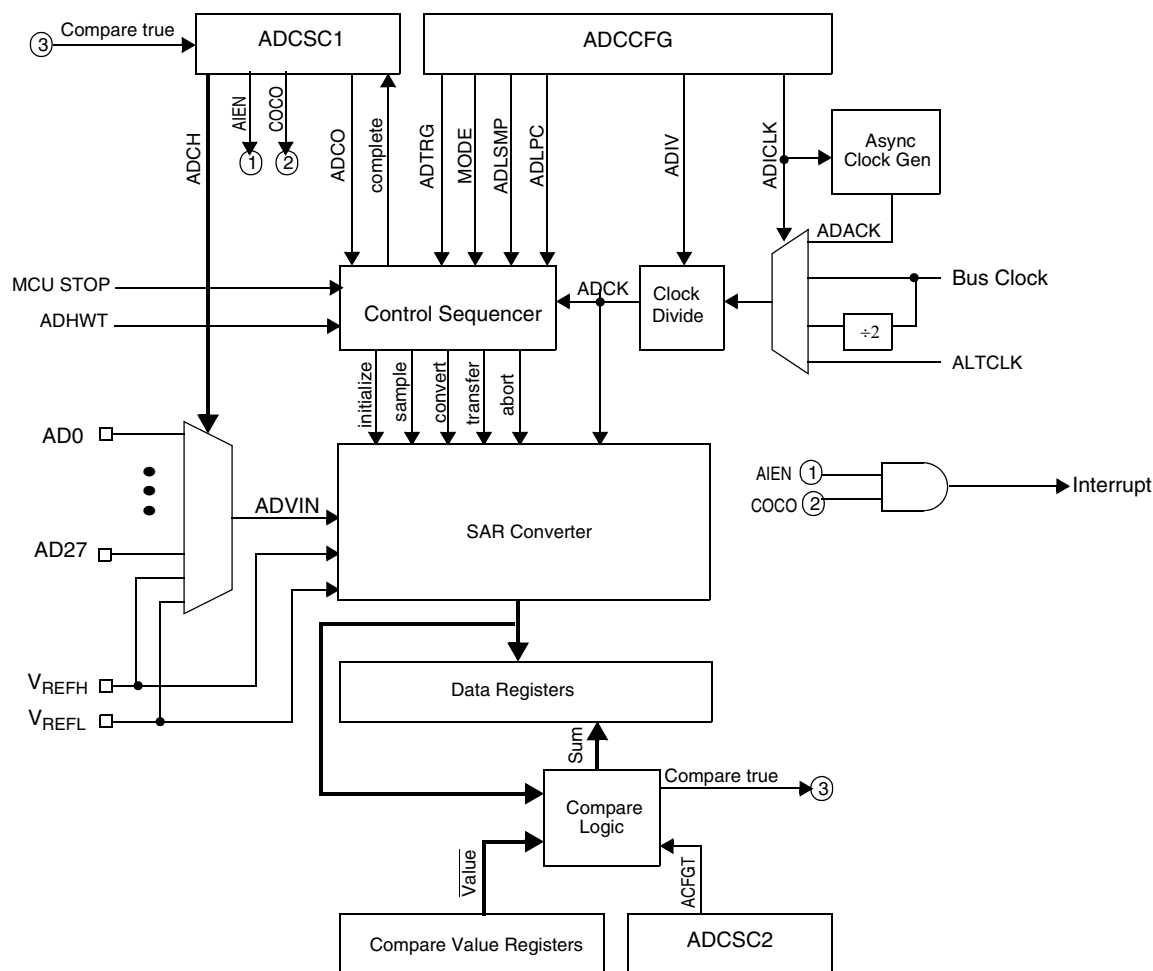


Figure 10-2. ADC Block Diagram

10.2 External Signal Description

The ADC module supports up to 28 separate analog inputs. It also requires four supply/reference/ground connections.

Table 10-2. Signal Properties

Name	Function
AD27–AD0	Analog Channel inputs
V _{REFH}	High reference voltage
V _{REFL}	Low reference voltage
V _{DDA}	Analog power supply
V _{SSA}	Analog ground

10.2.1 Analog Power (V_{DDA})

The ADC analog portion uses V_{DDA} as its power connection. In some packages, V_{DDA} is connected internally to V_{DD} . If externally available, connect the V_{DDA} pin to the same voltage potential as V_{DD} . External filtering may be necessary to ensure clean V_{DDA} for good results.

10.2.2 Analog Ground (V_{SSA})

The ADC analog portion uses V_{SSA} as its ground connection. In some packages, V_{SSA} is connected internally to V_{SS} . If externally available, connect the V_{SSA} pin to the same voltage potential as V_{SS} .

10.2.3 Voltage Reference High (V_{REFH})

V_{REFH} is the high reference voltage for the converter. In some packages, V_{REFH} is connected internally to V_{DDA} . If externally available, V_{REFH} may be connected to the same potential as V_{DDA} or may be driven by an external source between the minimum V_{DDA} spec and the V_{DDA} potential (V_{REFH} must never exceed V_{DDA}).

10.2.4 Voltage Reference Low (V_{REFL})

V_{REFL} is the low-reference voltage for the converter. In some packages, V_{REFL} is connected internally to V_{SSA} . If externally available, connect the V_{REFL} pin to the same voltage potential as V_{SSA} .

10.2.5 Analog Channel Inputs (ADx)

The ADC module supports up to 28 separate analog inputs. An input is selected for conversion through the ADCH channel select bits.

10.3 Register Definition

These memory-mapped registers control and monitor operation of the ADC:

- Status and control register, ADCSC1
- Status and control register, ADCSC2
- Data result registers, ADCRH and ADCRL
- Compare value registers, ADCCVH and ADCCVL
- Configuration register, ADCCFG
- Pin control registers, APCTL1, APCTL2, APCTL3

10.3.1 Status and Control Register 1 (ADCSC1)

This section describes the function of the ADC status and control register (ADCSC1). Writing ADCSC1 aborts the current conversion and initiates a new conversion (if the ADCH bits are equal to a value other than all 1s).

**Figure 10-3. Status and Control Register (ADCSC1)****Table 10-3. ADCSC1 Field Descriptions**

Field	Description
7 COCO	Conversion Complete Flag. The COCO flag is a read-only bit set each time a conversion is completed when the compare function is disabled (ACFE = 0). When the compare function is enabled (ACFE = 1), the COCO flag is set upon completion of a conversion only if the compare result is true. This bit is cleared when ADCSC1 is written or when ADCRL is read. 0 Conversion not completed 1 Conversion completed
6 AIEN	Interrupt Enable AIEN enables conversion complete interrupts. When COCO becomes set while AIEN is high, an interrupt is asserted. 0 Conversion complete interrupt disabled 1 Conversion complete interrupt enabled
5 ADCO	Continuous Conversion Enable. ADCO enables continuous conversions. 0 One conversion following a write to the ADCSC1 when software triggered operation is selected, or one conversion following assertion of ADHWT when hardware triggered operation is selected. 1 Continuous conversions initiated following a write to ADCSC1 when software triggered operation is selected. Continuous conversions are initiated by an ADHWT event when hardware triggered operation is selected.
4:0 ADCH	Input Channel Select. The ADCH bits form a 5-bit field that selects one of the input channels. The input channels are detailed in Table 10-4 . The successive approximation converter subsystem is turned off when the channel select bits are all set. This feature allows for explicit disabling of the ADC and isolation of the input channel from all sources. Terminating continuous conversions this way prevents an additional, single conversion from being performed. It is not necessary to set the channel select bits to all ones to place the ADC in a low-power state when continuous conversions are not enabled because the module automatically enters a low-power state when a conversion completes.

Table 10-4. Input Channel Select

ADCH	Input Select
00000–01111	AD0–15
10000–11011	AD16–27
11100	Reserved
11101	V _{REFH}
11110	V _{REFL}
11111	Module disabled

10.3.2 Status and Control Register 2 (ADCSC2)

The ADCSC2 register controls the compare function, conversion trigger, and conversion active of the ADC module.

	7	6	5	4	3	2	1	0
R	ADACT	ADTRG	ACFE	ACFGT	0	0	R ¹	R ¹
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-4. Status and Control Register 2 (ADCSC2)

¹ Bits 1 and 0 are reserved bits that must always be written to 0.

Table 10-5. ADCSC2 Register Field Descriptions

Field	Description
7 ADACT	Conversion Active. Indicates that a conversion is in progress. ADACT is set when a conversion is initiated and cleared when a conversion is completed or aborted. 0 Conversion not in progress 1 Conversion in progress
6 ADTRG	Conversion Trigger Select. Selects the type of trigger used for initiating a conversion. Two types of triggers are selectable: software trigger and hardware trigger. When software trigger is selected, a conversion is initiated following a write to ADCSC1. When hardware trigger is selected, a conversion is initiated following the assertion of the ADHWT input. 0 Software trigger selected 1 Hardware trigger selected
5 ACFE	Compare Function Enable. Enables the compare function. 0 Compare function disabled 1 Compare function enabled
4 ACFGT	Compare Function Greater Than Enable. Configures the compare function to trigger when the result of the conversion of the input being monitored is greater than or equal to the compare value. The compare function defaults to triggering when the result of the compare of the input being monitored is less than the compare value. 0 Compare triggers when input is less than compare value 1 Compare triggers when input is greater than or equal to compare value

10.3.3 Data Result High Register (ADCRH)

In 12-bit operation, ADCRH contains the upper four bits of 12-bit conversion data. In 10-bit operation, ADCRH contains the upper two bits of 10-bit conversion data. In 12-bit and 10-bit mode, ADCRH is updated each time a conversion completes except when automatic compare is enabled and the compare condition is not met. When configured for 10-bit mode, ADR[11:10] are cleared. When configured for 8-bit mode, ADR[11:8] are cleared.

When automatic compare is not enabled, the value stored in ADCRH are the upper bits of the conversion result. When automatic compare is enabled, the conversion result is manipulated as described in [Section 10.4.5, “Automatic Compare Function”](#) prior to storage in ADCRH:ADCRL registers.

In 12-bit and 10-bit mode, reading ADCRH prevents the ADC from transferring subsequent conversion data into the result registers until ADCRL is read. If ADCRL is not read until after the next conversion is completed, the intermediate conversion data is lost. In 8-bit mode, there is no interlocking with ADCRL. If the MODE bits are changed, any data in ADCRH becomes invalid.

	7	6	5	4	3	2	1	0
R	0	0	0	0	ADR11	ADR10	ADR9	ADR8
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-5. Data Result High Register (ADCRH)

10.3.4 Data Result Low Register (ADCRL)

ADCRL contains the lower eight bits of a 12-bit or 10-bit conversion data, and all eight bits of 8-bit conversion data. ADCRL is updated each time a conversion completes except when automatic compare is enabled and the compare condition is not met.

When automatic compare is not enabled, the value stored in ADCRL is the lower eight bits of the conversion result. When automatic compare is enabled, the conversion result is manipulated as described in [Section 10.4.5, “Automatic Compare Function”](#) prior to storage in ADCRH:ADCRL registers.

In 12-bit and 10-bit mode, reading ADCRH prevents the ADC from transferring subsequent conversion data into the result registers until ADCRL is read. If ADCRL is not read until the after next conversion is completed, the intermediate conversion data is lost. In 8-bit mode, there is no interlocking with ADCRH. If the MODE bits are changed, any data in ADCRL becomes invalid.

	7	6	5	4	3	2	1	0
R	ADR7	ADR6	ADR5	ADR4	ADR3	ADR2	ADR1	ADR0
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-6. Data Result Low Register (ADCRL)

10.3.5 Compare Value High Register (ADCCVH)

In 12-bit mode, the ADCCVH register holds the upper four bits of the 12-bit compare value. When the compare function is enabled, these bits are compared to the upper four bits of the result following a conversion in 12-bit mode.

	7	6	5	4	3	2	1	0
R	0	0	0	0	ADCV11	ADCV10	ADCV9	ADCV8
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-7. Compare Value High Register (ADCCVH)

In 10-bit mode, the ADCCVH register holds the upper two bits of the 10-bit compare value (ADCV[9:8]). These bits are compared to the upper two bits of the result following a conversion in 10-bit mode when the compare function is enabled.

In 8-bit mode, ADCCVH is not used during compare.

10.3.6 Compare Value Low Register (ADCCVL)

This register holds the lower eight bits of the 12-bit or 10-bit compare value or all eight bits of the 8-bit compare value. When the compare function is enabled, bits ADCV[7:0] are compared to the lower eight bits of the result following a conversion in 12-bit, 10-bit or 8-bit mode.

	7	6	5	4	3	2	1	0
R	ADCV7	ADCV6	ADCV5	ADCV4	ADCV3	ADCV2	ADCV1	ADCV0
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-8. Compare Value Low Register(ADCCVL)

10.3.7 Configuration Register (ADCCFG)

ADCCFG selects the mode of operation, clock source, clock divide, and configures for low power and long sample time.

	7	6	5	4	3	2	1	0
R	ADLPC	ADIV		ADLSMP	MODE		ADICLK	
W								
Reset:	0	0	0	0	0	0	0	0

Figure 10-9. Configuration Register (ADCCFG)

Table 10-6. ADCCFG Register Field Descriptions

Field	Description
7 ADLPC	Low-Power Configuration. ADLPC controls the speed and power configuration of the successive approximation converter. This optimizes power consumption when higher sample rates are not required. 0 High speed configuration 1 Low power configuration: The power is reduced at the expense of maximum clock speed.
6:5 ADIV	Clock Divide Select. ADIV selects the divide ratio used by the ADC to generate the internal clock ADCK. Table 10-7 shows the available clock configurations.
4 ADLSMP	Long Sample Time Configuration. ADLSMP selects between long and short sample time. This adjusts the sample period to allow higher impedance inputs to be accurately sampled or to maximize conversion speed for lower impedance inputs. Longer sample times can also be used to lower overall power consumption when continuous conversions are enabled if high conversion rates are not required. 0 Short sample time 1 Long sample time
3:2 MODE	Conversion Mode Selection. MODE bits are used to select between 12-, 10-, or 8-bit operation. See Table 10-8 .
1:0 ADICLK	Input Clock Select. ADICLK bits select the input clock source to generate the internal clock ADCK. See Table 10-9 .

Table 10-7. Clock Divide Select

ADIV	Divide Ratio	Clock Rate
00	1	Input clock
01	2	Input clock ÷ 2
10	4	Input clock ÷ 4
11	8	Input clock ÷ 8

Table 10-8. Conversion Modes

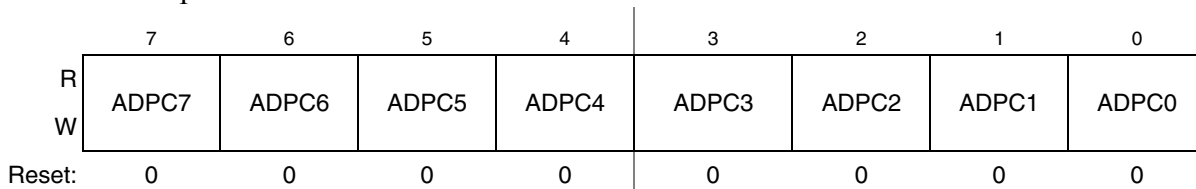
MODE	Mode Description
00	8-bit conversion (N=8)
01	12-bit conversion (N=12)
10	10-bit conversion (N=10)
11	Reserved

Table 10-9. Input Clock Select

ADICLK	Selected Clock Source
00	Bus clock
01	Bus clock divided by 2
10	Alternate clock (ALTCLK)
11	Asynchronous clock (ADACK)

10.3.8 Pin Control 1 Register (APCTL1)

The pin control registers disable the I/O port control of MCU pins used as analog inputs. APCTL1 is used to control the pins associated with channels 0–7 of the ADC module.

**Figure 10-10. Pin Control 1 Register (APCTL1)****Table 10-10. APCTL1 Register Field Descriptions**

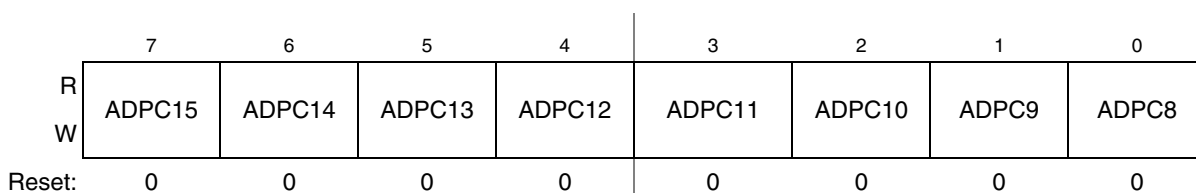
Field	Description
7 ADPC7	ADC Pin Control 7. ADPC7 controls the pin associated with channel AD7. 0 AD7 pin I/O control enabled 1 AD7 pin I/O control disabled
6 ADPC6	ADC Pin Control 6. ADPC6 controls the pin associated with channel AD6. 0 AD6 pin I/O control enabled 1 AD6 pin I/O control disabled
5 ADPC5	ADC Pin Control 5. ADPC5 controls the pin associated with channel AD5. 0 AD5 pin I/O control enabled 1 AD5 pin I/O control disabled
4 ADPC4	ADC Pin Control 4. ADPC4 controls the pin associated with channel AD4. 0 AD4 pin I/O control enabled 1 AD4 pin I/O control disabled
3 ADPC3	ADC Pin Control 3. ADPC3 controls the pin associated with channel AD3. 0 AD3 pin I/O control enabled 1 AD3 pin I/O control disabled
2 ADPC2	ADC Pin Control 2. ADPC2 controls the pin associated with channel AD2. 0 AD2 pin I/O control enabled 1 AD2 pin I/O control disabled

Table 10-10. APCTL1 Register Field Descriptions (continued)

Field	Description
1 ADPC1	ADC Pin Control 1. ADPC1 controls the pin associated with channel AD1. 0 AD1 pin I/O control enabled 1 AD1 pin I/O control disabled
0 ADPC0	ADC Pin Control 0. ADPC0 controls the pin associated with channel AD0. 0 AD0 pin I/O control enabled 1 AD0 pin I/O control disabled

10.3.9 Pin Control 2 Register (APCTL2)

APCTL2 controls channels 8–15 of the ADC module.

**Figure 10-11. Pin Control 2 Register (APCTL2)****Table 10-11. APCTL2 Register Field Descriptions**

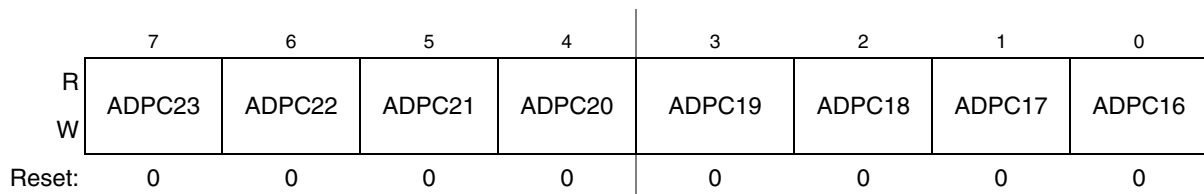
Field	Description
7 ADPC15	ADC Pin Control 15. ADPC15 controls the pin associated with channel AD15. 0 AD15 pin I/O control enabled 1 AD15 pin I/O control disabled
6 ADPC14	ADC Pin Control 14. ADPC14 controls the pin associated with channel AD14. 0 AD14 pin I/O control enabled 1 AD14 pin I/O control disabled
5 ADPC13	ADC Pin Control 13. ADPC13 controls the pin associated with channel AD13. 0 AD13 pin I/O control enabled 1 AD13 pin I/O control disabled
4 ADPC12	ADC Pin Control 12. ADPC12 controls the pin associated with channel AD12. 0 AD12 pin I/O control enabled 1 AD12 pin I/O control disabled
3 ADPC11	ADC Pin Control 11. ADPC11 controls the pin associated with channel AD11. 0 AD11 pin I/O control enabled 1 AD11 pin I/O control disabled
2 ADPC10	ADC Pin Control 10. ADPC10 controls the pin associated with channel AD10. 0 AD10 pin I/O control enabled 1 AD10 pin I/O control disabled

Table 10-11. APCTL2 Register Field Descriptions (continued)

Field	Description
1 ADPC9	ADC Pin Control 9. ADPC9 controls the pin associated with channel AD9. 0 AD9 pin I/O control enabled 1 AD9 pin I/O control disabled
0 ADPC8	ADC Pin Control 8. ADPC8 controls the pin associated with channel AD8. 0 AD8 pin I/O control enabled 1 AD8 pin I/O control disabled

10.3.10 Pin Control 3 Register (APCTL3)

APCTL3 controls channels 16–23 of the ADC module.

**Figure 10-12. Pin Control 3 Register (APCTL3)****Table 10-12. APCTL3 Register Field Descriptions**

Field	Description
7 ADPC23	ADC Pin Control 23. ADPC23 controls the pin associated with channel AD23. 0 AD23 pin I/O control enabled 1 AD23 pin I/O control disabled
6 ADPC22	ADC Pin Control 22. ADPC22 controls the pin associated with channel AD22. 0 AD22 pin I/O control enabled 1 AD22 pin I/O control disabled
5 ADPC21	ADC Pin Control 21. ADPC21 controls the pin associated with channel AD21. 0 AD21 pin I/O control enabled 1 AD21 pin I/O control disabled
4 ADPC20	ADC Pin Control 20. ADPC20 controls the pin associated with channel AD20. 0 AD20 pin I/O control enabled 1 AD20 pin I/O control disabled
3 ADPC19	ADC Pin Control 19. ADPC19 controls the pin associated with channel AD19. 0 AD19 pin I/O control enabled 1 AD19 pin I/O control disabled
2 ADPC18	ADC Pin Control 18. ADPC18 controls the pin associated with channel AD18. 0 AD18 pin I/O control enabled 1 AD18 pin I/O control disabled

Table 10-12. APCTL3 Register Field Descriptions (continued)

Field	Description
1 ADPC17	ADC Pin Control 17. ADPC17 controls the pin associated with channel AD17. 0 AD17 pin I/O control enabled 1 AD17 pin I/O control disabled
0 ADPC16	ADC Pin Control 16. ADPC16 controls the pin associated with channel AD16. 0 AD16 pin I/O control enabled 1 AD16 pin I/O control disabled

10.4 Functional Description

The ADC module is disabled during reset or when the ADCH bits are all high. The module is idle when a conversion has completed and another conversion has not been initiated. When idle, the module is in its lowest power state.

The ADC can perform an analog-to-digital conversion on any of the software selectable channels. In 12-bit and 10-bit mode, the selected channel voltage is converted by a successive approximation algorithm into a 12-bit digital result. In 8-bit mode, the selected channel voltage is converted by a successive approximation algorithm into a 9-bit digital result.

When the conversion is completed, the result is placed in the data registers (ADCRH and ADCRL). In 10-bit mode, the result is rounded to 10 bits and placed in the data registers (ADCRH and ADCRL). In 8-bit mode, the result is rounded to 8 bits and placed in ADCRL. The conversion complete flag (COCO) is then set and an interrupt is generated if the conversion complete interrupt has been enabled (AIEN = 1).

The ADC module has the capability of automatically comparing the result of a conversion with the contents of its compare registers. The compare function is enabled by setting the ACFE bit and operates with any of the conversion modes and configurations.

10.4.1 Clock Select and Divide Control

One of four clock sources can be selected as the clock source for the ADC module. This clock source is then divided by a configurable value to generate the input clock to the converter (ADCK). The clock is selected from one of the following sources by means of the ADICLK bits.

- The bus clock, which is equal to the frequency at which software is executed. This is the default selection following reset.
- The bus clock divided by two. For higher bus clock rates, this allows a maximum divide by 16 of the bus clock.
- ALTCLK, as defined for this MCU (See module section introduction).
- The asynchronous clock (ADACK). This clock is generated from a clock source within the ADC module. When selected as the clock source, this clock remains active while the MCU is in wait or stop3 mode and allows conversions in these modes for lower noise operation.

Whichever clock is selected, its frequency must fall within the specified frequency range for ADCK. If the available clocks are too slow, the ADC do not perform according to specifications. If the available clocks

are too fast, the clock must be divided to the appropriate frequency. This divider is specified by the ADIV bits and can be divide-by 1, 2, 4, or 8.

10.4.2 Input Select and Pin Control

The pin control registers (APCTL3, APCTL2, and APCTL1) disable the I/O port control of the pins used as analog inputs. When a pin control register bit is set, the following conditions are forced for the associated MCU pin:

- The output buffer is forced to its high impedance state.
- The input buffer is disabled. A read of the I/O port returns a zero for any pin with its input buffer disabled.
- The pullup is disabled.

10.4.3 Hardware Trigger

The ADC module has a selectable asynchronous hardware conversion trigger, ADHWT, that is enabled when the ADTRG bit is set. This source is not available on all MCUs. Consult the module introduction for information on the ADHWT source specific to this MCU.

When ADHWT source is available and hardware trigger is enabled (ADTRG=1), a conversion is initiated on the rising edge of ADHWT. If a conversion is in progress when a rising edge occurs, the rising edge is ignored. In continuous convert configuration, only the initial rising edge to launch continuous conversions is observed. The hardware trigger function operates in conjunction with any of the conversion modes and configurations.

10.4.4 Conversion Control

Conversions can be performed in 12-bit mode, 10-bit mode, or 8-bit mode as determined by the MODE bits. Conversions can be initiated by a software or hardware trigger. In addition, the ADC module can be configured for low power operation, long sample time, continuous conversion, and automatic compare of the conversion result to a software determined compare value.

10.4.4.1 Initiating Conversions

A conversion is initiated:

- Following a write to ADCSC1 (with ADCH bits not all 1s) if software triggered operation is selected.
- Following a hardware trigger (ADHWT) event if hardware triggered operation is selected.
- Following the transfer of the result to the data registers when continuous conversion is enabled.

If continuous conversions are enabled, a new conversion is automatically initiated after the completion of the current conversion. In software triggered operation, continuous conversions begin after ADCSC1 is written and continue until aborted. In hardware triggered operation, continuous conversions begin after a hardware trigger event and continue until aborted.

10.4.4.2 Completing Conversions

A conversion is completed when the result of the conversion is transferred into the data result registers, ADCRH and ADCRL. This is indicated by the setting of COCO. An interrupt is generated if AIEN is high at the time that COCO is set.

A blocking mechanism prevents a new result from overwriting previous data in ADCRH and ADCRL if the previous data is in the process of being read while in 12-bit or 10-bit MODE (the ADCRH register has been read but the ADCRL register has not). When blocking is active, the data transfer is blocked, COCO is not set, and the new result is lost. In the case of single conversions with the compare function enabled and the compare condition false, blocking has no effect and ADC operation is terminated. In all other cases of operation, when a data transfer is blocked, another conversion is initiated regardless of the state of ADCO (single or continuous conversions enabled).

If single conversions are enabled, the blocking mechanism could result in several discarded conversions and excess power consumption. To avoid this issue, the data registers must not be read after initiating a single conversion until the conversion completes.

10.4.4.3 Aborting Conversions

Any conversion in progress is aborted when:

- A write to ADCSC1 occurs (the current conversion will be aborted and a new conversion will be initiated, if ADCH are not all 1s).
- A write to ADCSC2, ADCCFG, ADCCVH, or ADCCVL occurs. This indicates a mode of operation change has occurred and the current conversion is therefore invalid.
- The MCU is reset.
- The MCU enters stop mode with ADACK not enabled.

When a conversion is aborted, the contents of the data registers, ADCRH and ADCRL, are not altered. However, they continue to be the values transferred after the completion of the last successful conversion. If the conversion was aborted by a reset, ADCRH and ADCRL return to their reset states.

10.4.4.4 Power Control

The ADC module remains in its idle state until a conversion is initiated. If ADACK is selected as the conversion clock source, the ADACK clock generator is also enabled.

Power consumption when active can be reduced by setting ADLPC. This results in a lower maximum value for f_{ADCK} (see the electrical specifications).

10.4.4.5 Sample Time and Total Conversion Time

The total conversion time depends on the sample time (as determined by ADLSMP), the MCU bus frequency, the conversion mode (8-bit, 10-bit or 12-bit), and the frequency of the conversion clock (f_{ADCK}). After the module becomes active, sampling of the input begins. ADLSMP selects between short (3.5 ADCK cycles) and long (23.5 ADCK cycles) sample times. When sampling is complete, the converter is isolated from the input channel and a successive approximation algorithm is performed to determine the

digital value of the analog signal. The result of the conversion is transferred to ADCRH and ADCRL upon completion of the conversion algorithm.

If the bus frequency is less than the f_{ADCK} frequency, precise sample time for continuous conversions cannot be guaranteed when short sample is enabled (ADLSMP=0). If the bus frequency is less than 1/11th of the f_{ADCK} frequency, precise sample time for continuous conversions cannot be guaranteed when long sample is enabled (ADLSMP=1).

The maximum total conversion time for different conditions is summarized in [Table 10-13](#).

Table 10-13. Total Conversion Time vs. Control Conditions

Conversion Type	ADICLK	ADLSMP	Max Total Conversion Time
Single or first continuous 8-bit	0x, 10	0	20 ADCK cycles + 5 bus clock cycles
Single or first continuous 10-bit or 12-bit	0x, 10	0	23 ADCK cycles + 5 bus clock cycles
Single or first continuous 8-bit	0x, 10	1	40 ADCK cycles + 5 bus clock cycles
Single or first continuous 10-bit or 12-bit	0x, 10	1	43 ADCK cycles + 5 bus clock cycles
Single or first continuous 8-bit	11	0	5 μ s + 20 ADCK + 5 bus clock cycles
Single or first continuous 10-bit or 12-bit	11	0	5 μ s + 23 ADCK + 5 bus clock cycles
Single or first continuous 8-bit	11	1	5 μ s + 40 ADCK + 5 bus clock cycles
Single or first continuous 10-bit or 12-bit	11	1	5 μ s + 43 ADCK + 5 bus clock cycles
Subsequent continuous 8-bit; $f_{BUS} \geq f_{ADCK}$	xx	0	17 ADCK cycles
Subsequent continuous 10-bit or 12-bit; $f_{BUS} \geq f_{ADCK}$	xx	0	20 ADCK cycles
Subsequent continuous 8-bit; $f_{BUS} \geq f_{ADCK}/11$	xx	1	37 ADCK cycles
Subsequent continuous 10-bit or 12-bit; $f_{BUS} \geq f_{ADCK}/11$	xx	1	40 ADCK cycles

The maximum total conversion time is determined by the clock source chosen and the divide ratio selected. The clock source is selectable by the ADICLK bits, and the divide ratio is specified by the ADIV bits. For example, in 10-bit mode, with the bus clock selected as the input clock source, the input clock divide-by-1 ratio selected, and a bus frequency of 8 MHz, then the conversion time for a single conversion is:

$$\text{Conversion time} = \frac{23 \text{ ADCK Cyc}}{8 \text{ MHz}/1} + \frac{5 \text{ bus Cyc}}{8 \text{ MHz}} = 3.5 \mu\text{s}$$

$$\text{Number of bus cycles} = 3.5 \mu\text{s} \times 8 \text{ MHz} = 28 \text{ cycles}$$

NOTE

The ADCK frequency must be between f_{ADCK} minimum and f_{ADCK} maximum to meet ADC specifications.

10.4.5 Automatic Compare Function

The compare function is enabled by the ACFE bit. The compare function can be configured to check for an upper or lower limit. After the input is sampled and converted, the compare value (ADCCVH and ADCCVL) is subtracted from the conversion result. When comparing to an upper limit (ACFGT = 1), if the conversion result is greater-than or equal-to the compare value, COCO is set. When comparing to a lower limit (ACFGT = 0), if the result is less than the compare value, COCO is set. An ADC interrupt is generated upon the setting of COCO if the ADC interrupt is enabled (AIEN = 1).

The subtract operation of two positive values (the conversion result less the compare value) results in a signed value that is 1-bit wider than the bit-width of the two terms. The final value transferred to the ADCRH and ADCRL registers is the result of the subtraction operation, excluding the sign bit. The value of the sign bit can be derived based on ACFG control setting. When ACFGT=1, the sign bit of any value stored in ADCRH and ADCRL is always 0, indicating a positive result for the subtract operation. When ACFGT = 1, the sign bit of any result is always 1, indicating a negative result for the subtract operation.

Upon completion of a conversion while the compare function is enabled, if the compare condition is not true, COCO is not set and no data is transferred to the result registers.

NOTE

The compare function can monitor the voltage on a channel while the MCU is in wait or stop3 mode. The ADC interrupt wakes the MCU when the compare condition is met.

An example of compare operation eases understanding of the compare feature. If the ADC is configured for 10-bit operation, ACFGT=0, and ADCCVH:ADCCVL= 0x200, then a conversion result of 0x080 causes the compare condition to be met and the COCO bit is set. A value of 0x280 is stored in ADCRH:ADCRL. This is signed data without the sign bit and must be combined with a derived sign bit to have meaning. The value stored in ADCRH:ADCRL is calculated as follows.

The value to interpret from the data is (Result – Compare Value) = (0x080 – 0x200) = –0x180. A standard method for handling subtraction is to convert the second term to its 2's complement, and then add the two terms. First calculate the 2's complement of 0x200 by complementing each bit and adding 1. Note that prior to complementing, a sign bit of 0 is added so that the 10-bit compare value becomes a 11-bit signed value that is always positive.

$$\begin{array}{rcl}
 \%101\ 1111\ 1111 & & \leq 1\text{'s complement of } 0x200 \text{ compare value} \\
 + & & \%1 \\
 \hline
 \%110\ 0000\ 0000 & & \leq 2\text{'s complement of } 0x200 \text{ compare value}
 \end{array}$$

Then the conversion result of 0x080 is added to 2's complement of 0x200:

$$\begin{array}{rcl}
 \%000\ 1000\ 0000 & & \\
 + & & \%110\ 0000\ 0000 \\
 \hline
 \%110\ 1000\ 0000 & & \leq \text{Subtraction result is } -0x180 \text{ in signed 11-bit data}
 \end{array}$$

The subtraction result is an 11-bit signed value. The lower 10 bits (0x280) are stored in ADCRH:ADCRL. The sign bit is known to be 1 (negative) because the ACFG_T=0, the COCO bit was set, and conversion data was updated in ADCRH:ADCRL.

A simpler way to use the data stored in ADCRH:ADCRL is to apply the following rules. When comparing for upper limit (ACFG_T=1), the value in ADCRH:ADCRL is a positive value and does not need to be manipulated. This value is the difference between the conversion result and the compare value. When comparing for lower limit (ACFG_T=0), ADCRH:ADCRL is a negative value without the sign bit. If the value from these registers is complemented and then a value of 1 is added, then the calculated value is the unsigned (i.e., absolute) difference between the conversion result and the compare value. In the previous example, 0x280 is stored in ADCRH:ADCRL. The following example shows how the absolute value of the difference is calculated.

```

%01 0111 1111 <= Complement of 10-bit value stored in ADCRH:ADCRL
+
%1
-----
%01 1000 0000 <= Unsigned value 0x180 is the absolute value of (Result - Compare Value)

```

10.4.6 MCU Wait Mode Operation

Wait mode is a lower power-consumption standby mode from which recovery is fast because the clock sources remain active. If a conversion is in progress when the MCU enters wait mode, it continues until completion. Conversions can be initiated while the MCU is in wait mode by means of the hardware trigger or if continuous conversions are enabled.

The bus clock, bus clock divided by two, and ADACK are available as conversion clock sources while in wait mode. The use of ALTCLK as the conversion clock source in wait is dependent on the definition of ALTCLK for this MCU. Consult the module introduction for information on ALTCLK specific to this MCU.

A conversion complete event sets the COCO and generates an ADC interrupt to wake the MCU from wait mode if the ADC interrupt is enabled (AIEN = 1).

10.4.7 MCU Stop3 Mode Operation

Stop mode is a low power-consumption standby mode during which most or all clock sources on the MCU are disabled.

10.4.7.1 Stop3 Mode With ADACK Disabled

If the asynchronous clock, ADACK, is not selected as the conversion clock, executing a stop instruction aborts the current conversion and places the ADC in its idle state. The contents of ADCRH and ADCRL are unaffected by stop3 mode. After exiting from stop3 mode, a software or hardware trigger is required to resume conversions.

10.4.7.2 Stop3 Mode With ADACK Enabled

If ADACK is selected as the conversion clock, the ADC continues operation during stop3 mode. For guaranteed ADC operation, the MCU's voltage regulator must remain active during stop3 mode. Consult the module introduction for configuration information for this MCU.

If a conversion is in progress when the MCU enters stop3 mode, it continues until completion. Conversions can be initiated while the MCU is in stop3 mode by means of the hardware trigger or if continuous conversions are enabled.

A conversion complete event sets the COCO and generates an ADC interrupt to wake the MCU from stop3 mode if the ADC interrupt is enabled (AIEN = 1).

NOTE

The ADC module can wake the system from low-power stop and cause the MCU to begin consuming run-level currents without generating a system level interrupt. To prevent this scenario, software should ensure the data transfer blocking mechanism (discussed in [Section 10.4.4.2, “Completing Conversions”](#)) is cleared when entering stop3 and continuing ADC conversions.

10.4.8 MCU Stop2 Mode Operation

The ADC module is automatically disabled when the MCU enters stop2 mode. All module registers contain their reset values following exit from stop2. Therefore, the module must be re-enabled and re-configured following exit from stop2.

10.5 Initialization Information

This section gives an example that provides some basic direction on how to initialize and configure the ADC module. You can configure the module for 8-, 10-, or 12-bit resolution, single or continuous conversion, and a polled or interrupt approach, among many other options. Refer to [Table 10-7](#), [Table 10-8](#), and [Table 10-9](#) for information used in this example.

NOTE

Hexadecimal values designated by a preceding 0x, binary values designated by a preceding %, and decimal values have no preceding character.

10.5.1 ADC Module Initialization Example

10.5.1.1 Initialization Sequence

Before the ADC module can be used to complete conversions, an initialization procedure must be performed. A typical sequence is as follows:

1. Update the configuration register (ADCCFG) to select the input clock source and the divide ratio used to generate the internal clock, ADCK. This register is also used for selecting sample time and low-power configuration.

2. Update status and control register 2 (ADCSC2) to select the conversion trigger (hardware or software) and compare function options, if enabled.
3. Update status and control register 1 (ADCSC1) to select whether conversions will be continuous or completed only once, and to enable or disable conversion complete interrupts. The input channel on which conversions will be performed is also selected here.

10.5.1.2 Pseudo-Code Example

In this example, the ADC module is set up with interrupts enabled to perform a single 10-bit conversion at low power with a long sample time on input channel 1, where the internal ADCK clock is derived from the bus clock divided by 1.

ADCCFG = 0x98 (%10011000)

Bit 7	ADLPC	1	Configures for low power (lowers maximum clock speed)
Bit 6:5	ADIV	00	Sets the ADCK to the input clock ÷ 1
Bit 4	ADLSMP	1	Configures for long sample time
Bit 3:2	MODE	10	Sets mode at 10-bit conversions
Bit 1:0	ADICLK	00	Selects bus clock as input clock source

ADCSC2 = 0x00 (%00000000)

Bit 7	ADACT	0	Flag indicates if a conversion is in progress
Bit 6	ADTRG	0	Software trigger selected
Bit 5	ACFE	0	Compare function disabled
Bit 4	ACFGT	0	Not used in this example
Bit 3:2		00	Reserved, always reads zero
Bit 1:0		00	Reserved for Freescale's internal use; always write zero

ADCSC1 = 0x41 (%01000001)

Bit 7	COCO	0	Read-only flag which is set when a conversion completes
Bit 6	AIEN	1	Conversion complete interrupt enabled
Bit 5	ADCO	0	One conversion only (continuous conversions disabled)
Bit 4:0	ADCH	00001	Input channel 1 selected as ADC input channel

ADCRH/L = 0xxx

Holds results of conversion. Read high byte (ADCRH) before low byte (ADCRL) so that conversion data cannot be overwritten with data from the next conversion.

ADCCVH/L = 0xxx

Holds compare value when compare function enabled

APCTL1=0x02

AD1 pin I/O control disabled. All other AD pins remain general purpose I/O pins

APCTL2=0x00

All other AD pins remain general purpose I/O pins

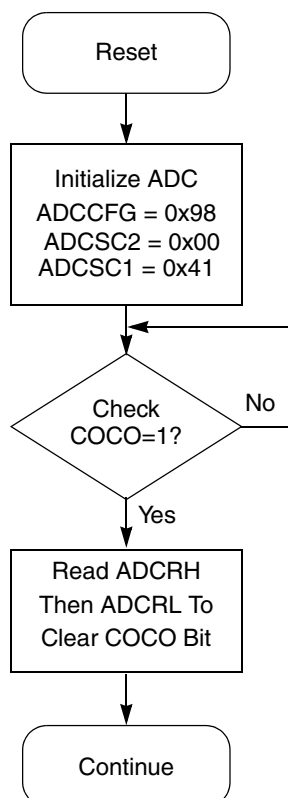


Figure 10-13. Initialization Flowchart for Example

10.6 Application Information

This section contains information for using the ADC module in applications. The ADC has been designed to be integrated into a microcontroller for use in embedded control applications requiring an A/D converter.

10.6.1 External Pins and Routing

The following sections discuss the external pins associated with the ADC module and how they should be used for best results.

10.6.1.1 Analog Supply Pins

The ADC module has analog power and ground supplies (V_{DDA} and V_{SSA}) available as separate pins on some devices. V_{SSA} is shared on the same pin as the MCU digital V_{SS} on some devices. On other devices, V_{SSA} and V_{DDA} are shared with the MCU digital supply pins. In these cases, there are separate pads for the analog supplies bonded to the same pin as the corresponding digital supply so that some degree of isolation between the supplies is maintained.

When available on a separate pin, both V_{DDA} and V_{SSA} must be connected to the same voltage potential as their corresponding MCU digital supply (V_{DD} and V_{SS}) and must be routed carefully for maximum noise immunity and bypass capacitors placed as near as possible to the package.

If separate power supplies are used for analog and digital power, the ground connection between these supplies must be at the V_{SSA} pin. This should be the only ground connection between these supplies if possible. The V_{SSA} pin makes a good single point ground location.

10.6.1.2 Analog Reference Pins

In addition to the analog supplies, the ADC module has connections for two reference voltage inputs. The high reference is V_{REFH} , which may be shared on the same pin as V_{DDA} on some devices. The low reference is V_{REFL} , which may be shared on the same pin as V_{SSA} on some devices.

When available on a separate pin, V_{REFH} may be connected to the same potential as V_{DDA} , or may be driven by an external source between the minimum V_{DDA} spec and the V_{DDA} potential (V_{REFH} must never exceed V_{DDA}). When available on a separate pin, V_{REFL} must be connected to the same voltage potential as V_{SSA} . V_{REFH} and V_{REFL} must be routed carefully for maximum noise immunity and bypass capacitors placed as near as possible to the package.

AC current in the form of current spikes required to supply charge to the capacitor array at each successive approximation step is drawn through the V_{REFH} and V_{REFL} loop. The best external component to meet this current demand is a 0.1 μF capacitor with good high frequency characteristics. This capacitor is connected between V_{REFH} and V_{REFL} and must be placed as near as possible to the package pins. Resistance in the path is not recommended because the current causes a voltage drop that could result in conversion errors. Inductance in this path must be minimum (parasitic only).

10.6.1.3 Analog Input Pins

The external analog inputs are typically shared with digital I/O pins on MCU devices. The pin I/O control is disabled by setting the appropriate control bit in one of the pin control registers. Conversions can be performed on inputs without the associated pin control register bit set. It is recommended that the pin control register bit always be set when using a pin as an analog input. This avoids problems with contention because the output buffer is in its high impedance state and the pullup is disabled. Also, the input buffer draws DC current when its input is not at V_{DD} or V_{SS} . Setting the pin control register bits for all pins used as analog inputs should be done to achieve lowest operating current.

Empirical data shows that capacitors on the analog inputs improve performance in the presence of noise or when the source impedance is high. Use of 0.01 μF capacitors with good high-frequency characteristics is sufficient. These capacitors are not necessary in all cases, but when used they must be placed as near as possible to the package pins and be referenced to V_{SSA} .

For proper conversion, the input voltage must fall between V_{REFH} and V_{REFL} . If the input is equal to or exceeds V_{REFH} , the converter circuit converts the signal to 0xFFFF (full scale 12-bit representation), 0x3FF (full scale 10-bit representation) or 0xFF (full scale 8-bit representation). If the input is equal to or less than V_{REFL} , the converter circuit converts it to 0x000. Input voltages between V_{REFH} and V_{REFL} are straight-line linear conversions. There is a brief current associated with V_{REFL} when the sampling

capacitor is charging. The input is sampled for 3.5 cycles of the ADCK source when ADLSMP is low, or 23.5 cycles when ADLSMP is high.

For minimal loss of accuracy due to current injection, pins adjacent to the analog input pins should not be transitioning during conversions.

10.6.2 Sources of Error

Several sources of error exist for A/D conversions. These are discussed in the following sections.

10.6.2.1 Sampling Error

For proper conversions, the input must be sampled long enough to achieve the proper accuracy. Given the maximum input resistance of approximately 7k Ω and input capacitance of approximately 5.5 pF, sampling to within 1/4LSB (at 12-bit resolution) can be achieved within the minimum sample window (3.5 cycles @ 8 MHz maximum ADCK frequency) provided the resistance of the external analog source (R_{AS}) is kept below 2 k Ω .

Higher source resistances or higher-accuracy sampling is possible by setting ADLSMP (to increase the sample window to 23.5 cycles) or decreasing ADCK frequency to increase sample time.

10.6.2.2 Pin Leakage Error

Leakage on the I/O pins can cause conversion error if the external analog source resistance (R_{AS}) is high. If this error cannot be tolerated by the application, keep R_{AS} lower than $V_{DDA} / (2^N \cdot I_{LEAK})$ for less than 1/4LSB leakage error ($N = 8$ in 8-bit, 10 in 10-bit or 12 in 12-bit mode).

10.6.2.3 Noise-Induced Errors

System noise that occurs during the sample or conversion process can affect the accuracy of the conversion. The ADC accuracy numbers are guaranteed as specified only if the following conditions are met:

- There is a 0.1 μ F low-ESR capacitor from V_{REFH} to V_{REFL} .
- There is a 0.1 μ F low-ESR capacitor from V_{DDA} to V_{SSA} .
- If inductive isolation is used from the primary supply, an additional 1 μ F capacitor is placed from V_{DDA} to V_{SSA} .
- V_{SSA} (and V_{REFL} , if connected) is connected to V_{SS} at a quiet point in the ground plane.
- Operate the MCU in wait or stop3 mode before initiating (hardware triggered conversions) or immediately after initiating (hardware or software triggered conversions) the ADC conversion.
 - For software triggered conversions, immediately follow the write to ADCSC1 with a wait instruction or stop instruction.
 - For stop3 mode operation, select ADACK as the clock source. Operation in stop3 reduces V_{DD} noise but increases effective conversion time due to stop recovery.
- There is no I/O switching, input or output, on the MCU during the conversion.

There are some situations where external system activity causes radiated or conducted noise emissions or excessive V_{DD} noise is coupled into the ADC. In these situations, or when the MCU cannot be placed in wait or stop3 or I/O activity cannot be halted, these recommended actions may reduce the effect of noise on the accuracy:

- Place a 0.01 μF capacitor (C_{AS}) on the selected input channel to V_{REFL} or V_{SSA} (this improves noise issues, but affects the sample rate based on the external analog source resistance).
- Average the result by converting the analog input many times in succession and dividing the sum of the results. Four samples are required to eliminate the effect of a 1LSB, one-time error.
- Reduce the effect of synchronous noise by operating off the asynchronous clock (ADACK) and averaging. Noise that is synchronous to ADCK cannot be averaged out.

10.6.2.4 Code Width and Quantization Error

The ADC quantizes the ideal straight-line transfer function into 4096 steps (in 12-bit mode). Each step ideally has the same height (1 code) and width. The width is defined as the delta between the transition points to one code and the next. The ideal code width for an N bit converter (in this case N can be 8, 10 or 12), defined as 1LSB, is:

$$1 \text{ lsb} = (V_{REFH} - V_{REFL}) / 2^N \quad \text{Eqn. 10-2}$$

There is an inherent quantization error due to the digitization of the result. For 8-bit or 10-bit conversions the code transitions when the voltage is at the midpoint between the points where the straight line transfer function is exactly represented by the actual transfer function. Therefore, the quantization error will be $\pm 1/2$ lsb in 8- or 10-bit mode. As a consequence, however, the code width of the first (0x000) conversion is only 1/2 lsb and the code width of the last (0xFF or 0x3FF) is 1.5 lsb.

For 12-bit conversions the code transitions only after the full code width is present, so the quantization error is -1 lsb to 0 lsb and the code width of each step is 1 lsb.

10.6.2.5 Linearity Errors

The ADC may also exhibit non-linearity of several forms. Every effort has been made to reduce these errors but the system should be aware of them because they affect overall accuracy. These errors are:

- Zero-scale error (E_{ZS}) (sometimes called offset) — This error is defined as the difference between the actual code width of the first conversion and the ideal code width (1/2 lsb in 8-bit or 10-bit modes and 1 lsb in 12-bit mode). If the first conversion is 0x001, the difference between the actual 0x001 code width and its ideal (1 lsb) is used.
- Full-scale error (E_{FS}) — This error is defined as the difference between the actual code width of the last conversion and the ideal code width (1.5 lsb in 8-bit or 10-bit modes and 1LSB in 12-bit mode). If the last conversion is 0x3FE, the difference between the actual 0x3FE code width and its ideal (1LSB) is used.
- Differential non-linearity (DNL) — This error is defined as the worst-case difference between the actual code width and the ideal code width for all conversions.

- Integral non-linearity (INL) — This error is defined as the highest-value the (absolute value of the) running sum of DNL achieves. More simply, this is the worst-case difference of the actual transition voltage to a given code and its corresponding ideal transition voltage, for all codes.
- Total unadjusted error (TUE) — This error is defined as the difference between the actual transfer function and the ideal straight-line transfer function and includes all forms of error.

10.6.2.6 Code Jitter, Non-Monotonicity, and Missing Codes

Analog-to-digital converters are susceptible to three special forms of error. These are code jitter, non-monotonicity, and missing codes.

Code jitter is when, at certain points, a given input voltage converts to one of two values when sampled repeatedly. Ideally, when the input voltage is infinitesimally smaller than the transition voltage, the converter yields the lower code (and vice-versa). However, even small amounts of system noise can cause the converter to be indeterminate (between two codes) for a range of input voltages around the transition voltage. This range is normally around $\pm 1/2$ lsb in 8-bit or 10-bit mode, or around 2 lsb in 12-bit mode, and increases with noise.

This error may be reduced by repeatedly sampling the input and averaging the result. Additionally the techniques discussed in [Section 10.6.2.3](#) reduces this error.

Non-monotonicity is defined as when, except for code jitter, the converter converts to a lower code for a higher input voltage. Missing codes are those values never converted for any input value.

In 8-bit or 10-bit mode, the ADC is guaranteed to be monotonic and have no missing codes.

Chapter 11

Internal Clock Source (S08ICSV3)

11.1 Introduction

The internal clock source (ICS) module provides clock source choices for the MCU. The module contains a frequency-locked loop (FLL) as a clock source that is controllable by an internal or an external reference clock. The module can provide this FLL clock or either of the internal or external reference clocks as a source for the MCU system clock. There are also signals provided to control a low power oscillator (XOSCVLP) module to allow the use of an external crystal/resonator as the external reference clock.

Whichever clock source is chosen, it is passed through a reduced bus divider (BDIV) which allows a lower final output clock frequency to be derived.

The ICS on the MC9S08QE8 series is configured to support only the low range DCO, therefore the DRS and DRST bits in ICSSC have no affect.

[Figure 11-1](#) shows the MC9S08QE8 series block diagram with the ICS highlighted.

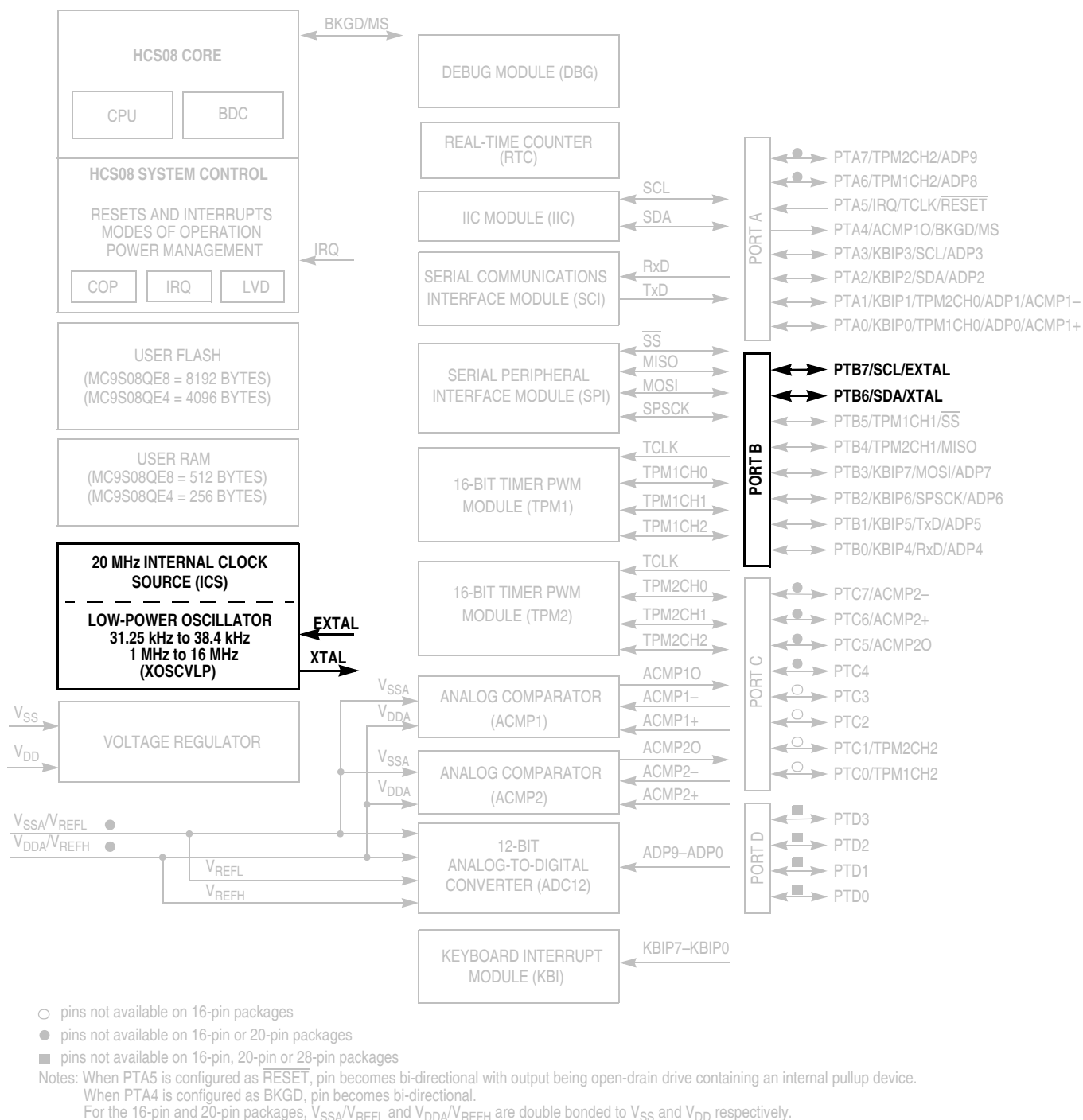


Figure 11-1. MC9S08QE8 Series Block Diagram Highlighting ICS Block and Pins

11.1.1 Features

Key features of the ICS module are:

- Frequency-locked loop (FLL) is trimmable for accuracy
- Internal or external reference clocks can be used to control the FLL
- Reference divider is provided for external clock
- Internal reference clock has 9 trim bits available
- Internal or external reference clocks can be selected as the clock source for the MCU
- Whichever clock is selected as the source can be divided down
 - 2-bit select for clock divider is provided
 - Allowable dividers are: 1, 2, 4, 8
- Control signals for a low power oscillator clock generator (OSCOUT) as the ICS external reference clock are provided
 - HGO, RANGE, EREFS, ERCLKEN, EREFSTEN
- FLL Engaged Internal mode is automatically selected out of reset
- BDC clock is provided as a constant divide by 2 of the low range DCO output
- Three selectable digitally-controlled oscillators (DCO) optimized for different frequency ranges.
- Option to maximize output frequency for a 32768 Hz external reference clock source.

11.1.2 Block Diagram

Figure 11-2 is the ICS block diagram.

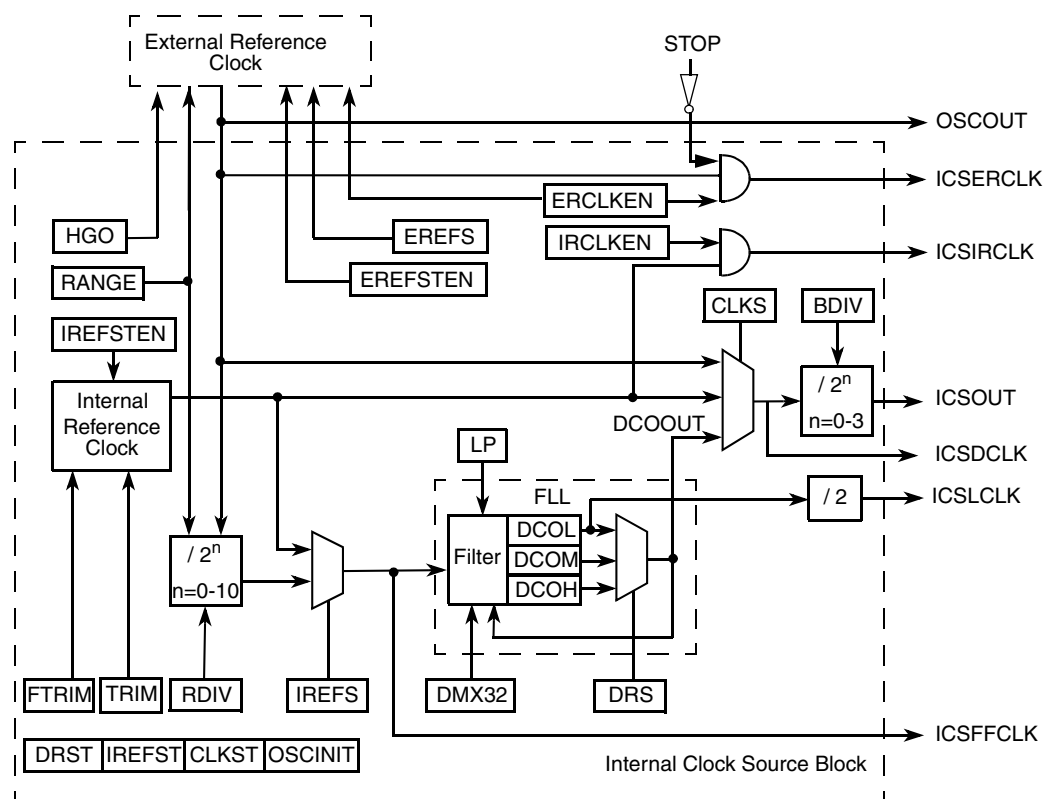


Figure 11-2. Internal Clock Source (ICS) Block Diagram

11.1.3 Modes of Operation

There are seven modes of operation for the ICS: FEI, FEE, FBI, FBILP, FBE, FBELP, and stop.

11.1.3.1 FLL Engaged Internal (FEI)

In FLL engaged internal mode, which is the default mode, the ICS supplies a clock derived from the FLL which is controlled by the internal reference clock. The BDC clock is supplied from the FLL.

11.1.3.2 FLL Engaged External (FEE)

In FLL engaged external mode, the ICS supplies a clock derived from the FLL which is controlled by an external reference clock source. The BDC clock is supplied from the FLL.

11.1.3.3 FLL Bypassed Internal (FBI)

In FLL bypassed internal mode, the FLL is enabled and controlled by the internal reference clock, but is bypassed. The ICS supplies a clock derived from the internal reference clock. The BDC clock is supplied from the FLL.

11.1.3.4 FLL Bypassed Internal Low Power (FBILP)

In FLL bypassed internal low power mode, the FLL is disabled and bypassed, and the ICS supplies a clock derived from the internal reference clock. The BDC clock is not available.

11.1.3.5 FLL Bypassed External (FBE)

In FLL bypassed external mode, the FLL is enabled and controlled by an external reference clock, but is bypassed. The ICS supplies a clock derived from the external reference clock source. The BDC clock is supplied from the FLL.

11.1.3.6 FLL Bypassed External Low Power (FBELP)

In FLL bypassed external low power mode, the FLL is disabled and bypassed, and the ICS supplies a clock derived from the external reference clock. The BDC clock is not available.

11.1.3.7 Stop (STOP)

In stop mode, the FLL is disabled and the internal or the ICS external reference clocks source (OSCOUT) can be selected to be enabled or disabled. The BDC clock is not available and the ICS does not provide an MCU clock source.

NOTE

The DCO frequency changes from the pre-stop value to its reset value and the FLL will need to re-acquire the lock before the frequency is stable. Timing sensitive operations should wait for the FLL acquisition time, $t_{Acquire}$, before executing.

11.2 External Signal Description

There are no ICS signals that connect off chip.

11.3 Register Definition

Figure 11-1 is a summary of ICS registers.

Table 11-1. ICS Register Summary

Name		7	6	5	4	3	2	1	0
ICSC1	R	CLKS		RDIV			IREFS	IRCLKEN	IREFSTEN
	W								
ICSC2	R	BDIV		RANGE	HGO	LP	EREFS	ERCLKEN	EREFSTEN
	W								
ICSTRM	R	TRIM							
	W								

Table 11-1. ICS Register Summary (continued)

Name		7	6	5	4	3	2	1	0
ICSSC	R	DRST		DMX32	IREFST	CLKST		OSCINIT	FTRIM
	W	DRS							

11.3.1 ICS Control Register 1 (ICSC1)

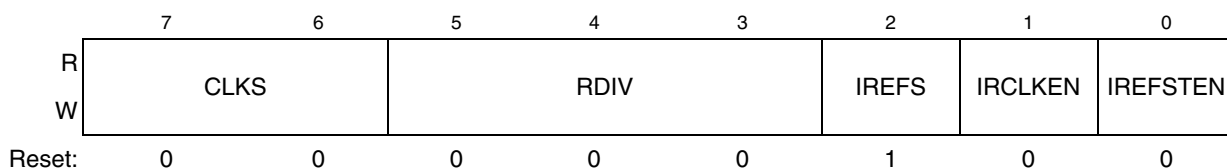


Figure 11-3. ICS Control Register 1 (ICSC1)

Table 11-2. ICS Control Register 1 Field Descriptions

Field	Description
7:6 CLKS	Clock Source Select — Selects the clock source that controls the bus frequency. The actual bus frequency depends on the value of the BDIV bits. 00 Output of FLL is selected. 01 Internal reference clock is selected. 10 External reference clock is selected. 11 Reserved, defaults to 00.
5:3 RDIV	Reference Divider — Selects the amount to divide down the external reference clock. Resulting frequency must be in the range 31.25 kHz to 39.0625 kHz. See Table 11-3 for the divide-by factors.
2 IREFS	Internal Reference Select — The IREFS bit selects the reference clock source for the FLL. 1 Internal reference clock selected. 0 External reference clock selected.
1 IRCLKEN	Internal Reference Clock Enable — The IRCLKEN bit enables the internal reference clock for use as ICSIRCLK. 1 ICSIRCLK active. 0 ICSIRCLK inactive.
0 IREFSTEN	Internal Reference Stop Enable — The IREFSTEN bit controls whether or not the internal reference clock remains enabled when the ICS enters stop mode. 1 Internal reference clock stays enabled in stop if IRCLKEN is set before entering stop. 0 Internal reference clock is disabled in stop.

Table 11-3. Reference Divide Factor

RDIV	RANGE=0	RANGE=1
0	1 ¹	32
1	2	64
2	4	128
3	8	256

Table 11-3. Reference Divide Factor

RDIV	RANGE=0	RANGE=1
4	16	512
5	32	1024
6	64	Reserved
7	128	Reserved

¹ Reset default

11.3.2 ICS Control Register 2 (ICSC2)

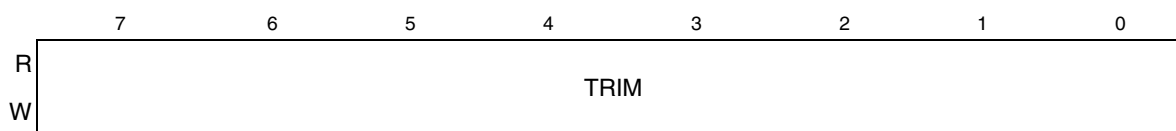


Figure 11-4. ICS Control Register 2 (ICSC2)

Table 11-4. ICS Control Register 2 Field Descriptions

Field	Description
7:6 BDIV	Bus Frequency Divider — Selects the amount to divide down the clock source selected by the CLKS bits. This controls the bus frequency. 00 Encoding 0 — Divides selected clock by 1. 01 Encoding 1 — Divides selected clock by 2 (reset default). 10 Encoding 2 — Divides selected clock by 4. 11 Encoding 3 — Divides selected clock by 8.
5 RANGE	Frequency Range Select — Selects the frequency range for the external oscillator. 1 High frequency range selected for the external oscillator. 0 Low frequency range selected for the external oscillator.
4 HGO	High Gain Oscillator Select — The HGO bit controls the external oscillator mode of operation. 1 Configure external oscillator for high gain operation. 0 Configure external oscillator for low power operation.
3 LP	Low Power Select — The LP bit controls whether the FLL is disabled in FLL bypassed modes. 1 FLL is disabled in bypass modes unless BDM is active. 0 FLL is not disabled in bypass mode.
2 EREFS	External Reference Select — The EREFS bit selects the source for the external reference clock. 1 Oscillator requested. 0 External Clock Source requested.
1 ERCLKEN	External Reference Enable — The ERCLKEN bit enables the external reference clock for use as ICSECLK. 1 ICSECLK active. 0 ICSECLK inactive.
0 EREFSTEN	External Reference Stop Enable — The EREFSTEN bit controls whether or not the external reference clock source (OSCOU) remains enabled when the ICS enters stop mode. 1 External reference clock source stays enabled in stop if ERCLKEN is set before entering stop. 0 External reference clock source is disabled in stop.

11.3.3 ICS Trim Register (ICSTRM)



Reset: Note: TRIM is loaded during reset from a factory programmed location when not in BDM mode. If in a BDM mode, a default value of 0x80 is loaded.

Figure 11-5. ICS Trim Register (ICSTRM)

Table 11-5. ICS Trim Register Field Descriptions

Field	Description
7:0 TRIM	<p>ICS Trim Setting — The TRIM bits control the internal reference clock frequency by controlling the internal reference clock period. The bits' effect are binary weighted (in other words, bit 1 adjusts twice as much as bit 0). Increasing the binary value in TRIM will increase the period, and decreasing the value will decrease the period.</p> <p>An additional fine trim bit is available in ICSSC as the FTRIM bit.</p>

11.3.4 ICS Status and Control (ICSSC)

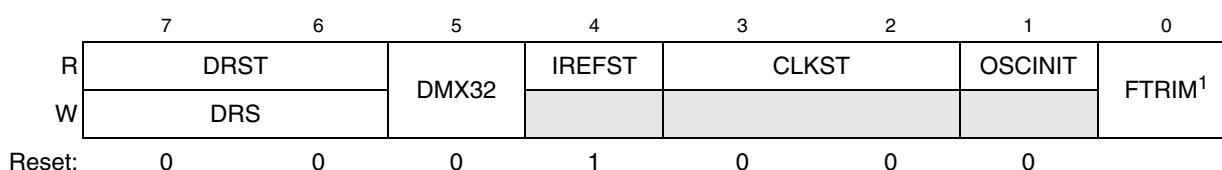


Figure 11-6. ICS Status and Control Register (ICSSC)

¹ FTRIM is loaded during reset from a factory programmed location when not in any BDM mode. If in a BDM mode, FTRIM gets loaded with a value of 1'b0.

Table 11-6. ICS Status and Control Register Field Descriptions

Field	Description
7-6 DRST DRS	<p>DCO Range Status — The DRST read field indicates the current frequency range for the FLL output, DCOOUT. See Table 11-7. The DRST field does not update immediately after a write to the DRS field due to internal synchronization between clock domains. Writing the DRS bits to 2'b11 is ignored and the DRST bits remain with the current setting.</p> <p>DCO Range Select — The DRS field selects the frequency range for the FLL output, DCOOUT. Writes to the DRS field while the LP bit is set are ignored.</p> <p>00 Low range. 01 Mid range. 10 High range. 11 Reserved.</p>
5 DMX32	<p>DCO Maximum frequency with 32.768 kHz reference — The DMX32 bit controls whether or not the DCO frequency range is narrowed to its maximum frequency with a 32.768 kHz reference. See Table 11-7.</p> <p>0 DCO has default range of 25%. 1 DCO is fined tuned for maximum frequency with 32.768 kHz reference.</p>

Table 11-6. ICS Status and Control Register Field Descriptions (continued)

Field	Description
4 IREFST	Internal Reference Status — The IREFST bit indicates the current source for the reference clock. The IREFST bit does not update immediately after a write to the IREFS bit due to internal synchronization between clock domains. 0 Source of reference clock is external clock. 1 Source of reference clock is internal clock.
3-2 CLKST	Clock Mode Status — The CLKST bits indicate the current clock mode. The CLKST bits don't update immediately after a write to the CLKS bits due to internal synchronization between clock domains. 00 Output of FLL is selected. 01 FLL Bypassed, Internal reference clock is selected. 10 FLL Bypassed, External reference clock is selected. 11 Reserved.
1 OSCINIT	OSC Initialization — If the external reference clock is selected by ERCLKEN or by the ICS being in FEE, FBE, or FBELP mode, and if EREFS is set, then this bit is set after the initialization cycles of the external oscillator clock have completed. This bit is only cleared when either ERCLKEN or EREFS are cleared.
0 FTRIM	ICS Fine Trim — The FTRIM bit controls the smallest adjustment of the internal reference clock frequency. Setting FTRIM will increase the period and clearing FTRIM will decrease the period by the smallest amount possible.

Table 11-7. DCO frequency range¹

DRS	DMX32	Reference range	FLL factor	DCO range
00	0	31.25 - 39.0625 kHz	512	16 - 20 MHz
	1	32.768 kHz	608	19.92 MHz
01	0	31.25 - 39.0625 kHz	1024	32 - 40 MHz
	1	32.768 kHz	1216	39.85 MHz
10	0	31.25 - 39.0625 kHz	1536	48 - 60 MHz
	1	32.768 kHz	1824	59.77 MHz
11	Reserved			

¹ The resulting bus clock frequency should not exceed the maximum specified bus clock frequency of the device.

11.4 Functional Description

11.4.1 Operational Modes

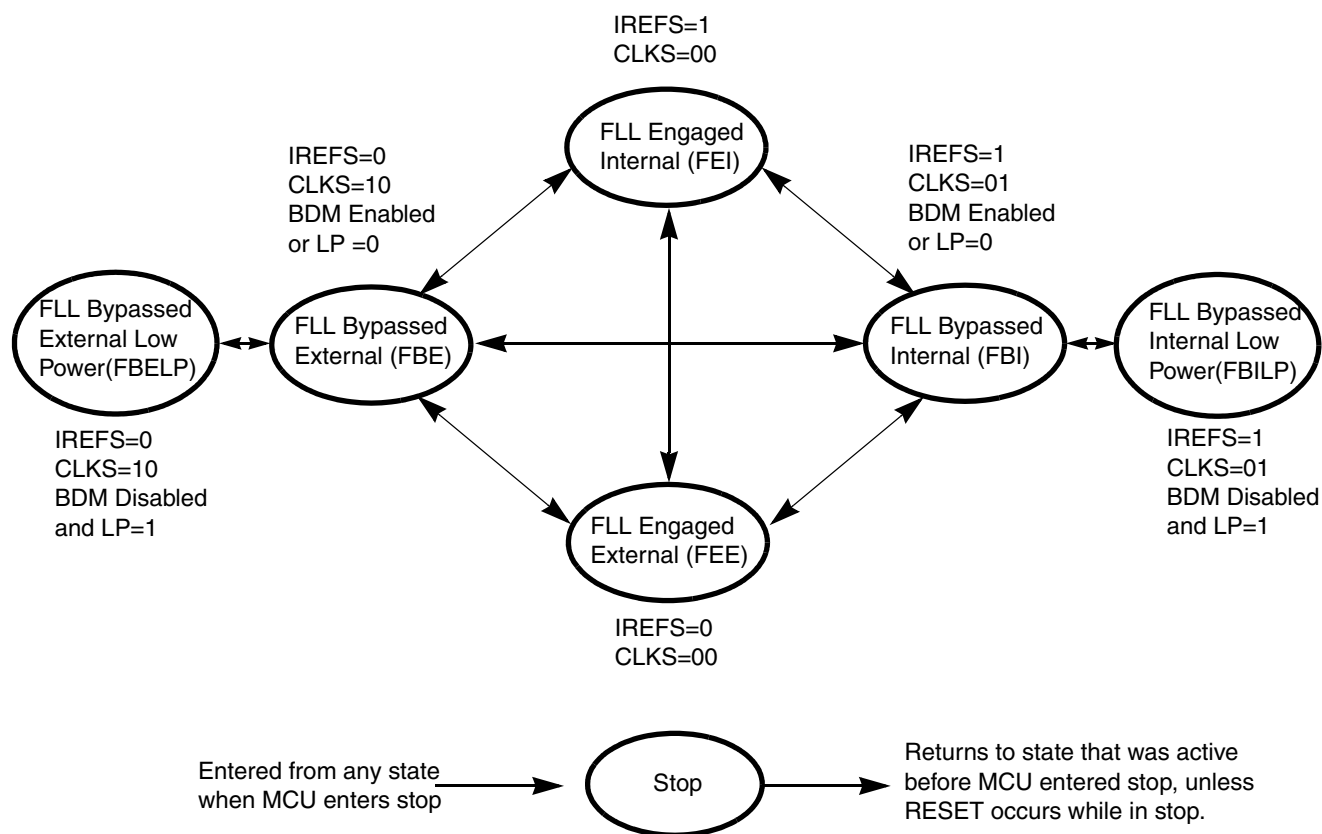


Figure 11-7. Clock Switching Modes

The seven states of the ICS are shown as a state diagram and are described below. The arrows indicate the allowed movements between the states.

11.4.1.1 FLL Engaged Internal (FEI)

FLL engaged internal (FEI) is the default mode of operation and is entered when all the following conditions occur:

- CLKS bits are written to 00.
- IREFS bit is written to 1.

In FLL engaged internal mode, the ICSOUT clock is derived from the FLL clock, which is controlled by the internal reference clock. The FLL loop locks the frequency to the FLL factor times the internal reference frequency. The ICSLCLK is available for BDC communications, and the internal reference clock is enabled.

11.4.1.2 FLL Engaged External (FEE)

The FLL engaged external (FEE) mode is entered when all the following conditions occur:

- CLKS bits are written to 00.
- IREFS bit is written to 0.
- RDIV bits are written to divide external reference clock to be within the range of 31.25 kHz to 39.0625 kHz.

In FLL engaged external mode, the ICSOUT clock is derived from the FLL clock which is controlled by the external reference clock source. The FLL loop locks the frequency to the FLL factor times the external reference frequency, as selected by the RDIV bits. The ICSLCLK is available for BDC communications, and the external reference clock is enabled.

11.4.1.3 FLL Bypassed Internal (FBI)

The FLL bypassed internal (FBI) mode is entered when all the following conditions occur:

- CLKS bits are written to 01.
- IREFS bit is written to 1.
- BDM mode is active or LP bit is written to 0.

In FLL bypassed internal mode, the ICSOUT clock is derived from the internal reference clock. The FLL clock is controlled by the internal reference clock, and the FLL loop locks the FLL frequency to the FLL factor times the internal reference frequency. The ICSLCLK will be available for BDC communications, and the internal reference clock is enabled.

11.4.1.4 FLL Bypassed Internal Low Power (FBILP)

The FLL bypassed internal low power (FBILP) mode is entered when all the following conditions occur:

- CLKS bits are written to 01.
- IREFS bit is written to 1.
- BDM mode is not active and LP bit is written to 1.

In FLL bypassed internal low power mode, the ICSOUT clock is derived from the internal reference clock and the FLL is disabled. The ICSLCLK will be not be available for BDC communications, and the internal reference clock is enabled.

11.4.1.5 FLL Bypassed External (FBE)

The FLL bypassed external (FBE) mode is entered when all the following conditions occur:

- CLKS bits are written to 10.
- IREFS bit is written to 0.
- RDIV bits are written to divide external reference clock to be within the range of 31.25 kHz to 39.0625 kHz.
- BDM mode is active or LP bit is written to 0.

In FLL bypassed external mode, the ICSOUT clock is derived from the external reference clock source. The FLL clock is controlled by the external reference clock, and the FLL loop locks the FLL frequency to the FLL factor times the external reference frequency, as selected by the RDIV bits, so that the ICSLCLK will be available for BDC communications, and the external reference clock is enabled.

11.4.1.6 FLL Bypassed External Low Power (FBELP)

The FLL bypassed external low power (FBELP) mode is entered when all the following conditions occur:

- CLKS bits are written to 10.
- IREFS bit is written to 0.
- BDM mode is not active and LP bit is written to 1.

In FLL bypassed external low power mode, the ICSOUT clock is derived from the external reference clock source and the FLL is disabled. The ICSLCLK will not be available for BDC communications. The external reference clock source is enabled.

11.4.1.7 Stop

Stop mode is entered whenever the MCU enters a STOP state. In this mode, all ICS clock signals are static except in the following cases:

ICSIRCLK will be active in stop mode when all the following conditions occur:

- IRCLKEN bit is written to 1.
- IREFSTEN bit is written to 1.

OSCOOUT will be active in stop mode when all the following conditions occur:

- ERCLKEN bit is written to 1.
- EREFSTEN bit is written to 1.

11.4.2 Mode Switching

The IREF bit can be changed at anytime, but the actual switch to the newly selected clock is shown by the IREFST bit. When switching between FLL engaged internal (FEI) and FLL engaged external (FEE) modes, the FLL begins locking again after the switch is completed.

The CLKS bits can also be changed at anytime, but the actual switch to the newly selected clock is shown by the CLKST bits. If the newly selected clock is not available, the previous clock remains selected.

The DRS bits can be changed at anytime except when LP bit is 1. If the DRS bits are changed while in FLL engaged internal (FEI) or FLL engaged external (FEE), the bus clock remains at the previous DCO range until the new DCO starts. When the new DCO starts the bus clock switches to it. After switching to the new DCO the FLL remains unlocked for several reference cycles. Once the selected DCO startup time is over, the FLL is locked. The completion of the switch is shown by the DRST bits.

11.4.3 Bus Frequency Divider

The BDIV bits can be changed at anytime and the actual switch to the new frequency occurs immediately.

11.4.4 Low Power Bit Usage

The low power bit (LP) is provided to allow the FLL to be disabled and thus conserve power when it is not being used. The DRS bits can not be written while LP bit is 1.

However, in some applications it may be desirable to allow the FLL to be enabled and to lock for maximum accuracy before switching to an FLL engaged mode. To do this, write the LP bit to 0.

11.4.5 DCO Maximum Frequency with 32.768 kHz Oscillator

The FLL has an option to change the clock multiplier for the selected DCO range such that it results in the maximum bus frequency with a common 32.768 kHz crystal reference clock.

11.4.6 Internal Reference Clock

When IRCLKEN is set the internal reference clock signal is presented as ICSIRCLK, which can be used as an additional clock source. To re-target the ICSIRCLK frequency, write a new value to the TRIM bits in the ICSTRM register to trim the period of the internal reference clock:

- Writing a larger value slows down the ICSIRCLK frequency.
- Writing a smaller value to the ICSTRM register speeds up the ICSIRCLK frequency.

The TRIM bits effect the ICSOUT frequency if the ICS is in FLL engaged internal (FEI), FLL bypassed internal (FBI), or FLL bypassed internal low power (FBILP) mode.

Until ICSIRCLK is trimmed, programming low reference divider (RDIV) factors may result in ICSOUT frequencies that exceed the maximum chip-level frequency and violate the chip-level clock timing specifications (see the [Device Overview](#) chapter).

If IREFSTEN is set and the IRCLKEN bit is written to 1, the internal reference clock keeps running during stop mode in order to provide a fast recovery upon exiting stop.

All MCU devices are factory programmed with a trim value in a reserved memory location. This value is uploaded to the ICSTRM register and ICS FTRIM register during any reset initialization. For finer precision, trim the internal oscillator in the application and set the FTRIM bit accordingly.

11.4.7 External Reference Clock

The ICS module supports an external reference clock with frequencies between 31.25 kHz to 40 MHz in all modes. When the ERCLKEN is set, the external reference clock signal is presented as ICSECLK, which can be used as an additional clock source in run mode. When IREFS = 1, the external reference clock is not used by the FLL and will only be used as ICSECLK. In these modes, the frequency can be equal to the maximum frequency the chip-level timing specifications support (see the [Device Overview](#) chapter).

If EREFSTEN is set and the ERCLKEN bit is written to 1, the external reference clock source (OSCOUT) keeps running during stop mode in order to provide a fast recovery upon exiting stop.

11.4.8 Fixed Frequency Clock

The ICS presents the divided FLL reference clock as ICSFFCLK for use as an additional clock source. ICSFFCLK frequency must be no more than 1/4 of the ICSOUT frequency to be valid.

11.4.9 Local Clock

The ICS presents the low range DCO output clock divided by two as ICSLCLK for use as a clock source for BDC communications. ICSLCLK is not available in FLL bypassed internal low power (FBILP) and FLL bypassed external low power (FBELP) modes.

Chapter 12

Inter-Integrated Circuit (S08IICV2)

12.1 Introduction

The inter-integrated circuit (IIC) provides a method of communication between a number of devices. The interface is designed to operate up to 100 kbps with maximum bus loading and timing. The device is capable of operating at higher baud rates, up to a maximum of clock/20, with reduced bus loading. The maximum communication length and the number of devices that can be connected are limited by a maximum bus capacitance of 400 pF.

NOTE

MC9S08QE8 series devices do not include stop1 mode. Please ignore references to stop1.

NOTE

The SDA and SCL must not be driven above V_{DD} . These pins are pseudo open-drain and contain a protection diode to V_{DD} .

12.1.1 Module Configuration

The IIC module pins, SDA and SCL can be repositioned under software control using IICPS in SOPT2 as shown in [Table 12-1](#). IICPS in SOPT2 selects which general-purpose I/O ports are associated with IIC operation.

Table 12-1. IIC1 Position Options

IICPS in SOPT2	Port Pin for SDA	Port Pin for SCL
0 (default)	PTA2	PTA3
1	PTB6	PTB7

12.1.2 IIC Clock Gating

The bus clock to the IIC can be gated on and off using the IIC bit in SCGC1. This bit is set after any reset, which enables the bus clock to this module. To conserve power, the IIC bit can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

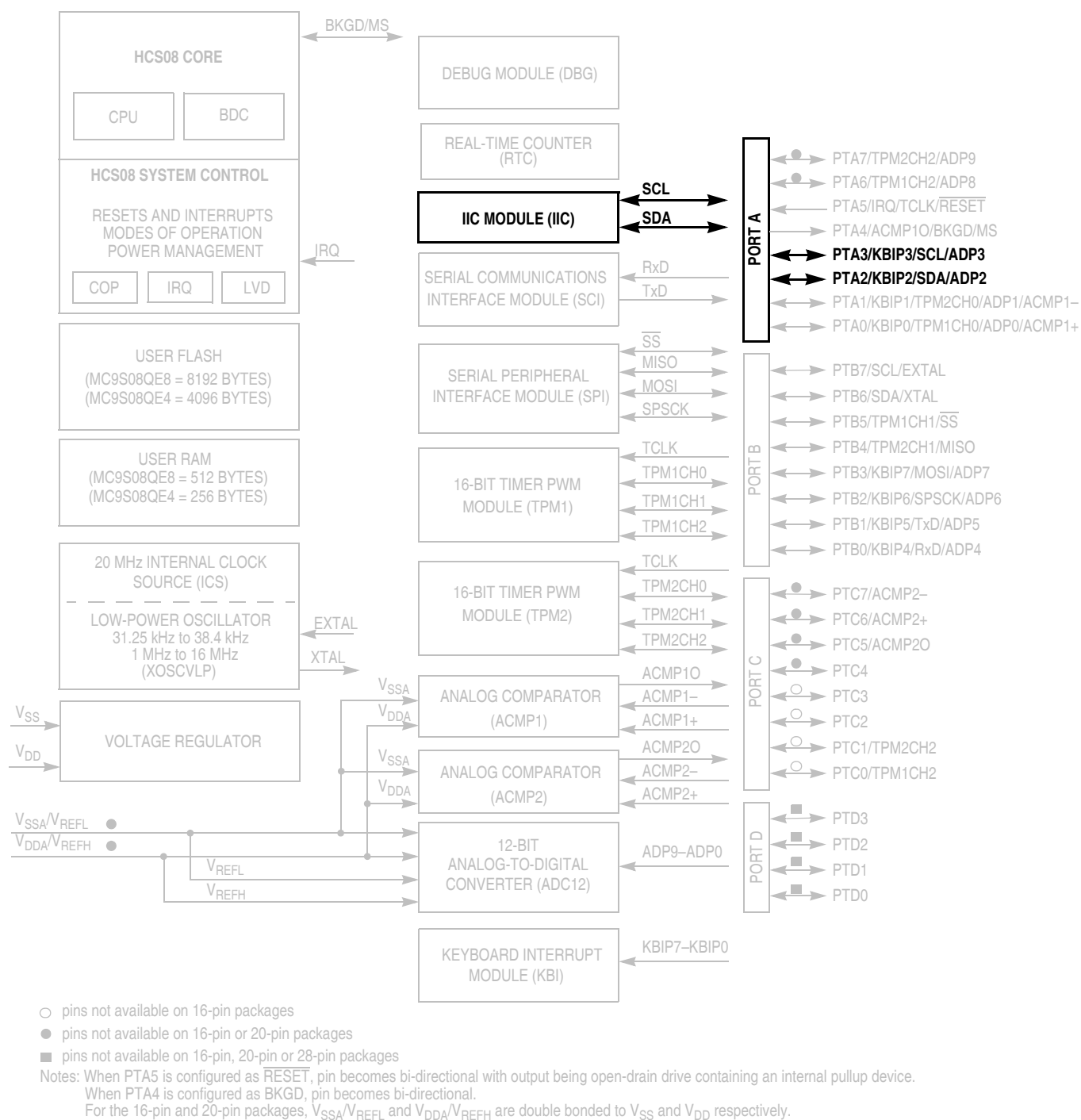


Figure 12-1. QE8 Block Diagram Highlighting the IIC Block and Pins

12.1.3 Features

The IIC includes these distinctive features:

- Compatible with IIC bus standard
- Multi-master operation
- Software programmable for one of 64 different serial clock frequencies
- Software selectable acknowledge bit
- Interrupt driven byte-by-byte data transfer
- Arbitration lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- Start and stop signal generation/detection
- Repeated start signal generation
- Acknowledge bit generation/detection
- Bus busy detection
- General call recognition
- 10-bit address extension

12.1.4 Modes of Operation

A brief description of the IIC in the various MCU modes is given here.

- **Run mode** — This is the basic mode of operation. To conserve power in this mode, disable the module.
- **Wait mode** — The module continues to operate while the MCU is in wait mode and can provide a wake-up interrupt.
- **Stop mode** — The IIC is inactive in stop3 mode for reduced power consumption. The stop instruction does not affect IIC register states. Stop2 resets the register contents.

12.1.5 Block Diagram

[Figure 12-2](#) is a block diagram of the IIC.

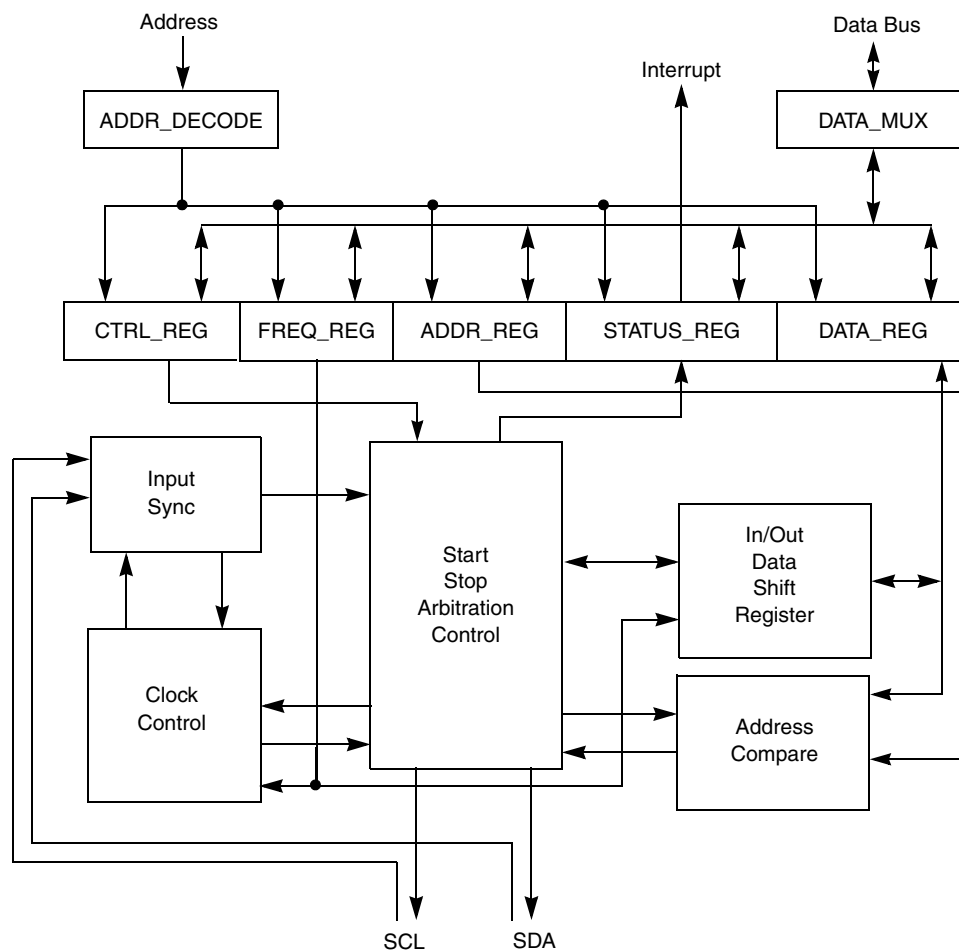


Figure 12-2. IIC Functional Block Diagram

12.2 External Signal Description

This section describes each user-accessible pin signal.

12.2.1 SCL — Serial Clock Line

The bidirectional SCL is the serial clock line of the IIC system.

12.2.2 SDA — Serial Data Line

The bidirectional SDA is the serial data line of the IIC system.

12.3 Register Definition

This section consists of the IIC register descriptions in address order.

Refer to the direct-page register summary in the [memory](#) chapter of this document for the absolute address assignments for all IIC registers. This section refers to registers and control bits only by their names. A

Freescall-provided equate or header file is used to translate these names into the appropriate absolute addresses.

12.3.1 IIC Address Register (IICA)

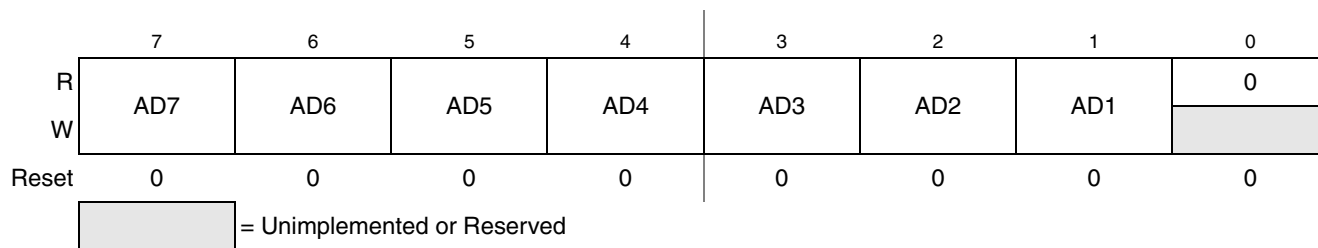


Figure 12-3. IIC Address Register (IICA)

Table 12-2. IICA Field Descriptions

Field	Description
7–1 AD[7:1]	Slave Address. The AD[7:1] field contains the slave address to be used by the IIC module. This field is used on the 7-bit address scheme and the lower seven bits of the 10-bit address scheme.

12.3.2 IIC Frequency Divider Register (IICF)

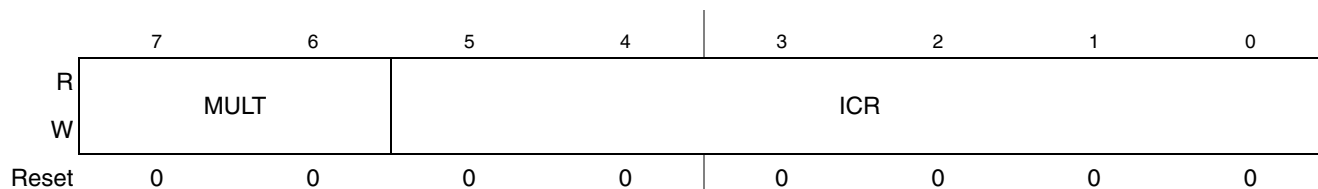


Figure 12-4. IIC Frequency Divider Register (IICF)

Table 12-3. IICF Field Descriptions

Field	Description
7–6 MULT	<p>IIC Multiplier Factor. The MULT bits define the multiplier factor, mul. This factor, along with the SCL divider, generates the IIC baud rate. The multiplier factor mul as defined by the MULT bits is provided below.</p> <p>00 mul = 01 01 mul = 02 10 mul = 04 11 Reserved</p>
5–0 ICR	<p>IIC Clock Rate. The ICR bits are used to prescale the bus clock for bit rate selection. These bits and the MULT bits determine the IIC baud rate, the SDA hold time, the SCL Start hold time, and the SCL Stop hold time. Table 12-5 provides the SCL divider and hold values for corresponding values of the ICR.</p> <p>The SCL divider multiplied by multiplier factor mul generates IIC baud rate.</p> $\text{IIC baud rate} = \frac{\text{bus speed (Hz)}}{\text{mul} \times \text{SCLdivider}} \quad \text{Eqn. 12-1}$ <p>SDA hold time is the delay from the falling edge of SCL (IIC clock) to the changing of SDA (IIC data).</p> $\text{SDA hold time} = \text{bus period (s)} \times \text{mul} \times \text{SDA hold value} \quad \text{Eqn. 12-2}$ <p>SCL start hold time is the delay from the falling edge of SDA (IIC data) while SCL is high (Start condition) to the falling edge of SCL (IIC clock).</p> $\text{SCL Start hold time} = \text{bus period (s)} \times \text{mul} \times \text{SCL Start hold value} \quad \text{Eqn. 12-3}$ <p>SCL stop hold time is the delay from the rising edge of SCL (IIC clock) to the rising edge of SDA (IIC data) while SCL is high (Stop condition).</p> $\text{SCL Stop hold time} = \text{bus period (s)} \times \text{mul} \times \text{SCL Stop hold value} \quad \text{Eqn. 12-4}$

For example, if the bus speed is 8 MHz, the table below shows the possible hold time values with different ICR and MULT selections to achieve an IIC baud rate of 100kbps.

Table 12-4. Hold Time Values for 8 MHz Bus Speed

MULT	ICR	Hold Times (μs)		
		SDA	SCL Start	SCL Stop
0x2	0x00	3.500	3.000	5.500
0x1	0x07	2.500	4.000	5.250
0x1	0x0B	2.250	4.000	5.250
0x0	0x14	2.125	4.250	5.125
0x0	0x18	1.125	4.750	5.125

Table 12-5. IIC Divider and Hold Values

ICR (hex)	SCL Divider	SDA Hold Value	SCL Hold (Start) Value	SCL Hold (Stop) Value
00	20	7	6	11
01	22	7	7	12
02	24	8	8	13
03	26	8	9	14
04	28	9	10	15
05	30	9	11	16
06	34	10	13	18
07	40	10	16	21
08	28	7	10	15
09	32	7	12	17
0A	36	9	14	19
0B	40	9	16	21
0C	44	11	18	23
0D	48	11	20	25
0E	56	13	24	29
0F	68	13	30	35
10	48	9	18	25
11	56	9	22	29
12	64	13	26	33
13	72	13	30	37
14	80	17	34	41
15	88	17	38	45
16	104	21	46	53
17	128	21	58	65
18	80	9	38	41
19	96	9	46	49
1A	112	17	54	57
1B	128	17	62	65
1C	144	25	70	73
1D	160	25	78	81
1E	192	33	94	97
1F	240	33	118	121

ICR (hex)	SCL Divider	SDA Hold Value	SCL Hold (Start) Value	SCL Hold (Stop) Value
20	160	17	78	81
21	192	17	94	97
22	224	33	110	113
23	256	33	126	129
24	288	49	142	145
25	320	49	158	161
26	384	65	190	193
27	480	65	238	241
28	320	33	158	161
29	384	33	190	193
2A	448	65	222	225
2B	512	65	254	257
2C	576	97	286	289
2D	640	97	318	321
2E	768	129	382	385
2F	960	129	478	481
30	640	65	318	321
31	768	65	382	385
32	896	129	446	449
33	1024	129	510	513
34	1152	193	574	577
35	1280	193	638	641
36	1536	257	766	769
37	1920	257	958	961
38	1280	129	638	641
39	1536	129	766	769
3A	1792	257	894	897
3B	2048	257	1022	1025
3C	2304	385	1150	1153
3D	2560	385	1278	1281
3E	3072	513	1534	1537
3F	3840	513	1918	1921

12.3.3 IIC Control Register (IICC1)

	7	6	5	4	3	2	1	0
R	IICEN	IICIE	MST	TX	TXAK	0	0	0
W						RSTA		
Reset	0	0	0	0	0	0	0	0

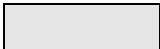
 = Unimplemented or Reserved

Figure 12-5. IIC Control Register (IICC1)

Table 12-6. IICC1 Field Descriptions

Field	Description
7 IICEN	IIC Enable. The IICEN bit determines whether the IIC module is enabled. 0 IIC is not enabled 1 IIC is enabled
6 IICIE	IIC Interrupt Enable. The IICIE bit determines whether an IIC interrupt is requested. 0 IIC interrupt request not enabled 1 IIC interrupt request enabled
5 MST	Master Mode Select. The MST bit changes from a 0 to a 1 when a start signal is generated on the bus and master mode is selected. When this bit changes from a 1 to a 0 a stop signal is generated and the mode of operation changes from master to slave. 0 Slave mode 1 Master mode
4 TX	Transmit Mode Select. The TX bit selects the direction of master and slave transfers. In master mode, this bit should be set according to the type of transfer required. Therefore, for address cycles, this bit is always high. When addressed as a slave, this bit should be set by software according to the SRW bit in the status register. 0 Receive 1 Transmit
3 TXAK	Transmit Acknowledge Enable. This bit specifies the value driven onto the SDA during data acknowledge cycles for master and slave receivers. 0 An acknowledge signal is sent out to the bus after receiving one data byte 1 No acknowledge signal response is sent
2 RSTA	Repeat start. Writing a 1 to this bit generates a repeated start condition provided it is the current master. This bit is always read as cleared. Attempting a repeat at the wrong time results in loss of arbitration.

12.3.4 IIC Status Register (IICS)

	7	6	5	4	3	2	1	0
R	TCF		BUSY	ARBL	0	SRW		RXAK
W		IAAS					IICIF	
Reset	1	0	0	0	0	0	0	0


 = Unimplemented or Reserved

Figure 12-6. IIC Status Register (IICS)

Table 12-7. IICS Field Descriptions

Field	Description
7 TCF	Transfer Complete Flag. This bit is set on the completion of a byte transfer. This bit is only valid during or immediately following a transfer to the IIC module or from the IIC module. The TCF bit is cleared by reading the IICD register in receive mode or writing to the IICD in transmit mode. 0 Transfer in progress 1 Transfer complete
6 IAAS	Addressed as a Slave. The IAAS bit is set when the calling address matches the programmed slave address or when the GCAEN bit is set and a general call is received. Writing the IICC register clears this bit. 0 Not addressed 1 Addressed as a slave
5 BUSY	Bus Busy. The BUSY bit indicates the status of the bus regardless of slave or master mode. The BUSY bit is set when a start signal is detected and cleared when a stop signal is detected. 0 Bus is idle 1 Bus is busy
4 ARBL	Arbitration Lost. This bit is set by hardware when the arbitration procedure is lost. The ARBL bit must be cleared by software by writing a 1 to it. 0 Standard bus operation 1 Loss of arbitration
2 SRW	Slave Read/Write. When addressed as a slave, the SRW bit indicates the value of the R/W command bit of the calling address sent to the master. 0 Slave receive, master writing to slave 1 Slave transmit, master reading from slave
1 IICIF	IIC Interrupt Flag. The IICIF bit is set when an interrupt is pending. This bit must be cleared by software, by writing a 1 to it in the interrupt routine. One of the following events can set the IICIF bit: <ul style="list-style-type: none"> One byte transfer completes Match of slave address to calling address Arbitration lost 0 No interrupt pending 1 Interrupt pending
0 RXAK	Receive Acknowledge. When the RXAK bit is low, it indicates an acknowledge signal has been received after the completion of one byte of data transmission on the bus. If the RXAK bit is high it means that no acknowledge signal is detected. 0 Acknowledge received 1 No acknowledge received

12.3.5 IIC Data I/O Register (IICD)

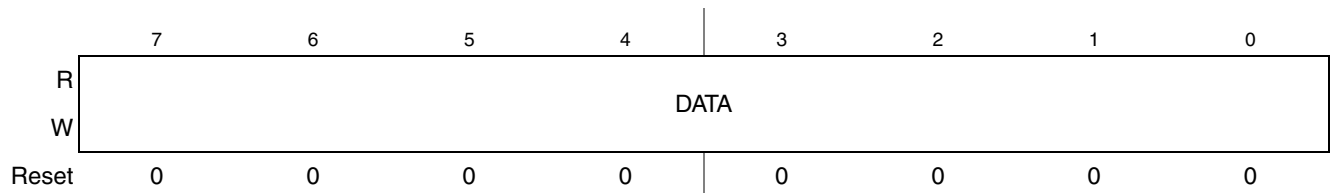


Figure 12-7. IIC Data I/O Register (IICD)

Table 12-8. IICD Field Descriptions

Field	Description
7–0 DATA	Data — In master transmit mode, when data is written to the IICD, a data transfer is initiated. The most significant bit is sent first. In master receive mode, reading this register initiates receiving of the next byte of data.

NOTE

When transitioning out of master receive mode, the IIC mode should be switched before reading the IICD register to prevent an inadvertent initiation of a master receive data transfer.

In slave mode, the same functions are available after an address match has occurred.

The TX bit in IICC must correctly reflect the desired direction of transfer in master and slave modes for the transmission to begin. For instance, if the IIC is configured for master transmit but a master receive is desired, reading the IICD does not initiate the receive.

Reading the IICD returns the last byte received while the IIC is configured in master receive or slave receive modes. The IICD does not reflect every byte transmitted on the IIC bus, nor can software verify that a byte has been written to the IICD correctly by reading it back.

In master transmit mode, the first byte of data written to IICD following assertion of MST is used for the address transfer and should comprise of the calling address (in bit 7 to bit 1) concatenated with the required R/W bit (in position bit 0).

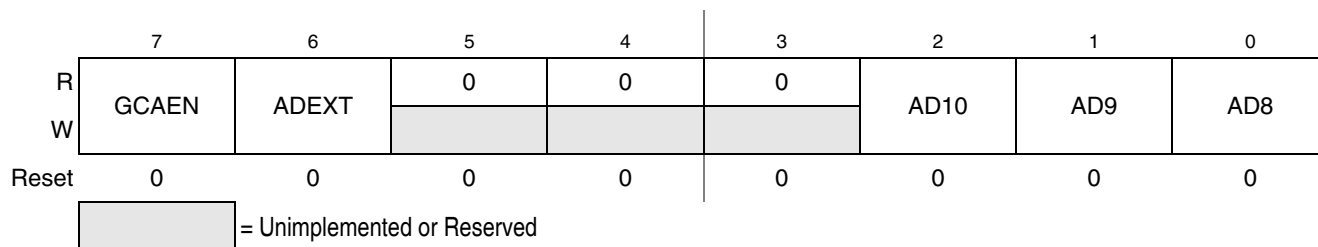
12.3.6 IIC Control Register 2 (IICC2)

Figure 12-8. IIC Control Register (IICC2)

Table 12-9. IICC2 Field Descriptions

Field	Description
7 GCAEN	General Call Address Enable. The GCAEN bit enables or disables general call address. 0 General call address is disabled 1 General call address is enabled
6 ADEXT	Address Extension. The ADEXT bit controls the number of bits used for the slave address. 0 7-bit address scheme 1 10-bit address scheme
2–0 AD[10:8]	Slave Address. The AD[10:8] field contains the upper three bits of the slave address in the 10-bit address scheme. This field is only valid when the ADEXT bit is set.

12.4 Functional Description

This section provides a complete functional description of the IIC module.

12.4.1 IIC Protocol

The IIC bus system uses a serial data line (SDA) and a serial clock line (SCL) for data transfer. All devices connected to it must have open drain or open collector outputs. A logic AND function is exercised on both lines with external pull-up resistors. The value of these resistors is system dependent.

Normally, a standard communication is composed of four parts:

- Start signal
- Slave address transmission
- Data transfer
- Stop signal

The stop signal should not be confused with the CPU stop instruction. The IIC bus system communication is described briefly in the following sections and illustrated in [Figure 12-9](#).

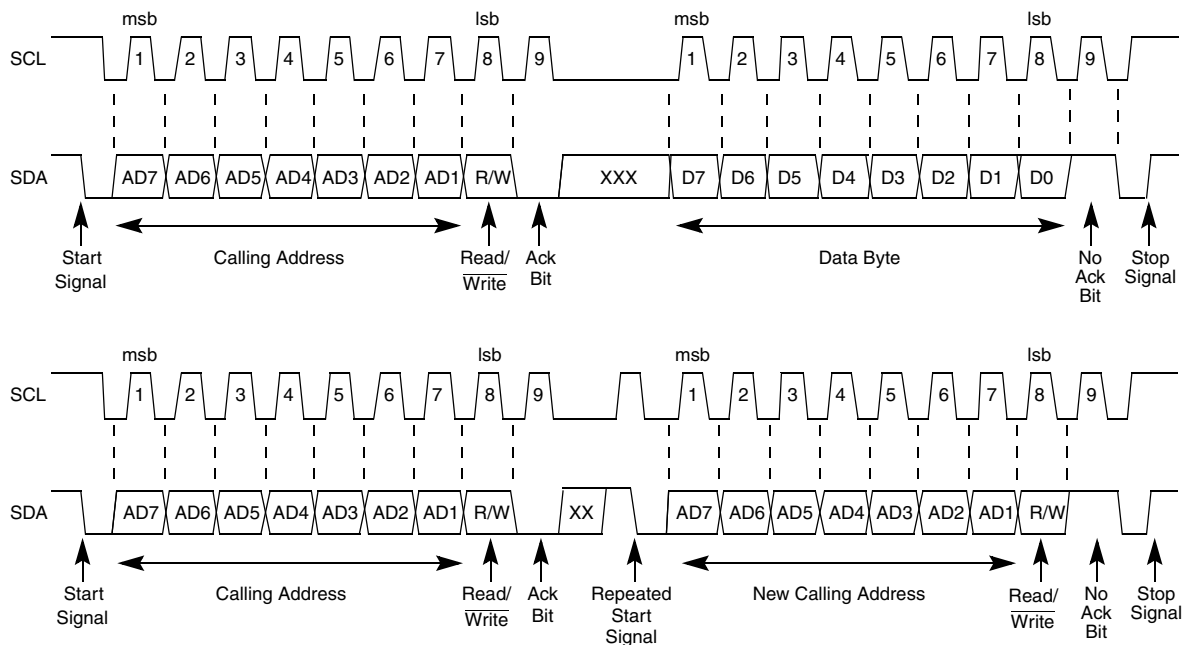


Figure 12-9. IIC Bus Transmission Signals

12.4.1.1 Start Signal

When the bus is free, no master device is engaging the bus (SCL and SDA lines are at logical high), a master may initiate communication by sending a start signal. As shown in [Figure 12-9](#), a start signal is defined as a high-to-low transition of SDA while SCL is high. This signal denotes the beginning of a new data transfer (each data transfer may contain several bytes of data) and brings all slaves out of their idle states.

12.4.1.2 Slave Address Transmission

The first byte of data transferred immediately after the start signal is the slave address transmitted by the master. This is a seven-bit calling address followed by a R/\overline{W} bit. The R/\overline{W} bit tells the slave the desired direction of data transfer.

1 = Read transfer, the slave transmits data to the master.

0 = Write transfer, the master transmits data to the slave.

Only the slave with a calling address that matches the one transmitted by the master responds by sending back an acknowledge bit. This is done by pulling the SDA low at the ninth clock (see [Figure 12-9](#)).

No two slaves in the system may have the same address. If the IIC module is the master, it must not transmit an address equal to its own slave address. The IIC cannot be master and slave at the same time. However, if arbitration is lost during an address cycle, the IIC reverts to slave mode and operates correctly even if it is being addressed by another master.

12.4.1.3 Data Transfer

Before successful slave addressing is achieved, the data transfer can proceed byte-by-byte in a direction specified by the R/\overline{W} bit sent by the calling master.

All transfers that come after an address cycle are referred to as data transfers, even if they carry sub-address information for the slave device

Each data byte is 8 bits long. Data may be changed only while SCL is low and must be held stable while SCL is high as shown in [Figure 12-9](#). There is one clock pulse on SCL for each data bit, the msb being transferred first. Each data byte is followed by a 9th (acknowledge) bit, which is signalled from the receiving device. An acknowledge is signalled by pulling the SDA low at the ninth clock. In summary, one complete data transfer needs nine clock pulses.

If the slave receiver does not acknowledge the master in the ninth bit time, the SDA line must be left high by the slave. The master interprets the failed acknowledge as an unsuccessful data transfer.

If the master receiver does not acknowledge the slave transmitter after a data byte transmission, the slave interprets this as an end of data transfer and releases the SDA line.

In either case, the data transfer is aborted and the master does one of two things:

- Relinquishes the bus by generating a stop signal.
- Commences a new calling by generating a repeated start signal.

12.4.1.4 Stop Signal

The master can terminate the communication by generating a stop signal to free the bus. However, the master may generate a start signal followed by a calling command without generating a stop signal first. This is called repeated start. A stop signal is defined as a low-to-high transition of SDA while SCL at logical 1 (see [Figure 12-9](#)).

The master can generate a stop even if the slave has generated an acknowledge at which point the slave must release the bus.

12.4.1.5 Repeated Start Signal

As shown in [Figure 12-9](#), a repeated start signal is a start signal generated without first generating a stop signal to terminate the communication. This is used by the master to communicate with another slave or with the same slave in different mode (transmit/receive mode) without releasing the bus.

12.4.1.6 Arbitration Procedure

The IIC bus is a true multi-master bus that allows more than one master to be connected on it. If two or more masters try to control the bus at the same time, a clock synchronization procedure determines the bus clock, for which the low period is equal to the longest clock low period and the high is equal to the shortest one among the masters. The relative priority of the contending masters is determined by a data arbitration procedure, a bus master loses arbitration if it transmits logic 1 while another master transmits logic 0. The losing masters immediately switch over to slave receive mode and stop driving SDA output. In this case, the transition from master to slave mode does not generate a stop condition. Meanwhile, a status bit is set by hardware to indicate loss of arbitration.

12.4.1.7 Clock Synchronization

Because wire-AND logic is performed on the SCL line, a high-to-low transition on the SCL line affects all the devices connected on the bus. The devices start counting their low period and after a device's clock has gone low, it holds the SCL line low until the clock high state is reached. However, the change of low to high in this device clock may not change the state of the SCL line if another device clock is still within its low period. Therefore, synchronized clock SCL is held low by the device with the longest low period. Devices with shorter low periods enter a high wait state during this time (see [Figure 12-10](#)). When all devices concerned have counted off their low period, the synchronized clock SCL line is released and pulled high. There is then no difference between the device clocks and the state of the SCL line and all the devices start counting their high periods. The first device to complete its high period pulls the SCL line low again.

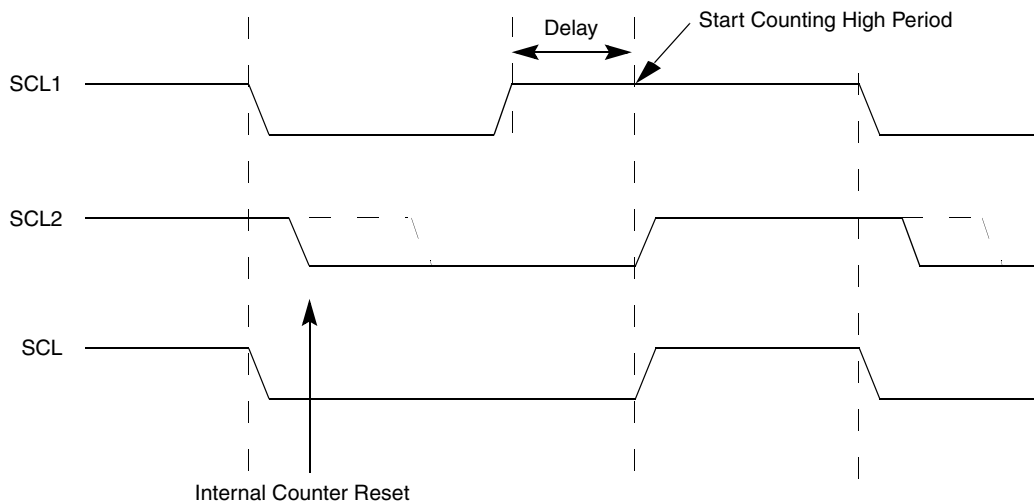


Figure 12-10. IIC Clock Synchronization

12.4.1.8 Handshaking

The clock synchronization mechanism can be used as a handshake in data transfer. Slave devices may hold the SCL low after completion of one byte transfer (9 bits). In such a case, it halts the bus clock and forces the master clock into wait states until the slave releases the SCL line.

12.4.1.9 Clock Stretching

The clock synchronization mechanism can be used by slaves to slow down the bit rate of a transfer. After the master has driven SCL low the slave can drive SCL low for the required period and then release it. If the slave SCL low period is greater than the master SCL low period then the resulting SCL bus signal low period is stretched.

12.4.2 10-bit Address

For 10-bit addressing, 0x11110 is used for the first 5 bits of the first address byte. Various combinations of read/write formats are possible within a transfer that includes 10-bit addressing.

12.4.2.1 Master-Transmitter Addresses a Slave-Receiver

The transfer direction is not changed (see [Table 12-10](#)). When a 10-bit address follows a start condition, each slave compares the first seven bits of the first byte of the slave address (11110XX) with its own address and tests whether the eighth bit ($\overline{R/W}$ direction bit) is 0. More than one device can find a match and generate an acknowledge (A1). Then, each slave that finds a match compares the eight bits of the second byte of the slave address with its own address. Only one slave finds a match and generates an acknowledge (A2). The matching slave remains addressed by the master until it receives a stop condition (P) or a repeated start condition (Sr) followed by a different slave address.

S	Slave Address 1st 7 bits 11110 + AD10 + AD9	R/W 0	A1	Slave Address 2nd byte AD[8:1]	A2	Data	A	...	Data	A/A	P
---	--	----------	----	-----------------------------------	----	------	---	-----	------	-----	---

Table 12-10. Master-Transmitter Addresses Slave-Receiver with a 10-bit Address

After the master-transmitter has sent the first byte of the 10-bit address, the slave-receiver sees an IIC interrupt. Software must ensure the contents of IICD are ignored and not treated as valid data for this interrupt.

12.4.2.2 Master-Receiver Addresses a Slave-Transmitter

The transfer direction is changed after the second $\overline{R/W}$ bit (see [Table 12-11](#)). Up to and including acknowledge bit A2, the procedure is the same as that described for a master-transmitter addressing a slave-receiver. After the repeated start condition (Sr), a matching slave remembers that it was addressed before. This slave then checks whether the first seven bits of the first byte of the slave address following Sr are the same as they were after the start condition (S) and tests whether the eighth ($\overline{R/W}$) bit is 1. If there is a match, the slave considers that it has been addressed as a transmitter and generates acknowledge A3. The slave-transmitter remains addressed until it receives a stop condition (P) or a repeated start condition (Sr) followed by a different slave address.

After a repeated start condition (Sr), all other slave devices also compare the first seven bits of the first byte of the slave address with their own addresses and test the eighth (R/\overline{W}) bit. However, none of them are addressed because $R/\overline{W} = 1$ (for 10-bit devices) or the 11110XX slave address (for 7-bit devices) does not match.

S	Slave Address 1st 7 bits 11110 + AD10 + AD9	R/W 0	A1	Slave Address 2nd byte AD[8:1]	A2	Sr	Slave Address 1st 7 bits 11110 + AD10 + AD9	R/W 1	A3	Data	A	...	Data	A	P
---	---	----------	----	--------------------------------------	----	----	---	----------	----	------	---	-----	------	---	---

Table 12-11. Master-Receiver Addresses a Slave-Transmitter with a 10-bit Address

After the master-receiver has sent the first byte of the 10-bit address, the slave-transmitter sees an IIC interrupt. Software must ensure the contents of IICD are ignored and not treated as valid data for this interrupt.

12.4.3 General Call Address

General calls can be requested in 7-bit address or 10-bit address. If the GCAEN bit is set, the IIC matches the general call address as well as its own slave address. When the IIC responds to a general call, it acts as a slave-receiver and the IAAS bit is set after the address cycle. Software must read the IICD register after the first byte transfer to determine whether the address matches its own slave address or a general call. If the value is 00, the match is a general call. If the GCAEN bit is clear, the IIC ignores any data supplied from a general call address by not issuing an acknowledgement.

12.5 Resets

The IIC is disabled after reset. The IIC cannot cause an MCU reset.

12.6 Interrupts

The IIC generates a single interrupt.

An interrupt from the IIC is generated when any of the events in [Table 12-12](#) occur, provided the IICIE bit is set. The interrupt is driven by bit IICIF (of the IIC status register) and masked with bit IICIE (of the IIC control register). The IICIF bit must be cleared by software by writing a 1 to it in the interrupt routine. You can determine the interrupt type by reading the status register.

Table 12-12. Interrupt Summary

Interrupt Source	Status	Flag	Local Enable
Complete 1-byte transfer	TCF	IICIF	IICIE
Match of received calling address	IAAS	IICIF	IICIE
Arbitration Lost	ARBL	IICIF	IICIE

12.6.1 Byte Transfer Interrupt

The TCF (transfer complete flag) bit is set at the falling edge of the ninth clock to indicate the completion of byte transfer.

12.6.2 Address Detect Interrupt

When the calling address matches the programmed slave address (IIC address register) or when the GCAEN bit is set and a general call is received, the IAAS bit in the status register is set. The CPU is interrupted, provided the IICIE is set. The CPU must check the SRW bit and set its Tx mode accordingly.

12.6.3 Arbitration Lost Interrupt

The IIC is a true multi-master bus that allows more than one master to be connected on it. If two or more masters try to control the bus at the same time, the relative priority of the contending masters is determined by a data arbitration procedure. The IIC module asserts this interrupt when it loses the data arbitration process and the ARBL bit in the status register is set.

Arbitration is lost in the following circumstances:

- SDA sampled as a low when the master drives a high during an address or data transmit cycle.
- SDA sampled as a low when the master drives a high during the acknowledge bit of a data receive cycle.
- A start cycle is attempted when the bus is busy.
- A repeated start cycle is requested in slave mode.
- A stop condition is detected when the master did not request it.

This bit must be cleared by software writing a 1 to it.

12.7 Initialization/Application Information

Module Initialization (Slave)

1. Write: IICC2
 - to enable or disable general call
 - to select 10-bit or 7-bit addressing mode
2. Write: IICA
 - to set the slave address
3. Write: IICC1
 - to enable IIC and interrupts
4. Initialize RAM variables (IICEN = 1 and IICIE = 1) for transmit data
5. Initialize RAM variables used to achieve the routine shown in [Figure 12-12](#)

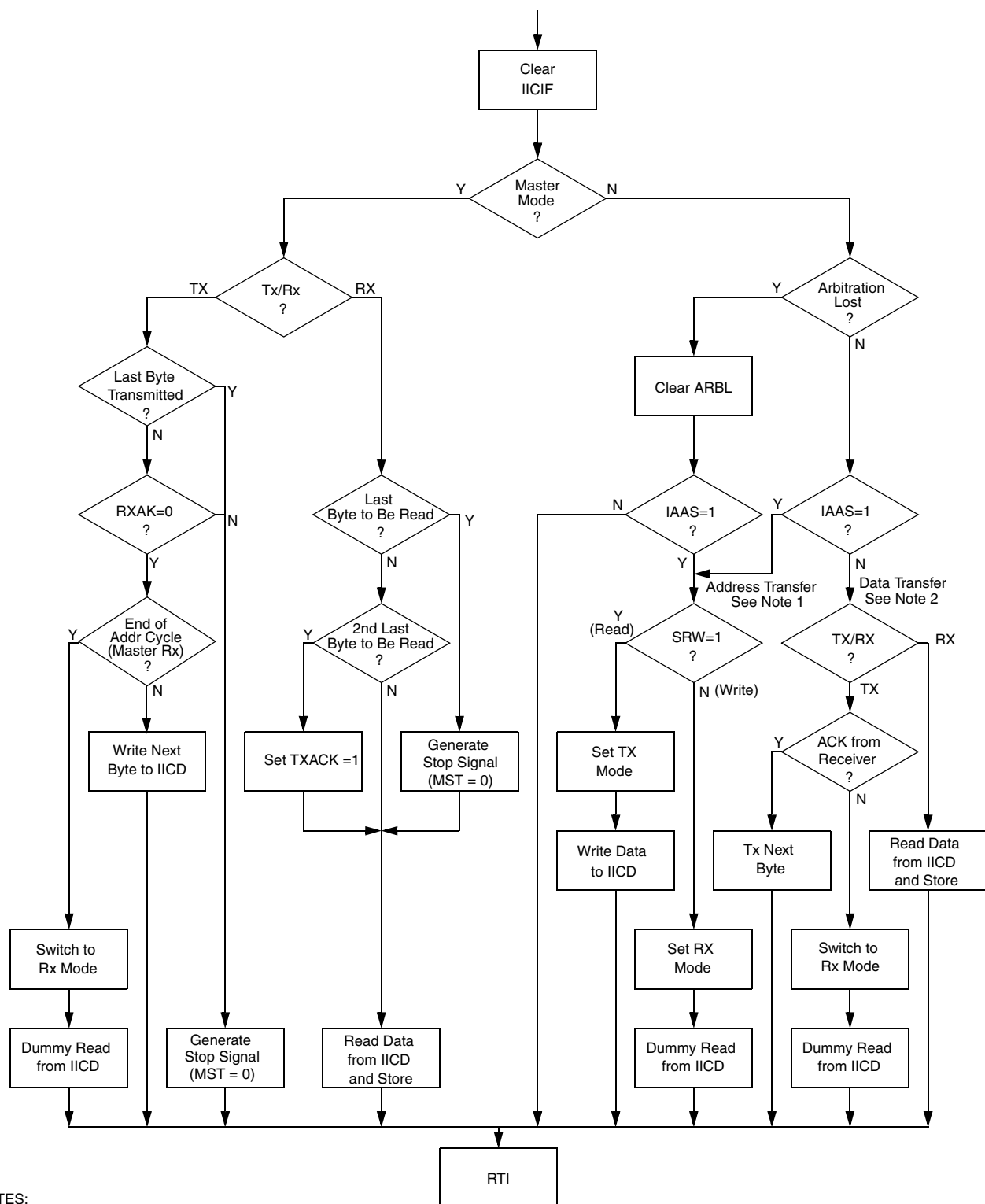
Module Initialization (Master)

1. Write: IICF
 - to set the IIC baud rate (example provided in this chapter)
2. Write: IICC1
 - to enable IIC and interrupts
3. Initialize RAM variables (IICEN = 1 and IICIE = 1) for transmit data
4. Initialize RAM variables used to achieve the routine shown in [Figure 12-12](#)
5. Write: IICC1
 - to enable TX

Register Model

IICA	AD[7:1]						0	
When addressed as a slave (in slave mode), the module responds to this address								
IICF	MULT		ICR					
Baud rate = BUSCLK / (2 x MULT x (SCL DIVIDER))								
IICC1	IICEN	IICIE	MST	TX	TXAK	RSTA	0	0
Module configuration								
IICS	TCF	IAAS	BUSY	ARBL	0	SRW	IICIF	RXAK
Module status flags								
IICD	DATA							
Data register; Write to transmit IIC data read to read IIC data								
IICC2	GCAEN	ADEXT	0	0	0	AD10	AD9	AD8
Address configuration								

Figure 12-11. IIC Module Quick Start



NOTES:

1. If general call is enabled, a check must be done to determine whether the received address was a general call address (0x00). If the received address was a general call address, then the general call must be handled by user software.
2. When 10-bit addressing is used to address a slave, the slave sees an interrupt following the first byte of the extended address. User software must ensure that for this interrupt, the contents of IICD are ignored and not treated as a valid data transfer.

Figure 12-12. Typical IIC Interrupt Routine

Chapter 13

Real-Time Counter (S08RTCV1)

13.1 Introduction

The real-time counter (RTC) consists of one 8-bit counter, one 8-bit comparator, several binary-based and decimal-based prescaler dividers, two clock sources, and one programmable periodic interrupt. This module can be used for time-of-day, calendar or any task scheduling functions. It can also serve as a cyclic wake up from low power modes without the need of external components.

13.1.1 ADC Hardware Trigger

This RTC can be enabled as a hardware trigger for the ADC module by setting the ADTRG bit in the ADCSC2 register. When enabled, the ADC will be triggered every time RTCINT matches RTCMOD. The RTC interrupt does not have to be enabled to trigger the ADC.

13.1.2 RTC Clock Sources

The RTC module on MC9S08QE8 series can be clocked from the ICSIRCLK, OSCOUT or the LPO.

ICSERCLK is not available as a source to the RTC in this MCU. In this chapter, when ERCLK is referenced as a clock source, it is replaced by OSCOUT for this MCU.

13.1.3 RTC Modes of Operation

All clock sources are available in all modes except stop2. The OSCOUT and LPO can be enabled as the clock source of the RTC in stop2.

13.1.4 RTC Status after Stop2 Wakeup

The registers associated with the RTC will be unaffected after a stop2 wakeup.

13.1.5 RTC Clock Gating

The bus clock to the RTC can be gated on and off using the RTC bit in SCGC2. This bit is set after any reset, which enables the bus clock to this module. To conserve power, the RTC bit can be cleared to disable the clock to this module when not in use. If the bus clock is not used as the RTC clock source, the bus clock must still be enabled to the RTC for proper operation. Interrupts from the RTC will not occur if the bus clock is gated off. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

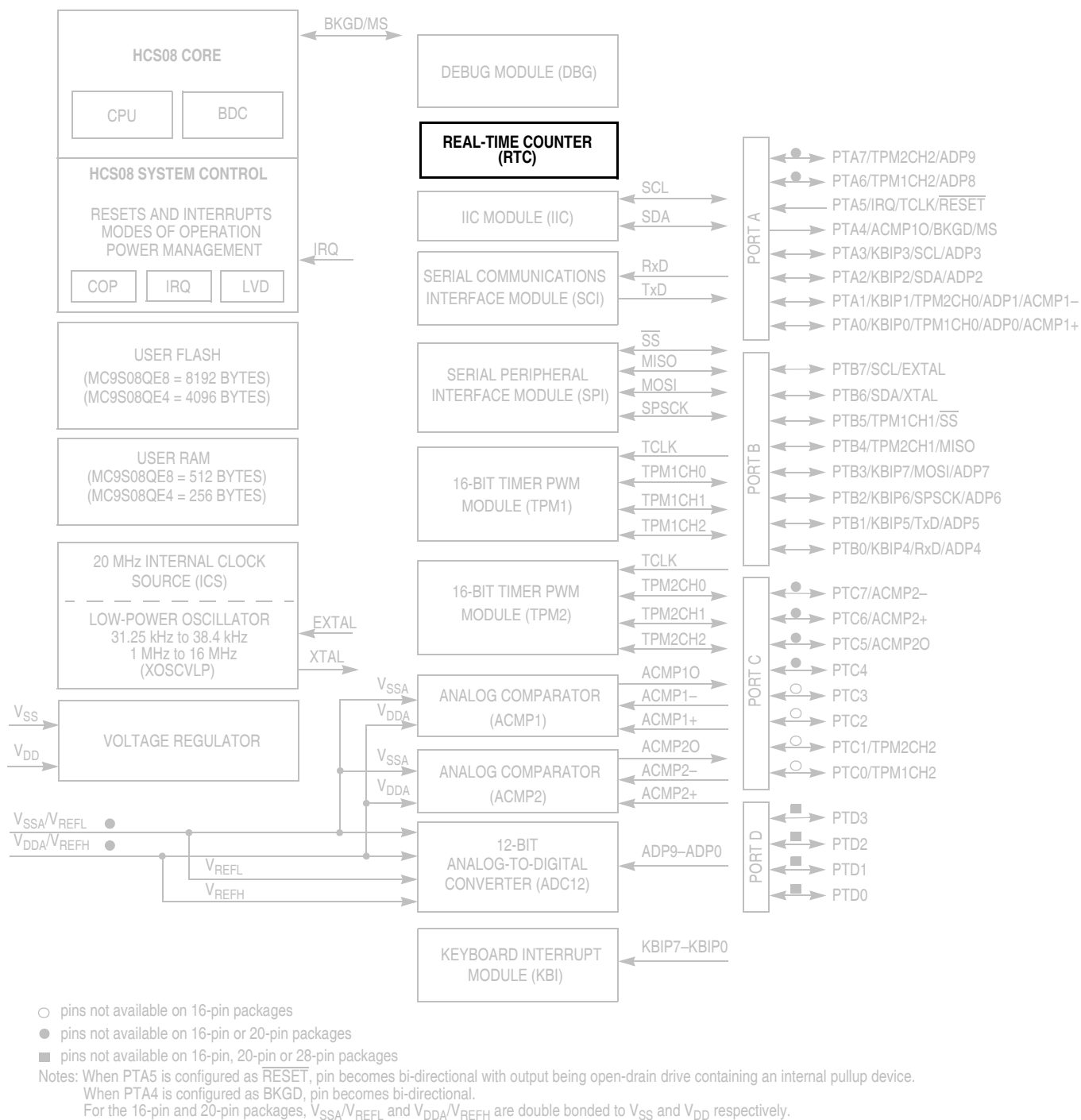


Figure 13-1. MC9S08QE8 Block Diagram Highlighting RTC Block

13.1.6 Features

Features of the RTC module include:

- 8-bit up-counter
 - 8-bit modulo match limit
 - Software controllable periodic interrupt on match
- Three software selectable clock sources for input to prescaler with selectable binary-based and decimal-based divider values
 - 1-kHz internal low-power oscillator (LPO)
 - External clock (ERCLK)
 - 32-kHz internal clock (IRCLK)

13.1.7 Modes of Operation

This section defines the operation in stop, wait and background debug modes.

13.1.7.1 Wait Mode

The RTC continues to run in wait mode if enabled before executing the appropriate instruction. Therefore, the RTC can bring the MCU out of wait mode if the real-time interrupt is enabled. For lowest possible current consumption, the RTC should be stopped by software if not needed as an interrupt source during wait mode.

13.1.7.2 Stop Modes

The RTC continues to run in stop2 or stop3 mode if the RTC is enabled before executing the STOP instruction. Therefore, the RTC can bring the MCU out of stop modes with no external components, if the real-time interrupt is enabled.

The LPO clock can be used in stop2 and stop3 modes. ERCLK and IRCLK clocks are only available in stop3 mode.

Power consumption is lower when all clock sources are disabled, but in that case, the real-time interrupt cannot wake up the MCU from stop modes.

13.1.7.3 Active Background Mode

The RTC suspends all counting during active background mode until the microcontroller returns to normal user operating mode. Counting resumes from the suspended value as long as the RTCMOD register is not written and the RTCPS and RTCLKS bits are not altered.

13.1.8 Block Diagram

The block diagram for the RTC module is shown in [Figure 13-2](#).

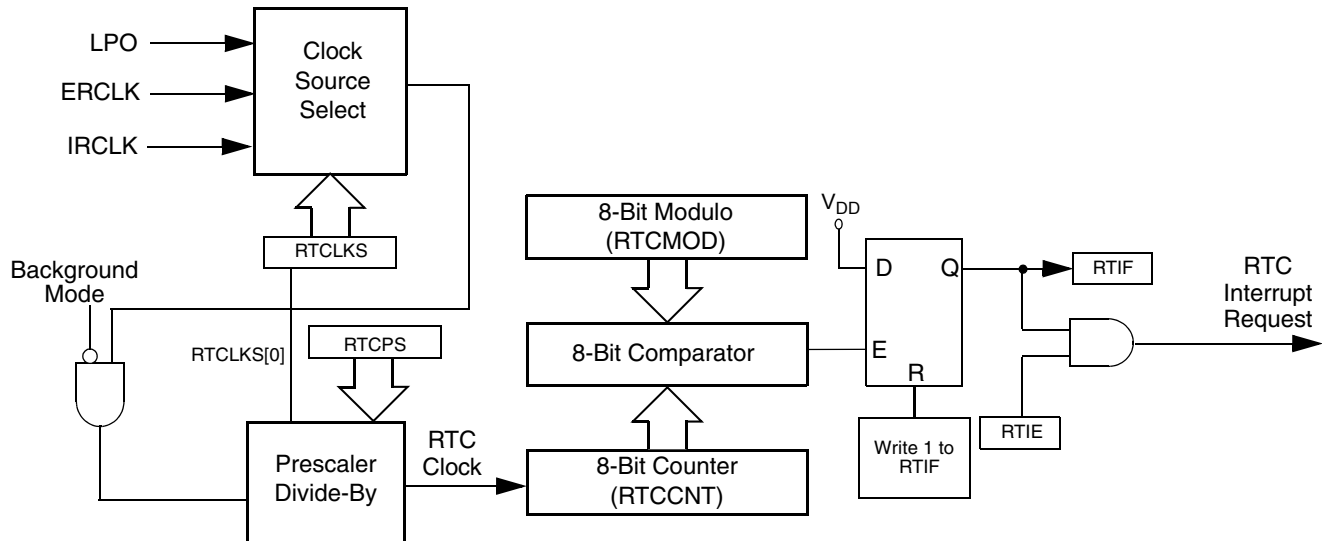


Figure 13-2. Real-Time Counter (RTC) Block Diagram

13.2 External Signal Description

The RTC does not include any off-chip signals.

13.3 Register Definition

The RTC includes a status and control register, an 8-bit counter register, and an 8-bit modulo register.

Refer to the direct-page register summary in the memory section of this document for the absolute address assignments for all RTC registers. This section refers to registers and control bits only by their names and relative address offsets.

[Table 13-1](#) is a summary of RTC registers.

Table 13-1. RTC Register Summary

Name		7	6	5	4	3	2	1	0
RTCSC	R	RTIF	RTCLKS		RTIE	RTCPS			
	W								
RTCCNT	R	RTCCNT							
	W								
RTCMOD	R	RTCMOD							
	W								

13.3.1 RTC Status and Control Register (RTCSC)

RTCSC contains the real-time interrupt status flag (RTIF), the clock select bits (RTCLKS), the real-time interrupt enable bit (RTIE), and the prescaler select bits (RTCPS).

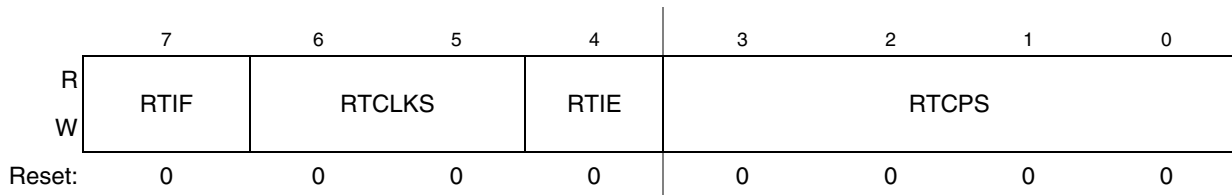


Figure 13-3. RTC Status and Control Register (RTCSC)

Table 13-2. RTCSC Field Descriptions

Field	Description
7 RTIF	Real-Time Interrupt Flag This status bit indicates the RTC counter register reached the value in the RTC modulo register. Writing a logic 0 has no effect. Writing a logic 1 clears the bit and the real-time interrupt request. Reset clears RTIF. 0 RTC counter has not reached the value in the RTC modulo register. 1 RTC counter has reached the value in the RTC modulo register.
6–5 RTCLKS	Real-Time Clock Source Select. These two read/write bits select the clock source input to the RTC prescaler. Changing the clock source clears the prescaler and RTCCNT counters. When selecting a clock source, ensure that the clock source is properly enabled (if applicable) to ensure correct operation of the RTC. Reset clears RTCLKS. 00 Real-time clock source is the 1-kHz low power oscillator (LPO) 01 Real-time clock source is the external clock (ERCLK) 1x Real-time clock source is the internal clock (IRCLK)
4 RTIE	Real-Time Interrupt Enable. This read/write bit enables real-time interrupts. If RTIE is set, then an interrupt is generated when RTIF is set. Reset clears RTIE. 0 Real-time interrupt requests are disabled. Use software polling. 1 Real-time interrupt requests are enabled.
3–0 RTCPS	Real-Time Clock Prescaler Select. These four read/write bits select binary-based or decimal-based divide-by values for the clock source. See Table 13-3 . Changing the prescaler value clears the prescaler and RTCCNT counters. Reset clears RTCPS.

Table 13-3. RTC Prescaler Divide-by values

RTCLKS[0]	RTCPS															
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	Off	2 ³	2 ⁵	2 ⁶	2 ⁷	2 ⁸	2 ⁹	2 ¹⁰	1	2	2 ²	10	2 ⁴	10 ²	5x10 ²	10 ³
1	Off	2 ¹⁰	2 ¹¹	2 ¹²	2 ¹³	2 ¹⁴	2 ¹⁵	2 ¹⁶	10 ³	2x10 ³	5x10 ³	10 ⁴	2x10 ⁴	5x10 ⁴	10 ⁵	2x10 ⁵

13.3.2 RTC Counter Register (RTCCNT)

RTCCNT is the read-only value of the current RTC count of the 8-bit counter.

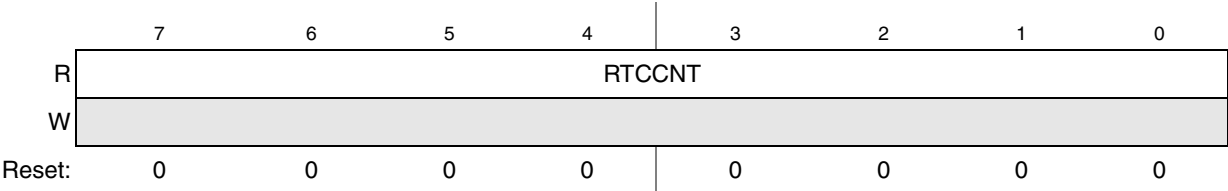


Figure 13-4. RTC Counter Register (RTCCNT)

Table 13-4. RTCCNT Field Descriptions

Field	Description
7:0 RTCCNT	RTC Count. These eight read-only bits contain the current value of the 8-bit counter. Writes have no effect to this register. Reset, writing to RTCMOD, or writing different values to RTCLKS and RTCPS clear the count to 0x00.

13.3.3 RTC Modulo Register (RTCMOD)

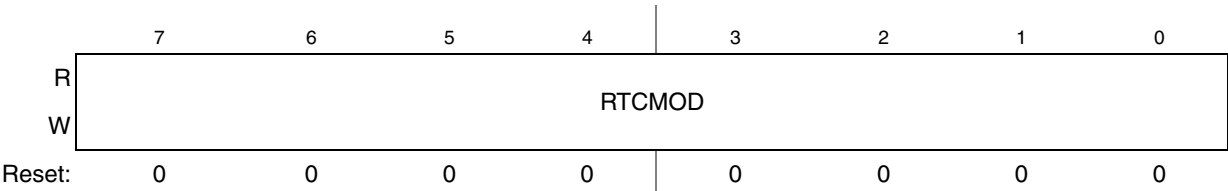


Figure 13-5. RTC Modulo Register (RTCMOD)

Table 13-5. RTCMOD Field Descriptions

Field	Description
7:0 RTCMOD	RTC Modulo. These eight read/write bits contain the modulo value used to reset the count to 0x00 upon a compare match and set the RTIF status bit. A value of 0x00 sets the RTIF bit on each rising edge of the prescaler output. Writing to RTCMOD resets the prescaler and the RTCCNT counters to 0x00. Reset sets the modulo to 0x00.

13.4 Functional Description

The RTC is composed of a main 8-bit up-counter with an 8-bit modulo register, a clock source selector, and a prescaler block with binary-based and decimal-based selectable values. The module also contains software selectable interrupt logic.

After any MCU reset, the counter is stopped and reset to 0x00, the modulus register is set to 0x00, and the prescaler is off. The 1-kHz internal oscillator clock is selected as the default clock source. To start the prescaler, write any value other than zero to the prescaler select bits (RTCPS).

Three clock sources are software selectable: the low power oscillator clock (LPO), the external clock (ERCLK), and the internal clock (IRCLK). The RTC clock select bits (RTCLKS) select the desired clock source. If a different value is written to RTCLKS, the prescaler and RTCCNT counters are reset to 0x00.

RTCPS and the RTCLKS[0] bit select the desired divide-by value. If a different value is written to RTCPS, the prescaler and RTCCNT counters are reset to 0x00. Table 13-6 shows different prescaler period values.

Table 13-6. Prescaler Period

RTCPS	1-kHz Internal Clock (RTCLKS = 00)	1-MHz External Clock (RTCLKS = 01)	32-kHz Internal Clock (RTCLKS = 10)	32-kHz Internal Clock (RTCLKS = 11)
0000	Off	Off	Off	Off
0001	8 ms	1.024 ms	250 μ s	32 ms
0010	32 ms	2.048 ms	1 ms	64 ms
0011	64 ms	4.096 ms	2 ms	128 ms
0100	128 ms	8.192 ms	4 ms	256 ms
0101	256 ms	16.4 ms	8 ms	512 ms
0110	512 ms	32.8 ms	16 ms	1.024 s
0111	1.024 s	65.5 ms	32 ms	2.048 s
1000	1 ms	1 ms	31.25 μ s	31.25 ms
1001	2 ms	2 ms	62.5 μ s	62.5 ms
1010	4 ms	5 ms	125 μ s	156.25 ms
1011	10 ms	10 ms	312.5 μ s	312.5 ms
1100	16 ms	20 ms	0.5 ms	0.625 s
1101	0.1 s	50 ms	3.125 ms	1.5625 s
1110	0.5 s	0.1 s	15.625 ms	3.125 s
1111	1 s	0.2 s	31.25 ms	6.25 s

The RTC modulo register (RTCMOD) allows the compare value to be set to any value from 0x00 to 0xFF. When the counter is active, the counter increments at the selected rate until the count matches the modulo value. When these values match, the counter resets to 0x00 and continues counting. The real-time interrupt flag (RTIF) is set when a match occurs. The flag sets on the transition from the modulo value to 0x00. Writing to RTCMOD resets the prescaler and the RTCCNT counters to 0x00.

The RTC allows for an interrupt to be generated when RTIF is set. To enable the real-time interrupt, set the real-time interrupt enable bit (RTIE) in RTCSC. RTIF is cleared by writing a 1 to RTIF.

13.4.1 RTC Operation Example

This section shows an example of the RTC operation as the counter reaches a matching value from the modulo register.

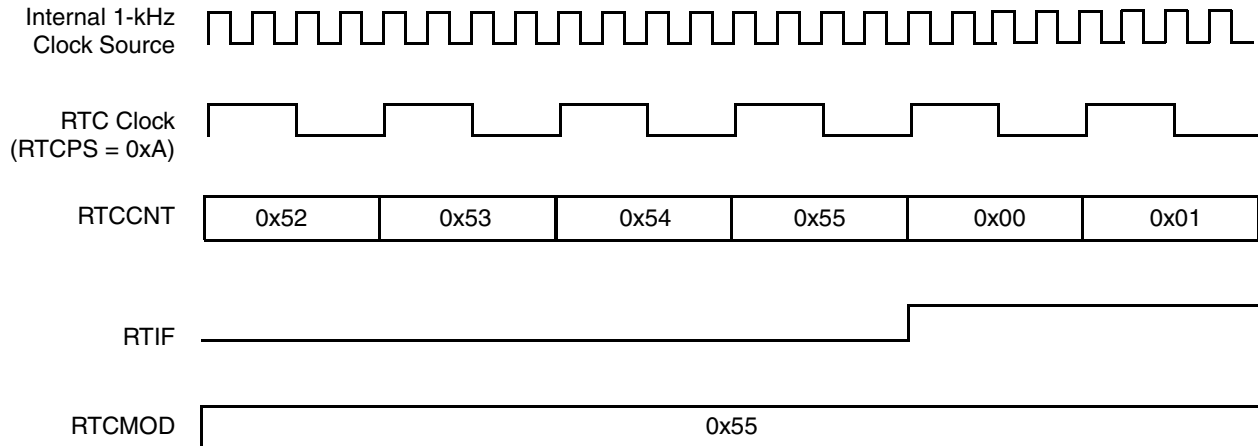


Figure 13-6. RTC Counter Overflow Example

In the example of [Figure 13-6](#), the selected clock source is the 1-kHz internal oscillator clock source. The prescaler (RTCPs) is set to 0xA or divide-by-4. The modulo value in the RTCMOD register is set to 0x55. When the counter, RTCCNT, reaches the modulo value of 0x55, the counter overflows to 0x00 and continues counting. The real-time interrupt flag, RTIF, sets when the counter value changes from 0x55 to 0x00. A real-time interrupt is generated when RTIF is set, if RTIE is set.

13.5 Initialization/Application Information

This section provides example code to give some basic direction to a user on how to initialize and configure the RTC module. The example software is implemented in C language.

The example below shows how to implement time of day with the RTC using the 1-kHz clock source to achieve the lowest possible power consumption. Because the 1-kHz clock source is not as accurate as a crystal, software can be added for any adjustments. For accuracy without adjustments at the expense of additional power consumption, the external clock (ERCLK) or the internal clock (IRCLK) can be selected with appropriate prescaler and modulo values.

```
/* Initialize the elapsed time counters */
Seconds = 0;
Minutes = 0;
Hours = 0;
Days=0;

/* Configure RTC to interrupt every 1 second from 1-kHz clock source */
RTCMOD.byte = 0x00;
RTCSC.byte = 0x1F;

/*****
Function Name : RTC_ISR
Notes : Interrupt service routine for RTC module.
*****/
```

```
#pragma TRAP_PROC
void RTC_ISR(void)
{
    /* Clear the interrupt flag */
    RTCSC.byte = RTCSC.byte | 0x80;
    /* RTC interrupts every 1 Second */
    Seconds++;
    /* 60 seconds in a minute */
    if (Seconds > 59){
        Minutes++;
        Seconds = 0;
    }
    /* 60 minutes in an hour */
    if (Minutes > 59){
        Hours++;
        Minutes = 0;
    }
    /* 24 hours in a day */
    if (Hours > 23){
        Days ++;
        Hours = 0;
    }
}
```


Chapter 14

Serial Communications Interface (S08SCIV4)

14.1 Introduction

[Figure 14-1](#) shows the MC9S08QE8 series block diagram with the SCI highlighted.

14.1.1 SCI Clock Gating

The bus clock to the SCI can be gated on and off using the SCI bit in SCGC1. This bit is set after any reset, which enables the bus clock to this module. To conserve power, the SCI bit can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

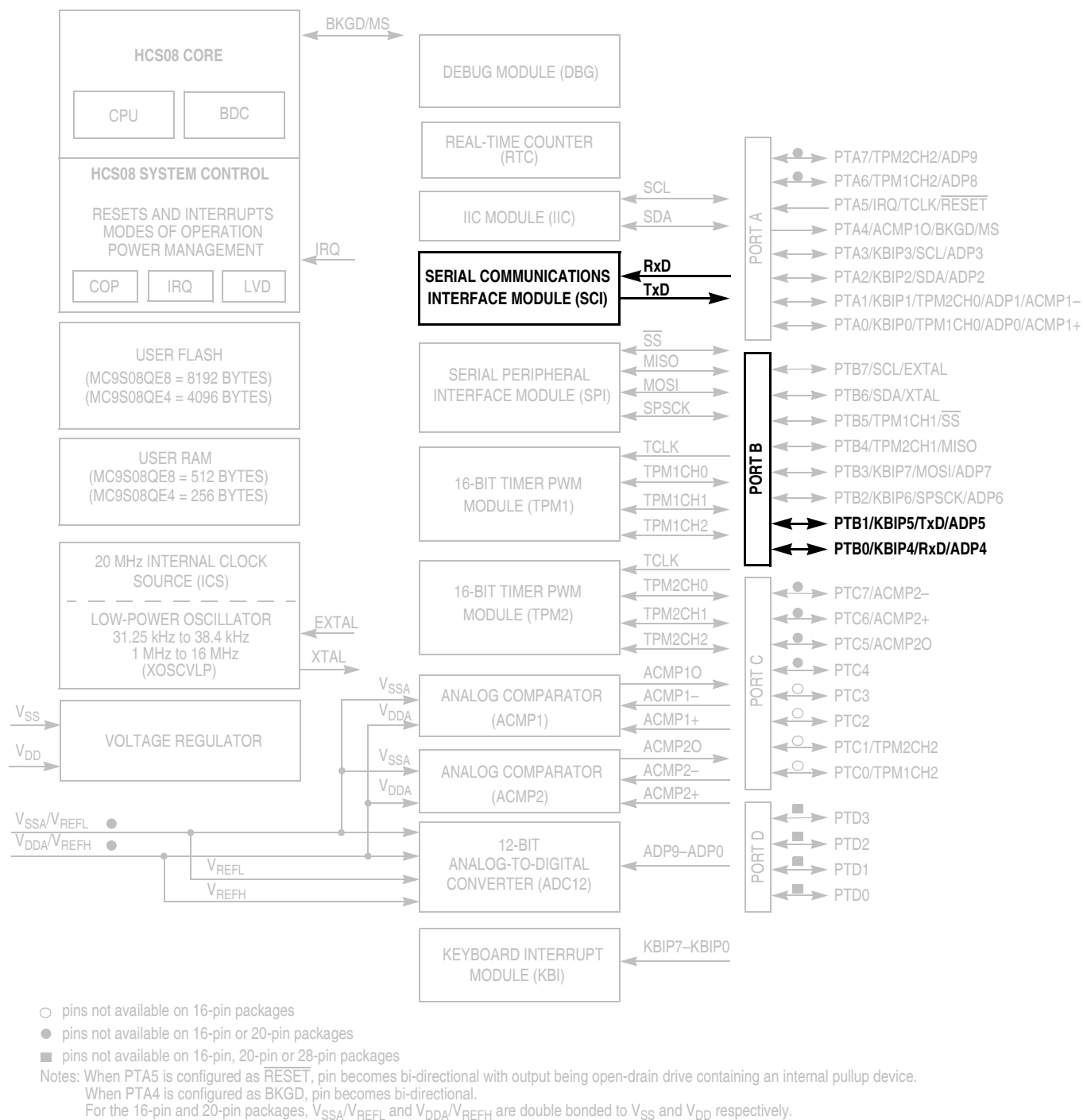


Figure 14-1. MC9S08QE8 Series Block Diagram Highlighting SCI Block and Pins

14.1.2 Features

Features of SCI module include:

- Full-duplex, standard non-return-to-zero (NRZ) format
- Double-buffered transmitter and receiver with separate enables
- Programmable baud rates (13-bit modulo divider)
- Interrupt-driven or polled operation:
 - Transmit data register empty and transmission complete
 - Receive data register full
 - Receive overrun, parity error, framing error, and noise error
 - Idle receiver detect
 - Active edge on receive pin
 - Break detect supporting LIN
- Hardware parity generation and checking
- Programmable 8-bit or 9-bit character length
- Receiver wakeup by idle-line or address-mark
- Optional 13-bit break character generation / 11-bit break character detection
- Independently selectable polarity for transmitter output and receiver input

14.1.3 Modes of Operation

See [Section 14.3, “Functional Description,”](#) For details concerning SCI operation in these modes:

- 8- and 9-bit data modes
- Stop mode operation
- Loop mode
- Single-wire mode

14.1.4 Block Diagram

[Figure 14-2](#) shows the transmitter portion of the SCI.

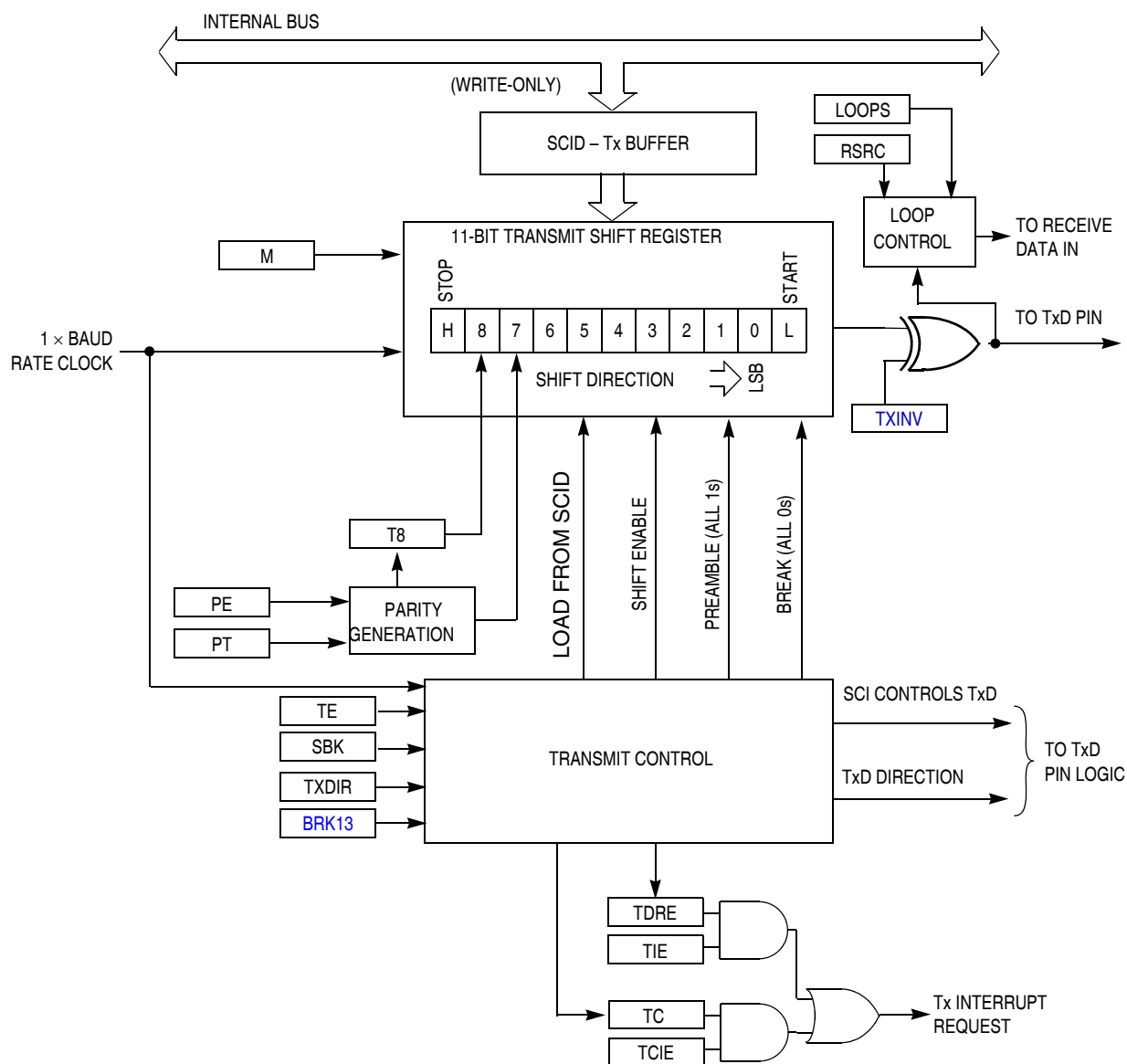


Figure 14-2. SCI Transmitter Block Diagram

Figure 14-3 shows the receiver portion of the SCI.

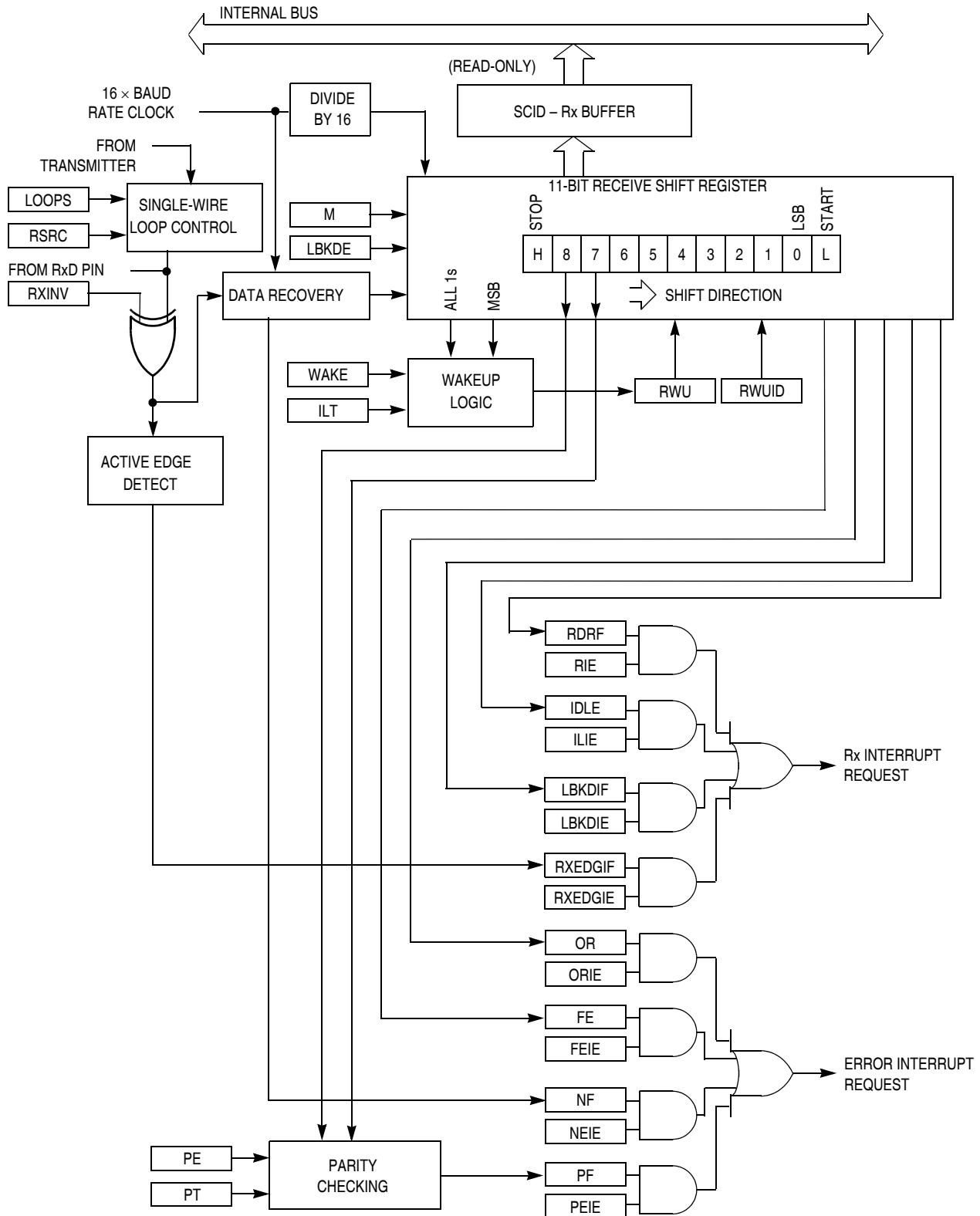


Figure 14-3. SCI Receiver Block Diagram

14.2 Register Definition

The SCI has eight 8-bit registers to control baud rate, select SCI options, report SCI status, and for transmit/receive data.

Refer to the direct-page register summary in the [Memory](#) chapter of this data sheet for the absolute address assignments for all SCI registers. This section refers to registers and control bits only by their names. A Freescale-provided equate or header file is used to translate these names into the appropriate absolute addresses.

14.2.1 SCI Baud Rate Registers (SCIBDH, SCIBDL)

This pair of registers controls the prescale divisor for SCI baud rate generation. To update the 13-bit baud rate setting [SBR12:SBR0], first write to SCIBDH to buffer the high half of the new value and then write to SCIBDL. The working value in SCIBDH does not change until SCIBDL is written.

SCIBDL is reset to a non-zero value, so after reset the baud rate generator remains disabled until the first time the receiver or transmitter is enabled (RE or TE bits in SCIC2 are written to 1).

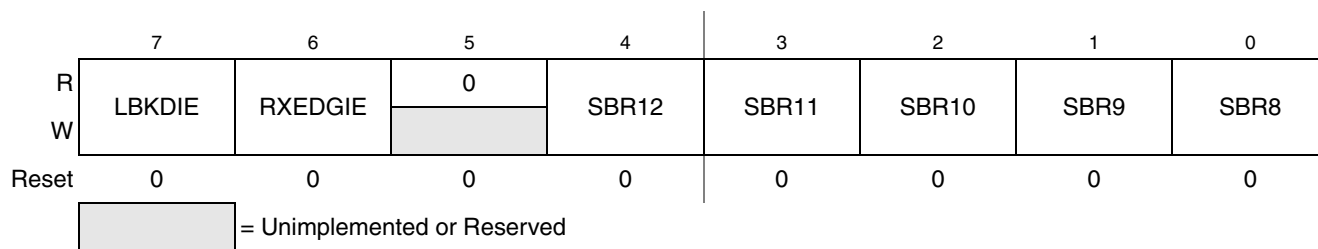


Figure 14-4. SCI Baud Rate Register (SCIBDH)

Table 14-1. SCIBDH Field Descriptions

Field	Description
7 LBKDIE	LIN Break Detect Interrupt Enable (for LBKDIF) 0 Hardware interrupts from LBKDIF disabled (use polling). 1 Hardware interrupt requested when LBKDIF flag is 1.
6 RXEDGIE	RxD Input Active Edge Interrupt Enable (for RXEDGIF) 0 Hardware interrupts from RXEDGIF disabled (use polling). 1 Hardware interrupt requested when RXEDGIF flag is 1.
4:0 SBR[12:8]	Baud Rate Modulo Divisor — The 13 bits in SBR[12:0] are referred to collectively as BR, and they set the modulo divide rate for the SCI baud rate generator. When BR = 0, the SCI baud rate generator is disabled to reduce supply current. When BR = 1 to 8191, the SCI baud rate = $BUSCLK/(16 \times BR)$. See also BR bits in Table 14-2 .

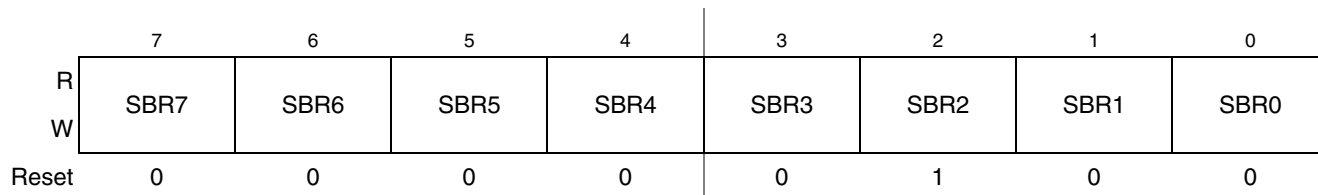


Figure 14-5. SCI Baud Rate Register (SCIBDL)

Table 14-2. SCIBDL Field Descriptions

Field	Description
7:0 SBR[7:0]	Baud Rate Modulo Divisor — These 13 bits in SBR[12:0] are referred to collectively as BR, and they set the modulo divide rate for the SCI baud rate generator. When BR = 0, the SCI baud rate generator is disabled to reduce supply current. When BR = 1 to 8191, the SCI baud rate = BUSCLK/(16×BR). See also BR bits in Table 14-1 .

14.2.2 SCI Control Register 1 (SCIC1)

This read/write register is used to control various optional features of the SCI system.

	7	6	5	4	3	2	1	0
R	LOOPS	SCISWAI	RSRC	M	WAKE	ILT	PE	PT
W								
Reset	0	0	0	0	0	0	0	0

Figure 14-6. SCI Control Register 1 (SCIC1)

Table 14-3. SCIC1 Field Descriptions

Field	Description
7 LOOPS	Loop Mode Select — Selects between loop back modes and normal 2-pin full-duplex modes. When LOOPS = 1, the transmitter output is internally connected to the receiver input. 0 Normal operation — RxD and TxD use separate pins. 1 Loop mode or single-wire mode where transmitter outputs are internally connected to receiver input. (See RSRC bit.) RxD pin is not used by SCI.
6 SCISWAI	SCI Stops in Wait Mode 0 SCI clocks continue to run in wait mode so the SCI can be the source of an interrupt that wakes up the CPU. 1 SCI clocks freeze while CPU is in wait mode.
5 RSRC	Receiver Source Select — This bit has no meaning or effect unless the LOOPS bit is set to 1. When LOOPS = 1, the receiver input is internally connected to the TxD pin and RSRC determines whether this connection is also connected to the transmitter output. 0 Provided LOOPS = 1, RSRC = 0 selects internal loop back mode and the SCI does not use the RxD pins. 1 Single-wire SCI mode where the TxD pin is connected to the transmitter output and receiver input.
4 M	9-Bit or 8-Bit Mode Select 0 Normal — start + 8 data bits (LSB first) + stop. 1 Receiver and transmitter use 9-bit data characters start + 8 data bits (LSB first) + 9th data bit + stop.
3 WAKE	Receiver Wakeup Method Select — Refer to Section 14.3.3.2, “Receiver Wakeup Operation” for more information. 0 Idle-line wakeup. 1 Address-mark wakeup.
2 ILT	Idle Line Type Select — Setting this bit to 1 ensures that the stop bit and logic 1 bits at the end of a character do not count toward the 10 or 11 bit times of logic high level needed by the idle line detection logic. Refer to Section 14.3.3.2.1, “Idle-Line Wakeup” for more information. 0 Idle character bit count starts after start bit. 1 Idle character bit count starts after stop bit.

Table 14-3. SCIC1 Field Descriptions (continued)

Field	Description
1 PE	Parity Enable — Enables hardware parity generation and checking. When parity is enabled, the most significant bit (MSB) of the data character (eighth or ninth data bit) is treated as the parity bit. 0 No hardware parity generation or checking. 1 Parity enabled.
0 PT	Parity Type — Provided parity is enabled (PE = 1), this bit selects even or odd parity. Odd parity means the total number of 1s in the data character, including the parity bit, is odd. Even parity means the total number of 1s in the data character, including the parity bit, is even. 0 Even parity. 1 Odd parity.

14.2.3 SCI Control Register 2 (SCIC2)

This register can be read or written at any time.

	7	6	5	4	3	2	1	0
R	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
W								
Reset	0	0	0	0	0	0	0	0

Figure 14-7. SCI Control Register 2 (SCIC2)**Table 14-4. SCIC2 Field Descriptions**

Field	Description
7 TIE	Transmit Interrupt Enable (for TDRE) 0 Hardware interrupts from TDRE disabled (use polling). 1 Hardware interrupt requested when TDRE flag is 1.
6 TCIE	Transmission Complete Interrupt Enable (for TC) 0 Hardware interrupts from TC disabled (use polling). 1 Hardware interrupt requested when TC flag is 1.
5 RIE	Receiver Interrupt Enable (for RDRF) 0 Hardware interrupts from RDRF disabled (use polling). 1 Hardware interrupt requested when RDRF flag is 1.
4 ILIE	Idle Line Interrupt Enable (for IDLE) 0 Hardware interrupts from IDLE disabled (use polling). 1 Hardware interrupt requested when IDLE flag is 1.
3 TE	Transmitter Enable 0 Transmitter off. 1 Transmitter on. TE must be 1 in order to use the SCI transmitter. When TE = 1, the SCI forces the TxD pin to act as an output for the SCI system. When the SCI is configured for single-wire operation (LOOPS = RSRC = 1), TXDIR controls the direction of traffic on the single SCI communication line (TxD pin). TE also can be used to queue an idle character by writing TE = 0 then TE = 1 while a transmission is in progress. Refer to Section 14.3.2.1, “Send Break and Queued Idle” for more details. When TE is written to 0, the transmitter keeps control of the port TxD pin until any data, queued idle, or queued break character finishes transmitting before allowing the pin to revert to a general-purpose I/O pin.

Table 14-4. SCIC2 Field Descriptions (continued)

Field	Description
2 RE	Receiver Enable — When the SCI receiver is off, the RxD pin reverts to being a general-purpose port I/O pin. If LOOPS = 1 the RxD pin reverts to being a general-purpose I/O pin even if RE = 1. 0 Receiver off. 1 Receiver on.
1 RWU	Receiver Wakeup Control — This bit can be written to 1 to place the SCI receiver in a standby state where it waits for automatic hardware detection of a selected wakeup condition. The wakeup condition is either an idle line between messages (WAKE = 0, idle-line wakeup), or a logic 1 in the most significant data bit in a character (WAKE = 1, address-mark wakeup). Application software sets RWU and (normally) a selected hardware condition automatically clears RWU. Refer to Section 14.3.3.2, “Receiver Wakeup Operation” for more details. 0 Normal SCI receiver operation. 1 SCI receiver in standby waiting for wakeup condition.
0 SBK	Send Break — Writing a 1 and then a 0 to SBK queues a break character in the transmit data stream. Additional break characters of 10 or 11 (13 or 14 if BRK13 = 1) bit times of logic 0 are queued as long as SBK = 1. Depending on the timing of the set and clear of SBK relative to the information currently being transmitted, a second break character may be queued before software clears SBK. Refer to Section 14.3.2.1, “Send Break and Queued Idle” for more details. 0 Normal transmitter operation. 1 Queue break character(s) to be sent.

14.2.4 SCI Status Register 1 (SCIS1)

This register has eight read-only status flags. Writes have no effect. Special software sequences (which do not involve writing to this register) are used to clear these status flags.

	7	6	5	4	3	2	1	0
R	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
W								
Reset	1	1	0	0	0	0	0	0

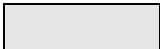
 = Unimplemented or Reserved

Figure 14-8. SCI Status Register 1 (SCIS1)

Table 14-5. SCIS1 Field Descriptions

Field	Description
7 TDRE	<p>Transmit Data Register Empty Flag — TDRE is set out of reset and when a transmit data value transfers from the transmit data buffer to the transmit shifter, leaving room for a new character in the buffer. To clear TDRE, read SCIS1 with TDRE = 1 and then write to the SCI data register (SCID).</p> <p>0 Transmit data register (buffer) full. 1 Transmit data register (buffer) empty.</p>
6 TC	<p>Transmission Complete Flag — TC is set out of reset and when TDRE = 1 and no data, preamble, or break character is being transmitted.</p> <p>0 Transmitter active (sending data, a preamble, or a break). 1 Transmitter idle (transmission activity complete).</p> <p>TC is cleared automatically by reading SCIS1 with TC = 1 and then doing one of the following three things:</p> <ul style="list-style-type: none"> • Write to the SCI data register (SCID) to transmit new data • Queue a preamble by changing TE from 0 to 1 • Queue a break character by writing 1 to SBK in SCIC2
5 RDRF	<p>Receive Data Register Full Flag — RDRF becomes set when a character transfers from the receive shifter into the receive data register (SCID). To clear RDRF, read SCIS1 with RDRF = 1 and then read the SCI data register (SCID).</p> <p>0 Receive data register empty. 1 Receive data register full.</p>
4 IDLE	<p>Idle Line Flag — IDLE is set when the SCI receive line becomes idle for a full character time after a period of activity. When ILT = 0, the receiver starts counting idle bit times after the start bit. So if the receive character is all 1s, these bit times and the stop bit time count toward the full character time of logic high (10 or 11 bit times depending on the M control bit) needed for the receiver to detect an idle line. When ILT = 1, the receiver doesn't start counting idle bit times until after the stop bit. So the stop bit and any logic high bit times at the end of the previous character do not count toward the full character time of logic high needed for the receiver to detect an idle line.</p> <p>To clear IDLE, read SCIS1 with IDLE = 1 and then read the SCI data register (SCID). After IDLE has been cleared, it cannot become set again until after a new character has been received and RDRF has been set. IDLE will get set only once even if the receive line remains idle for an extended period.</p> <p>0 No idle line detected. 1 Idle line was detected.</p>
3 OR	<p>Receiver Overrun Flag — OR is set when a new serial character is ready to be transferred to the receive data register (buffer), but the previously received character has not been read from SCID yet. In this case, the new character (and all associated error information) is lost because there is no room to move it into SCID. To clear OR, read SCIS1 with OR = 1 and then read the SCI data register (SCID).</p> <p>0 No overrun. 1 Receive overrun (new SCI data lost).</p>
2 NF	<p>Noise Flag — The advanced sampling technique used in the receiver takes seven samples during the start bit and three samples in each data bit and the stop bit. If any of these samples disagrees with the rest of the samples within any bit time in the frame, the flag NF will be set at the same time as the flag RDRF gets set for the character. To clear NF, read SCIS1 and then read the SCI data register (SCID).</p> <p>0 No noise detected. 1 Noise detected in the received character in SCID.</p>

Table 14-5. SCIS1 Field Descriptions (continued)

Field	Description
1 FE	Framing Error Flag — FE is set at the same time as RDRF when the receiver detects a logic 0 where the stop bit was expected. This suggests the receiver was not properly aligned to a character frame. To clear FE, read SCIS1 with FE = 1 and then read the SCI data register (SCID). 0 No framing error detected. This does not guarantee the framing is correct. 1 Framing error.
0 PF	Parity Error Flag — PF is set at the same time as RDRF when parity is enabled (PE = 1) and the parity bit in the received character does not agree with the expected parity value. To clear PF, read SCIS1 and then read the SCI data register (SCID). 0 No parity error. 1 Parity error.

14.2.5 SCI Status Register 2 (SCIS2)

This register has one read-only status flag.

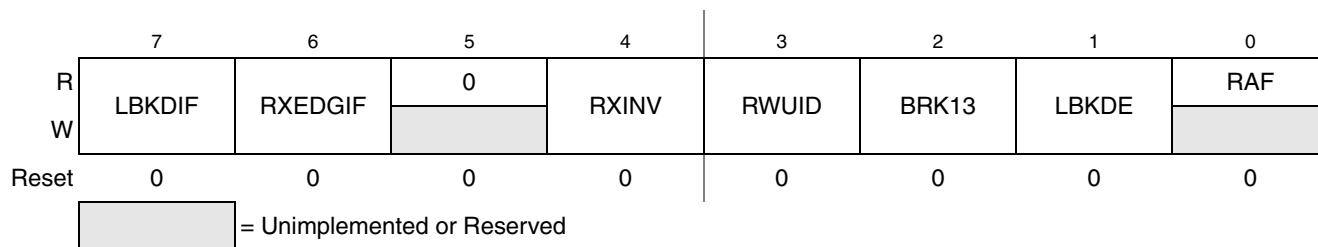


Figure 14-9. SCI Status Register 2 (SCIS2)

Table 14-6. SCIS2 Field Descriptions

Field	Description
7 LBKDIF	LIN Break Detect Interrupt Flag — LBKDIF is set when the LIN break detect circuitry is enabled and a LIN break character is detected. LBKDIF is cleared by writing a “1” to it. 0 No LIN break character has been detected. 1 LIN break character has been detected.
6 RXEDGIF	RxD Pin Active Edge Interrupt Flag — RXEDGIF is set when an active edge (falling if RXINV = 0, rising if RXINV=1) on the RxD pin occurs. RXEDGIF is cleared by writing a “1” to it. 0 No active edge on the receive pin has occurred. 1 An active edge on the receive pin has occurred.
4 RXINV ¹	Receive Data Inversion — Setting this bit reverses the polarity of the received data input. 0 Receive data not inverted 1 Receive data inverted
3 RWUID	Receive Wake Up Idle Detect — RWUID controls whether the idle character that wakes up the receiver sets the IDLE bit. 0 During receive standby state (RWU = 1), the IDLE bit does not get set upon detection of an idle character. 1 During receive standby state (RWU = 1), the IDLE bit gets set upon detection of an idle character.
2 BRK13	Break Character Generation Length — BRK13 is used to select a longer transmitted break character length. Detection of a framing error is not affected by the state of this bit. 0 Break character is transmitted with length of 10 bit times (11 if M = 1) 1 Break character is transmitted with length of 13 bit times (14 if M = 1)

Table 14-6. SCIS2 Field Descriptions (continued)

Field	Description
1 LBKDE	LIN Break Detection Enable —LBKDE is used to select a longer break character detection length. While LBKDE is set, framing error (FE) and receive data register full (RDRF) flags are prevented from setting. 0 Break character is detected at length of 10 bit times (11 if M = 1). 1 Break character is detected at length of 11 bit times (12 if M = 1).
0 RAF	Receiver Active Flag — RAF is set when the SCI receiver detects the beginning of a valid start bit, and RAF is cleared automatically when the receiver detects an idle line. This status flag can be used to check whether an SCI character is being received before instructing the MCU to go to stop mode. 0 SCI receiver idle waiting for a start bit. 1 SCI receiver active (RxD input not idle).

¹ Setting RXINV inverts the RxD input for all cases: data bits, start and stop bits, break, and idle.

When using an internal oscillator in a LIN system, it is necessary to raise the break detection threshold by one bit time. Under the worst case timing conditions allowed in LIN, it is possible that a 0x00 data character can appear to be 10.26 bit times long at a slave which is running 14% faster than the master. This would trigger normal break detection circuitry which is designed to detect a 10 bit break symbol. When the LBKDE bit is set, framing errors are inhibited and the break detection threshold changes from 10 bits to 11 bits, preventing false detection of a 0x00 data character as a LIN break symbol.

14.2.6 SCI Control Register 3 (SCIC3)

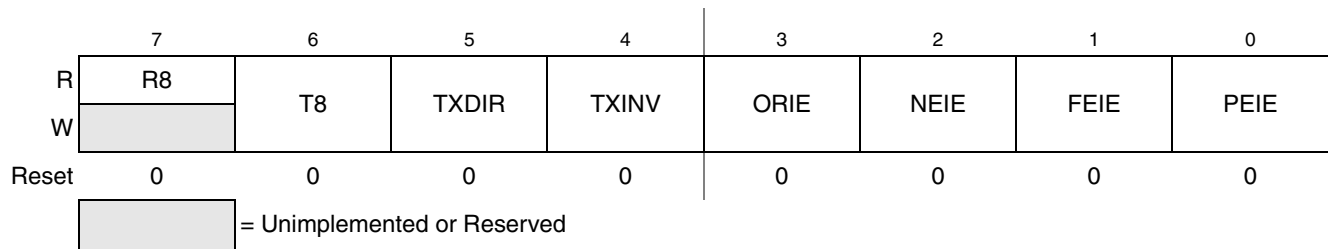


Figure 14-10. SCI Control Register 3 (SCIC3)

Table 14-7. SCIC3 Field Descriptions

Field	Description
7 R8	Ninth Data Bit for Receiver — When the SCI is configured for 9-bit data (M = 1), R8 can be thought of as a ninth receive data bit to the left of the MSB of the buffered data in the SCID register. When reading 9-bit data, read R8 before reading SCID because reading SCID completes automatic flag clearing sequences which could allow R8 and SCID to be overwritten with new data.
6 T8	Ninth Data Bit for Transmitter — When the SCI is configured for 9-bit data (M = 1), T8 may be thought of as a ninth transmit data bit to the left of the MSB of the data in the SCID register. When writing 9-bit data, the entire 9-bit value is transferred to the SCI shift register after SCID is written so T8 should be written (if it needs to change from its previous value) before SCID is written. If T8 does not need to change in the new value (such as when it is used to generate mark or space parity), it need not be written each time SCID is written.
5 TXDIR	TxD Pin Direction in Single-Wire Mode — When the SCI is configured for single-wire half-duplex operation (LOOPS = RSRC = 1), this bit determines the direction of data at the TxD pin. 0 TxD pin is an input in single-wire mode. 1 TxD pin is an output in single-wire mode.

Table 14-7. SCIC3 Field Descriptions (continued)

Field	Description
4 TXINV ¹	Transmit Data Inversion — Setting this bit reverses the polarity of the transmitted data output. 0 Transmit data not inverted 1 Transmit data inverted
3 ORIE	Overrun Interrupt Enable — This bit enables the overrun flag (OR) to generate hardware interrupt requests. 0 OR interrupts disabled (use polling). 1 Hardware interrupt requested when OR = 1.
2 NEIE	Noise Error Interrupt Enable — This bit enables the noise flag (NF) to generate hardware interrupt requests. 0 NF interrupts disabled (use polling). 1 Hardware interrupt requested when NF = 1.
1 FEIE	Framing Error Interrupt Enable — This bit enables the framing error flag (FE) to generate hardware interrupt requests. 0 FE interrupts disabled (use polling). 1 Hardware interrupt requested when FE = 1.
0 PEIE	Parity Error Interrupt Enable — This bit enables the parity error flag (PF) to generate hardware interrupt requests. 0 PF interrupts disabled (use polling). 1 Hardware interrupt requested when PF = 1.

¹ Setting TXINV inverts the TxD output for all cases: data bits, start and stop bits, break, and idle.

14.2.7 SCI Data Register (SCID)

This register is actually two separate registers. Reads return the contents of the read-only receive data buffer and writes go to the write-only transmit data buffer. Reads and writes of this register are also involved in the automatic flag clearing mechanisms for the SCI status flags.

	7	6	5	4	3	2	1	0
R	R7	R6	R5	R4	R3	R2	R1	R0
W	T7	T6	T5	T4	T3	T2	T1	T0
Reset	0	0	0	0	0	0	0	0

Figure 14-11. SCI Data Register (SCID)

14.3 Functional Description

The SCI allows full-duplex, asynchronous, NRZ serial communication among the MCU and remote devices, including other MCUs. The SCI comprises a baud rate generator, transmitter, and receiver block. The transmitter and receiver operate independently, although they use the same baud rate generator. During normal operation, the MCU monitors the status of the SCI, writes the data to be transmitted, and processes received data. The following describes each of the blocks of the SCI.

14.3.1 Baud Rate Generation

As shown in [Figure 14-12](#), the clock source for the SCI baud rate generator is the bus-rate clock.

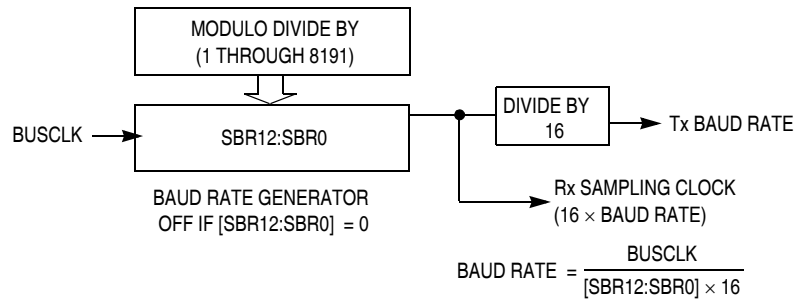


Figure 14-12. SCI Baud Rate Generation

SCI communications require the transmitter and receiver (which typically derive baud rates from independent clock sources) to use the same baud rate. Allowed tolerance on this baud frequency depends on the details of how the receiver synchronizes to the leading edge of the start bit and how bit sampling is performed.

The MCU resynchronizes to bit boundaries on every high-to-low transition, but in the worst case, there are no such transitions in the full 10- or 11-bit time character frame so any mismatch in baud rate is accumulated for the whole character time. For a Freescale Semiconductor SCI system whose bus frequency is driven by a crystal, the allowed baud rate mismatch is about ± 4.5 percent for 8-bit data format and about ± 4 percent for 9-bit data format. Although baud rate modulo divider settings do not always produce baud rates that exactly match standard rates, it is normally possible to get within a few percent, which is acceptable for reliable communications.

14.3.2 Transmitter Functional Description

This section describes the overall block diagram for the SCI transmitter, as well as specialized functions for sending break and idle characters. The transmitter block diagram is shown in [Figure 14-2](#).

The transmitter output (TxD) idle state defaults to logic high (TXINV = 0 following reset). The transmitter output is inverted by setting TXINV = 1. The transmitter is enabled by setting the TE bit in SCIC2. This queues a preamble character that is one full character frame of the idle state. The transmitter then remains idle until data is available in the transmit data buffer. Programs store data into the transmit data buffer by writing to the SCI data register (SCID).

The central element of the SCI transmitter is the transmit shift register that is either 10 or 11 bits long depending on the setting in the M control bit. For the remainder of this section, we will assume M = 0, selecting the normal 8-bit data mode. In 8-bit data mode, the shift register holds a start bit, eight data bits, and a stop bit. When the transmit shift register is available for a new SCI character, the value waiting in the transmit data register is transferred to the shift register (synchronized with the baud rate clock) and the transmit data register empty (TDRE) status flag is set to indicate another character may be written to the transmit data buffer at SCID.

If no new character is waiting in the transmit data buffer after a stop bit is shifted out the TxD pin, the transmitter sets the transmit complete flag and enters an idle mode, with TxD high, waiting for more characters to transmit.

Writing 0 to TE does not immediately release the pin to be a general-purpose I/O pin. Any transmit activity that is in progress must first be completed. This includes data characters in progress, queued idle characters, and queued break characters.

14.3.2.1 Send Break and Queued Idle

The SBK control bit in SCIC2 is used to send break characters which were originally used to gain the attention of old teletype receivers. Break characters are a full character time of logic 0 (10 bit times including the start and stop bits). A longer break of 13 bit times can be enabled by setting BRK13 = 1. Normally, a program would wait for TDRE to become set to indicate the last character of a message has moved to the transmit shifter, then write 1 and then write 0 to the SBK bit. This action queues a break character to be sent as soon as the shifter is available. If SBK is still 1 when the queued break moves into the shifter (synchronized to the baud rate clock), an additional break character is queued. If the receiving device is another Freescale Semiconductor SCI, the break characters will be received as 0s in all eight data bits and a framing error (FE = 1) occurs.

When idle-line wakeup is used, a full character time of idle (logic 1) is needed between messages to wake up any sleeping receivers. Normally, a program would wait for TDRE to become set to indicate the last character of a message has moved to the transmit shifter, then write 0 and then write 1 to the TE bit. This action queues an idle character to be sent as soon as the shifter is available. As long as the character in the shifter does not finish while TE = 0, the SCI transmitter never actually releases control of the TxD pin. If there is a possibility of the shifter finishing while TE = 0, set the general-purpose I/O controls so the pin that is shared with TxD is an output driving a logic 1. This ensures that the TxD line will look like a normal idle line even if the SCI loses control of the port pin between writing 0 and then 1 to TE.

The length of the break character is affected by the BRK13 and M bits as shown below.

Table 14-8. Break Character Length

BRK13	M	Break Character Length
0	0	10 bit times
0	1	11 bit times
1	0	13 bit times
1	1	14 bit times

14.3.3 Receiver Functional Description

In this section, the receiver block diagram ([Figure 14-3](#)) is used as a guide for the overall receiver functional description. Next, the data sampling technique used to reconstruct receiver data is described in more detail. Finally, two variations of the receiver wakeup function are explained.

The receiver input is inverted by setting RXINV = 1. The receiver is enabled by setting the RE bit in SCIC2. Character frames consist of a start bit of logic 0, eight (or nine) data bits (LSB first), and a stop bit of logic 1. For information about 9-bit data mode, refer to [Section 14.3.5.1, “8- and 9-Bit Data Modes.”](#) For the remainder of this discussion, we assume the SCI is configured for normal 8-bit data mode.

After receiving the stop bit into the receive shifter, and provided the receive data register is not already full, the data character is transferred to the receive data register and the receive data register full (RDRF)

status flag is set. If RDRF was already set indicating the receive data register (buffer) was already full, the overrun (OR) status flag is set and the new data is lost. Because the SCI receiver is double-buffered, the program has one full character time after RDRF is set before the data in the receive data buffer must be read to avoid a receiver overrun.

When a program detects that the receive data register is full ($RDRF = 1$), it gets the data from the receive data register by reading SCID. The RDRF flag is cleared automatically by a 2-step sequence which is normally satisfied in the course of the user's program that handles receive data. Refer to [Section 14.3.4, "Interrupts and Status Flags"](#) for more details about flag clearing.

14.3.3.1 Data Sampling Technique

The SCI receiver uses a $16\times$ baud rate clock for sampling. The receiver starts by taking logic level samples at 16 times the baud rate to search for a falling edge on the RxD serial data input pin. A falling edge is defined as a logic 0 sample after three consecutive logic 1 samples. The $16\times$ baud rate clock is used to divide the bit time into 16 segments labeled RT1 through RT16. When a falling edge is located, three more samples are taken at RT3, RT5, and RT7 to make sure this was a real start bit and not merely noise. If at least two of these three samples are 0, the receiver assumes it is synchronized to a receive character.

The receiver then samples each bit time, including the start and stop bits, at RT8, RT9, and RT10 to determine the logic level for that bit. The logic level is interpreted to be that of the majority of the samples taken during the bit time. In the case of the start bit, the bit is assumed to be 0 if at least two of the samples at RT3, RT5, and RT7 are 0 even if one or all of the samples taken at RT8, RT9, and RT10 are 1s. If any sample in any bit time (including the start and stop bits) in a character frame fails to agree with the logic level for that bit, the noise flag (NF) will be set when the received character is transferred to the receive data buffer.

The falling edge detection logic continuously looks for falling edges, and if an edge is detected, the sample clock is resynchronized to bit times. This improves the reliability of the receiver in the presence of noise or mismatched baud rates. It does not improve worst case analysis because some characters do not have any extra falling edges anywhere in the character frame.

In the case of a framing error, provided the received character was not a break character, the sampling logic that searches for a falling edge is filled with three logic 1 samples so that a new start bit can be detected almost immediately.

In the case of a framing error, the receiver is inhibited from receiving any new characters until the framing error flag is cleared. The receive shift register continues to function, but a complete character cannot transfer to the receive data buffer if FE is still set.

14.3.3.2 Receiver Wakeup Operation

Receiver wakeup is a hardware mechanism that allows an SCI receiver to ignore the characters in a message that is intended for a different SCI receiver. In such a system, all receivers evaluate the first character(s) of each message, and as soon as they determine the message is intended for a different receiver, they write logic 1 to the receiver wake up (RWU) control bit in SCIC2. When RWU bit is set, the status flags associated with the receiver (with the exception of the idle bit, IDLE, when RWUID bit is set) are inhibited from setting, thus eliminating the software overhead for handling the unimportant message

characters. At the end of a message, or at the beginning of the next message, all receivers automatically force RWU to 0 so all receivers wake up in time to look at the first character(s) of the next message.

14.3.3.2.1 Idle-Line Wakeup

When WAKE = 0, the receiver is configured for idle-line wakeup. In this mode, RWU is cleared automatically when the receiver detects a full character time of the idle-line level. The M control bit selects 8-bit or 9-bit data mode that determines how many bit times of idle are needed to constitute a full character time (10 or 11 bit times because of the start and stop bits).

When RWU is one and RWUID is zero, the idle condition that wakes up the receiver does not set the IDLE flag. The receiver wakes up and waits for the first data character of the next message which will set the RDRF flag and generate an interrupt if enabled. When RWUID is one, any idle condition sets the IDLE flag and generates an interrupt if enabled, regardless of whether RWU is zero or one.

The idle-line type (ILT) control bit selects one of two ways to detect an idle line. When ILT = 0, the idle bit counter starts after the start bit so the stop bit and any logic 1s at the end of a character count toward the full character time of idle. When ILT = 1, the idle bit counter does not start until after a stop bit time, so the idle detection is not affected by the data in the last character of the previous message.

14.3.3.2.2 Address-Mark Wakeup

When WAKE = 1, the receiver is configured for address-mark wakeup. In this mode, RWU is cleared automatically when the receiver detects a logic 1 in the most significant bit of a received character (eighth bit in M = 0 mode and ninth bit in M = 1 mode).

Address-mark wakeup allows messages to contain idle characters but requires that the MSB be reserved for use in address frames. The logic 1 MSB of an address frame clears the RWU bit before the stop bit is received and sets the RDRF flag. In this case the character with the MSB set is received even though the receiver was sleeping during most of this character time.

14.3.4 Interrupts and Status Flags

The SCI system has three separate interrupt vectors to reduce the amount of software needed to isolate the cause of the interrupt. One interrupt vector is associated with the transmitter for TDRE and TC events. Another interrupt vector is associated with the receiver for RDRF, IDLE, RXEDGIF and LBKDIF events, and a third vector is used for OR, NF, FE, and PF error conditions. Each of these ten interrupt sources can be separately masked by local interrupt enable masks. The flags can still be polled by software when the local masks are cleared to disable generation of hardware interrupt requests.

The SCI transmitter has two status flags that optionally can generate hardware interrupt requests. Transmit data register empty (TDRE) indicates when there is room in the transmit data buffer to write another transmit character to SCID. If the transmit interrupt enable (TIE) bit is set, a hardware interrupt will be requested whenever TDRE = 1. Transmit complete (TC) indicates that the transmitter is finished transmitting all data, preamble, and break characters and is idle with TxD at the inactive level. This flag is often used in systems with modems to determine when it is safe to turn off the modem. If the transmit complete interrupt enable (TCIE) bit is set, a hardware interrupt will be requested whenever TC = 1.

Instead of hardware interrupts, software polling may be used to monitor the TDRE and TC status flags if the corresponding TIE or TCIE local interrupt masks are 0s.

When a program detects that the receive data register is full ($RDRF = 1$), it gets the data from the receive data register by reading SCID. The RDRF flag is cleared by reading SCIS1 while $RDRF = 1$ and then reading SCID.

When polling is used, this sequence is naturally satisfied in the normal course of the user program. If hardware interrupts are used, SCIS1 must be read in the interrupt service routine (ISR). Normally, this is done in the ISR anyway to check for receive errors, so the sequence is automatically satisfied.

The IDLE status flag includes logic that prevents it from getting set repeatedly when the RxD line remains idle for an extended period of time. IDLE is cleared by reading SCIS1 while $IDLE = 1$ and then reading SCID. After IDLE has been cleared, it cannot become set again until the receiver has received at least one new character and has set RDRF.

If the associated error was detected in the received character that caused RDRF to be set, the error flags — noise flag (NF), framing error (FE), and parity error flag (PF) — get set at the same time as RDRF. These flags are not set in overrun cases.

If RDRF was already set when a new character is ready to be transferred from the receive shifter to the receive data buffer, the overrun (OR) flag gets set instead the data along with any associated NF, FE, or PF condition is lost.

At any time, an active edge on the RxD serial data input pin causes the RXEDGIF flag to set. The RXEDGIF flag is cleared by writing a “1” to it. This function does depend on the receiver being enabled ($RE = 1$).

14.3.5 Additional SCI Functions

The following sections describe additional SCI functions.

14.3.5.1 8- and 9-Bit Data Modes

The SCI system (transmitter and receiver) can be configured to operate in 9-bit data mode by setting the M control bit in SCIC1. In 9-bit mode, there is a ninth data bit to the left of the MSB of the SCI data register. For the transmit data buffer, this bit is stored in T8 in SCIC3. For the receiver, the ninth bit is held in R8 in SCIC3.

For coherent writes to the transmit data buffer, write to the T8 bit before writing to SCID.

If the bit value to be transmitted as the ninth bit of a new character is the same as for the previous character, it is not necessary to write to T8 again. When data is transferred from the transmit data buffer to the transmit shifter, the value in T8 is copied at the same time data is transferred from SCID to the shifter.

9-bit data mode typically is used in conjunction with parity to allow eight bits of data plus the parity in the ninth bit. Or it is used with address-mark wakeup so the ninth data bit can serve as the wakeup bit. In custom protocols, the ninth bit can also serve as a software-controlled marker.

14.3.5.2 Stop Mode Operation

During all stop modes, clocks to the SCI module are halted.

In stop1 and stop2 modes, all SCI register data is lost and must be re-initialized upon recovery from these two stop modes. No SCI module registers are affected in stop3 mode.

The receive input active edge detect circuit is still active in stop3 mode, but not in stop2. . An active edge on the receive input brings the CPU out of stop3 mode if the interrupt is not masked (RXEDGIE = 1).

Note, because the clocks are halted, the SCI module will resume operation upon exit from stop (only in stop3 mode). Software should ensure stop mode is not entered while there is a character being transmitted out of or received into the SCI module.

14.3.5.3 Loop Mode

When LOOPS = 1, the RSRC bit in the same register chooses between loop mode (RSRC = 0) or single-wire mode (RSRC = 1). Loop mode is sometimes used to check software, independent of connections in the external system, to help isolate system problems. In this mode, the transmitter output is internally connected to the receiver input and the RxD pin is not used by the SCI, so it reverts to a general-purpose port I/O pin.

14.3.5.4 Single-Wire Operation

When LOOPS = 1, the RSRC bit in the same register chooses between loop mode (RSRC = 0) or single-wire mode (RSRC = 1). Single-wire mode is used to implement a half-duplex serial connection. The receiver is internally connected to the transmitter output and to the TxD pin. The RxD pin is not used and reverts to a general-purpose port I/O pin.

In single-wire mode, the TXDIR bit in SCIC3 controls the direction of serial data on the TxD pin. When TXDIR = 0, the TxD pin is an input to the SCI receiver and the transmitter is temporarily disconnected from the TxD pin so an external device can send serial data to the receiver. When TXDIR = 1, the TxD pin is an output driven by the transmitter. In single-wire mode, the internal loop back connection from the transmitter to the receiver causes the receiver to receive characters that are sent out by the transmitter.

Chapter 15

Serial Peripheral Interface (S08SPIV3)

15.1 Introduction

[Figure 15-1](#) shows the MC9S08QE8 series block diagram with the SPI highlighted.

NOTE

This MCU does not have stop1 mode, so ignore references to stop1 in this chapter.

15.1.1 SPI Clock Gating

The bus clock to the SPI can be gated on and off using the SPI bit in SCGC2. These bits are set after any reset, which enables the bus clock to this module. To conserve power, these bits can be cleared to disable the clock to this module when not in use. See [Section 5.7, “Peripheral Clock Gating,”](#) for details.

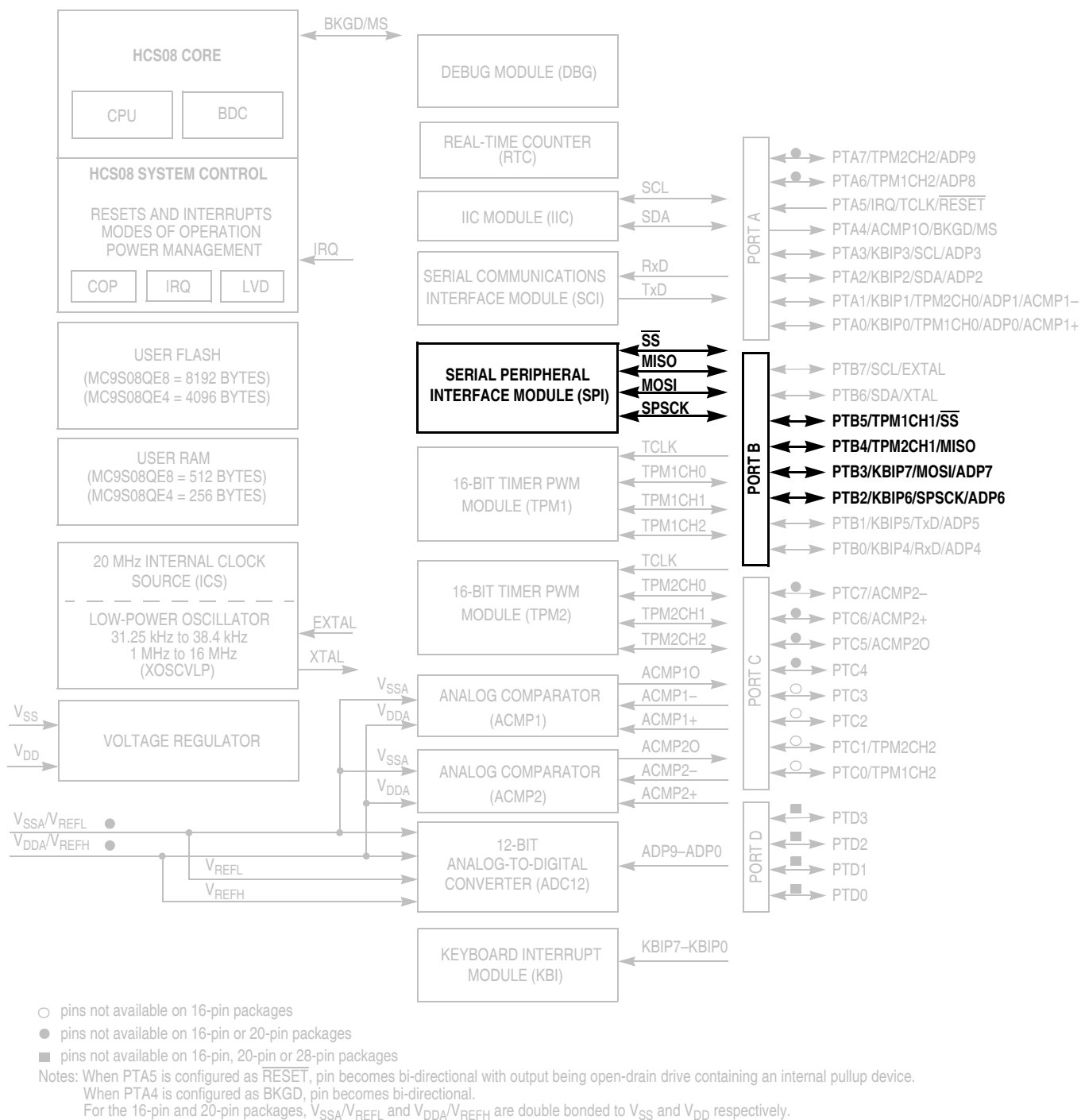


Figure 15-1. MC9S08QE8 Series Block Diagram Highlighting SPI Block and Pins

15.1.2 Features

Features of the SPI module include:

- Master or slave mode operation
- Full-duplex or single-wire bidirectional option
- Programmable transmit bit rate
- Double-buffered transmit and receive
- Serial clock phase and polarity options
- Slave select output
- Selectable MSB-first or LSB-first shifting

15.1.3 Block Diagrams

This section includes block diagrams showing SPI system connections, the internal organization of the SPI module, and the SPI clock dividers that control the master mode bit rate.

15.1.3.1 SPI System Block Diagram

Figure 15-2 shows the SPI modules of two MCUs connected in a master-slave arrangement. The master device initiates all SPI data transfers. During a transfer, the master shifts data out (on the MOSI pin) to the slave while simultaneously shifting data in (on the MISO pin) from the slave. The transfer effectively exchanges the data that was in the SPI shift registers of the two SPI systems. The SPSCCK signal is a clock output from the master and an input to the slave. The slave device must be selected by a low level on the slave select input (\overline{SS} pin). In this system, the master device has configured its \overline{SS} pin as an optional slave select output.

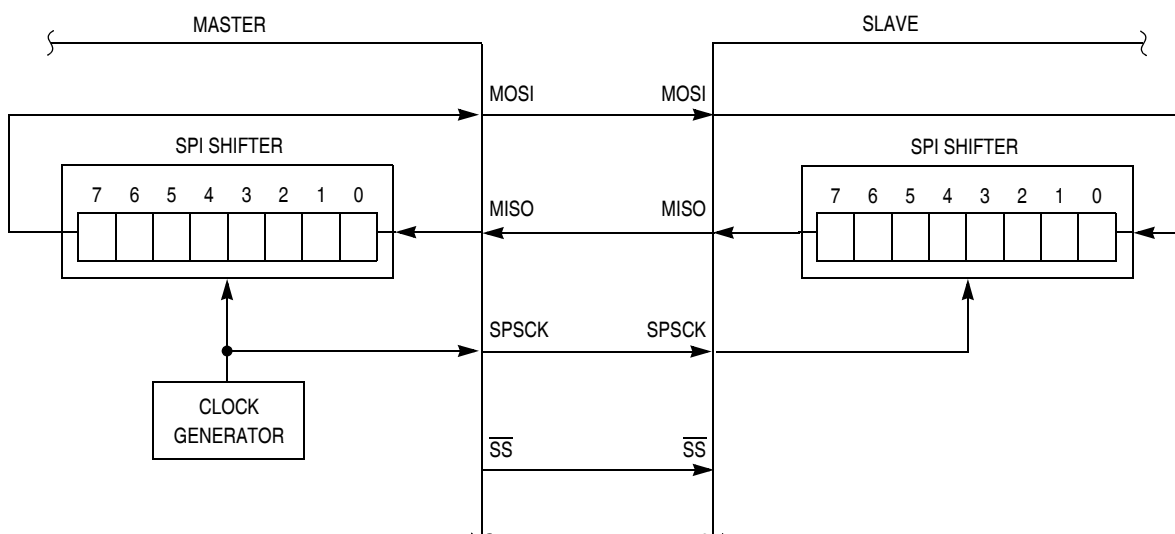


Figure 15-2. SPI System Connections

The most common uses of the SPI system include connecting simple shift registers for adding input or output ports or connecting small peripheral devices such as serial A/D or D/A converters. Although [Figure 15-2](#) shows a system where data is exchanged between two MCUs, many practical systems involve simpler connections where data is unidirectionally transferred from the master MCU to a slave or from a slave to the master MCU.

15.1.3.2 SPI Module Block Diagram

[Figure 15-3](#) is a block diagram of the SPI module. The central element of the SPI is the SPI shift register. Data is written to the double-buffered transmitter (write to SPID) and gets transferred to the SPI shift register at the start of a data transfer. After shifting in a byte of data, the data is transferred into the double-buffered receiver where it can be read (read from SPID). Pin multiplexing logic controls connections between MCU pins and the SPI module.

When the SPI is configured as a master, the clock output is routed to the SPSCCK pin, the shifter output is routed to MOSI, and the shifter input is routed from the MISO pin.

When the SPI is configured as a slave, the SPSCCK pin is routed to the clock input of the SPI, the shifter output is routed to MISO, and the shifter input is routed from the MOSI pin.

In the external SPI system, simply connect all SPSCCK pins to each other, all MISO pins together, and all MOSI pins together. Peripheral devices often use slightly different names for these pins.



15.1.4 SPI Baud Rate Generation

As shown in [Figure 15-4](#), the clock source for the SPI baud rate generator is the bus clock. The three prescale bits (SPPR2:SPPR1:SPPR0) choose a prescale divisor of 1, 2, 3, 4, 5, 6, 7, or 8. The three rate select bits (SPR3:SPR2:SPR1:SPR0) divide the output of the prescaler stage by 2, 4, 8, 16, 32, 64, 128, 256, or 512 to get the internal SPI master mode bit-rate clock.

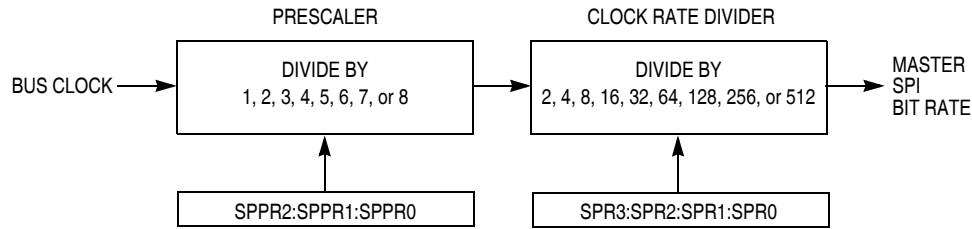


Figure 15-4. SPI Baud Rate Generation

15.2 External Signal Description

The SPI optionally shares four port pins. The function of these pins depends on the settings of SPI control bits. When the SPI is disabled ($SPE = 0$), these four pins revert to being general-purpose port I/O pins that are not controlled by the SPI.

15.2.1 SPCK — SPI Serial Clock

When the SPI is enabled as a slave, this pin is the serial clock input. When the SPI is enabled as a master, this pin is the serial clock output.

15.2.2 MOSI — Master Data Out, Slave Data In

When the SPI is enabled as a master and SPI pin control zero ($SPC0$) is 0 (not bidirectional mode), this pin is the serial data output. When the SPI is enabled as a slave and $SPC0 = 0$, this pin is the serial data input. If $SPC0 = 1$ to select single-wire bidirectional mode, and master mode is selected, this pin becomes the bidirectional data I/O pin (MOMI). Also, the bidirectional mode output enable bit determines whether the pin acts as an input ($BIDIROE = 0$) or an output ($BIDIROE = 1$). If $SPC0 = 1$ and slave mode is selected, this pin is not used by the SPI and reverts to being a general-purpose port I/O pin.

15.2.3 MISO — Master Data In, Slave Data Out

When the SPI is enabled as a master and SPI pin control zero ($SPC0$) is 0 (not bidirectional mode), this pin is the serial data input. When the SPI is enabled as a slave and $SPC0 = 0$, this pin is the serial data output. If $SPC0 = 1$ to select single-wire bidirectional mode, and slave mode is selected, this pin becomes the bidirectional data I/O pin (SISO) and the bidirectional mode output enable bit determines whether the pin acts as an input ($BIDIROE = 0$) or an output ($BIDIROE = 1$). If $SPC0 = 1$ and master mode is selected, this pin is not used by the SPI and reverts to being a general-purpose port I/O pin.

15.2.4 \overline{SS} — Slave Select

When the SPI is enabled as a slave, this pin is the low-true slave select input. When the SPI is enabled as a master and mode fault enable is off ($MODFEN = 0$), this pin is not used by the SPI and reverts to being a general-purpose port I/O pin. When the SPI is enabled as a master and $MODFEN = 1$, the slave select output enable bit determines whether this pin acts as the mode fault input ($SSOE = 0$) or as the slave select output ($SSOE = 1$).

15.3 Modes of Operation

15.3.1 SPI in Stop Modes

The SPI is disabled in all stop modes, regardless of the settings before executing the STOP instruction. During either stop1 or stop2 mode, the SPI module will be fully powered down. Upon wake-up from stop1 or stop2 mode, the SPI module will be in the reset state. During stop3 mode, clocks to the SPI module are halted. No registers are affected. If stop3 is exited with a reset, the SPI will be put into its reset state. If stop3 is exited with an interrupt, the SPI continues from the state it was in when stop3 was entered.

15.4 Register Definition

The SPI has five 8-bit registers to select SPI options, control baud rate, report SPI status, and for transmit/receive data.

Refer to the direct-page register summary in the [Memory](#) chapter of this data sheet for the absolute address assignments for all SPI registers. This section refers to registers and control bits only by their names, and a Freescale-provided equate or header file is used to translate these names into the appropriate absolute addresses.

15.4.1 SPI Control Register 1 (SPIC1)

This read/write register includes the SPI enable control, interrupt enables, and configuration options.

	7	6	5	4	3	2	1	0
R								
W								
Reset	0	0	0	0	0	1	0	0

Figure 15-5. SPI Control Register 1 (SPIC1)

Table 15-1. SPIC1 Field Descriptions

Field	Description
7 SPIE	SPI Interrupt Enable (for SPRF and MODF) — This is the interrupt enable for SPI receive buffer full (SPRF) and mode fault (MODF) events. 0 Interrupts from SPRF and MODF inhibited (use polling) 1 When SPRF or MODF is 1, request a hardware interrupt
6 SPE	SPI System Enable — Disabling the SPI halts any transfer that is in progress, clears data buffers, and initializes internal state machines. SPRF is cleared and SPTEF is set to indicate the SPI transmit data buffer is empty. 0 SPI system inactive 1 SPI system enabled
5 SPTIE	SPI Transmit Interrupt Enable — This is the interrupt enable bit for SPI transmit buffer empty (SPTEF). 0 Interrupts from SPTEF inhibited (use polling) 1 When SPTEF is 1, hardware interrupt requested

Table 15-1. SPIC1 Field Descriptions (continued)

Field	Description
4 MSTR	Master/Slave Mode Select 0 SPI module configured as a slave SPI device 1 SPI module configured as a master SPI device
3 CPOL	Clock Polarity — This bit effectively places an inverter in series with the clock signal from a master SPI or to a slave SPI device. Refer to Section 15.5.1, “SPI Clock Formats” for more details. 0 Active-high SPI clock (idles low) 1 Active-low SPI clock (idles high)
2 CPHA	Clock Phase — This bit selects one of two clock formats for different kinds of synchronous serial peripheral devices. Refer to Section 15.5.1, “SPI Clock Formats” for more details. 0 First edge on SPSCCK occurs at the middle of the first cycle of an 8-cycle data transfer 1 First edge on SPSCCK occurs at the start of the first cycle of an 8-cycle data transfer
1 SSOE	Slave Select Output Enable — This bit is used in combination with the mode fault enable (MODFEN) bit in SPCR2 and the master/slave (MSTR) control bit to determine the function of the \overline{SS} pin as shown in Table 15-2 .
0 LSBFE	LSB First (Shifter Direction) 0 SPI serial data transfers start with most significant bit 1 SPI serial data transfers start with least significant bit

Table 15-2. \overline{SS} Pin Function

MODFEN	SSOE	Master Mode	Slave Mode
0	0	General-purpose I/O (not SPI)	Slave select input
0	1	General-purpose I/O (not SPI)	Slave select input
1	0	\overline{SS} input for mode fault	Slave select input
1	1	Automatic \overline{SS} output	Slave select input

NOTE

Ensure that the SPI must not be disabled (SPE=0) at the same time as a bit change to the CPHA bit. These changes should be performed as separate operations or unexpected behavior may occur.

15.4.2 SPI Control Register 2 (SPIC2)

This read/write register is used to control optional features of the SPI system. Bits 7, 6, 5, and 2 are not implemented and always read 0.

	7	6	5	4	3	2	1	0
R	0	0	0	MODFEN	BIDIROE	0	SPISWAI	SPC0
W								
Reset	0	0	0	0	0	0	0	0


 = Unimplemented or Reserved

Figure 15-6. SPI Control Register 2 (SPIC2)

Table 15-3. SPIC2 Register Field Descriptions

Field	Description
4 MODFEN	Master Mode-Fault Function Enable — When the SPI is configured for slave mode, this bit has no meaning or effect. (The \overline{SS} pin is the slave select input.) In master mode, this bit determines how the \overline{SS} pin is used (refer to Table 15-2 for more details). 0 Mode fault function disabled, master \overline{SS} pin reverts to general-purpose I/O not controlled by SPI 1 Mode fault function enabled, master \overline{SS} pin acts as the mode fault input or the slave select output
3 BIDIROE	Bidirectional Mode Output Enable — When bidirectional mode is enabled by SPI pin control 0 (SPC0) = 1, BIDIROE determines whether the SPI data output driver is enabled to the single bidirectional SPI I/O pin. Depending on whether the SPI is configured as a master or a slave, it uses either the MOSI (MOMI) or MISO (SISO) pin, respectively, as the single SPI data I/O pin. When SPC0 = 0, BIDIROE has no meaning or effect. 0 Output driver disabled so SPI data I/O pin acts as an input 1 SPI I/O pin enabled as an output
1 SPISWAI	SPI Stop in Wait Mode 0 SPI clocks continue to operate in wait mode 1 SPI clocks stop when the MCU enters wait mode
0 SPC0	SPI Pin Control 0 — The SPC0 bit chooses single-wire bidirectional mode. If MSTR = 0 (slave mode), the SPI uses the MISO (SISO) pin for bidirectional SPI data transfers. If MSTR = 1 (master mode), the SPI uses the MOSI (MOMI) pin for bidirectional SPI data transfers. When SPC0 = 1, BIDIROE is used to enable or disable the output driver for the single bidirectional SPI I/O pin. 0 SPI uses separate pins for data input and data output 1 SPI configured for single-wire bidirectional operation

15.4.3 SPI Baud Rate Register (SPIBR)

This register is used to set the prescaler and bit rate divisor for an SPI master. This register may be read or written at any time.

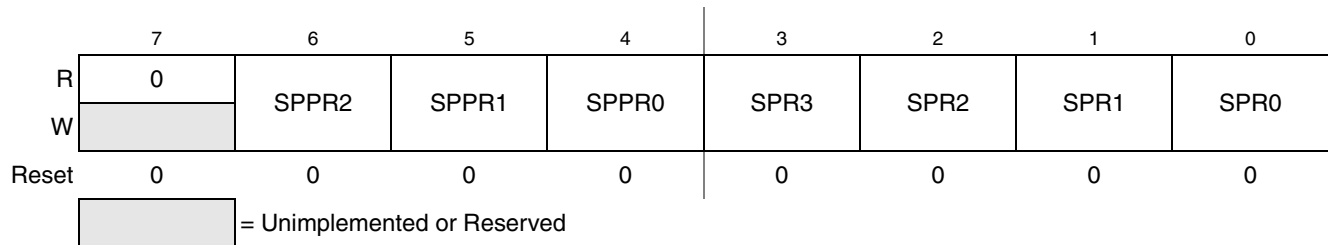


Figure 15-7. SPI Baud Rate Register (SPIBR)

Table 15-4. SPIBR Register Field Descriptions

Field	Description
6:4 SPPR[2:0]	SPI Baud Rate Prescale Divisor — This 3-bit field selects one of eight divisors for the SPI baud rate prescaler as shown in Table 15-5. The input to this prescaler is the bus rate clock (BUSCLK). The output of this prescaler drives the input of the SPI baud rate divider (see Figure 15-4).
2:0 SPR[3:0]	SPI Baud Rate Divisor — This 4-bit field selects one of eight divisors for the SPI baud rate divider as shown in Table 15-6. The input to this divider comes from the SPI baud rate prescaler (see Figure 15-4). The output of this divider is the SPI bit rate clock for master mode.

Table 15-5. SPI Baud Rate Prescaler Divisor

SPPR2:SPPR1:SPPR0	Prescaler Divisor
0:0:0	1
0:0:1	2
0:1:0	3
0:1:1	4
1:0:0	5
1:0:1	6
1:1:0	7
1:1:1	8

Table 15-6. SPI Baud Rate Divisor

SPR3:SPR2:SPR1:SPR0	Rate Divisor
0:0:0:0	2
0:0:0:1	4
0:0:1:0	8
0:0:1:1	16
0:1:0:0	32
0:1:0:1	64
0:1:1:0	128
0:1:1:1	256
1:0:0:0	512
All other combinations	512

15.4.4 SPI Status Register (SPIS)

This register has three read-only status bits. Bits 6, 3, 2, 1, and 0 are not implemented and always read 0. Writes have no meaning or effect.

	7	6	5	4	3	2	1	0
R	SPRF	0	SPTEF	MODF	0	0	0	0
W								
Reset	0	0	1	0	0	0	0	0

= Unimplemented or Reserved

Figure 15-8. SPI Status Register (SPIS)

Table 15-7. SPIS Register Field Descriptions

Field	Description
7 SPRF	SPI Read Buffer Full Flag — SPRF is set at the completion of an SPI transfer to indicate that received data may be read from the SPI data register (SPID). SPRF is cleared by reading SPRF while it is set, then reading the SPI data register. 0 No data available in the receive data buffer 1 Data available in the receive data buffer
5 SPTEF	SPI Transmit Buffer Empty Flag — This bit is set when there is room in the transmit data buffer. It is cleared by reading SPIS with SPTEF set, followed by writing a data value to the transmit buffer at SPID. SPIS must be read with SPTEF = 1 before writing data to SPID or the SPID write will be ignored. SPTEF generates an SPTEF CPU interrupt request if the SPTIE bit in the SPIC1 is also set. SPTEF is automatically set when a data byte transfers from the transmit buffer into the transmit shift register. For an idle SPI (no data in the transmit buffer or the shift register and no transfer in progress), data written to SPID is transferred to the shifter almost immediately so SPTEF is set within two bus cycles allowing a second 8-bit data value to be queued into the transmit buffer. After completion of the transfer of the value in the shift register, the queued value from the transmit buffer will automatically move to the shifter and SPTEF will be set to indicate there is room for new data in the transmit buffer. If no new data is waiting in the transmit buffer, SPTEF simply remains set and no data moves from the buffer to the shifter. 0 SPI transmit buffer not empty 1 SPI transmit buffer empty
4 MODF	Master Mode Fault Flag — MODF is set if the SPI is configured as a master and the slave select input goes low, indicating some other SPI device is also configured as a master. The \overline{SS} pin acts as a mode fault error input only when MSTR = 1, MODFEN = 1, and SSOE = 0; otherwise, MODF will never be set. MODF is cleared by reading MODF while it is 1, then writing to SPI control register 1 (SPIC1). 0 No mode fault error 1 Mode fault error detected

15.4.5 SPI Data Register (SPID)

	7	6	5	4	3	2	1	0
R	Bit 7	6	5	4	3	2	1	Bit 0
W								
Reset	0	0	0	0	0	0	0	0

Figure 15-9. SPI Data Register (SPID)

Reads of this register return the data read from the receive data buffer. Writes to this register write data to the transmit data buffer. When the SPI is configured as a master, writing data to the transmit data buffer initiates an SPI transfer.

Data should not be written to the transmit data buffer unless the SPI transmit buffer empty flag (SPTEF) is set, indicating there is room in the transmit buffer to queue a new transmit byte.

Data may be read from SPID any time after SPRF is set and before another transfer is finished. Failure to read the data out of the receive data buffer before a new transfer ends causes a receive overrun condition and the data from the new transfer is lost.

15.5 Functional Description

An SPI transfer is initiated by checking for the SPI transmit buffer empty flag (SPTEF = 1) and then writing a byte of data to the SPI data register (SPID) in the master SPI device. When the SPI shift register is available, this byte of data is moved from the transmit data buffer to the shifter, SPTEF is set to indicate there is room in the buffer to queue another transmit character if desired, and the SPI serial transfer starts.

During the SPI transfer, data is sampled (read) on the MISO pin at one SPSCCK edge and shifted, changing the bit value on the MOSI pin, one-half SPSCCK cycle later. After eight SPSCCK cycles, the data that was in the shift register of the master has been shifted out the MOSI pin to the slave while eight bits of data were shifted in the MISO pin into the master's shift register. At the end of this transfer, the received data byte is moved from the shifter into the receive data buffer and SPRF is set to indicate the data can be read by reading SPID. If another byte of data is waiting in the transmit buffer at the end of a transfer, it is moved into the shifter, SPTEF is set, and a new transfer is started.

Normally, SPI data is transferred most significant bit (MSB) first. If the least significant bit first enable (LSBFE) bit is set, SPI data is shifted LSB first.

When the SPI is configured as a slave, its \overline{SS} pin must be driven low before a transfer starts and \overline{SS} must stay low throughout the transfer. If a clock format where CPHA = 0 is selected, \overline{SS} must be driven to a logic 1 between successive transfers. If CPHA = 1, \overline{SS} may remain low between successive transfers. See [Section 15.5.1, "SPI Clock Formats"](#) for more details.

Because the transmitter and receiver are double buffered, a second byte, in addition to the byte currently being shifted out, can be queued into the transmit data buffer, and a previously received character can be in the receive data buffer while a new character is being shifted in. The SPTEF flag indicates when the transmit buffer has room for a new character. The SPRF flag indicates when a received character is available in the receive data buffer. The received character must be read out of the receive buffer (read SPID) before the next transfer is finished or a receive overrun error results.

In the case of a receive overrun, the new data is lost because the receive buffer still held the previous character and was not ready to accept the new data. There is no indication for such an overrun condition so the application system designer must ensure that previous data has been read from the receive buffer before a new transfer is initiated.

15.5.1 SPI Clock Formats

To accommodate a wide variety of synchronous serial peripherals from different manufacturers, the SPI system has a clock polarity (CPOL) bit and a clock phase (CPHA) control bit to select one of four clock formats for data transfers. CPOL selectively inserts an inverter in series with the clock. CPHA chooses between two different clock phase relationships between the clock and data.

[Figure 15-10](#) shows the clock formats when CPHA = 1. At the top of the figure, the eight bit times are shown for reference with bit 1 starting at the first SPSCCK edge and bit 8 ending one-half SPSCCK cycle after the sixteenth SPSCCK edge. The MSB first and LSB first lines show the order of SPI data bits depending on the setting in LSBFE. Both variations of SPSCCK polarity are shown, but only one of these waveforms applies for a specific transfer, depending on the value in CPOL. The SAMPLE IN waveform applies to the MOSI input of a slave or the MISO input of a master. The MOSI waveform applies to the

MOSI output pin from a master and the MISO waveform applies to the MISO output from a slave. The \overline{SS} OUT waveform applies to the slave select output from a master (provided MODFEN and SSOE = 1). The master \overline{SS} output goes to active low one-half SPSCCK cycle before the start of the transfer and goes back high at the end of the eighth bit time of the transfer. The \overline{SS} IN waveform applies to the slave select input of a slave.

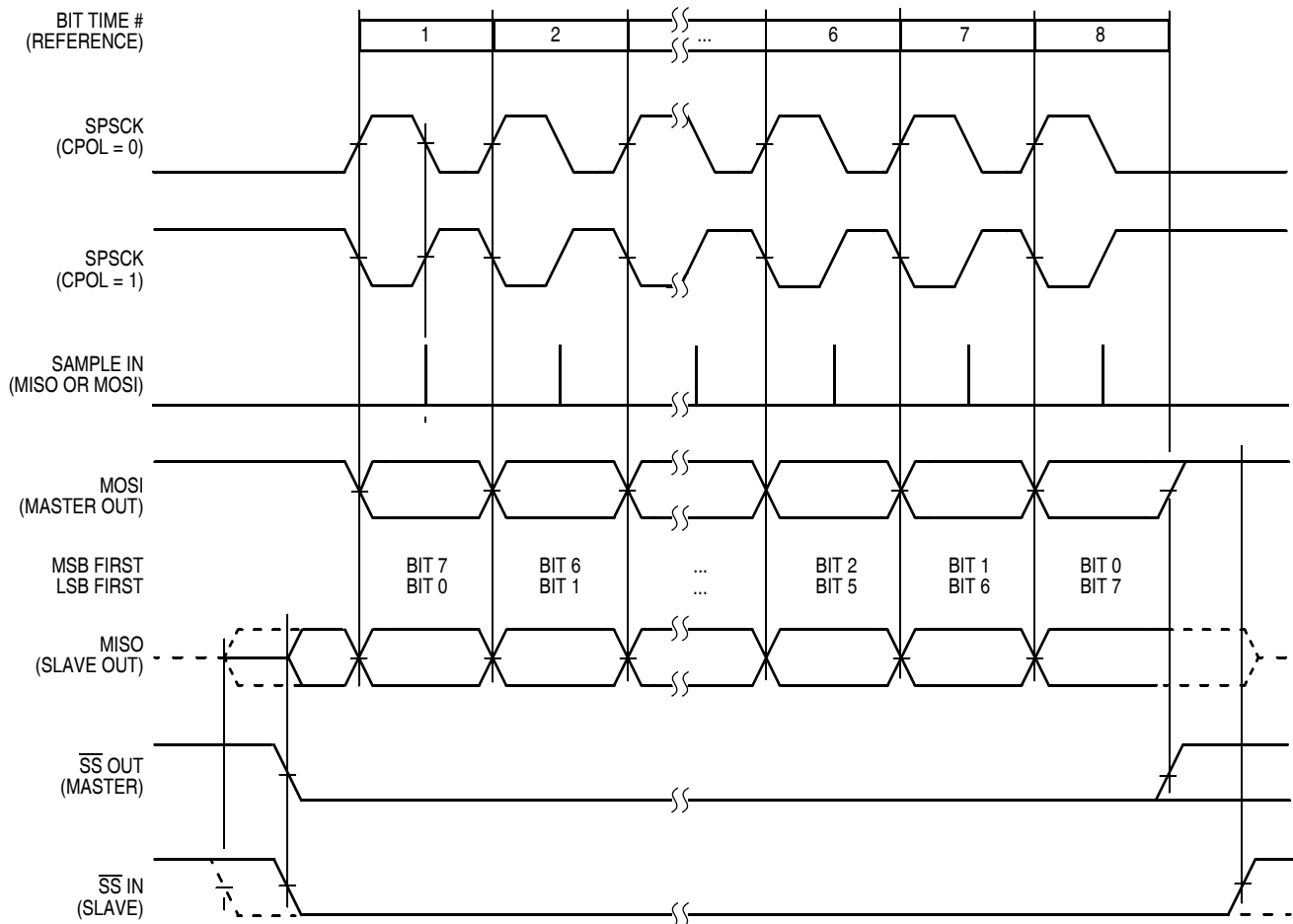


Figure 15-10. SPI Clock Formats (CPHA = 1)

When CPHA = 1, the slave begins to drive its MISO output when \overline{SS} goes to active low, but the data is not defined until the first SPSCCK edge. The first SPSCCK edge shifts the first bit of data from the shifter onto the MOSI output of the master and the MISO output of the slave. The next SPSCCK edge causes both the master and the slave to sample the data bit values on their MISO and MOSI inputs, respectively. At the third SPSCCK edge, the SPI shifter shifts one bit position which shifts in the bit value that was just sampled, and shifts the second data bit value out the other end of the shifter to the MOSI and MISO outputs of the master and slave, respectively. When CPHA = 1, the slave's \overline{SS} input is not required to go to its inactive high level between transfers.

Figure 15-11 shows the clock formats when CPHA = 0. At the top of the figure, the eight bit times are shown for reference with bit 1 starting as the slave is selected (\overline{SS} IN goes low), and bit 8 ends at the last SPSCCK edge. The MSB first and LSB first lines show the order of SPI data bits depending on the setting

in LSBFE. Both variations of SPSCCK polarity are shown, but only one of these waveforms applies for a specific transfer, depending on the value in CPOL. The SAMPLE IN waveform applies to the MOSI input of a slave or the MISO input of a master. The MOSI waveform applies to the MOSI output pin from a master and the MISO waveform applies to the MISO output from a slave. The \overline{SS} OUT waveform applies to the slave select output from a master (provided MODFEN and SSOE = 1). The master \overline{SS} output goes to active low at the start of the first bit time of the transfer and goes back high one-half SPSCCK cycle after the end of the eighth bit time of the transfer. The \overline{SS} IN waveform applies to the slave select input of a slave.

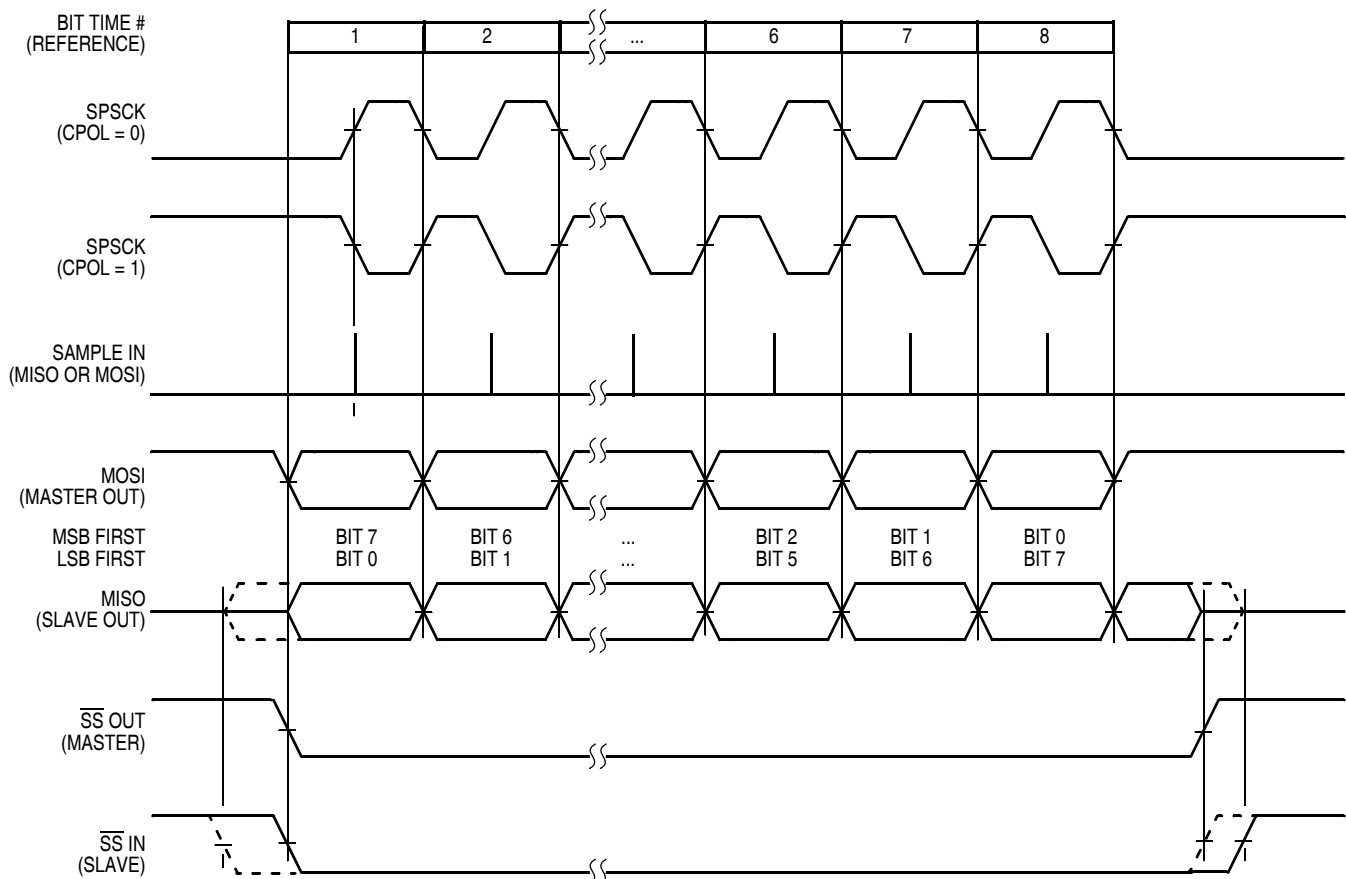


Figure 15-11. SPI Clock Formats (CPHA = 0)

When CPHA = 0, the slave begins to drive its MISO output with the first data bit value (MSB or LSB depending on LSBFE) when \overline{SS} goes to active low. The first SPSCCK edge causes both the master and the slave to sample the data bit values on their MISO and MOSI inputs, respectively. At the second SPSCCK edge, the SPI shifter shifts one bit position which shifts in the bit value that was just sampled and shifts the second data bit value out the other end of the shifter to the MOSI and MISO outputs of the master and slave, respectively. When CPHA = 0, the slave's \overline{SS} input must go to its inactive high level between transfers.

15.5.2 SPI Interrupts

There are three flag bits, two interrupt mask bits, and one interrupt vector associated with the SPI system. The SPI interrupt enable mask (SPIE) enables interrupts from the SPI receiver full flag (SPRF) and mode fault flag (MODF). The SPI transmit interrupt enable mask (SPTIE) enables interrupts from the SPI transmit buffer empty flag (SPTEF). When one of the flag bits is set, and the associated interrupt mask bit is set, a hardware interrupt request is sent to the CPU. If the interrupt mask bits are cleared, software can poll the associated flag bits instead of using interrupts. The SPI interrupt service routine (ISR) should check the flag bits to determine what event caused the interrupt. The service routine should also clear the flag bit(s) before returning from the ISR (usually near the beginning of the ISR).

15.5.3 Mode Fault Detection

A mode fault occurs and the mode fault flag (MODF) becomes set when a master SPI device detects an error on the \overline{SS} pin (provided the \overline{SS} pin is configured as the mode fault input signal). The \overline{SS} pin is configured to be the mode fault input signal when MSTR = 1, mode fault enable is set (MODFEN = 1), and slave select output enable is clear (SSOE = 0).

The mode fault detection feature can be used in a system where more than one SPI device might become a master at the same time. The error is detected when a master's \overline{SS} pin is low, indicating that some other SPI device is trying to address this master as if it were a slave. This could indicate a harmful output driver conflict, so the mode fault logic is designed to disable all SPI output drivers when such an error is detected.

When a mode fault is detected, MODF is set and MSTR is cleared to change the SPI configuration back to slave mode. The output drivers on the SPSCCK, MOSI, and MISO (if not bidirectional mode) are disabled.

MODF is cleared by reading it while it is set, then writing to the SPI control register 1 (SPIC1). User software should verify the error condition has been corrected before changing the SPI back to master mode.

Chapter 16

Timer/Pulse-Width Modulator (S08TPMV3)

16.1 Introduction

Figure 16-1 shows the MC9S08QE8 series block diagram with the TPM highlighted.

16.1.1 ACMP/TPM Configuration Information

The ACMP modules can be configured to connect the output of the analog comparator to a TPM input capture channel 0 by setting the corresponding ACICx bit in SOPT2. With ACICx set, the TPMxCH0 pin is not available externally regardless of the configuration of the TPMx module.

The ACMP1 output can be connected to TPM1CH0. The ACMP2 output can be connected to TPM2CH0.

16.1.2 TPM External Clock

The TPM modules on the MC9S08QE8 series use the TCLK pin.

16.1.3 TPM Pin Repositioning

The TPM modules pins, TPM1CH2 and TPM2CH2, can be repositioned under software control using TPMxCH2PS bits in SOPT2 as shown in Table 16-1.

Table 16-1. TPM Position Options

TPMxCH2PS in SOPT2	Port Pin for TPM1CH2	Port Pin for TPM2CH2
0 (default)	PTA6	PTA7
1	PTC0	PTC1

16.1.4 TPM Clock Gating

The bus clock to the TPMs can be gated on and off using the TPM2 bit and TPM1 bit in SCGC1. These bits are set after any reset, which enables the bus clock to this module. To conserve power, these bits can be cleared to disable the clock to this module when not in use. See Section 5.7, “Peripheral Clock Gating,” for details.

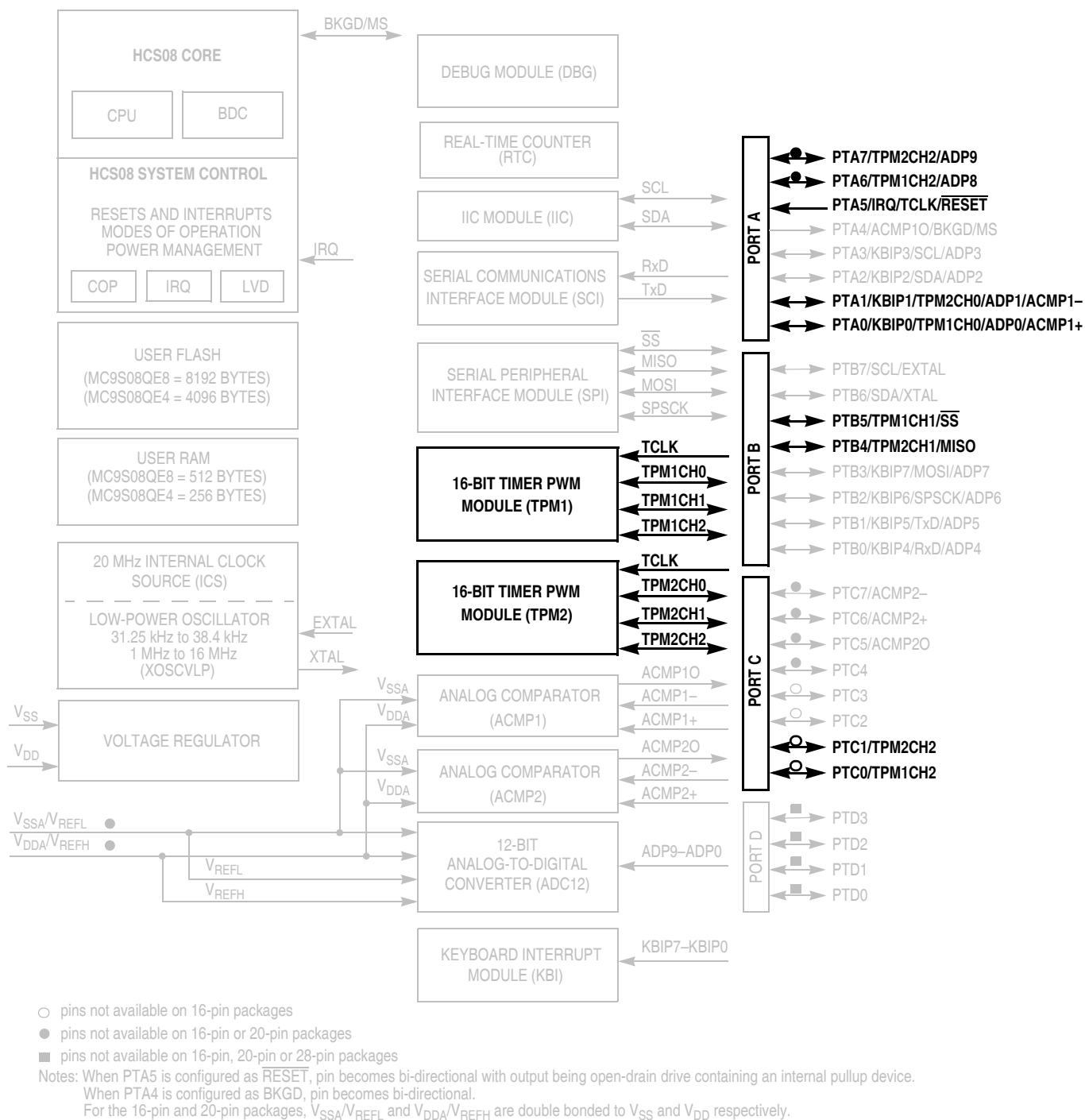


Figure 16-1. MC9S08QE8 Series Block Diagram Highlighting TPM Blocks and Pins

16.1.5 Features

The TPM includes these distinctive features:

- One to eight channels:
 - Each channel is input capture, output compare, or edge-aligned PWM
 - Rising-edge, falling-edge, or any-edge input capture trigger
 - Set, clear, or toggle output compare action
 - Selectable polarity on PWM outputs
- Module is configured for buffered, center-aligned pulse-width-modulation (CPWM) on all channels
- Timer clock source selectable as bus clock, fixed frequency clock, or an external clock
 - Prescale taps for divide-by 1, 2, 4, 8, 16, 32, 64, or 128 used for any clock input selection
 - Fixed frequency clock is an additional clock input to allow the selection of an on chip clock source other than bus clock
 - Selecting external clock connects TPM clock to a chip level input pin therefore allowing to synchronize the TPM counter with an off chip clock source
- 16-bit free-running or modulus count with up/down selection
- One interrupt per channel and one interrupt for TPM counter overflow

16.1.6 Modes of Operation

In general, TPM channels are independently configured to operate in input capture, output compare, or edge-aligned PWM modes. A control bit allows the whole TPM (all channels) to switch to center-aligned PWM mode. When center-aligned PWM mode is selected, input capture, output compare, and edge-aligned PWM functions are not available on any channels of this TPM module.

When the MCU is in active BDM background or BDM foreground mode, the TPM temporarily suspends all counting until the MCU returns to normal user operating mode. During stop mode, all TPM input clocks are stopped, so the TPM is effectively disabled until clocks resume. During wait mode, the TPM continues to operate normally. If the TPM does not need to produce a real time reference or provide the interrupt sources needed to wake the MCU from wait mode, the power can then be saved by disabling TPM functions before entering wait mode.

- Input capture mode

When a selected edge event occurs on the associated MCU pin, the current value of the 16-bit timer counter is captured into the channel value register and an interrupt flag bit is set. Rising edges, falling edges, any edge, or no edge (disable channel) are selected as the active edge that triggers the input capture.
- Output compare mode

When the value in the timer counter register matches the channel value register, an interrupt flag bit is set, and a selected output action is forced on the associated MCU pin. The output compare action is selected to force the pin to zero, force the pin to one, toggle the pin, or ignore the pin (used for software timing functions).
- Edge-aligned PWM mode

The value of a 16-bit modulo register plus 1 sets the period of the PWM output signal. The channel value register sets the duty cycle of the PWM output signal. You can also choose the polarity of the PWM output signal. Interrupts are available at the end of the period and at the duty-cycle transition point. This type of PWM signal is called edge-aligned because the leading edges of all PWM signals are aligned with the beginning of the period that is same for all channels within a TPM.

- Center-aligned PWM mode

Twice the value of a 16-bit modulo register sets the period of the PWM output, and the channel-value register sets the half-duty-cycle duration. The timer counter counts up until it reaches the modulo value and then counts down until it reaches zero. As the count matches the channel value register while counting down, the PWM output becomes active. When the count matches the channel value register while counting up, the PWM output becomes inactive. This type of PWM signal is called center-aligned because the centers of the active duty cycle periods for all channels are aligned with a count value of zero. This type of PWM is required for types of motors used in small appliances.

This is a high-level description only. Detailed descriptions of operating modes are in later sections.

16.1.7 Block Diagram

The TPM uses one input/output (I/O) pin per channel, TPMxCHn (timer channel n) where n is the channel number (1–8). The TPM shares its I/O pins with general purpose I/O port pins (refer to I/O pin descriptions in full-chip specification for the specific chip implementation).

Figure 16-2 shows the TPM structure. The central component of the TPM is the 16-bit counter that can operate as a free-running counter or a modulo up/down counter. The TPM counter (when operating in normal up-counting mode) provides the timing reference for the input capture, output compare, and edge-aligned PWM functions. The timer counter modulo registers, TPMxMODH:TPMxMODL, control the modulo value of the counter (the values 0x0000 or 0xFFFF effectively make the counter free running). Software can read the counter value at any time without affecting the counting sequence. Any write to either half of the TPMxCNT counter resets the counter, regardless of the data value written.

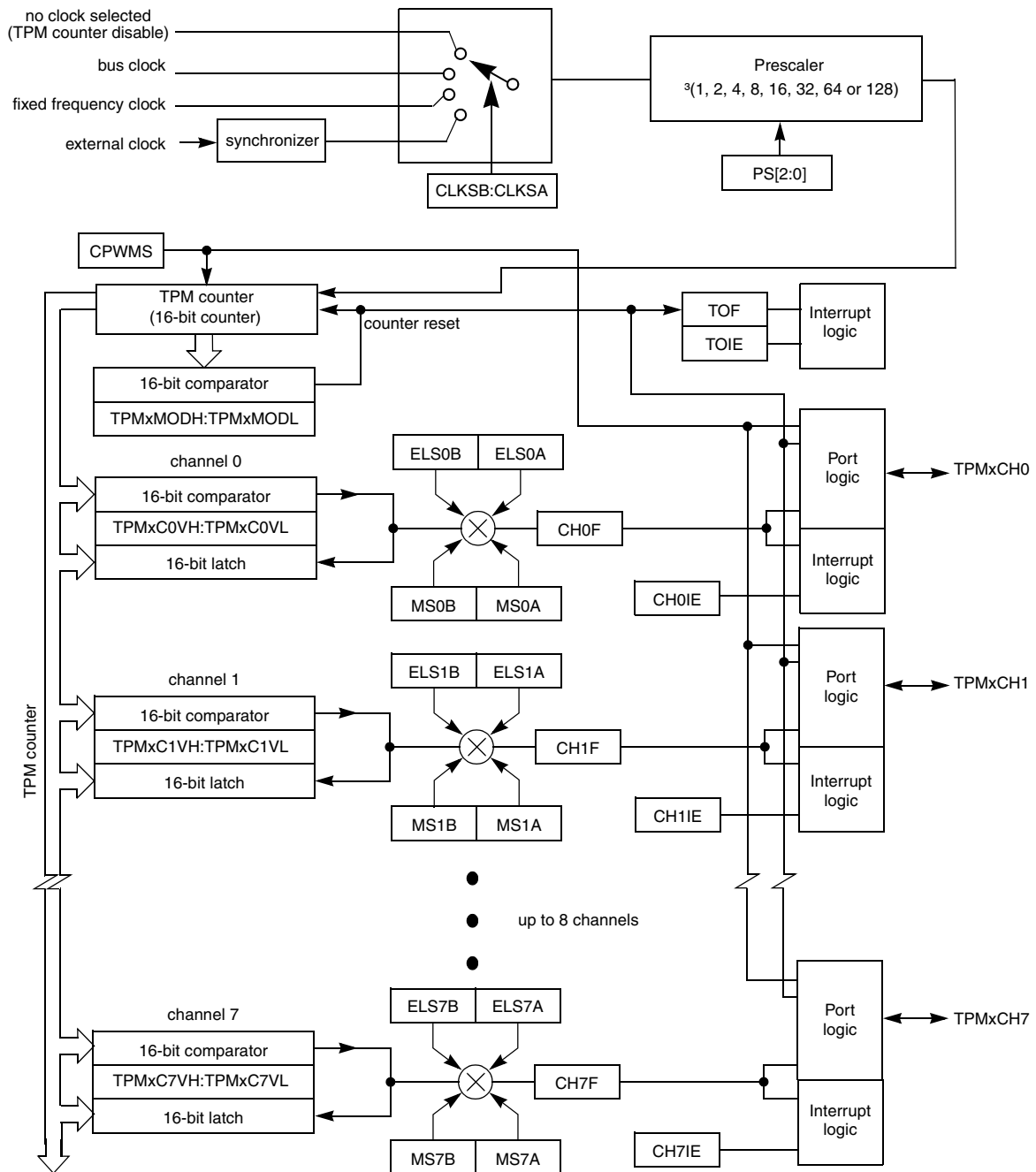


Figure 16-2. TPM Block Diagram

The TPM channels are programmable independently as input capture, output compare, or edge-aligned PWM channels. Alternately, the TPM can be configured to produce CPWM outputs on all channels. When the TPM is configured for CPWMs (the counter operates as an up/down counter) input capture, output compare, and EPWM functions are not practical.

16.2 Signal Description

Table 16-2 shows the user-accessible signals for the TPM. The number of channels are varied from one to eight. When an external clock is included, it can be shared with the same pin as any TPM channel; however, it could be connected to a separate input pin. Refer to the I/O pin descriptions in full-chip specification for the specific chip implementation.

Table 16-2. Signal Properties

Name	Function
EXTCLK ¹	External clock source that is selected to drive the TPM counter.
TPMxCHn ²	I/O pin associated with TPM channel n.

¹ The external clock pin can be shared with any channel pin. However, depending upon full-chip implementation, this signal could be connected to a separate external pin.

² n = channel number (1–8)

16.2.1 Detailed Signal Descriptions

16.2.1.1 EXTCLK — External Clock Source

The external clock signal can share the same pin as a channel pin, however the channel pin can not be used for channel I/O function when external clock is selected. If this pin is used as an external clock (CLKSB:CLKSA = 1:1), the channel can still be configured to output compare mode therefore allowing its use as a timer (ELSnB:ELSnA = 0:0).

For proper TPM operation, the external clock frequency must not exceed one-fourth of the bus clock frequency.

16.2.1.2 TPMxCHn — TPM Channel n I/O Pins

The TPM channel does not control the I/O pin when ELSnB:ELSnA or CLKSb:CLKSA are cleared so it normally reverts to general purpose I/O control. When CPWMS is set and ELSnB:ELSnA are not cleared, all TPM channels are configured for center-aligned PWM and the TPMxCHn pins are all controlled by TPM. When CPWMS is cleared, the MSnB:MSnA control bits determine whether the channel is configured for input capture, output compare, or edge-aligned PWM.

When a channel is configured for input capture (CPWMS = 0, MSnB:MSnA = 0:0, and ELSnB:ELSnA ≠ 0:0), the TPMxCHn pin is forced to act as an edge-sensitive input to the TPM. ELSnB:ELSnA control bits determine what polarity edge or edges trigger input capture events. The channel input signal is synchronized on the bus clock. This implies the minimum pulse width—that can

be reliably detected—on an input capture pin is four bus clock periods (with ideal clock pulses as near as two bus clocks can be detected).

When a channel is configured for output compare (CPWMS = 0, MSnB:MSnA = 0:1, and ELSnB:ELSnA \neq 0:0), the TPMxCHn pin is an output controlled by the TPM. The ELSnB:ELSnA bits determine whether the TPMxCHn pin is toggled, cleared, or set each time the 16-bit channel value register matches the TPM counter.

When the output compare toggle mode is initially selected, the previous value on the pin is driven out until the next output compare event, the pin is then toggled.

When a channel is configured for edge-aligned PWM (CPWMS = 0, MSnB = 1, and ELSnB:ELSnA \neq 0:0), the TPMxCHn pin is an output controlled by the TPM, and ELSnB:ELSnA bits control the polarity of the PWM output signal. When ELSnB is set and ELSnA is cleared, the TPMxCHn pin is forced high at the start of each new period (TPMxCNT=0x0000), and it is forced low when the channel value register matches the TPM counter. When ELSnA is set, the TPMxCHn pin is forced low at the start of each new period (TPMxCNT=0x0000), and it is forced high when the channel value register matches the TPM counter.

TPMxMODH:TPMxMODL = 0x0008
TPMxCnVH:TPMxCnVL = 0x0005

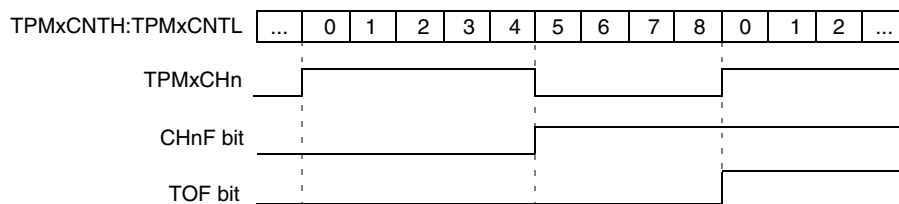


Figure 16-3. High-true pulse of an edge-aligned PWM

TPMxMODH:TPMxMODL = 0x0008
TPMxCnVH:TPMxCnVL = 0x0005

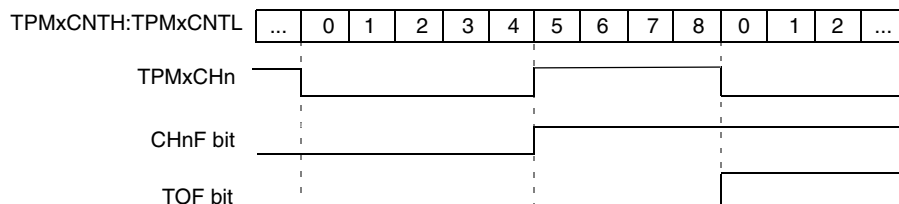


Figure 16-4. Low-true pulse of an edge-aligned PWM

When the TPM is configured for center-aligned PWM (CPWMS = 1 and ELSnB:ELSnA \neq 0:0), the TPMxCHn pins are outputs controlled by the TPM, and ELSnB:ELSnA bits control the polarity of the PWM output signal. If ELSnB is set and ELSnA is cleared, the corresponding TPMxCHn pin is cleared when the TPM counter is counting up, and the channel value register matches the TPM counter; and it is

set when the TPM counter is counting down, and the channel value register matches the TPM counter. If ELSnA is set, the corresponding TPMxCHn pin is set when the TPM counter is counting up and the channel value register matches the TPM counter; and it is cleared when the TPM counter is counting down and the channel value register matches the TPM counter.

TPMxMODH:TPMxMODL = 0x0008
TPMxCnVH:TPMxCnVL = 0x0005

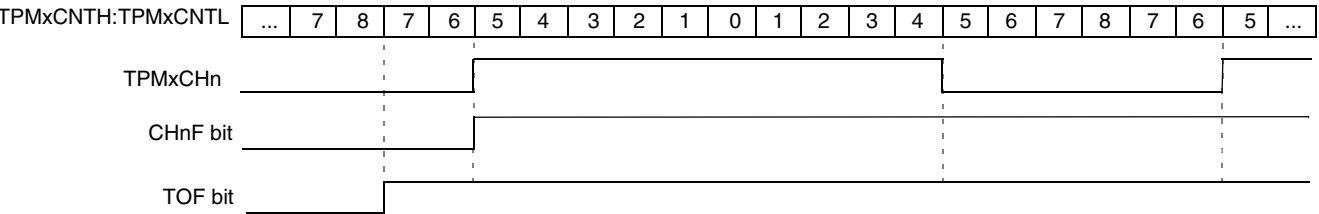


Figure 16-5. High-true pulse of a center-aligned PWM

TPMxMODH:TPMxMODL = 0x0008
TPMxCnVH:TPMxCnVL = 0x0005

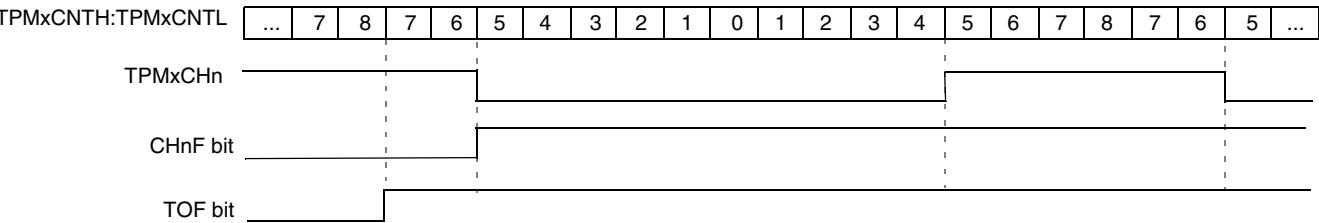


Figure 16-6. Low-true pulse of a center-aligned PWM

16.3 Register Definition

16.3.1 TPM Status and Control Register (TPMxSC)

TPMxSC contains the overflow status flag and control bits used to configure the interrupt enable, TPM configuration, clock source, and prescale factor. These controls relate to all channels within this timer module.

	7	6	5	4	3	2	1	0
R	TOF	TOIE	CPWMS	CLKSB	CLKSA	PS2	PS1	PS0
W	0							
Reset	0	0	0	0	0	0	0	0

Figure 16-7. TPM Status and Control Register (TPMxSC)

Table 16-3. TPMxSC Field Descriptions

Field	Description
7 TOF	Timer overflow flag. This read/write flag is set when the TPM counter resets to 0x0000 after reaching the modulo value programmed in the TPM counter modulo registers. Clear TOF by reading the TPM status and control register when TOF is set and then writing a logic 0 to TOF. If another TPM overflow occurs before the clearing sequence is completed, the sequence is reset so TOF remains set after the clear sequence was completed for the earlier TOF. This is done so a TOF interrupt request cannot be lost during the clearing sequence for a previous TOF. Reset clears TOF. Writing a logic 1 to TOF has no effect. 0 TPM counter has not reached modulo value or overflow. 1 TPM counter has overflowed.
6 TOIE	Timer overflow interrupt enable. This read/write bit enables TPM overflow interrupts. If TOIE is set, an interrupt is generated when TOF equals one. Reset clears TOIE. 0 TOF interrupts inhibited (use for software polling). 1 TOF interrupts enabled.
5 CPWMS	Center-aligned PWM select. This read/write bit selects CPWM operating mode. By default, the TPM operates in up-counting mode for input capture, output compare, and edge-aligned PWM functions. Setting CPWMS reconfigures the TPM to operate in up/down counting mode for CPWM functions. Reset clears CPWMS. 0 All channels operate as input capture, output compare, or edge-aligned PWM mode as selected by the MSnB:MSnA control bits in each channel's status and control register. 1 All channels operate in center-aligned PWM mode.
4–3 CLKS[B:A]	Clock source selection bits. As shown in Table 16-4 , this 2-bit field is used to disable the TPM counter or select one of three clock sources to TPM counter and counter prescaler.
2–0 PS[2:0]	Prescale factor select. This 3-bit field selects one of eight division factors for the TPM clock as shown in Table 16-5 . This prescaler is located after any clock synchronization or clock selection so it affects the clock selected to drive the TPM counter. The new prescale factor affects the selected clock on the next bus clock cycle after the new value is updated into the register bits.

Table 16-4. TPM Clock Selection

CLKSB:CLKSA	TPM Clock to Prescaler Input
00	No clock selected (TPM counter disable)

Table 16-4. TPM Clock Selection

CLKSB:CLKSA	TPM Clock to Prescaler Input
01	Bus clock
10	Fixed frequency clock
11	External clock

Table 16-5. Prescale Factor Selection

PS[2:0]	TPM Clock Divided-by
000	1
001	2
010	4
011	8
100	16
101	32
110	64
111	128

16.3.2 TPM-Counter Registers (TPMxCNTH:TPMxCNTL)

The two read-only TPM counter registers contain the high and low bytes of the value in the TPM counter. Reading either byte (TPMxCNTH or TPMxCNTL) latches the contents of both bytes into a buffer where they remain latched until the other half is read. This allows coherent 16-bit reads in big-endian or little-endian order that makes this more friendly to various compiler implementations. The coherency mechanism is automatically restarted by an MCU reset or any write to the timer status/control register (TPMxSC).

Reset clears the TPM counter registers. Writing any value to TPMxCNTH or TPMxCNTL also clears the TPM counter (TPMxCNTH:TPMxCNTL) and resets the coherency mechanism, regardless of the data involved in the write.

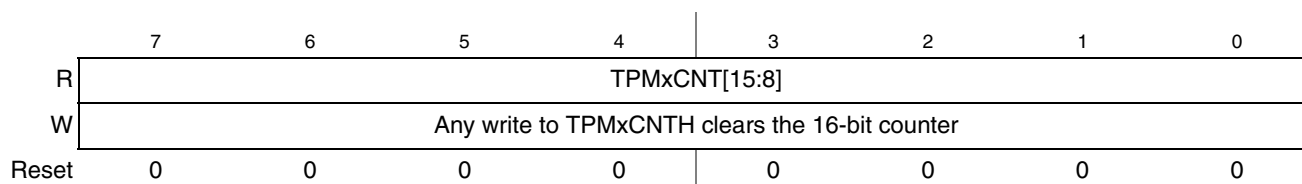


Figure 16-8. TPM Counter Register High (TPMxCNTH)

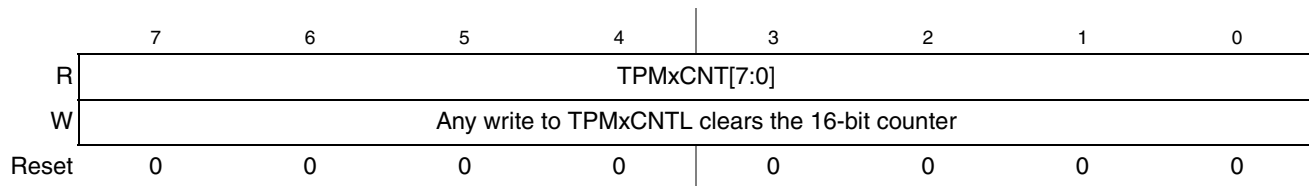


Figure 16-9. TPM Counter Register Low (TPMxCNTL)

When BDM is active, the timer counter is frozen (this is the value you read). The coherency mechanism is frozen so the buffer latches remain in the state they were in when the BDM became active, even if one or both counter halves are read while BDM is active. This assures that if you were in the middle of reading a 16-bit register when BDM became active, it reads the appropriate value from the other half of the 16-bit value after returning to normal execution.

In BDM mode, writing any value to TPMxSC, TPMxCNTH, or TPMxCNTL registers resets the read coherency mechanism of the TPMxCNTH:TPMxCNTL registers, regardless of the data involved in the write.

16.3.3 TPM Counter Modulo Registers (TPMxMODH:TPMxMODL)

The read/write TPM modulo registers contain the modulo value for the TPM counter. After the TPM counter reaches the modulo value, the TPM counter resumes counting from 0x0000 at the next clock, and the overflow flag (TOF) becomes set. Writing to TPMxMODH or TPMxMODL inhibits the TOF bit and overflow interrupts until the other byte is written. Reset sets the TPM counter modulo registers to 0x0000 that results in a free running timer counter (modulo disabled).

Writes to any of the registers TPMxMODH and TPMxMODL actually writes to buffer registers and the registers are updated with the value of their write buffer according to the value of CLKSB:CLKSA bits:

- If CLKSB and CLKSA are cleared, the registers are updated when the second byte is written
- If CLKSB and CLKSA are not cleared, the registers are updated after both bytes were written, and the TPM counter changes from (TPMxMODH:TPMxMODL – 1) to (TPMxMODH:TPMxMODL). If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFFE to 0xFFFF

The latching mechanism is manually reset by writing to the TPMxSC address (whether BDM is active or not).

When BDM is active, the coherency mechanism is frozen (unless reset by writing to TPMxSC register) so the buffer latches remain in the state they were in when the BDM became active, even if one or both halves of the modulo register are written while BDM is active. Any write to the modulo registers bypasses the buffer latches and directly writes to the modulo register while BDM is active.

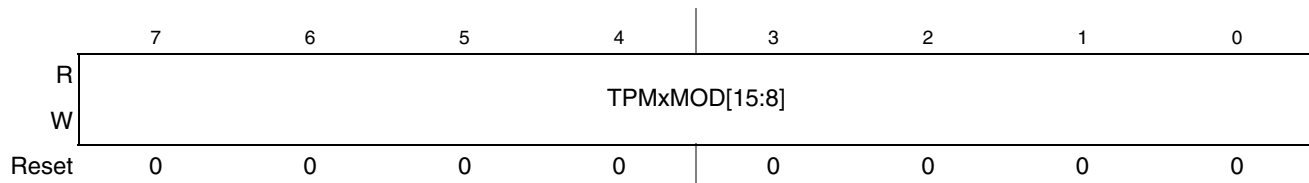
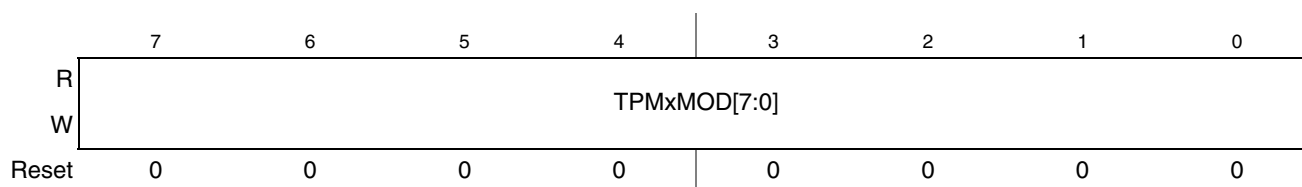


Figure 16-10. TPM Counter Modulo Register High (TPMxMODH)



Reset the TPM counter before writing to the TPM modulo registers to avoid confusion about when the first counter overflow occurs.

16.3.4 TPM Channel n Status and Control Register (TPMxCnSC)

TPMxCnSC contains the channel-interrupt-status flag and control bits that configure the interrupt enable, channel configuration, and pin function.

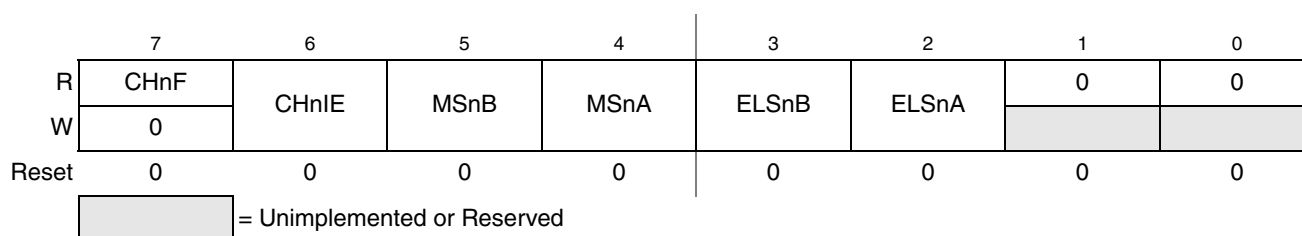


Figure 16-12. TPM Channel n Status and Control Register (TPMxCnSC)

Table 16-6. TPMxCnSC Field Descriptions

Field	Description
7 CHnF	Channel n flag. When channel n is an input capture channel, this read/write bit is set when an active edge occurs on the channel n input. When channel n is an output compare or edge-aligned/center-aligned PWM channel, CHnF is set when the value in the TPM counter registers matches the value in the TPM channel n value registers. When channel n is an edge-aligned/center-aligned PWM channel and the duty cycle is set to 0% or 100%, CHnF is not set even when the value in the TPM counter registers matches the value in the TPM channel n value registers. A corresponding interrupt is requested when this bit is set and channel n interrupt is enabled (CHnIE = 1). Clear CHnF by reading TPMxCnSC while this bit is set and then writing a logic 0 to it. If another interrupt request occurs before the clearing sequence is completed CHnF remains set. This is done so a CHnF interrupt request is not lost due to clearing a previous CHnF. Reset clears this bit. Writing a logic 1 to CHnF has no effect. 0 No input capture or output compare event occurred on channel n. 1 Input capture or output compare event on channel n.
6 CHnIE	Channel n interrupt enable. This read/write bit enables interrupts from channel n. Reset clears this bit. 0 Channel n interrupt requests disabled (use for software polling). 1 Channel n interrupt requests enabled.
5 MSnB	Mode select B for TPM channel n. When CPWMS is cleared, setting the MSnB bit configures TPM channel n for edge-aligned PWM mode. Refer to the summary of channel mode and setup controls in Table 16-7 .

Table 16-6. TPMxCnSC Field Descriptions (continued)

Field	Description
4 MSnA	Mode select A for TPM channel n. When CPWMS and MSnB are cleared, the MSnA bit configures TPM channel n for input capture mode or output compare mode. Refer to Table 16-7 for a summary of channel mode and setup controls. Note: If the associated port pin is not stable for at least two bus clock cycles before changing to input capture mode, it is possible to get an unexpected indication of an edge trigger.
3–2 ELSnB ELSnA	Edge/level select bits. Depending upon the operating mode for the timer channel as set by CPWMS:MSnB:MSnA and shown in Table 16-7 , these bits select the polarity of the input edge that triggers an input capture event, select the level that is driven in response to an output compare match, or select the polarity of the PWM output. If ELSnB and ELSnA bits are cleared, the channel pin is not controlled by TPM. This configuration can be used by software compare only, because it does not require the use of a pin for the channel.

Table 16-7. Mode, Edge, and Level Selection

CPWMS	MSnB:MSnA	ELSnB:ELSnA	Mode	Configuration
X	XX	00	Pin is not controlled by TPM. It is reverted to general purpose I/O or other peripheral control	
0	00	01	Input capture	Capture on rising edge only
		10		Capture on falling edge only
		11		Capture on rising or falling edge
	01	00	Output compare	Software compare only
		01		Toggle output on channel match
		10		Clear output on channel match
		11		Set output on channel match
	1X	10	Edge-aligned PWM	High-true pulses (clear output on channel match)
		X1		Low-true pulses (set output on channel match)
1	XX	10	Center-aligned PWM	High-true pulses (clear output on channel match when TPM counter is counting up)
		X1		Low-true pulses (set output on channel match when TPM counter is counting up)

16.3.5 TPM Channel Value Registers (TPMxCnVH:TPMxCnVL)

These read/write registers contain the captured TPM counter value of the input capture function or the output compare value for the output compare or PWM functions. The channel registers are cleared by reset.

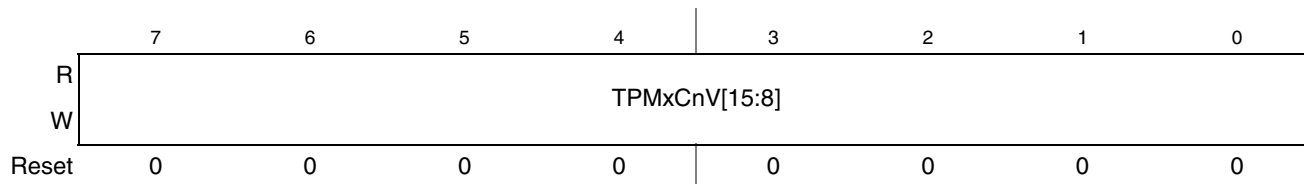


Figure 16-13. TPM Channel Value Register High (TPMxCnVH)

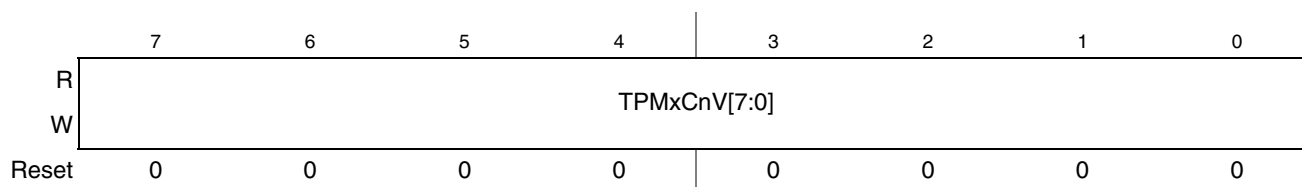


Figure 16-14. TPM Channel Value Register Low (TPMxCnVL)

In input capture mode, reading either byte (TPMxCnVH or TPMxCnVL) latches the contents of both bytes into a buffer where they remain latched until the other half is read. This latching mechanism also resets (becomes unlatched) when the TPMxCnSC register is written (whether BDM mode is active or not). Any write to the channel registers is ignored during the input capture mode.

When BDM is active, the coherency mechanism is frozen (unless reset by writing to TPMxCnSC register) so the buffer latches remain in the state they were in when the BDM became active, even if one or both halves of the channel register are read while BDM is active. This assures that if you were in the middle of reading a 16-bit register when BDM became active, it reads the appropriate value from the other half of the 16-bit value after returning to normal execution. The value read from the TPMxCnVH and TPMxCnVL registers in BDM mode is the value of these registers and not the value of their read buffer.

In output compare or PWM modes, writing to either byte (TPMxCnVH or TPMxCnVL) latches the value into a buffer. After both bytes were written, they are transferred as a coherent 16-bit value into the timer-channel registers according to the value of CLKS_B:CLKS_A bits and the selected mode:

- If CLKS_B and CLKS_A are cleared, the registers are updated when the second byte is written.
- If CLKS_B and CLKS_A are not cleared and in output compare mode, the registers are updated after the second byte is written and on the next change of the TPM counter (end of the prescaler counting).
- If CLKS_B and CLKS_A are not cleared and in EPWM or CPWM modes, the registers are updated after both bytes were written, and the TPM counter changes from (TPM_xMODH:TPM_xMODL – 1) to (TPM_xMODH:TPM_xMODL). If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFFE to 0xFFFF.

The latching mechanism is manually reset by writing to the TPMxCnSC register (whether BDM mode is active or not). This latching mechanism allows coherent 16-bit writes in either big-endian or little-endian order that is friendly to various compiler implementations.

When BDM is active, the coherency mechanism is frozen so the buffer latches remain in the state they were in when the BDM became active even if one or both halves of the channel register are written while BDM is active. Any write to the channel registers bypasses the buffer latches and directly write to the channel register while BDM is active. The values written to the channel register while BDM is active are used for PWM and output compare operation after normal execution resumes. Writes to the channel registers while BDM is active do not interfere with partial completion of a coherency sequence. After the coherency mechanism is fully exercised, the channel registers are updated using the buffered values (while BDM was not active).

16.4 Functional Description

All TPM functions are associated with a central 16-bit counter that allows flexible selection of the clock and prescale factor. There is also a 16-bit modulo register associated with this counter.

The CPWMS control bit chooses between center-aligned PWM operation for all channels in the TPM (CPWMS=1) or general purpose timing functions (CPWMS=0) where each channel can independently be configured to operate in input capture, output compare, or edge-aligned PWM mode. The CPWMS control bit is located in the TPM status and control register because it affects all channels within the TPM and influences the way the main counter operates. (In CPWM mode, the counter changes to an up/down mode rather than the up-counting mode used for general purpose timer functions.)

The following sections describe TPM counter and each of the timer operating modes (input capture, output compare, edge-aligned PWM, and center-aligned PWM). Because details of pin operation and interrupt activity depend upon the operating mode, these topics are covered in the associated mode explanation sections.

16.4.1 Counter

All timer functions are based on the main 16-bit counter (TPMxCNTH:TPMxCNTL). This section discusses selection of the clock, end-of-count overflow, up-counting vs. up/down counting, and manual counter reset.

16.4.1.1 Counter Clock Source

The 2-bit field, CLKSB:CLKSA, in the timer status and control register (TPMxSC) disables the TPM counter or selects one of three clock sources to TPM counter ([Table 16-4](#)). After any MCU reset, CLKSB and CLKSA are cleared so no clock is selected and the TPM counter is disabled (TPM is in a very low power state). You can read or write these control bits at any time. Disabling the TPM counter by writing 00 to CLKSB:CLKSA bits, does not affect the values in the TPM counter or other registers.

The fixed frequency clock is an alternative clock source for the TPM counter that allows the selection of a clock other than the bus clock or external clock. This clock input is defined by chip integration. You can refer chip specific documentation for further information. Due to TPM hardware implementation limitations, the frequency of the fixed frequency clock must not exceed the bus clock frequency. The fixed frequency clock has no limitations for low frequency operation.

The external clock passes through a synchronizer clocked by the bus clock to assure that counter transitions are properly aligned to bus clock transitions. Therefore, in order to meet Nyquist criteria considering also jitter, the frequency of the external clock source must not exceed 1/4 of the bus clock frequency.

When the external clock source is shared with a TPM channel pin, this pin must not be used in input capture mode. However, this channel can be used in output compare mode with ELSnB:ELSnA = 0:0 for software timing functions. In this case, the channel output is disabled, but the channel match events continue to set the appropriate flag.

16.4.1.2 Counter Overflow and Modulo Reset

An interrupt flag and enable are associated with the 16-bit main counter. The flag (TOF) is a software-accessible indication that the timer counter has overflowed. The enable signal selects between software polling (TOIE = 0) where no interrupt is generated, or interrupt-driven operation (TOIE = 1) where the interrupt is generated whenever the TOF is set.

The conditions causing TOF to become set depend on whether the TPM is configured for center-aligned PWM (CPWMS = 1). If CPWMS is cleared and there is no modulus limit, the 16-bit timer counter counts from 0x0000 through 0xFFFF and overflows to 0x0000 on the next counting clock. TOF is set at the transition from 0xFFFF to 0x0000. When a modulus limit is set, TOF is set at the transition from the value set in the modulus register to 0x0000. When the TPM is in center-aligned PWM mode (CPWMS = 1), the TOF flag is set as the counter changes direction at the end of the count value set in the modulus register (at the transition from the value set in the modulus register to the next lower count value). This corresponds to the end of a PWM period (the 0x0000 count value corresponds to the center of a period).

16.4.1.3 Counting Modes

The main timer counter has two counting modes. When center-aligned PWM is selected (CPWMS = 1), the counter operates in up/down counting mode. Otherwise, the counter operates as a simple up counter. As an up counter, the timer counter counts from 0x0000 through its terminal count and continues with 0x0000. The terminal count is 0xFFFF or a modulus value in TPMxMODH:TPMxMODL.

When center-aligned PWM operation is specified, the counter counts up from 0x0000 through its terminal count and then down to 0x0000 where it changes back to up counting. The terminal count value and 0x0000 are normal length counts (one timer clock period long). In this mode, the timer overflow flag (TOF) is set at the end of the terminal-count period (as the count changes to the next lower count value).

16.4.1.4 Manual Counter Reset

The main timer counter can be manually reset at any time by writing any value to TPMxCNTH or TPMxCNTL. Resetting the counter in this manner also resets the coherency mechanism in case only half of the counter was read before resetting the count.

16.4.2 Channel Mode Selection

If CPWMS is cleared, MSnB and MSnA bits determine the basic mode of operation for the corresponding channel. Choices include input capture, output compare, and edge-aligned PWM.

16.4.2.1 Input Capture Mode

With the input capture function, the TPM can capture the time at which an external event occurs. When an active edge occurs on the pin of an input capture channel, the TPM latches the contents of the TPM counter into the channel-value registers (TPMxCnVH:TPMxCnVL). Rising edges, falling edges, or any edge is chosen as the active edge that triggers an input capture.

In input capture mode, the TPMxCnVH and TPMxCnVL registers are read only.

When either half of the 16-bit capture register is read, the other half is latched into a buffer to support coherent 16-bit accesses in big-endian or little-endian order. The coherency sequence can be manually reset by writing to TPMxCnSC.

An input capture event sets a flag bit (CHnF) that optionally generates a CPU interrupt request.

While in BDM, the input capture function works as configured. When an external event occurs, the TPM latches the contents of the TPM counter (frozen because of the BDM mode) into the channel value registers and sets the flag bit.

16.4.2.2 Output Compare Mode

With the output compare function, the TPM can generate timed pulses with programmable position, polarity, duration, and frequency. When the counter reaches the value in TPMxCnVH:TPMxCnVL registers of an output compare channel, the TPM can set, clear, or toggle the channel pin.

Writes to any of TPMxCnVH and TPMxCnVL registers actually write to buffer registers. In output compare mode, the TPMxCnVH:TPMxCnVL registers are updated with the value of their write buffer only after both bytes were written and according to the value of CLKSB:CLKSA bits:

- If CLKSB and CLKSA are cleared, the registers are updated when the second byte is written
- If CLKSB and CLKSA are not cleared, the registers are updated at the next change of the TPM counter (end of the prescaler counting) after the second byte is written.

The coherency sequence can be manually reset by writing to the channel status/control register (TPMxCnSC).

An output compare event sets a flag bit (CHnF) that optionally generates a CPU interrupt request.

16.4.2.3 Edge-Aligned PWM Mode

This type of PWM output uses the normal up-counting mode of the timer counter (CPWMS=0) and can be used when other channels in the same TPM are configured for input capture or output compare functions. The period of this PWM signal is determined by the value of the modulus register (TPMxMODH:TPMxMODL) plus 1. The duty cycle is determined by the value of the timer channel register (TPMxCnVH:TPMxCnVL). The polarity of this PWM signal is determined by ELSnA bit. 0% and 100% duty cycle cases are possible.

The time between the modulus overflow and the channel match value (TPMxCnVH:TPMxCnVL) is the pulse width or duty cycle (Figure 16-15). If ELSnA is cleared, the counter overflow forces the PWM signal high, and the channel match forces the PWM signal low. If ELSnA is set, the counter overflow forces the PWM signal low, and the channel match forces the PWM signal high.

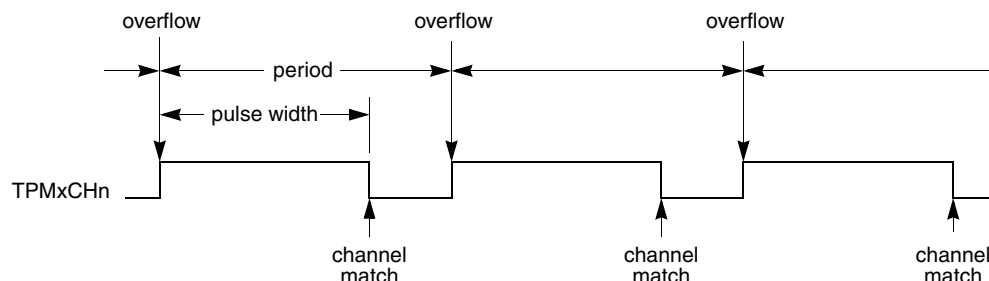


Figure 16-15. EPWM period and pulse width (ELSnA=0)

When the channel value register is set to 0x0000, the duty cycle is 0%. A 100% duty cycle is achieved by setting the timer-channel register (TPMxCnVH:TPMxCnVL) to a value greater than the modulus setting. This implies that the modulus setting must be less than 0xFFFF in order to get 100% duty cycle.

The timer channel registers are buffered to ensure coherent 16-bit updates and to avoid unexpected PWM pulse widths. Writes to any of the registers TPMxCnVH and TPMxCnVL actually write to buffer registers. In edge-aligned PWM mode, the TPMxCnVH:TPMxCnVL registers are updated with the value of their write buffer according to the value of CLKSB:CLKSA bits:

- If CLKSB and CLKSA are cleared, the registers are updated when the second byte is written
- If CLKSB and CLKSA are not cleared, the registers are updated after both bytes were written, and the TPM counter changes from (TPMxMODH:TPMxMODL – 1) to (TPMxMODH:TPMxMODL). If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFE to 0xFFFF.

16.4.2.4 Center-Aligned PWM Mode

This type of PWM output uses the up/down counting mode of the timer counter (CPWMS=1). The channel match value in TPMxCnVH:TPMxCnVL determines the pulse width (duty cycle) of the PWM signal while the period is determined by the value in TPMxMODH:TPMxMODL. TPMxMODH:TPMxMODL must be kept in the range of 0x0001 to 0x7FFF because values outside this range can produce ambiguous results. ELSnA determines the polarity of the CPWM signal.

$$\text{pulse width} = 2 \times (\text{TPMxCnVH:TPMxCnVL})$$

$$\text{period} = 2 \times (\text{TPMxMODH:TPMxMODL}); \text{TPMxMODH:TPMxMODL} = 0x0001\text{--}0x7FFF$$

If TPMxCnVH:TPMxCnVL is zero or negative (bit 15 set), the duty cycle is 0%. If TPMxCnVH:TPMxCnVL is a positive value (bit 15 clear) and is greater than the non-zero modulus setting, the duty cycle is 100% because the channel match never occurs. This implies the usable range of periods set by the modulus register is 0x0001 through 0x7FFE (0x7FFF if you do not need to generate 100% duty cycle). This is not a significant limitation. The resulting period is much longer than required for normal applications.

All zeros in TPMxMODH:TPMxMODL is a special case that must not be used with center-aligned PWM mode. When CPWMS is cleared, this case corresponds to the counter running free from 0x0000 through 0xFFFF. When CPWMS is set, the counter needs a valid match to the modulus register somewhere other than at 0x0000 in order to change directions from up-counting to down-counting.

The channel match value in the TPM channel registers (times two) determines the pulse width (duty cycle) of the CPWM signal (Figure 16-16). If ELSnA is cleared, a channel match occurring while counting up clears the CPWM output signal and a channel match occurring while counting down sets the output. The counter counts up until it reaches the modulo setting in TPMxMODH:TPMxMODL, then counts down until it reaches zero. This sets the period equal to two times TPMxMODH:TPMxMODL.

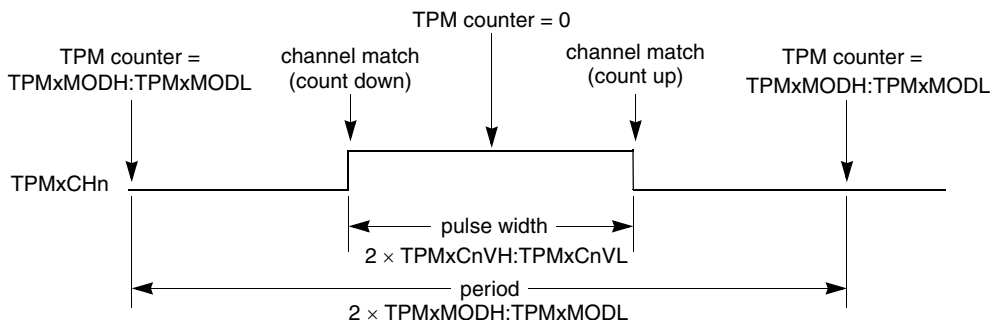


Figure 16-16. CPWM period and pulse width (ELSnA=0)

Center-aligned PWM outputs typically produce less noise than edge-aligned PWMs because fewer I/O pin transitions are lined up at the same system clock edge. This type of PWM is also required for some types of motor drives.

Input capture, output compare, and edge-aligned PWM functions do not make sense when the counter is operating in up/down counting mode so this implies that all active channels within a TPM must be used in CPWM mode when CPWMS is set.

The timer channel registers are buffered to ensure coherent 16-bit updates and to avoid unexpected PWM pulse widths. Writes to any of the registers TPMxCnVH and TPMxCnVL actually write to buffer registers. In center-aligned PWM mode, the TPMxCnVH:TPMxCnVL registers are updated with the value of their write buffer according to the value of CLKSB:CLKSA bits:

- If CLKSB and CLKSA are cleared, the registers are updated when the second byte is written
- If CLKSB and CLKSA are not cleared, the registers are updated after both bytes were written, and the TPM counter changes from (TPMxMODH:TPMxMODL – 1) to (TPMxMODH:TPMxMODL). If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFFE to 0xFFFF.

When TPMxCNTH:TPMxCNTL equals TPMxMODH:TPMxMODL, the TPM can optionally generate a TOF interrupt (at the end of this count).

16.5 Reset Overview

16.5.1 General

The TPM is reset whenever any MCU reset occurs.

16.5.2 Description of Reset Operation

Reset clears TPMxSC that disables TPM counter clock and overflow interrupt (TOIE=0). CPWMS, MSnB, MSnA, ELSnB, and ELSnA are all cleared. This configures all TPM channels for input capture operation and the associated pins are not controlled by TPM.

16.6 Interrupts

16.6.1 General

The TPM generates an optional interrupt for the main counter overflow and an interrupt for each channel. The meaning of channel interrupts depends on each channel's mode of operation. If the channel is configured for input capture, the interrupt flag is set each time the selected input capture edge is recognized. If the channel is configured for output compare or PWM modes, the interrupt flag is set each time the main timer counter matches the value in the 16-bit channel value register.

All TPM interrupts are listed in [Table 16-8](#).

Table 16-8. Interrupt Summary

Interrupt	Local Enable	Source	Description
TOF	TOIE	Counter overflow	Set each time the TPM counter reaches its terminal count (at transition to its next count value)
CHnF	CHnIE	Channel event	An input capture event or channel match took place on channel n

The TPM module provides high-truth interrupt signals.

16.6.2 Description of Interrupt Operation

For each interrupt source in the TPM, a flag bit is set upon recognition of the interrupt condition such as timer overflow, channel input capture, or output compare events. This flag is read (polled) by software to determine that the action has occurred, or an associated enable bit (TOIE or CHnIE) can be set to enable the interrupt generation. While the interrupt enable bit is set, the interrupt is generated whenever the associated interrupt flag is set. Software must perform a sequence of steps to clear the interrupt flag before returning from the interrupt-service routine.

TPM interrupt flags are cleared by a two-step process including a read of the flag bit while it is set followed by a write of zero to the bit. If a new event is detected between these two steps, the sequence is reset and the interrupt flag remains set after the second step to avoid the possibility of missing the new event.

16.6.2.1 Timer Overflow Interrupt (TOF) Description

The meaning and details of operation for TOF interrupts varies slightly depending upon the mode of operation of the TPM system (general purpose timing functions versus center-aligned PWM operation). The flag is cleared by the two step sequence described above.

16.6.2.1.1 Normal Case

When CPWMS is cleared, TOF is set when the timer counter changes from the terminal count (the value in the modulo register) to 0x0000. If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFF to 0x0000.

16.6.2.1.2 Center-Aligned PWM Case

When CPWMS is set, TOF is set when the timer counter changes direction from up-counting to down-counting at the end of the terminal count (the value in the modulo register).

16.6.2.2 Channel Event Interrupt Description

The meaning of channel interrupts depends on the channel's current mode (input capture, output compare, edge-aligned PWM, or center-aligned PWM).

16.6.2.2.1 Input Capture Events

When a channel is configured as an input capture channel, the ELSnB:ELSnA bits select if channel pin is not controlled by TPM, rising edges, falling edges, or any edge as the edge that triggers an input capture event. When the selected edge is detected, the interrupt flag is set. The flag is cleared by the two-step sequence described in [Section 16.6.2, "Description of Interrupt Operation."](#)

16.6.2.2.2 Output Compare Events

When a channel is configured as an output compare channel, the interrupt flag is set each time the main timer counter matches the 16-bit value in the channel value register. The flag is cleared by the two-step sequence described in [Section 16.6.2, "Description of Interrupt Operation."](#)

16.6.2.2.3 PWM End-of-Duty-Cycle Events

When the channel is configured for edge-aligned PWM, the channel flag is set when the timer counter matches the channel value register that marks the end of the active duty cycle period. When the channel is configured for center-aligned PWM, the timer count matches the channel value register twice during each PWM cycle. In this CPWM case, the channel flag is set at the start and at the end of the active duty cycle period when the timer counter matches the channel value register. The flag is cleared by the two-step sequence described in [Section 16.6.2, "Description of Interrupt Operation."](#)

Chapter 17

Development Support

17.1 Introduction

Development support systems in the HCS08 include the background debug controller (BDC) and the on-chip debug module (DBG). The BDC provides a single-wire debug interface to the target MCU that provides a convenient interface for programming the on-chip flash and other nonvolatile memories. The BDC is also the primary debug interface for development and allows non-intrusive access to memory data and traditional debug features such as CPU register modify, breakpoints, and single instruction trace commands.

In the HCS08 Family, address and data bus signals are not available on external pins. Debug is done through commands fed into the target MCU via the single-wire background debug interface. The debug module provides a means to selectively trigger and capture bus information so an external development system can reconstruct what happened inside the MCU on a cycle-by-cycle basis without having external access to the address and data signals.

17.1.1 Forcing Active Background

The method for forcing active background mode depends on the specific HCS08 derivative. For the MC9S08QE8 series, you can force active background after a power-on reset by holding the BKGD pin low as the device exits the reset condition. You can also force active background by driving BKGD low immediately after a serial background command that writes a one to the BDFR bit in the SBD FR register. Other causes of reset, including an external pin reset or an internally generated error reset ignore the state of the BKGD pin and reset into normal user mode. If no debug pod is connected to the BKGD pin, the MCU will always reset into normal operating mode.

17.1.2 Module Configuration

The alternate BDC clock source is the ICSLCLK. This clock source is selected by clearing the CLKSW bit in the BDCSCR register. For details on ICSLCLK, see the “Functional Description” section of the ICS chapter.

17.1.3 Features

Features of the BDC module include:

- Single pin for mode selection and background communications
- BDC registers are not located in the memory map
- SYNC command to determine target communications rate
- Non-intrusive commands for memory access
- Active background mode commands for CPU register access
- GO and TRACE1 commands
- BACKGROUND command can wake CPU from stop or wait modes
- One hardware address breakpoint built into BDC
- Oscillator runs in stop mode, if BDC enabled
- COP watchdog disabled while in active background mode

17.2 Background Debug Controller (BDC)

All MCUs in the HCS08 Family contain a single-wire background debug interface that supports in-circuit programming of on-chip nonvolatile memory and sophisticated non-intrusive debug capabilities. Unlike debug interfaces on earlier 8-bit MCUs, this system does not interfere with normal application resources. It does not use any user memory or locations in the memory map and does not share any on-chip peripherals.

BDC commands are divided into two groups:

- Active background mode commands require that the target MCU is in active background mode (the user program is not running). Active background mode commands allow the CPU registers to be read or written, and allow the user to trace one user instruction at a time, or GO to the user program from active background mode.
- Non-intrusive commands can be executed at any time even while the user's program is running. Non-intrusive commands allow a user to read or write MCU memory locations or access status and control registers within the background debug controller.

Typically, a relatively simple interface pod is used to translate commands from a host computer into commands for the custom serial interface to the single-wire background debug system. Depending on the development tool vendor, this interface pod may use a standard RS-232 serial port, a parallel printer port, or some other type of communications such as a universal serial bus (USB) to communicate between the host PC and the pod. The pod typically connects to the target system with ground, the BKGD pin, $\overline{\text{RESET}}$, and sometimes V_{DD} . An open-drain connection to reset allows the host to force a target system reset, which is useful to regain control of a lost target system or to control startup of a target system before the on-chip nonvolatile memory has been programmed. Sometimes V_{DD} can be used to allow the pod to use power from the target system to avoid the need for a separate power supply. However, if the pod is powered separately, it can be connected to a running target system without forcing a target system reset or otherwise disturbing the running application program.

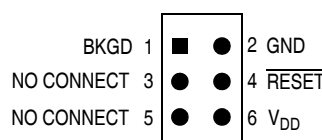


Figure 17-1. BDM Tool Connector

17.2.1 BKGD Pin Description

BKGD is the single-wire background debug interface pin. The primary function of this pin is for bidirectional serial communication of active background mode commands and data. During reset, this pin is used to select between starting in active background mode or starting the user's application program. This pin is also used to request a timed sync response pulse to allow a host development tool to determine the correct clock frequency for background debug serial communications.

BDC serial communications use a custom serial protocol first introduced on the M68HC12 Family of microcontrollers. This protocol assumes the host knows the communication clock rate that is determined by the target BDC clock rate. All communication is initiated and controlled by the host that drives a high-to-low edge to signal the beginning of each bit time. Commands and data are sent most significant bit first (MSB first). For a detailed description of the communications protocol, refer to [Section 17.2.2, "Communication Details."](#)

If a host is attempting to communicate with a target MCU that has an unknown BDC clock rate, a SYNC command may be sent to the target MCU to request a timed sync response signal from which the host can determine the correct communication speed.

BKGD is a pseudo-open-drain pin and there is an on-chip pullup so no external pullup resistor is required. Unlike typical open-drain pins, the external RC time constant on this pin, which is influenced by external capacitance, plays almost no role in signal rise time. The custom protocol provides for brief, actively driven speedup pulses to force rapid rise times on this pin without risking harmful drive level conflicts. Refer to [Section 17.2.2, "Communication Details,"](#) for more detail.

When no debugger pod is connected to the 6-pin BDM interface connector, the internal pullup on BKGD chooses normal operating mode. When a debug pod is connected to BKGD it is possible to force the MCU into active background mode after reset. The specific conditions for forcing active background depend upon the HCS08 derivative (refer to the introduction to this Development Support section). It is not necessary to reset the target MCU to communicate with it through the background debug interface.

17.2.2 Communication Details

The BDC serial interface requires the external controller to generate a falling edge on the BKGD pin to indicate the start of each bit time. The external controller provides this falling edge whether data is transmitted or received.

BKGD is a pseudo-open-drain pin that can be driven either by an external controller or by the MCU. Data is transferred MSB first at 16 BDC clock cycles per bit (nominal speed). The interface times out if 512 BDC clock cycles occur between falling edges from the host. Any BDC command that was in progress

when this timeout occurs is aborted without affecting the memory or operating mode of the target MCU system.

The custom serial protocol requires the debug pod to know the target BDC communication clock speed.

The clock switch (CLKSW) control bit in the BDC status and control register allows the user to select the BDC clock source. The BDC clock source can either be the bus or the alternate BDC clock source.

The BKGD pin can receive a high or low level or transmit a high or low level. The following diagrams show timing for each of these cases. Interface timing is synchronous to clocks in the target BDC, but asynchronous to the external host. The internal BDC clock signal is shown for reference in counting cycles.

Figure 17-2 shows an external host transmitting a logic 1 or 0 to the BKGD pin of a target HCS08 MCU. The host is asynchronous to the target so there is a 0-to-1 cycle delay from the host-generated falling edge to where the target perceives the beginning of the bit time. Ten target BDC clock cycles later, the target senses the bit level on the BKGD pin. Typically, the host actively drives the pseudo-open-drain BKGD pin during host-to-target transmissions to speed up rising edges. Because the target does not drive the BKGD pin during the host-to-target transmission period, there is no need to treat the line as an open-drain signal during this period.

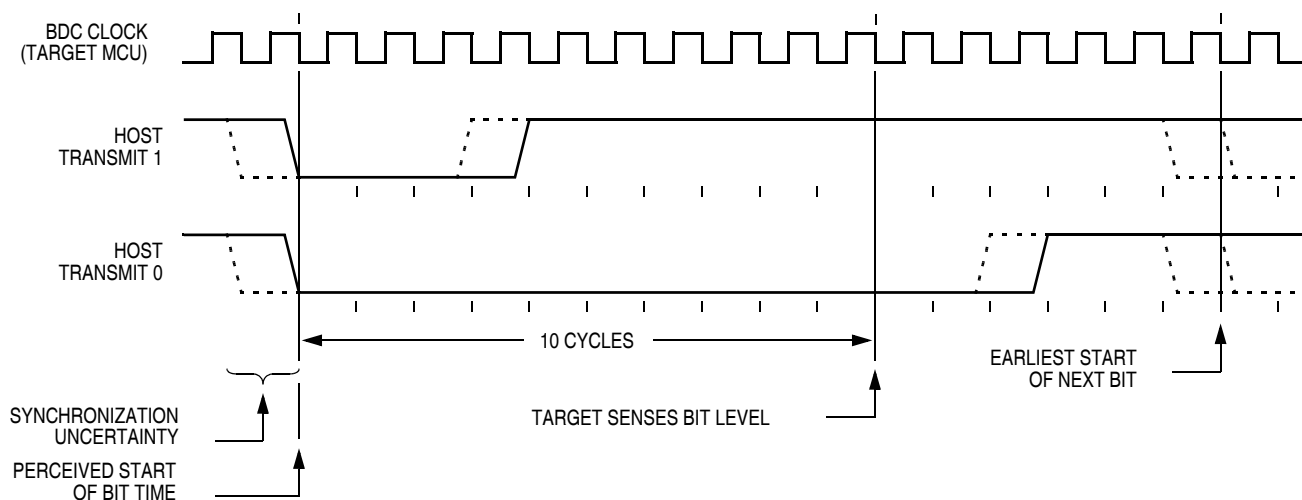


Figure 17-2. BDC Host-to-Target Serial Bit Timing

Figure 17-3 shows the host receiving a logic 1 from the target HCS08 MCU. Because the host is asynchronous to the target MCU, there is a 0-to-1 cycle delay from the host-generated falling edge on BKGD to the perceived start of the bit time in the target MCU. The host holds the BKGD pin low long enough for the target to recognize it (at least two target BDC cycles). The host must release the low drive before the target MCU drives a brief active-high speedup pulse seven cycles after the perceived start of the bit time. The host should sample the bit level about 10 cycles after it started the bit time.

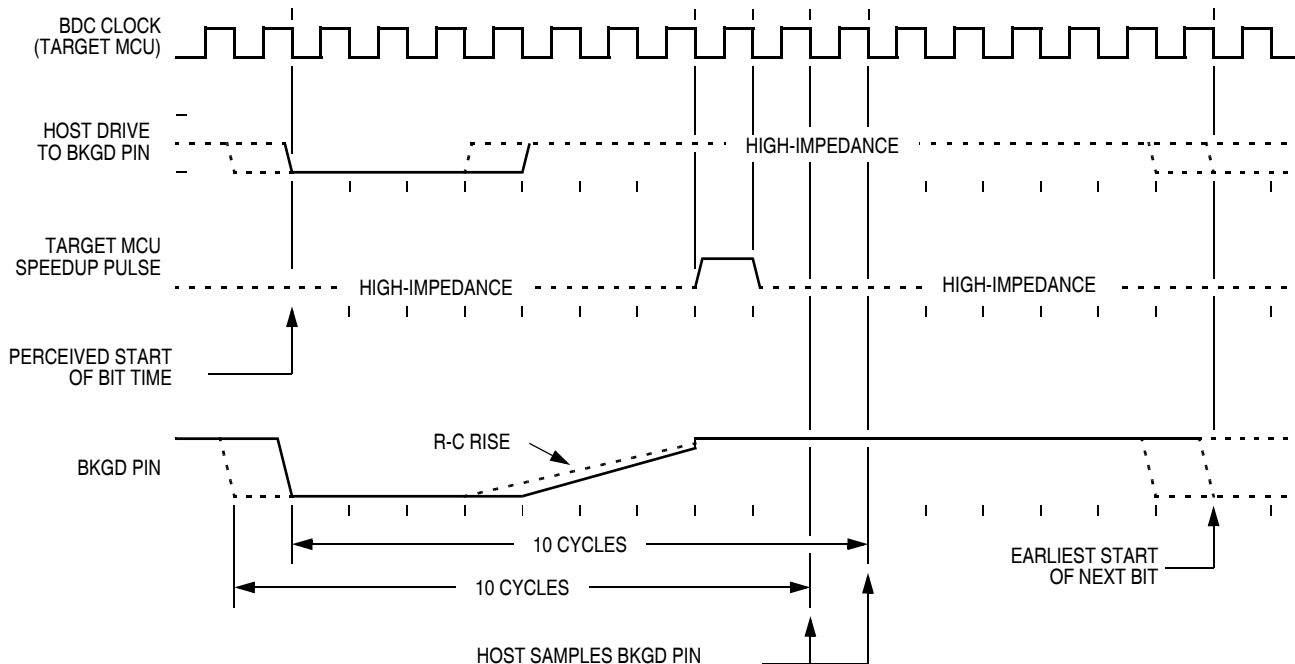


Figure 17-3. BDC Target-to-Host Serial Bit Timing (Logic 1)

Figure 17-4 shows the host receiving a logic 0 from the target HCS08 MCU. Because the host is asynchronous to the target MCU, there is a 0-to-1 cycle delay from the host-generated falling edge on BKGD to the start of the bit time as perceived by the target MCU. The host initiates the bit time but the target HCS08 finishes it. Because the target wants the host to receive a logic 0, it drives the BKGD pin low for 13 BDC clock cycles, then briefly drives it high to speed up the rising edge. The host samples the bit level about 10 cycles after starting the bit time.

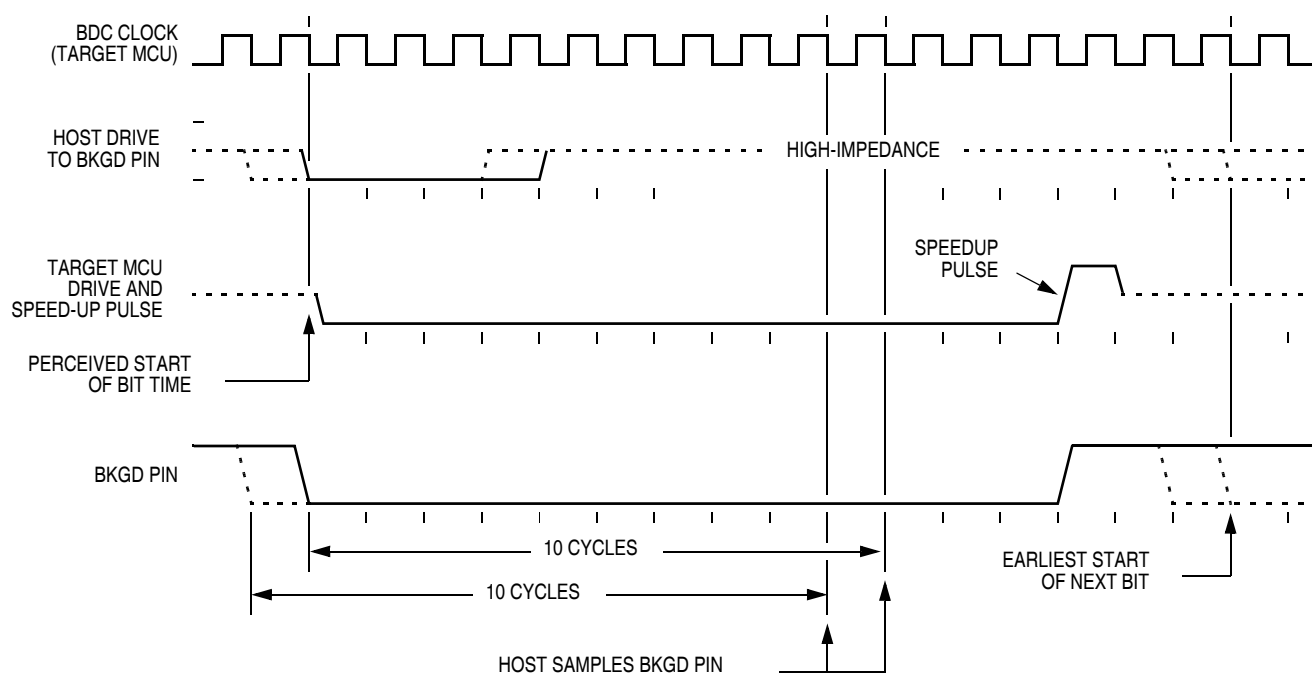


Figure 17-4. BDM Target-to-Host Serial Bit Timing (Logic 0)

17.2.3 BDC Commands

BDC commands are sent serially from a host computer to the BKGD pin of the target HCS08 MCU. All commands and data are sent MSB-first using a custom BDC communications protocol. Active background mode commands require that the target MCU is currently in the active background mode while non-intrusive commands may be issued at any time whether the target MCU is in active background mode or running a user application program.

Table 17-1 shows all HCS08 BDC commands, a shorthand description of their coding structure, and the meaning of each command.

Coding Structure Nomenclature

This nomenclature is used in Table 17-1 to describe the coding structure of the BDC commands.

Commands begin with an 8-bit hexadecimal command code in the host-to-target direction (most significant bit first)

- / = separates parts of the command
- d = delay 16 target BDC clock cycles
- AAAA = a 16-bit address in the host-to-target direction
- RD = 8 bits of read data in the target-to-host direction
- WD = 8 bits of write data in the host-to-target direction
- RD16 = 16 bits of read data in the target-to-host direction
- WD16 = 16 bits of write data in the host-to-target direction
- SS = the contents of BDCSCR in the target-to-host direction (STATUS)
- CC = 8 bits of write data for BDCSCR in the host-to-target direction (CONTROL)
- RBKP = 16 bits of read data in the target-to-host direction (from BDCBKPT breakpoint register)
- WBKP = 16 bits of write data in the host-to-target direction (for BDCBKPT breakpoint register)

Table 17-1. BDC Command Summary

Command Mnemonic	Active BDM/ Non-intrusive	Coding Structure	Description
SYNC	Non-intrusive	n/a ¹	Request a timed reference pulse to determine target BDC communication speed
ACK_ENABLE	Non-intrusive	D5/d	Enable acknowledge protocol. Refer to Freescale document order no. HCS08RMv1/D.
ACK_DISABLE	Non-intrusive	D6/d	Disable acknowledge protocol. Refer to Freescale document order no. HCS08RMv1/D.
BACKGROUND	Non-intrusive	90/d	Enter active background mode if enabled (ignore if ENBDM bit equals 0)
READ_STATUS	Non-intrusive	E4/SS	Read BDC status from BDCSCR
WRITE_CONTROL	Non-intrusive	C4/CC	Write BDC controls in BDCSCR
READ_BYTE	Non-intrusive	E0/AAAA/d/RD	Read a byte from target memory
READ_BYTE_WS	Non-intrusive	E1/AAAA/d/SS/RD	Read a byte and report status
READ_LAST	Non-intrusive	E8/SS/RD	Re-read byte from address just read and report status
WRITE_BYTE	Non-intrusive	C0/AAAA/WD/d	Write a byte to target memory
WRITE_BYTE_WS	Non-intrusive	C1/AAAA/WD/d/SS	Write a byte and report status
READ_BKPT	Non-intrusive	E2/RBKP	Read BDCBKPT breakpoint register
WRITE_BKPT	Non-intrusive	C2/WBKP	Write BDCBKPT breakpoint register
GO	Active BDM	08/d	Go to execute the user application program starting at the address currently in the PC

Table 17-1. BDC Command Summary (continued)

Command Mnemonic	Active BDM/ Non-intrusive	Coding Structure	Description
TRACE1	Active BDM	10/d	Trace 1 user instruction at the address in the PC, then return to active background mode
TAGGO	Active BDM	18/d	Same as GO but enable external tagging (HCS08 devices have no external tagging pin)
READ_A	Active BDM	68/d/RD	Read accumulator (A)
READ_CCR	Active BDM	69/d/RD	Read condition code register (CCR)
READ_PC	Active BDM	6B/d/RD16	Read program counter (PC)
READ_HX	Active BDM	6C/d/RD16	Read H and X register pair (H:X)
READ_SP	Active BDM	6F/d/RD16	Read stack pointer (SP)
READ_NEXT	Active BDM	70/d/RD	Increment H:X by one then read memory byte located at H:X
READ_NEXT_WS	Active BDM	71/d/SS/RD	Increment H:X by one then read memory byte located at H:X. Report status and data.
WRITE_A	Active BDM	48/WD/d	Write accumulator (A)
WRITE_CCR	Active BDM	49/WD/d	Write condition code register (CCR)
WRITE_PC	Active BDM	4B/WD16/d	Write program counter (PC)
WRITE_HX	Active BDM	4C/WD16/d	Write H and X register pair (H:X)
WRITE_SP	Active BDM	4F/WD16/d	Write stack pointer (SP)
WRITE_NEXT	Active BDM	50/WD/d	Increment H:X by one, then write memory byte located at H:X
WRITE_NEXT_WS	Active BDM	51/WD/d/SS	Increment H:X by one, then write memory byte located at H:X. Also report status.

¹ The SYNC command is a special operation that does not have a command code.

The SYNC command is unlike other BDC commands because the host does not necessarily know the correct communications speed to use for BDC communications until after it has analyzed the response to the SYNC command.

To issue a SYNC command, the host:

- Drives the BKGD pin low for at least 128 cycles of the slowest possible BDC clock (The slowest clock is normally the reference oscillator/64 or the self-clocked rate/64.)
- Drives BKGD high for a brief speedup pulse to get a fast rise time (This speedup pulse is typically one cycle of the fastest clock in the system.)
- Removes all drive to the BKGD pin so it reverts to high impedance

- Monitors the BKGD pin for the sync response pulse

The target, upon detecting the SYNC request from the host (which is a much longer low time than would ever occur during normal BDC communications):

- Waits for BKGD to return to a logic high
- Delays 16 cycles to allow the host to stop driving the high speedup pulse
- Drives BKGD low for 128 BDC clock cycles
- Drives a 1-cycle high speedup pulse to force a fast rise time on BKGD
- Removes all drive to the BKGD pin so it reverts to high impedance

The host measures the low time of this 128-cycle sync response pulse and determines the correct speed for subsequent BDC communications. Typically, the host can determine the correct communication speed within a few percent of the actual target speed and the communication protocol can easily tolerate speed errors of several percent.

17.2.4 BDC Hardware Breakpoint

The BDC includes one relatively simple hardware breakpoint that compares the CPU address bus to a 16-bit match value in the BDCBKPT register. This breakpoint can generate a forced breakpoint or a tagged breakpoint. A forced breakpoint causes the CPU to enter active background mode at the first instruction boundary following any access to the breakpoint address. The tagged breakpoint causes the instruction opcode at the breakpoint address to be tagged so that the CPU will enter active background mode rather than executing that instruction if and when it reaches the end of the instruction queue. This implies that tagged breakpoints can only be placed at the address of an instruction opcode while forced breakpoints can be set at any address.

The breakpoint enable (BKPTEN) control bit in the BDC status and control register (BDCSCR) is used to enable the breakpoint logic (BKPTEN = 1). When BKPTEN = 0, its default value after reset, the breakpoint logic is disabled and no BDC breakpoints are requested regardless of the values in other BDC breakpoint registers and control bits. The force/tag select (FTS) control bit in BDCSCR is used to select forced (FTS = 1) or tagged (FTS = 0) type breakpoints.

17.3 Register Definition

This section contains the descriptions of the BDC registers and control bits.

This section refers to registers and control bits only by their names. A Freescale-provided equate or header file is used to translate these names into the appropriate absolute addresses.

17.3.1 BDC Registers and Control Bits

The BDC has two registers:

- The BDC status and control register (BDCSCR) is an 8-bit register containing control and status bits for the background debug controller.
- The BDC breakpoint match register (BDCBKPT) holds a 16-bit breakpoint match address.

These registers are accessed with dedicated serial BDC commands and are not located in the memory space of the target MCU (so they do not have addresses and cannot be accessed by user programs).

Some of the bits in the BDCSCR have write limitations; otherwise, these registers may be read or written at any time. For example, the ENBDM control bit may not be written while the MCU is in active background mode. (This prevents the ambiguous condition of the control bit forbidding active background mode while the MCU is already in active background mode.) Also, the four status bits (BDMACT, WS, WSF, and DVF) are read-only status indicators and can never be written by the WRITE_CONTROL serial BDC command. The clock switch (CLKSW) control bit may be read or written at any time.

17.3.1.1 BDC Status and Control Register (BDCSCR)

This register can be read or written by serial BDC commands (READ_STATUS and WRITE_CONTROL) but is not accessible to user programs because it is not located in the normal memory map of the MCU.

	7	6	5	4	3	2	1	0
R	ENBDM	BDMACT	BKPTEN	FTS	CLKSW	WS	WSF	DVF
W								
Normal Reset	0	0	0	0	0	0	0	0
Reset in Active BDM:	1	1	0	0	1	0	0	0

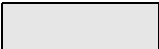
 = Unimplemented or Reserved

Figure 17-5. BDC Status and Control Register (BDCSCR)

Table 17-2. BDCSCR Register Field Descriptions

Field	Description
7 ENBDM	Enable BDM (Permit Active Background Mode) — Typically, this bit is written to 1 by the debug host shortly after the beginning of a debug session or whenever the debug host resets the target and remains 1 until a normal reset clears it. 0 BDM cannot be made active (non-intrusive commands still allowed) 1 BDM can be made active to allow active background mode commands
6 BDMACT	Background Mode Active Status — This is a read-only status bit. 0 BDM not active (user application program running) 1 BDM active and waiting for serial commands
5 BKPTEN	BDC Breakpoint Enable — If this bit is clear, the BDC breakpoint is disabled and the FTS (force tag select) control bit and BDCBKPT match register are ignored. 0 BDC breakpoint disabled 1 BDC breakpoint enabled

Table 17-2. BDCSCR Register Field Descriptions (continued)

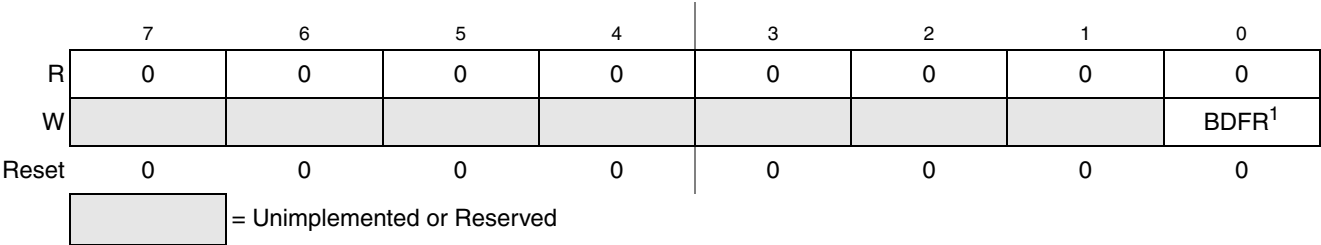
Field	Description
4 FTS	Force/Tag Select — When FTS = 1, a breakpoint is requested whenever the CPU address bus matches the BDCBKPT match register. When FTS = 0, a match between the CPU address bus and the BDCBKPT register causes the fetched opcode to be tagged. If this tagged opcode ever reaches the end of the instruction queue, the CPU enters active background mode rather than executing the tagged opcode. 0 Tag opcode at breakpoint address and enter active background mode if CPU attempts to execute that instruction 1 Breakpoint match forces active background mode at next instruction boundary (address need not be an opcode)
3 CLKSW	Select Source for BDC Communications Clock — CLKSW defaults to 0, which selects the alternate BDC clock source. 0 Alternate BDC clock source 1 MCU bus clock
2 WS	Wait or Stop Status — When the target CPU is in wait or stop mode, most BDC commands cannot function. However, the BACKGROUND command can be used to force the target CPU out of wait or stop and into active background mode where all BDC commands work. Whenever the host forces the target MCU into active background mode, the host should issue a READ_STATUS command to check that BDMACT = 1 before attempting other BDC commands. 0 Target CPU is running user application code or in active background mode (was not in wait or stop mode when background became active) 1 Target CPU is in wait or stop mode, or a BACKGROUND command was used to change from wait or stop to active background mode
1 WSF	Wait or Stop Failure Status — This status bit is set if a memory access command failed due to the target CPU executing a wait or stop instruction at or about the same time. The usual recovery strategy is to issue a BACKGROUND command to get out of wait or stop mode into active background mode, repeat the command that failed, then return to the user program. (Typically, the host would restore CPU registers and stack values and re-execute the wait or stop instruction.) 0 Memory access did not conflict with a wait or stop instruction 1 Memory access command failed because the CPU entered wait or stop mode
0 DVF	Data Valid Failure Status — This status bit is not used in the MC9S08QE8 Series because it does not have any slow access memory. 0 Memory access did not conflict with a slow memory access 1 Memory access command failed because CPU was not finished with a slow memory access

17.3.1.2 BDC Breakpoint Match Register (BDCBKPT)

This 16-bit register holds the address for the hardware breakpoint in the BDC. The BKPTEN and FTS control bits in BDCSCR are used to enable and configure the breakpoint logic. Dedicated serial BDC commands (READ_BKPT and WRITE_BKPT) are used to read and write the BDCBKPT register but is not accessible to user programs because it is not located in the normal memory map of the MCU. Breakpoints are normally set while the target MCU is in active background mode before running the user application program. For additional information about setup and use of the hardware breakpoint logic in the BDC, refer to [Section 17.2.4, “BDC Hardware Breakpoint.”](#)

17.3.2 System Background Debug Force Reset Register (SBDFR)

This register contains a single write-only control bit. A serial background mode command such as WRITE_BYTE must be used to write to SBDFR. Attempts to write this register from a user program are ignored. Reads always return 0x00.



¹ BDFR is writable only through serial background mode debug commands, not from user programs.

Figure 17-6. System Background Debug Force Reset Register (SBDFR)

Table 17-3. SBDFR Register Field Description

Field	Description
0 BDFR	Background Debug Force Reset — A serial active background mode command such as WRITE_BYTE allows an external debug host to force a target system reset. Writing 1 to this bit forces an MCU reset. This bit cannot be written from a user program.

Chapter 18

Debug Module (S08DBGV3) (64K)

18.1 Introduction

The DBG module implements an on-chip ICE (in-circuit emulation) system and allows non-intrusive debug of application software by providing an on-chip trace buffer with flexible triggering capability. The trigger also can provide extended breakpoint capacity. The on-chip ICE system is optimized for the HCS08 8-bit architecture and supports 64K bytes or 128K bytes of memory space.

18.1.1 Features

The on-chip ICE system includes these distinctive features:

- Three comparators (A, B, and C) with ability to match addresses in 64K space
 - Dual mode, Comparators A and B used to compare addresses
 - Full mode, Comparator A compares address and Comparator B compares data
 - Can be used as triggers and/or breakpoints
 - Comparator C can be used as a normal hardware breakpoint
 - Loop1 capture mode, Comparator C is used to track most recent COF event captured into FIFO
- Tag and Force type breakpoints
- Nine trigger modes
 - A
 - A Or B
 - A Then B
 - A And B, where B is data (Full mode)
 - A And Not B, where B is data (Full mode)
 - Event Only B, store data
 - A Then Event Only B, store data
 - Inside Range, $A \leq \text{Address} \leq B$
 - Outside Range, $\text{Address} < A$ or $\text{Address} > B$
- FIFO for storing change of flow information and event only data
 - Source address of conditional branches taken
 - Destination address of indirect JMP and JSR instruction
 - Destination address of interrupts, RTI, RTC, and RTS instruction
 - Data associated with Event B trigger modes

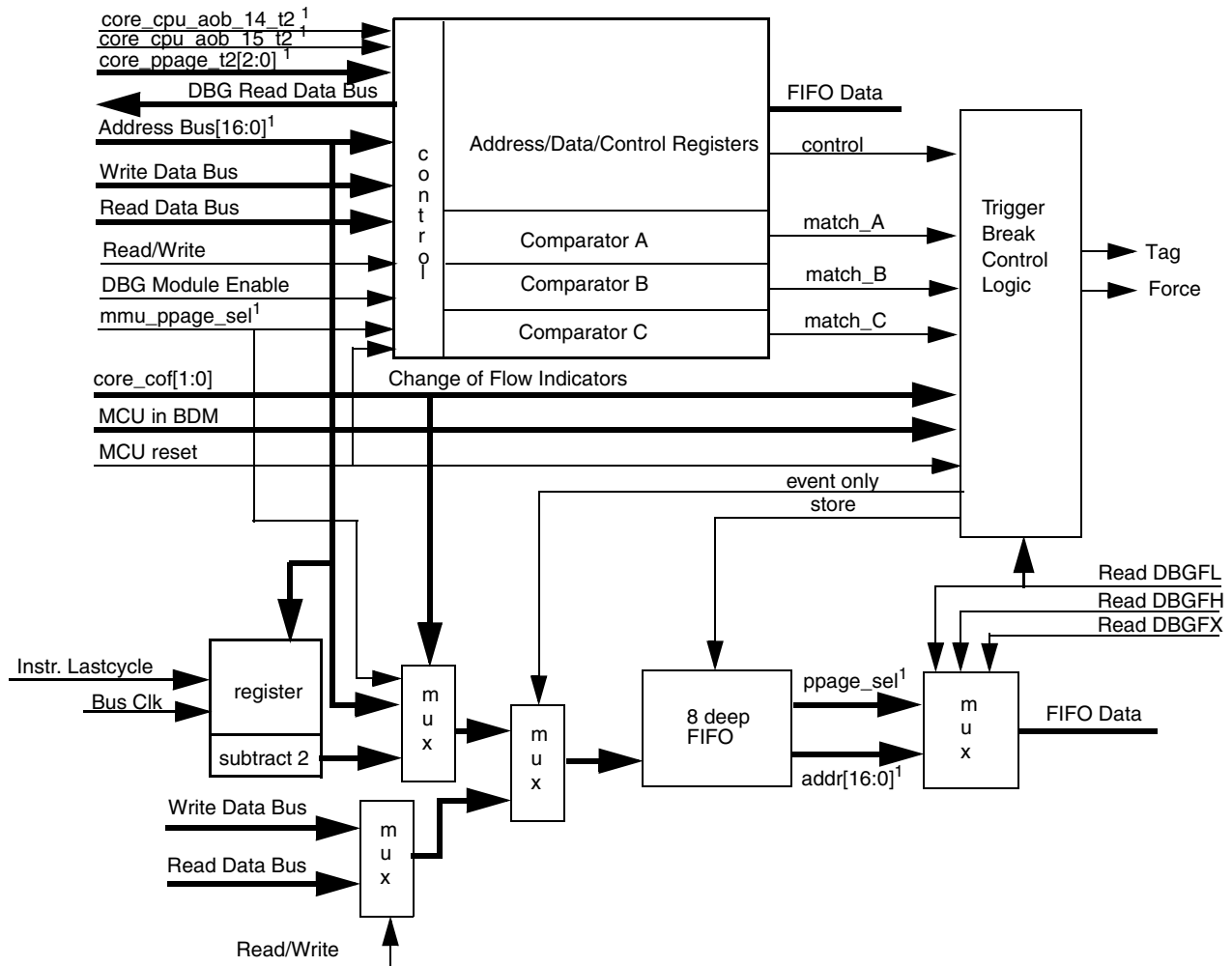
- Ability to End-trace until reset and Begin-trace from reset

18.1.2 Modes of Operation

The on-chip ICE system can be enabled in all MCU functional modes. The DBG module is disabled if the MCU is secure. The DBG module comparators are disabled when executing a Background Debug Mode (BDM) command.

18.1.3 Block Diagram

Figure 18-1 shows the structure of the DBG module.



1. In 64K versions of this module there are only 16 address lines [15:0], there are no core_cpu_aob_14_t2, core_cpu_aob_15_t2, core_ppage_t2[2:0], and ppage_sel signals.

Figure 18-1. DBG Block Diagram

18.2 Signal Description

The DBG module contains no external signals.

18.3 Memory Map and Registers

This section provides a detailed description of all DBG registers accessible to the end user.

18.3.1 Module Memory Map

Table 18-1 shows the registers contained in the DBG module.

Table 18-1. Module Memory Map

Address	Use	Access
Base + \$0000	Debug Comparator A High Register (DBGCAH)	Read/write
Base + \$0001	Debug Comparator A Low Register (DBGCAL)	Read/write
Base + \$0002	Debug Comparator B High Register (DBGCBH)	Read/write
Base + \$0003	Debug Comparator B Low Register (DBGCBL)	Read/write
Base + \$0004	Debug Comparator C High Register (DBGCCH)	Read/write
Base + \$0005	Debug Comparator C Low Register (DBGCCL)	Read/write
Base + \$0006	Debug FIFO High Register (DBGFH)	Read only
Base + \$0007	Debug FIFO Low Register (DBGFL)	Read only
Base + \$0008	Debug Comparator A Extension Register (DBGCAH)	Read/write
Base + \$0009	Debug Comparator B Extension Register (DBGCBH)	Read/write
Base + \$000A	Debug Comparator C Extension Register (DBGCCX)	Read/write
Base + \$000B	reserved	Read only
Base + \$000C	Debug Control Register (DBGCR)	Read/write
Base + \$000D	Debug Trigger Register (DBGTR)	Read/write
Base + \$000E	Debug Status Register (DBGSR)	Read only
Base + \$000F	Debug FIFO Count Register (DBGFCNT)	Read only

18.3.2 Register Descriptions

Table 18-2. Register Bit Summary

	7	6	5	4	3	2	1	0
DBGCAH	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
DBGCAL	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DBGCBH	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
DBGCBL	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DBGCCH	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
DBGCCL	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DBGFHH	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
DBGFHL	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DBGCAH	RWAEN	RWA	0	0	0	0	0	0
DBGCBH	RWBEN	RWB	0	0	0	0	0	0
DBGCCX	RWCEN	RWC	0	0	0	0	0	0
reserved	0	0	0	0	0	0	0	0
DBGC	DBGEN	ARM	TAG	BRKEN	-	-	-	LOOP1
DBGT	TRGSEL	BEGIN	0	0	TRG[3:0]			
DBGS	AF	BF	CF	0	0	0	0	ARMF
DBGCNT	0	0	0	0	CNT[3:0]			

This section consists of the DBG register descriptions in address order.

Note: For all registers below, consider: U = Unchanged, bit maintain its value after reset.

18.3.2.1 Debug Comparator A High Register (DBGCAH)

Module Base + 0x0000

	7	6	5	4	3	2	1	0
R	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
POR or non-end-run	1	1	1	1	1	1	1	1
Reset end-run¹	U	U	U	U	U	U	U	U

Figure 18-2. Debug Comparator A High Register (DBGCAH)

¹ In the case of an end-trace to reset where DBGGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-3. DBGCAH Field Descriptions

Field	Description
Bits 15–8	Comparator A High Compare Bits — The Comparator A High compare bits control whether Comparator A will compare the address bus bits [15:8] to a logic 1 or logic 0. 0 Compare corresponding address bit to a logic 0 1 Compare corresponding address bit to a logic 1

18.3.2.2 Debug Comparator A Low Register (DBGCAL)

Module Base + 0x0001

	7	6	5	4	3	2	1	0
R								
W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
POR or non- end-run	1	1	1	1	1	1	1	0
Reset end-run ¹	U	U	U	U	U	U	U	U

Figure 18-3. Debug Comparator A Low Register (DBGCAL)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-4. DBGCAL Field Descriptions

Field	Description
Bits 7–0	Comparator A Low Compare Bits — The Comparator A Low compare bits control whether Comparator A will compare the address bus bits [7:0] to a logic 1 or logic 0. 0 Compare corresponding address bit to a logic 0 1 Compare corresponding address bit to a logic 1

18.3.2.3 Debug Comparator B High Register (DBGCBH)

Module Base + 0x0002

	7	6	5	4	3	2	1	0
R								
W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	U	U	U	U	U

Figure 18-4. Debug Comparator B High Register (DBGCBH)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-5. DBGCBH Field Descriptions

Field	Description
Bits 15–8	Comparator B High Compare Bits — The Comparator B High compare bits control whether Comparator B will compare the address bus bits [15:8] to a logic 1 or logic 0. Not used in Full mode. 0 Compare corresponding address bit to a logic 0 1 Compare corresponding address bit to a logic 1

18.3.2.4 Debug Comparator B Low Register (DBGCBL)

Module Base + 0x0003

	7	6	5	4	3	2	1	0
R								
W								
POR								
or non-								
end-run	0	0	0	0	0	0	0	0
Reset								
end-run ¹	U	U	U	U	U	U	U	U

Figure 18-5. Debug Comparator B Low Register (DBGCBL)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-6. DBGCBL Field Descriptions

Field	Description
Bits 7–0	Comparator B Low Compare Bits — The Comparator B Low compare bits control whether Comparator B will compare the address bus or data bus bits [7:0] to a logic 1 or logic 0. 0 Compare corresponding address bit to a logic 0, compares to data if in Full mode 1 Compare corresponding address bit to a logic 1, compares to data if in Full mode

18.3.2.5 Debug Comparator C High Register (DBGCCCH)

Module Base + 0x0004

	7	6	5	4	3	2	1	0
R	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	U	U	U	U	U

Figure 18-6. Debug Comparator C High Register (DBGCCCH)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-7. DBGCCCH Field Descriptions

Field	Description
Bits 15–8	Comparator C High Compare Bits — The Comparator C High compare bits control whether Comparator C will compare the address bus bits [15:8] to a logic 1 or logic 0. 0 Compare corresponding address bit to a logic 0 1 Compare corresponding address bit to a logic 1

18.3.2.6 Debug Comparator C Low Register (DBGCCCL)

Module Base + 0x0005

	7	6	5	4	3	2	1	0
R	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	U	U	U	U	U

Figure 18-7. Debug Comparator C Low Register (DBGCCCL)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-8. DBGCCCL Field Descriptions

Field	Description
Bits 7–0	Comparator C Low Compare Bits — The Comparator C Low compare bits control whether Comparator C will compare the address bus bits [7:0] to a logic 1 or logic 0. 0 Compare corresponding address bit to a logic 0 1 Compare corresponding address bit to a logic 1

18.3.2.7 Debug FIFO High Register (DBGFH)

Module Base + 0x0006

	7	6	5	4	3	2	1	0
R	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	U	U	U	U	U

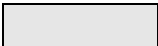
 = Unimplemented or Reserved

Figure 18-8. Debug FIFO High Register (DBGFH)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-9. DBGFH Field Descriptions

Field	Description
Bits 15–8	FIFO High Data Bits — The FIFO High data bits provide access to bits [15:8] of data in the FIFO. This register is not used in event only modes and will read a \$00 for valid FIFO words.

18.3.2.8 Debug FIFO Low Register (DBGFL)

Module Base + 0x0007

	7	6	5	4	3	2	1	0
R	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	U	U	U	U	U

 = Unimplemented or Reserved

Figure 18-9. Debug FIFO Low Register (DBGFL)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-10. DBGFL Field Descriptions

Field	Description
Bits 7–0	FIFO Low Data Bits — The FIFO Low data bits contain the least significant byte of data in the FIFO. When reading FIFO words, read DBGFX and DBGFH before reading DBGFL because reading DBGFL causes the FIFO pointers to advance to the next FIFO location. In event-only modes, there is no useful information in DBGFX and DBGFH so it is not necessary to read them before reading DBGFL.

18.3.2.9 Debug Comparator A Extension Register (DBGCAx)

Module Base + 0x0008

	7	6	5	4	3	2	1	0
R	RWAEN	RWA	0	0	0	0	0	0
W								
POR or non-end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	0	0	0	0	U


 = Unimplemented or Reserved

Figure 18-10. Debug Comparator A Extension Register (DBGCAx)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-11. DBGCAx Field Descriptions

Field	Description
7 RWAEN	Read/Write Comparator A Enable Bit — The RWAEN bit controls whether read or write comparison is enabled for Comparator A. 0 Read/Write is not used in comparison 1 Read/Write is used in comparison
6 RWA	Read/Write Comparator A Value Bit — The RWA bit controls whether read or write is used in compare for Comparator A. The RWA bit is not used if RWAEN = 0. 0 Write cycle will be matched 1 Read cycle will be matched

18.3.2.10 Debug Comparator B Extension Register (DBGCBX)

Module Base + 0x0009

	7	6	5	4	3	2	1	0
R	RWBEN	RWB	0	0	0	0	0	0
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	0	0	0	0	U


 = Unimplemented or Reserved

Figure 18-11. Debug Comparator B Extension Register (DBGCBX)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-12. DBGCBX Field Descriptions

Field	Description
7 RWBEN	Read/Write Comparator B Enable Bit — The RWBEN bit controls whether read or write comparison is enabled for Comparator B. In full modes, RWAEN and RWA are used to control comparison of R/W and RWBEN is ignored. 0 Read/Write is not used in comparison 1 Read/Write is used in comparison
6 RWB	Read/Write Comparator B Value Bit — The RWB bit controls whether read or write is used in compare for Comparator B. The RWB bit is not used if RWBEN = 0. In full modes, RWAEN and RWA are used to control comparison of R/W and RWB is ignored. 0 Write cycle will be matched 1 Read cycle will be matched

18.3.2.11 Debug Comparator C Extension Register (DBGCCX)

Module Base + 0x000A

	7	6	5	4	3	2	1	0
R	RWCEN	RWC	0	0	0	0	0	0
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	U	U	U	0	0	0	0	U


 = Unimplemented or Reserved

Figure 18-12. Debug Comparator C Extension Register (DBGCCX)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the bits in this register do not change after reset.

Table 18-13. DBGCCX Field Descriptions

Field	Description
7 RWCEN	Read/Write Comparator C Enable Bit — The RWCEN bit controls whether read or write comparison is enabled for Comparator C. 0 Read/Write is not used in comparison 1 Read/Write is used in comparison
6 RWC	Read/Write Comparator C Value Bit — The RWC bit controls whether read or write is used in compare for Comparator C. The RWC bit is not used if RWCEN = 0. 0 Write cycle will be matched 1 Read cycle will be matched

18.3.2.12 Debug Control Register (DBGC)

Module Base + 0x000C

	7	6	5	4	3	2	1	0
R	DBGEN	ARM	TAG	BRKEN	0	0	0	LOOP1
W								
POR or non-end-run	1	1	0	0	0	0	0	0
Reset end-run ¹	U	0	U	0	0	0	0	U
	= Unimplemented or Reserved							

Figure 18-13. Debug Control Register (DBGC)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the ARM and BRKEN bits are cleared but the remaining control bits in this register do not change after reset.

Table 18-14. DBGC Field Descriptions

Field	Description
7 DBGEN	DBG Module Enable Bit — The DBGEN bit enables the DBG module. The DBGEN bit is forced to zero and cannot be set if the MCU is secure. 0 DBG not enabled 1 DBG enabled
6 ARM	Arm Bit — The ARM bit controls whether the debugger is comparing and storing data in FIFO. See Section 18.4.4.2, “Arming the DBG Module” for more information. 0 Debugger not armed 1 Debugger armed
5 TAG	Tag or Force Bit — The TAG bit controls whether a debugger or comparator C breakpoint will be requested as a tag or force breakpoint to the CPU. The TAG bit is not used if BRKEN = 0. 0 Force request selected 1 Tag request selected
4 BRKEN	Break Enable Bit — The BRKEN bit controls whether the debugger will request a breakpoint to the CPU at the end of a trace run, and whether comparator C will request a breakpoint to the CPU. 0 CPU break request not enabled 1 CPU break request enabled
0 LOOP1	Select LOOP1 Capture Mode — This bit selects either normal capture mode or LOOP1 capture mode. LOOP1 is not used in event-only modes. 0 Normal operation - capture COF events into the capture buffer FIFO 1 LOOP1 capture mode enabled. When the conditions are met to store a COF value into the FIFO, compare the current COF address with the address in comparator C. If these addresses match, override the FIFO capture and do not increment the FIFO count. If the address does not match comparator C, capture the COF address, including the PPACC indicator, into the FIFO and into comparator C.

18.3.2.13 Debug Trigger Register (DBGT)

Module Base + 0x000D

	7	6	5	4	3	2	1	0
R	TRGSEL	BEGIN	0	0	TRG			
W ²								
POR or non- end-run	0	1	0	0	0	0	0	0
Reset end-run ¹	U	U	0	0	U	U	U	U


 = Unimplemented or Reserved

Figure 18-14. Debug Trigger Register (DBGT)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the control bits in this register do not change after reset.

² The DBG trigger register (DBGT) can not be changed unless ARM=0.

Table 18-15. DBGT Field Descriptions

Field	Description
7 TRGSEL	Trigger Selection Bit — The TRGSEL bit controls the triggering condition for the comparators. See Section 18.4.4, “Trigger Break Control (TBC)” for more information. 0 Trigger on any compare address access 1 Trigger if opcode at compare address is executed
6 BEGIN	Begin/End Trigger Bit — The BEGIN bit controls whether the trigger begins or ends storing of data in FIFO. 0 Trigger at end of stored data 1 Trigger before storing data
3–0 TRG	Trigger Mode Bits — The TRG bits select the trigger mode of the DBG module as shown in Table 18-16 .

Table 18-16. Trigger Mode Encoding

TRG Value	Meaning
0000	A Only
0001	A Or B
0010	A Then B
0011	Event Only B
0100	A Then Event Only B
0101	A And B (Full Mode)
0110	A And Not B (Full mode)
0111	Inside Range
1000	Outside Range

Table 18-16. Trigger Mode Encoding

TRG Value	Meaning
1001 ↓ 1111	No Trigger

NOTE

The DBG trigger register (DBGTR) can not be changed unless ARM=0.

18.3.2.14 Debug Status Register (DBGSR)

Module Base + 0x000E

	7	6	5	4	3	2	1	0
R	AF	BF	CF	0	0	0	0	ARMF
W								
POR or non- end-run	0	0	0	0	0	0	0	1
Reset end-run ¹	U	U	U	0	0	0	0	0


 = Unimplemented or Reserved

Figure 18-15. Debug Status Register (DBGSR)

¹ In the case of an end-trace to reset where DBGGEN=1 and BEGIN=0, ARMF gets cleared by reset but AF, BF, and CF do not change after reset.

Table 18-17. DBGSR Field Descriptions

Field	Description
7 AF	Trigger A Match Bit — The AF bit indicates if Trigger A match condition was met since arming. 0 Comparator A did not match 1 Comparator A match
6 BF	Trigger B Match Bit — The BF bit indicates if Trigger B match condition was met since arming. 0 Comparator B did not match 1 Comparator B match
5 CF	Trigger C Match Bit — The CF bit indicates if Trigger C match condition was met since arming. 0 Comparator C did not match 1 Comparator C match
0 ARMF	Arm Flag Bit — The ARMF bit indicates whether the debugger is waiting for trigger or waiting for the FIFO to fill. While DBGGEN = 1, this status bit is a read-only image of the ARM bit in DBGCR. See Section 18.4.4.2, “Arming the DBG Module” for more information. 0 Debugger not armed 1 Debugger armed

18.3.2.15 Debug Count Status Register (DBGCNT)

Module Base + 0x000F

	7	6	5	4	3	2	1	0
R	0	0	0	0	CNT			
W								
POR or non- end-run	0	0	0	0	0	0	0	0
Reset end-run ¹	0	0	0	0	U	U	U	U


 = Unimplemented or Reserved

Figure 18-16. Debug Count Status Register (DBGCNT)

¹ In the case of an end-trace to reset where DBGEN=1 and BEGIN=0, the CNT[3:0] bits do not change after reset.

Table 18-18. DBGS Field Descriptions

Field	Description
3–0 CNT	FIFO Valid Count Bits — The CNT bits indicate the amount of valid data stored in the FIFO. Table 18-19 shows the correlation between the CNT bits and the amount of valid data in FIFO. The CNT will stop after a count to eight even if more data is being stored in the FIFO. The CNT bits are cleared when the DBG module is armed, and the count is incremented each time a new word is captured into the FIFO. The host development system is responsible for checking the value in CNT[3:0] and reading the correct number of words from the FIFO because the count does not decrement as data is read out of the FIFO at the end of a trace run.

Table 18-19. CNT Bits

CNT Value	Meaning
0000	No data valid
0001	1 word valid
0010	2 words valid
0011	3 words valid
0100	4 words valid
0101	5 words valid
0110	6 words valid
0111	7 words valid
1000	8 words valid

18.4 Functional Description

This section provides a complete functional description of the on-chip ICE system. The DBG module is enabled by setting the DBGGEN bit in the DBGCR register. Enabling the module allows the arming, triggering and storing of data in the FIFO. The DBG module is made up of three main blocks, the Comparators, Trigger Break Control logic and the FIFO.

18.4.1 Comparator

The DBG module contains three comparators, A, B, and C. Comparator A compares the core address bus with the address stored in the DBGCAH and DBGCAL registers. Comparator B compares the core address bus with the address stored in the DBGCBH and DBGCBL registers except in full mode, where it compares the data buses to the data stored in the DBGCBL register. Comparator C compares the core address bus with the address stored in the DBGCCCH and DBGCCCL registers. Matches on Comparators A, B, and C are signaled to the Trigger Break Control (TBC) block.

18.4.1.1 RWA and RWAEN in Full Modes

In full modes ("A And B" and "A And Not B") RWAEN and RWA are used to select read or write comparisons for both comparators A and B. To select write comparisons and the write data bus in Full Modes set RWAEN=1 and RWA=0, otherwise read comparisons and the read data bus will be selected. The RWBEN and RWB bits are not used and will be ignored in Full Modes.

18.4.1.2 Comparator C in LOOP1 Capture Mode

Normally comparator C is used as a third hardware breakpoint and is not involved in the trigger logic for the on-chip ICE system. In this mode, it compares the core address bus with the address stored in the DBGCCCH and DBGCCCL registers. However, in LOOP1 capture mode, comparator C is managed by logic in the DBG module to track the address of the most recent change-of-flow event that was captured into the FIFO buffer. In LOOP1 capture mode, comparator C is not available for use as a normal hardware breakpoint.

When the ARM and DBGGEN bits are set to one in LOOP1 capture mode, comparator C value registers are cleared to prevent the previous contents of these registers from interfering with the LOOP1 capture mode operation. When a COF event is detected, the address of the event is compared to the contents of the DBGCCCH and DBGCCCL registers to determine whether it is the same as the previous COF entry in the capture FIFO. If the values match, the capture is inhibited to prevent the FIFO from filling up with duplicate entries. If the values do not match, the COF event is captured into the FIFO and the DBGCCCH and DBGCCCL registers are updated to reflect the address of the captured COF event.

18.4.2 Breakpoints

A breakpoint request to the CPU at the end of a trace run can be created if the BRKEN bit in the DBGCR register is set. The value of the BEGIN bit in DBGT register determines when the breakpoint request to the CPU will occur. If the BEGIN bit is set, begin-trigger is selected and the breakpoint request will not occur until the FIFO is filled with 8 words. If the BEGIN bit is cleared, end-trigger is selected and the breakpoint request will occur immediately at the trigger cycle.

When traditional hardware breakpoints from comparators A or B are desired, set BEGIN=0 to select an end-trace run and set the trigger mode to either 0x0 (A-only) or 0x1 (A OR B) mode.

There are two types of breakpoint requests supported by the DBG module, tag-type and force-type. Tagged breakpoints are associated with opcode addresses and allow breaking just before a specific instruction executes. Force breakpoints are not associated with opcode addresses and allow breaking at the next instruction boundary. The TAG bit in the DBGCR register determines whether CPU breakpoint requests will be a tag-type or force-type breakpoints. When TAG=0, a force-type breakpoint is requested and it will take effect at the next instruction boundary after the request. When TAG=1, a tag-type breakpoint is registered into the instruction queue and the CPU will break if/when this tag reaches the head of the instruction queue and the tagged instruction is about to be executed.

18.4.2.1 Hardware Breakpoints

Comparators A, B, and C can be used as three traditional hardware breakpoints whether the on-chip ICE real-time capture function is required or not. To use any breakpoint or trace run capture functions set DBGEN=1. BRKEN and TAG affect all three comparators. When BRKEN=0, no CPU breakpoints are enabled. When BRKEN=1, CPU breakpoints are enabled and the TAG bit determines whether the breakpoints will be tag-type or force-type breakpoints. To use comparators A and B as hardware breakpoints, set DBGT=0x81 for tag-type breakpoints and 0x01 for force-type breakpoints. This sets up an end-type trace with trigger mode “A OR B”.

Comparator C is not involved in the trigger logic for the on-chip ICE system.

18.4.3 Trigger Selection

The TRGSEL bit in the DBGT register is used to determine the triggering condition of the on-chip ICE system. TRGSEL applies to both trigger A and B except in the event only trigger modes. By setting the TRGSEL bit, the comparators will qualify a match with the output of opcode tracking logic. The opcode tracking logic is internal to each comparator and determines whether the CPU executed the opcode at the compare address. With the TRGSEL bit cleared a comparator match is all that is necessary for a trigger condition to be met.

NOTE

If the TRGSEL is set, the address stored in the comparator match address registers must be an opcode address for the trigger to occur.

18.4.4 Trigger Break Control (TBC)

The TBC is the main controller for the DBG module. Its function is to decide whether data should be stored in the FIFO based on the trigger mode and the match signals from the comparator. The TBC also determines whether a request to break the CPU should occur.

The TAG bit in DBGCR controls whether CPU breakpoints are treated as tag-type or force-type breakpoints. The TRGSEL bit in DBGT controls whether a comparator A or B match is further qualified by opcode tracking logic. Each comparator has a separate circuit to track opcodes because the comparators could

correspond to separate instructions that could be propagating through the instruction queue at the same time.

In end-type trace runs (BEGIN=0), when the comparator registers match, including the optional R/W match, this signal goes to the CPU break logic where BRKEN determines whether a CPU break is requested and the TAG control bit determines whether the CPU break will be a tag-type or force-type breakpoint. When TRGSEL is set, the R/W qualified comparator match signal also passes through the opcode tracking logic. If/when it propagates through this logic, it will cause a trigger to the ICE logic to begin or end capturing information into the FIFO. In the case of an end-type (BEGIN=0) trace run, the qualified comparator signal stops the FIFO from capturing any more information.

If a CPU breakpoint is also enabled, you would want TAG and TRGSEL to agree so that the CPU break occurs at the same place in the application program as the FIFO stopped capturing information. If TRGSEL was 0 and TAG was 1 in an end-type trace run, the FIFO would stop capturing as soon as the comparator address matched, but the CPU would continue running until a TAG signal could propagate through the CPU's instruction queue which could take a long time in the case where changes of flow caused the instruction queue to be flushed. If TRGSEL was one and TAG was zero in an end-type trace run, the CPU would break before the comparator match signal could propagate through the opcode tracking logic to end the trace run.

In begin-type trace runs (BEGIN=1), the start of FIFO capturing is triggered by the qualified comparator signals, and the CPU breakpoint (if enabled by BRKEN=1) is triggered when the FIFO becomes full. Since this FIFO full condition does not correspond to the execution of a tagged instruction, it would not make sense to use TAG=1 for a begin-type trace run.

18.4.4.1 Begin- and End-Trigger

The definition of begin- and end-trigger as used in the DBG module are as follows:

- Begin-trigger: Storage in FIFO occurs after the trigger and continues until 8 locations are filled.
- End-trigger: Storage in FIFO occurs until the trigger with the least recent data falling out of the FIFO if more than 8 words are collected.

18.4.4.2 Arming the DBG Module

Arming occurs by enabling the DBG module by setting the DBGEN bit and by setting the ARM bit in the DBGCR register. The ARM bit in the DBGCR register and the ARMF bit in the DBGS register are cleared when the trigger condition is met in end-trigger mode or when the FIFO is filled in begin-trigger mode. In the case of an end-trace where DBGEN=1 and BEGIN=0, ARM and ARMF are cleared by any reset to end the trace run that was in progress. The ARMF bit is also cleared if ARM is written to zero or when the DBGEN bit is low. The TBC logic determines whether a trigger condition has been met based on the trigger mode and the trigger selection.

18.4.4.3 Trigger Modes

The on-chip ICE system supports nine trigger modes. The trigger modes are encoded as shown in [Table 18-16](#). The trigger mode is used as a qualifier for either starting or ending the storing of data in the FIFO. When the match condition is met, the appropriate flag AF or BF is set in DBGS register. Arming

the DBG module clears the AF, BF, and CF flags in the DBGS register. In all trigger modes except for the event only modes change of flow addresses are stored in the FIFO. In the event only modes only the value on the data bus at the trigger event B comparator match address will be stored.

18.4.4.3.1 A Only

In the A Only trigger mode, if the match condition for A is met, the AF flag in the DBGS register is set.

18.4.4.3.2 A Or B

In the A Or B trigger mode, if the match condition for A or B is met, the corresponding flag(s) in the DBGS register are set.

18.4.4.3.3 A Then B

In the A Then B trigger mode, the match condition for A must be met before the match condition for B is compared. When the match condition for A or B is met, the corresponding flag in the DBGS register is set.

18.4.4.3.4 Event Only B

In the Event Only B trigger mode, if the match condition for B is met, the BF flag in the DBGS register is set. The Event Only B trigger mode is considered a begin-trigger type and the BEGIN bit in the DBGT register is ignored.

18.4.4.3.5 A Then Event Only B

In the A Then Event Only B trigger mode, the match condition for A must be met before the match condition for B is compared. When the match condition for A or B is met, the corresponding flag in the DBGS register is set. The A Then Event Only B trigger mode is considered a begin-trigger type and the BEGIN bit in the DBGT register is ignored.

18.4.4.3.6 A And B (Full Mode)

In the A And B trigger mode, Comparator A compares to the address bus and Comparator B compares to the data bus. In the A and B trigger mode, if the match condition for A and B happen on the same bus cycle, both the AF and BF flags in the DBGS register are set. If a match condition on only A or only B happens, no flags are set.

For Breakpoint tagging operation with an end-trigger type trace, only matches from Comparator A will be used to determine if the Breakpoint conditions are met and Comparator B matches will be ignored.

18.4.4.3.7 A And Not B (Full Mode)

In the A And Not B trigger mode, comparator A compares to the address bus and comparator B compares to the data bus. In the A And Not B trigger mode, if the match condition for A and Not B happen on the same bus cycle, both the AF and BF flags in the DBGS register are set. If a match condition on only A or only Not B occur no flags are set.

For Breakpoint tagging operation with an end-trigger type trace, only matches from Comparator A will be used to determine if the Breakpoint conditions are met and Comparator B matches will be ignored.

18.4.4.3.8 Inside Range, $A \leq \text{address} \leq B$

In the Inside Range trigger mode, if the match condition for A and B happen on the same bus cycle, both the AF and BF flags in the DBGS register are set. If a match condition on only A or only B occur no flags are set.

18.4.4.3.9 Outside Range, $\text{address} < A$ or $\text{address} > B$

In the Outside Range trigger mode, if the match condition for A or B is met, the corresponding flag in the DBGS register is set.

The four control bits BEGIN and TRGSEL in DBGT, and BRKEN and TAG in DBGCR, determine the basic type of debug run as shown in Table 1.21. Some of the 16 possible combinations are not used (refer to the notes at the end of the table).

Table 18-20. Basic Types of Debug Runs

BEGIN	TRGSEL	BRKEN	TAG	Type of Debug Run
0	0	0	x ⁽¹⁾	Fill FIFO until trigger address (No CPU breakpoint - keep running)
0	0	1	0	Fill FIFO until trigger address, then force CPU breakpoint
0	0	1	1	Do not use ⁽²⁾
0	1	0	x ⁽¹⁾	Fill FIFO until trigger opcode about to execute (No CPU breakpoint - keep running)
0	1	1	0	Do not use ⁽³⁾
0	1	1	1	Fill FIFO until trigger opcode about to execute (trigger causes CPU breakpoint)
1	0	0	x ⁽¹⁾	Start FIFO at trigger address (No CPU breakpoint - keep running)
1	0	1	0	Start FIFO at trigger address, force CPU breakpoint when FIFO full
1	0	1	1	Do not use ⁽⁴⁾
1	1	0	x ⁽¹⁾	Start FIFO at trigger opcode (No CPU breakpoint - keep running)
1	1	1	0	Start FIFO at trigger opcode, force CPU breakpoint when FIFO full
1	1	1	1	Do not use ⁽⁴⁾

¹ When BRKEN = 0, TAG is do not care (x in the table).

² In end trace configurations (BEGIN = 0) where a CPU breakpoint is enabled (BRKEN = 1), TRGSEL should agree with TAG. In this case, where TRGSEL = 0 to select no opcode tracking qualification and TAG = 1 to specify a tag-type CPU breakpoint, the CPU breakpoint would not take effect until sometime after the FIFO stopped storing values. Depending on program loops or interrupts, the delay could be very long.

³ In end trace configurations (BEGIN = 0) where a CPU breakpoint is enabled (BRKEN = 1), TRGSEL should agree with TAG. In this case, where TRGSEL = 1 to select opcode tracking qualification and TAG = 0 to specify a force-type CPU breakpoint, the CPU breakpoint would erroneously take effect before the FIFO stopped storing values and the debug run would not complete normally.

⁴ In begin trace configurations (BEGIN = 1) where a CPU breakpoint is enabled (BRKEN = 1), TAG should not be set to 1. In begin trace debug runs, the CPU breakpoint corresponds to the FIFO full condition which does not correspond to a taggable instruction fetch.

18.4.5 FIFO

The FIFO is an eight word deep FIFO. In all trigger modes except for event only, the data stored in the FIFO will be change of flow addresses. In the event only trigger modes only the data bus value corresponding to the event is stored. In event only trigger modes, the high byte of the valid data from the FIFO will always read a 0x00.

18.4.5.1 Storing Data in FIFO

In all trigger modes except for the event only modes, the address stored in the FIFO will be determined by the change of flow indicators from the core. The signal `core_cof[1]` indicates the current core address is the destination address of an indirect JSR or JMP instruction, or a RTS or RTI instruction or interrupt vector and the destination address should be stored. The signal `core_cof[0]` indicates that a conditional branch was taken and that the source address of the conditional branch should be stored.

18.4.5.2 Storing with Begin-Trigger

Storing with Begin-Trigger can be used in all trigger modes. Once the DBG module is enabled and armed in the begin-trigger mode, data is not stored in the FIFO until the trigger condition is met. Once the trigger condition is met the DBG module will remain armed until 8 words are stored in the FIFO. If the `core_cof[1]` signal becomes asserted, the current address is stored in the FIFO. If the `core_cof[0]` signal becomes asserted, the address registered during the previous last cycle is decremented by two and stored in the FIFO.

18.4.5.3 Storing with End-Trigger

Storing with End-Trigger cannot be used in event-only trigger modes. Once the DBG module is enabled and armed in the end-trigger mode, data is stored in the FIFO until the trigger condition is met. If the `core_cof[1]` signal becomes asserted, the current address is stored in the FIFO. If the `core_cof[0]` signal becomes asserted, the address registered during the previous last cycle is decremented by two and stored in the FIFO. When the trigger condition is met, the ARM and ARMF will be cleared and no more data will be stored. In non-event only end-trigger modes, if the trigger is at a change of flow address the trigger event will be stored in the FIFO.

18.4.5.4 Reading Data from FIFO

The data stored in the FIFO can be read using BDM commands provided the DBG module is enabled and not armed (`DBGEN=1` and `ARM=0`). The FIFO data is read out first-in-first-out. By reading the CNT bits in the DBG CNT register at the end of a trace run, the number of valid words can be determined. The FIFO data is read by optionally reading the DBG FH register followed by the DBG FL register. Each time the DBG FL register is read the FIFO is shifted to allow reading of the next word however the count does not decrement. In event-only trigger modes where the FIFO will contain only the data bus values stored, to read the FIFO only DBG FL needs to be accessed.

The FIFO is normally only read while ARM and ARMF=0, however reading the FIFO while the DBG module is armed will return the data value in the oldest location of the FIFO and the TBC will not allow

the FIFO to shift. This action could cause a valid entry to be lost because the unexpected read blocked the FIFO advance.

If the DBG module is not armed and the DBGFL register is read, the TBC will store the current opcode address. Through periodic reads of the DBGFL and DBGFL registers while the DBG module is not armed, host software can provide a histogram of program execution. This is called profile mode.

18.4.6 Interrupt Priority

When TRGSEL is set and the DBG module is armed to trigger on begin- or end-trigger types, a trigger is not detected in the condition where a pending interrupt occurs at the same time that a target address reaches the top of the instruction pipe. In these conditions, the pending interrupt has higher priority and code execution switches to the interrupt service routine.

When TRGSEL is clear and the DBG module is armed to trigger on end-trigger types, the trigger event is detected on a program fetch of the target address, even when an interrupt becomes pending on the same cycle. In these conditions, the pending interrupt has higher priority, the exception is processed by the core and the interrupt vector is fetched. Code execution is halted before the first instruction of the interrupt service routine is executed. In this scenario, the DBG module will have cleared ARM without having recorded the change-of-flow that occurred as part of the interrupt exception. Note that the stack will hold the return addresses and can be used to reconstruct execution flow in this scenario.

When TRGSEL is clear and the DBG module is armed to trigger on begin-trigger types, the trigger event is detected on a program fetch of the target address, even when an interrupt becomes pending on the same cycle. In this scenario, the FIFO captures the change of flow event. Because the system is configured for begin-trigger, the DBG remains armed and does not break until the FIFO has been filled by subsequent change of flow events.

18.5 Resets

The DBG module cannot cause an MCU reset.

There are two different ways this module will respond to reset depending upon the conditions before the reset event. If the DBG module was setup for an end trace run with DBGGEN=1 and BEGIN=0, ARM, ARMF, and BRKEN are cleared but the reset function on most DBG control and status bits is overridden so a host development system can read out the results of the trace run after the MCU has been reset. In all other cases including POR, the DBG module controls are initialized to start a begin trace run starting from when the reset vector is fetched. The conditions for the default begin trace run are:

- DBGCAH=0xFF, DBGCAL=0xFE so comparator A is set to match when the 16-bit CPU address 0xFFFFE appears during the reset vector fetch
- DBGC=0xC0 to enable and arm the DBG module
- DBGT=0x40 to select a force-type trigger, a BEGIN trigger, and A-only trigger mode

18.6 Interrupts

The DBG contains no interrupt source.

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